

Devices in the S6E2C3 Series are highly integrated 32-bit microcontrollers with high performance and competitive cost. This series is based on the ARM Cortex-M4F processor with on-chip flash memory and SRAM. The series has peripherals such as motor control timers, A/D converters, and communications interfaces (USB, UART, CSIO (SPI), I²C, LIN). The products that are described in this data sheet are placed into TYPE3-M4 product categories "FM4 Family Peripheral Manual Main Part (002-04856)."

Features

32-bit ARM Cortex-M4F Core

- Processor version: r0p1
- Up to 200 MHz frequency operation
- FPU built-in
- Support DSP instructions
- Memory protection unit (MPU): improves the reliability of an embedded system
- Integrated nested vectored interrupt controller (NVIC): 1 NMI (non-maskable interrupt) and 128 peripheral interrupts and 16 priority levels
- 24-bit system timer (Sys Tick): system timer for OS task management

On-chip Memories

■ Flash memory

This series is based on two independent on-chip flash memories.

- Up to 2048 Kbytes
- Built-in flash accelerator system with 16 Kbytes trace buffer memory
- Read access to flash memory that can be achieved without wait-cycle up to an operating frequency of 72 MHz. Even at the operating frequency more than 72 MHz, an equivalent single cycle access to flash memory can be obtained by the flash accelerator system.
- Security function for code protection

■ SRAM

This is composed of three independent SRAMs (SRAM0, SRAM1 and SRAM2). SRAM0 is connected to the I-code bus or D-code bus of Cortex-M4F core. SRAM1 and SRAM2 are connected to system bus of Cortex-M4F core.

- SRAM0: up to 192 Kbytes
- SRAM1: 32 Kbytes
- SRAM2: 32 Kbytes

External Bus Interface

- Supports SRAM, NOR, NAND flash and SDRAM device
- Up to 9 chip selects CS0 to CS8 (CS8 is only for SDRAM)
- 8-/16-/32-bit data width
- Up to 25-bit address bus
- Maximum Access size: 256M byte
- Supports address/data multiplexing
- Supports external RDY function
- Supports scramble function
- Possible to set the validity/invalidity of the scramble function for the external areas 0x6000_0000 to 0xDFFF_FFFF in 4 Mbytes units.
- Possible to set two kinds of the scramble key
 Note: It is necessary to use the Cypress provided software library to use the scramble function.

USB Interface (Max two Channels)

The USB interface is composed of a device and a host.

■ USB device

- USB 2.0 Full-speed supported
- Max 6 EndPoint supported
 - EndPoint 0 is control transfer
 - EndPoint 1, 2 can be selected bulk-transfer, interrupt-transfer or isochronous-transfer
 - EndPoint 3 to 5 can select bulk-transfer or interrupt-transfer
 - EndPoint 1 to 5 comprise double buffer
- The size of each endpoint is as follows.
 - Endpoint 0, 2 to 5: 64 byte
 - EndPoint 1: 256 byte

■ USB host

- USB2.0 Full-Speed/Low-Speed supported
- Bulk-transfer, interrupt-transfer, and isochronous-transfer support
- USB Device connected/dis-connected automatically detect
- IN/OUT token handshake packet automatically
- Max 256-byte packet length supported
- Wake-up function supported

Multi-function Serial Interface (Max 16 channels)

- Separate 64 byte receive and transmit FIFO buffers for channels 0 to 7.
- Operation mode is selectable for each channel from the following:
 - UART
 - CSIO (SPI)
 - LIN
 - I²C
- UART
 - Full-duplex double buffer
 - Selection with or without parity supported
 - Built-in dedicated baud rate generator
 - External clock available as a serial clock
 - Various error detect functions available (parity errors, framing errors, and overrun errors)
- CSIO (SPI)
 - Full-duplex double buffer
 - Built-in dedicated baud rate generator
 - Overrun error detect function available
 - Serial chip select function (ch 6 and ch 7 only)
 - Supports high-speed SPI (ch 4 and ch 6 only)
 - Data length 5 to 16-bit
- LIN
 - LIN protocol Rev.2.1 supported
 - Full-duplex double buffer
 - Master/slave mode supported
 - LIN break field generation (can change to 13- to 16-bit length)
 - LIN break delimiter generation (can change to 1- to 4-bit length)
 - Various error detect functions available (parity errors, framing errors, and overrun errors)
- I²C
 - Standard mode (Max 100 kbps)/
Fast mode (Max 400 kbps) supported
 - Fast mode Plus (Fm+) (Max 1000 kbps, only for ch 3 = ch A and ch 7 = ch B) supported

DMA Controller (Eight channels)

DMA controller has an independent bus, so the CPU and DMA controller can process simultaneously.

- Eight independently configured and operated channels
- Transfer can be started by software or request from the built-in peripherals
- Transfer address area: 32-bit (4 GB)
- Transfer mode: Block transfer/Burst transfer/Demand transfer
- Transfer data type: bytes/half-word/word
- Transfer block count: 1 to 16
- Number of transfers: 1 to 65536

DSTC (Descriptor System data Transfer Controller; 256 Channels)

The DSTC can transfer data at high-speed without going via the CPU. The DSTC adopts the descriptor system and, following the specified contents of the descriptor that has already been constructed on the memory, can access directly the memory/peripheral device and perform the data-transfer operation.

It supports the software activation, the hardware activation, and the chain activation functions.

A/D Converter (Max 32 channels)

- 12-bit A/D Converter
 - Successive approximation type
 - Built-in three units
 - Conversion time: 0.5 μs at 5 V
 - Priority conversion available (priority at two levels)
 - Scanning conversion mode
 - Built-in FIFO for conversion data storage (for SCAN conversion: 16 steps, for priority conversion: 4 steps)

D/A Converter (Max 2 Channels)

- R-2R type
- 12-bit resolution

Base Timer (Max 16 Channels)

Operation mode is selected from the following for each channel:

- 16-bit PWM timer
- 16-bit PPG timer
- 16-/32-bit reload timer
- 16-/32-bit PWC timer

General Purpose I/O Port

This series can use its pins as general purpose I/O ports when they are not used for external bus or peripherals; moreover, the port relocate function is built in. It can set the I/O port to which the peripheral function can be allocated.

- Capable of pull-up control per pin
- Capable of reading pin level directly
- Built-in port-relocate function
- Up to 120 high-speed general-purpose I/O ports in 144-pin package
- Some pins 5 V tolerant I/O.
See 4. Pin Descriptions and 5. I/O Circuit Type for the corresponding pins.

Multi-function Timer (Max three Units)

The multi-function timer is composed of the following blocks:

Minimum resolution: 5.00 ns

- 16-bit free-run timer × 3 ch/unit
- Input capture × 4 ch/unit
- Output compare × 6 ch/unit
- A/D activation compare × 6 ch/unit
- Waveform generator × 3 ch/unit
- 16-bit PPG timer × 3 ch/unit

The following functions can be used to achieve the motor control:

- PWM signal output function
- DC chopper waveform output function
- Dead time function
- Input capture function
- A/D convertor activate function
- DTIF (motor emergency stop) interrupt function

Real-Time Clock (RTC)

The real-time clock can count year, month, day, hour, minute, second, or day of the week from 00 to 99.

- Interrupt function with specifying date and time (year/month/day/hour/minute) is available. This function is also available by specifying only year, month, day, hour, or minute.
- Timer interrupt function after set time or each set time.
- Capable of rewriting the time with continuing the time count.
- Leap year automatic count is available.

Quadrature Position/Revolution Counter (QPRC; Max four Channels)

The Quadrature Position/Revolution Counter (QPRC) is used to measure the position of the position encoder. It is also possible to use up/down counter.

- The detection edge of the three external event input pins AIN, BIN and ZIN is configurable.
- 16-bit position counter
- 16-bit revolution counter
- Two 16-bit compare registers

Dual Timer (32-/16-bit Down Counter)

The dual timer consists of two programmable 32/16-bit down counters.

Operation mode is selectable from the following for each channel:

- Free-running
- Periodic (= Reload)
- One shot

Watch Counter

The watch counter is used for wake up from low-power consumption mode. It is possible to select the main clock, sub clock, built-in High-speed CR clock, or built-in low-speed CR clock as the clock source.

- Interval timer: up to 64 s (max) with a sub clock of 32.768 kHz

External Interrupt Controller Unit

- External interrupt input pin: Max 32 pins
- Include one non-maskable interrupt (NMI)

Watchdog Timer (2 Channels)

A watchdog timer can generate interrupts or a reset when a time-out value is reached.

This series consists of two different watchdogs: a "hardware" watchdog and a "software" watchdog.

The hardware watchdog timer is clocked by low-speed internal CR oscillator. The hardware watchdog is thus active in any power saving mode except RTC mode and Stop mode.

Cyclic Redundancy Check (CRC) Accelerator

The CRC accelerator helps to verify data transmission or storage integrity.

CCITT CRC16 and IEEE-802.3 CRC32 are supported.

- CCITT CRC16 generator polynomial: 0x1021
- IEEE-802.3 CRC32 generator polynomial: 0x04C11DB7

Programmable Cyclic Redundancy Check (PRGCRC) Accelerator

The CRC accelerator helps a verify data transmission or storage integrity.

CCITT CRC16, IEEE-802.3 CRC32 and generating polynomial are supported.

- CCITT CRC16 generator polynomial: 0x1021
- IEEE-802.3 CRC32 generator polynomial: 0x04C11DB7
- Generating polynomial

SD Card Interface

It is possible to use the SD card that conforms to the following standards.

- Part 1 Physical Layer Specification version 3.01
- Part E1 SDIO Specification version 3.00
- Part A2 SD Host Controller Standard Specification version 3.00
- 1-bit or 4-bit data bus

I²S (Inter-IC Sound Bus) Interface (TX x 1 channel, RX x 1 channel)

- Supports three transfer protocols
 - I²S
 - Left justified
 - DSP mode
 - Separate clock generation block for flexible system integration options
- Master/slave mode selectable
- RX Only, TX Only or TX and RX simultaneous operation selectable
- Word length is programmable from 7-bits to 32 bits
- RX/TX FIFO integrated (RX: 66 words x 32-bits, TX: 66 words x 32-bits)
- DMA, interrupts, or polling based data transfer supported

High-Speed Quad SPI

Up to 66 MHz clock rates for very fast data transfers to and from SPI compatible devices.

Up to 256 Mbytes of memory mapped address space.

- Single data rate (SDR)
- Supports single, dual, and quad data modes
- Built-in direct mode and command sequencer mode
 - Direct mode: Access by use of transmission FIFO/reception FIFO (up to 16 word x 32 bit)
 - Command sequencer mode: Automatic access assigned to external device area.

Clock and Reset

■ Clocks

Five clock sources (two external oscillators, two internal CR oscillators, and Main PLL) that are dynamically selectable.

- Main clock: 4 MHz to 48 MHz
- Sub clock: 32.768 kHz
- High-speed internal CR clock: 4 MHz
- Low-speed internal CR clock: 100 kHz
- Main PLL Clock

■ Resets

- Reset requests from INITX pin
- Power on reset
- Software reset
- Watchdog timer reset
- Low-voltage detector reset
- Clock supervisor reset

Clock Supervisor (CSV)

Clocks generated by internal CR oscillators are used to supervise abnormality of the external clocks.

- External OSC clock failure (clock stop) is detected, reset is asserted.
- External OSC frequency anomaly is detected, interrupt or reset is asserted.

Low-Voltage Detector (LVD)

This Series include two-stage monitoring of voltage on the VCC pins. when the voltage falls below the voltage that has been set, the low-voltage detector function generates an interrupt or reset.

- LVD1: error reporting via interrupt
- LVD2: auto-reset operation

Low-power Consumption Mode

Six low power consumption modes are supported.

- Sleep
- Timer
- RTC
- Stop
- Deep standby RTC (selectable from with/without RAM retention)
- Deep standby stop (selectable from with/without RAM retention)

Peripheral Clock Gating

The system can reduce the current consumption of the total system with gating the operation clocks of peripheral functions not used.

VBAT

The consumption power during the RTC operation can be reduced by supplying the power supply independent from the RTC (calendar circuit)/32 kHz oscillation circuit. The following circuits can also be used.

- RTC
- 32-kHz oscillation circuit
- Power-on circuit
- Back up register: 32 bytes
- Port circuit

Debug

- Serial wire JTAG debug port (SWJ-DP)
- Embedded trace macrocells (ETM) provide comprehensive debug and trace facilities.
- AHB trace macrocells (HTM)

Unique ID

Unique value of the device (41-bit) is set.

Power Supply

- Four power supplies
 - Wide range voltage:
 - VCC = 2.7 V to 5.5 V
 - Power supply for USB ch 0 I/O:
 - USBVCC0 = 3.0 V to 3.6 V (when USB is used)
 - = 2.7 V to 5.5 V (when GPIO is used)
 - Power supply for USB ch 1 I/O:
 - USBVCC1 = 3.0 V to 3.6 V (when USB is used)
 - = 2.7 V to 5.5 V (when GPIO is used)
 - Power supply for VBAT:
 - VBAT = 1.65 V to 5.5 V

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1. Product Lineup

Memory Size

| Product Name | | S6E2C38H/J/L | S6E2C39H/J/L | S6E2C3AH/J/L |
|----------------------|-------|--------------|--------------|--------------|
| On-chip flash memory | | 1024 Kbytes | 1536 Kbytes | 2048 Kbytes |
| On-chip | SRAM | 128 Kbytes | 192 Kbytes | 256 Kbytes |
| | SRAM0 | 64 Kbytes | 128 Kbytes | 192 Kbytes |
| | SRAM1 | 32 Kbytes | 32 Kbytes | 32 Kbytes |
| | SRAM2 | 32 Kbytes | 32 Kbytes | 32 Kbytes |

Function

| Product Name | | S6E2C38H0A S6E2C39H0A S6E2C3AH0A | S6E2C38J0A S6E2C39J0A S6E2C3AJ0A | S6E2C38L0A S6E2C39L0A S6E2C3AL0A |
|--|------------------------|--|---|--|
| Pin count | | 144 | 176/192 | 216 |
| CPU | | Cortex-M4F, MPU, NVIC 128 ch | | |
| Freq. | | 200 MHz | | |
| Power supply voltage range | | 2.7 V to 5.5 V | | |
| USB2.0 (device/host) | | 2 ch | | |
| DMAC | | 8ch | | |
| DSTC | | 256 ch | | |
| External bus interface | | Addr: 25-bit (Max), Data: 8-/16-bit CS: 9 (Max), SRAM, NOR flash NAND flash | Addr: 25-bit (Max), Data: 8-/16-bit CS: 9 (Max), SRAM, NOR flash , NAND flash SDRAM | Addr: 25-bit (Max), Data: 8-/16-/32-bit CS: 9 (Max), SRAM, NOR flash , NAND flash, SDRAM |
| Multi-function serial interface (UART/CSIO/LIN/I ² C) | | 16ch (Max) ch 0 to ch 7 : FIFO, ch 8 to ch 15 : No FIFO | | |
| Base timer (PWC/Reload timer/PWM/PPG) | | 16 ch (Max) | | |
| MF timer | A/D activation compare | 6 ch | | |
| | Input capture | 4 ch | | |
| | Free-run timer | 3 ch | | |
| | Output compare | 6 ch | | |
| | Waveform generator | 3 ch | | |
| | PPG | 3 ch | | |
| SD card interface | | 1 unit | | |
| I ² S | | - | 1 unit | |
| High-speed quad SPI | | - | 1 unit | |
| QPRC | | 4 ch (Max) | | |
| Dual timer | | 1 unit | | |
| Real-time clock | | 1 unit | | |
| Watch counter | | 1 unit | | |
| CRC accelerator | | Yes (fixed, programmable) | | |
| Watchdog timer | | 1 ch (SW) + 1 ch (HW) | | |
| External interrupts | | 32 pins (Max)+ NMI × 1 | | |
| I/O ports | | 120 pins (Max) | 152 pins (Max) | 190 pins (Max) |
| 12-bit A/D converter | | 24 ch (3 units) | 32 ch (3 units) | |
| 12-bit D/A converter | | 2 units (Max) | | |
| CSV (clock supervisor) | | Yes | | |
| LVD (low-voltage detector) | | 2 ch | | |
| Built-in CR | High-speed | 4 MHz | | |
| | Low-speed | 100 kHz | | |
| Debug function | | SWJ-DP/ETM/HTM | | |
| Unique ID | | Yes | | |

Notes:

- All signals of the peripheral function in each product cannot be allocated by limiting the pins of package. It is necessary to use the port relocate function of the I/O port according to your function use.
- See 12.4.3 Built-In CR Oscillation Characteristics for the accuracy of the built-in CR.

2. Packages

| Package | Product Name | S6E2C38H0A | S6E2C38J0A | S6E2C38L0A |
|-----------------------------|--------------|------------|------------|------------|
| | | S6E2C39H0A | S6E2C39J0A | S6E2C39L0A |
| | | S6E2C3AH0A | S6E2C3AJ0A | S6E2C3AL0A |
| LQFP: LQS144 (0.5-mm pitch) | | ○ | - | - |
| LQFP: LQP176 (0.5-mm pitch) | | - | ○ | - |
| BGA : LBE192 (0.8-mm pitch) | | - | ○ | - |
| LQFP: LQQ216 (0.4-mm pitch) | | - | - | ○ |

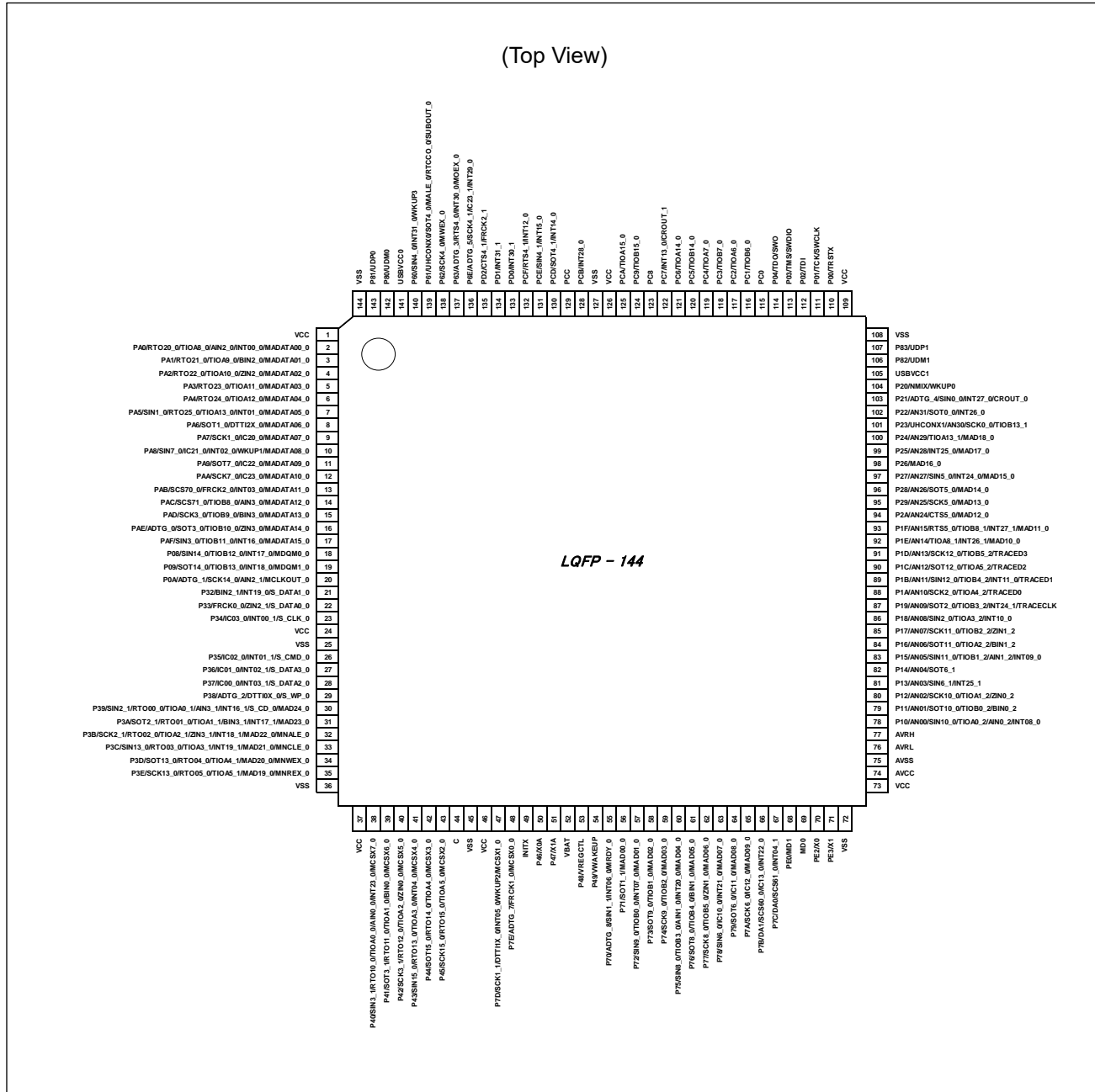
○: Supported

Note:

- See 14. Package Diagrams for detailed information on each package.

3. Pin Assignments

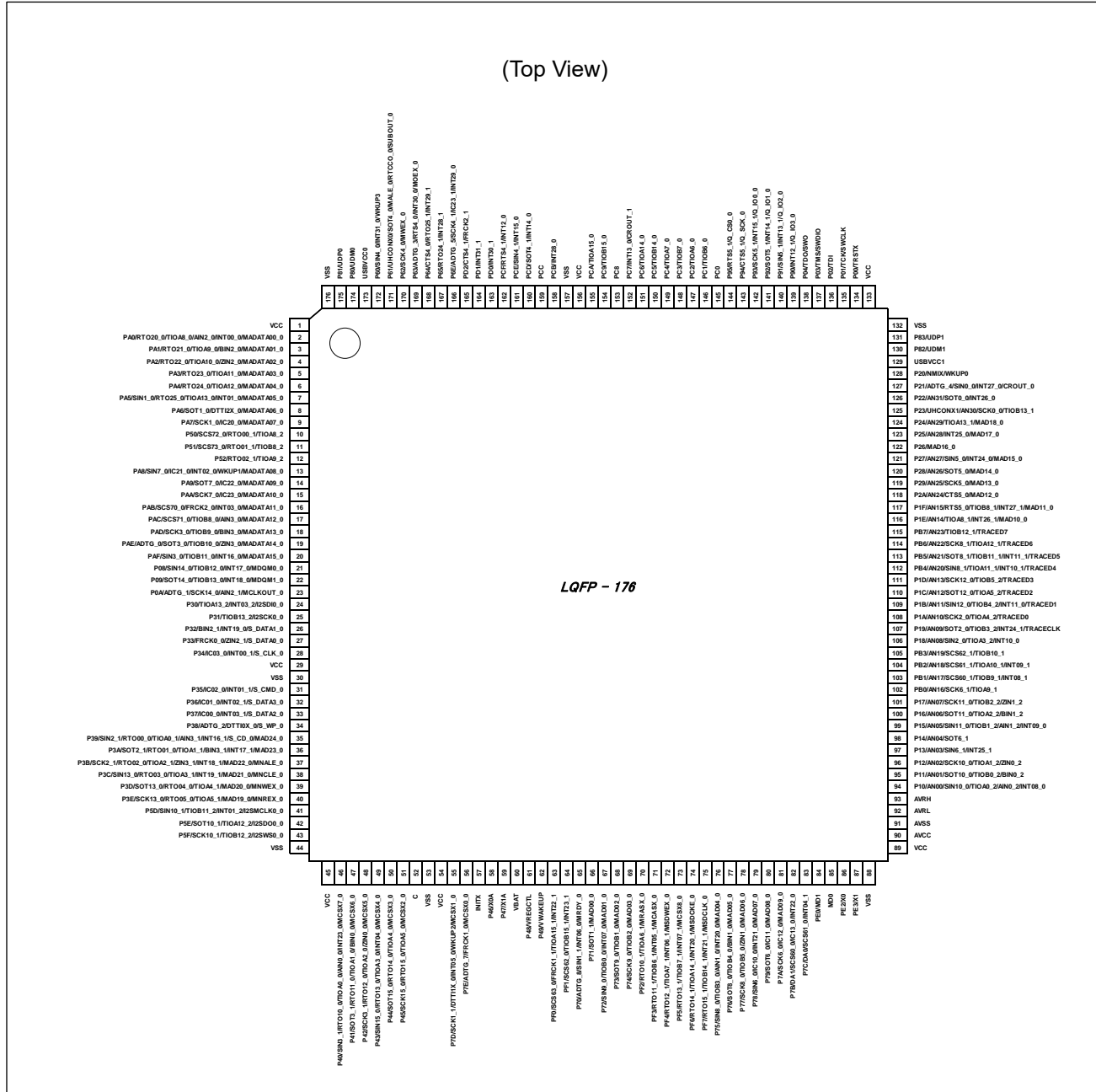
LQS144



Note:

- The number after the underscore ("_") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

LQP176



Note:

- The number after the underscore ("_") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

LQ216

(Top View)

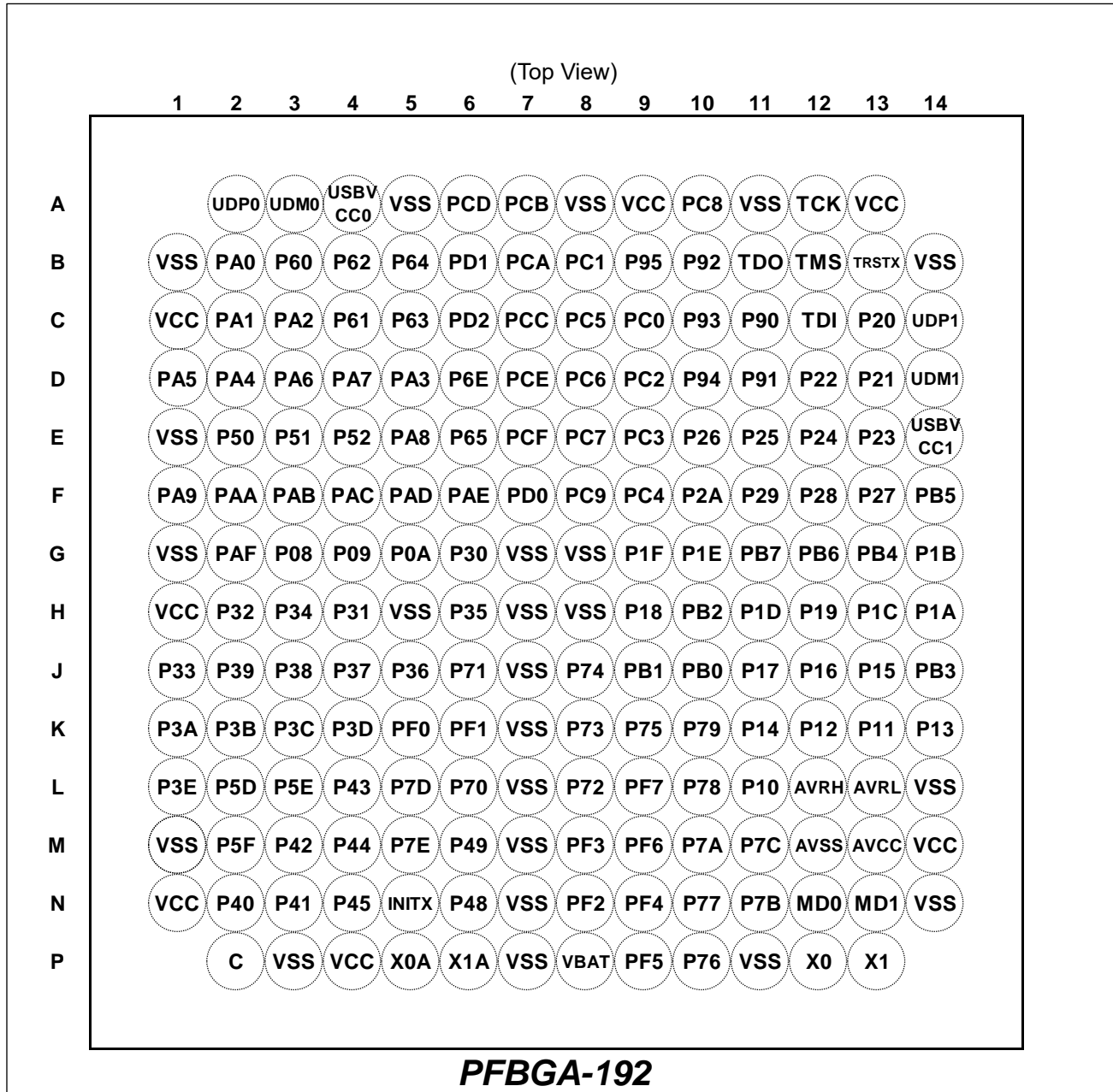
| | | | |
|----|--|-----|---------------------------------------|
| 1 | VCC | 162 | VSS |
| 2 | PA1RT020_0710A8_0I2N2_0INT08_0IMADAT4A00_0 | 161 | PS3UDP1 |
| 3 | PA1RT021_0710A8_0I2N2_0IMADAT4A01_0 | 160 | PS3UDM1 |
| 4 | PA21RT022_0710A10_0I2N2_0IMADAT4A02_0 | 159 | USBVCC1 |
| 5 | PA31RT023_0710A11_0IMADAT4A03_0 | 158 | PS20N0XWKLUP0 |
| 6 | PA41RT024_0710A12_0IMADAT4A04_0 | 157 | PS12A070_0I2N2_0INT27_0SCROUT_0 |
| 7 | PA51SIN1_0RT025_0710A13_0INT10_0IMADAT4A05_0 | 156 | PS2AN215070_0INT26_0 |
| 8 | PA61SOT1_0RT12X_0IMADAT4A06_0 | 155 | PS23UHCONK1AN20SCK0_0710B13_1 |
| 9 | PA71SCK1_0I2C20_0IMADAT4A07_0 | 154 | PS4AN29710A13_1MAD18_0 |
| 10 | PS51SCE22_0RT026_0710A8_0IMADAT4A16_0 | 153 | PS2AN20B1205_0MAD17_0 |
| 11 | PS11SCE23_0RT021_0710B8_0IMADAT4A17_0 | 152 | PS26MAD16_0 |
| 12 | PS21RT022_0710A9_0IMADAT4A18_0 | 151 | PS1F81B00_1I2N2_0INT11_02TRACED15 |
| 13 | PS21RT023_0710B9_0IMADAT4A19_0 | 150 | PS21SOT1_0I2N2_02TRACED14 |
| 14 | PA61SIN7_0I2C1_0I2N20_0SWRUP1MADAT4A08_0 | 149 | PSB1SCK6_1I2N2_0INT10_02TRACED13 |
| 15 | PA61SOT7_0I2C2_0IMADAT4A09_0 | 148 | PS1C1TRACED12 |
| 16 | PA61SCK7_0I2C3_0IMADAT4A10_0 | 147 | PS21AN2710B5_0INT24_0MAD15_0 |
| 17 | PA61SCE70_0I2C02_0INT02_0IMADAT4A11_0 | 146 | PS2AN20SOT5_0MAD14_0 |
| 18 | PA61SCE71_0710B8_0I2N2_0IMADAT4A12_0 | 145 | PS2AN25SCK5_0MAD13_0 |
| 19 | PS41SIN15_1I2T004_1I2T0A10_0INT08_0IMADAT4A20_0 | 144 | PS2AN24CT5_0MAD12_0 |
| 20 | PS51SOT15_1I2T005_1I2T0B10_0IMADAT4A21_0 | 143 | PS1FAN151075_0710B8_1INT27_1MAD11_0 |
| 21 | PS51SCK15_1I2T10X_1I2T0B0_1MADAT4A22_0 | 142 | PS1FAN1470A8_1INT26_1MAD10_0 |
| 22 | PS71RC00_1I2T0B1_1MADAT4A23_0 | 141 | PS1AN23710B12_1YTRACED7 |
| 23 | PA61SCK3_0710B8_0I2N3_0IMADAT4A13_0 | 140 | PS6AN22SCK4_1I2T0A12_1YTRACED6 |
| 24 | PA61SOT3_0I2T01_0I2N20_0IMADAT4A14_0 | 139 | PS6AN21SOT6_1I2T0B1_1INT11_1YTRACED5 |
| 25 | PA61SIN3_0710B1_0INT16_0IMADAT4A15_0 | 138 | PS6AN20SIN6_1I2T0A11_1INT10_1YTRACED4 |
| 26 | PS61SIN11_1I2C01_1I2T0B2_1INT02_0IMADAT4A24_0 | 137 | VCC |
| 27 | PS61SOT11_1I2C02_1I2T0B3_1MADAT4A25_0 | 136 | VSS |
| 28 | PS61SCK11_1I2C03_1I2T0A4_1MADAT4A26_0 | 135 | PS1AN13SCK12_0710B8_02TRACED3 |
| 29 | PS61SCK0_1I2T0B5_1MADAT4A27_0 | 134 | PS1CAN12SOT12_0710A5_02TRACED2 |
| 30 | PS61SIN14_0710B12_0INT17_0MAD00_0 | 133 | PS1CAN11SIN12_0710B8_0INT11_02TRACED1 |
| 31 | PS61SOT14_0710B13_0INT18_0MAD01_0 | 132 | PS1AN10SCK8_0710A2_02TRACED0 |
| 32 | PS61ADT0_1SCK14_0I2N2_1M1SCLKOUT_0 | 131 | PS1SAN09SOT7_0710B3_0INT24_1YTRACECLK |
| 33 | PS71C10A1_2IMADAT4A28_0I2TCC0_1SUBOUT1_0 | 130 | PS1AN08SIN2_0710A3_0INT10_0 |
| 34 | PS71C10A13_2INT03_2MAD02_0I2S00_0 | 129 | PS6AN19SCK62_1I2T0B10_1 |
| 35 | PS11T0B13_2MAD03_0I2SCK0_0 | 128 | PS2AN18SCK1_1I2T0A10_1INT09_1 |
| 36 | PS31B02_1INT19_0I2S_DATA1_0 | 127 | PS1AN17SCK60_1I2T0B9_1INT08_1 |
| 37 | PS31SCK0_1I2S_DATA0_0 | 126 | PS6AN16SCK4_1I2T0A9_1 |
| 38 | PS41C00_0INT06_0I2S_CLK_0 | 125 | PS1AN16SCK1_1I2T0B2_0I2N1_2 |
| 39 | VCC | 124 | PS1AN06SOT11_0710A2_0I2N1_2 |
| 40 | VSS | 123 | PS1SAN05SIN1_0710B1_0I2N1_2INT09_0 |
| 41 | PS31C02_0INT01_0I2S_CMD_0 | 122 | PS61SCK3_1I2N2_02TRACED11 |
| 42 | PS31SCK1_0INT02_0I2S_DATA3_0 | 121 | PS61SOT3_1I2N2_02TRACED10 |
| 43 | PS31C00_0INT03_0I2S_DATA2_0 | 120 | PS61SIN9_1I2N2_0INT03_02TRACED9 |
| 44 | PS31ADT0_2I2T10X_0I2S_WP_0 | 119 | PS61ADT0_0SCK3_1INT08_02TRACED8 |
| 45 | PS31B02_1I2T0B6_1I2N2_1INT16_1I2S_CMD_0IMAD4_0 | 118 | PS1AN04SOT6_1 |
| 46 | PS41SOT2_1I2T0A1_0710A1_0I2N3_1INT17_1MAD23_0 | 117 | PS1SAN03SIN6_1INT25_1 |
| 47 | PS31SCK2_1I2T0A2_0710A2_1I2N3_1INT18_1MAD22_0MNALE_0 | 116 | PS12AN02SCK10_0710A1_0I2N2_0 |
| 48 | PS31SIN3_0I2T0A3_0710A3_1INT19_1MAD21_0MNALE_0 | 115 | PS11AN01SOT10_0710B0_0I2N2_0 |
| 49 | PS31SOT1_0I2T0A4_0710A4_1MAD20_0MNALE_0 | 114 | PS1SAN00SIN9_0710A0_0I2N2_0INT08_0 |
| 50 | PS31SCK13_0I2T0A5_0710A5_1MAD19_0MNALE_0 | 113 | AVRH |
| 51 | PS31SIN10_1I2T0B11_0INT01_0IMADAT4A29_0I2S1MCLK0_0 | 112 | AVRL |
| 52 | PS31SOT10_1I2T0A12_0IMADAT4A30_0I2S00_0 | 111 | AVB5 |
| 53 | PS31SCK10_1I2T0B12_0IMADAT4A31_0I2S1W00_0 | 110 | AVCC |
| 54 | VSS | 109 | VCC |

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Note:

- The number after the underscore ("_") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

LBE192



Note:

- The number after the underscore ("_") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

4. Pin Descriptions

List of Pin Functions

The number after the underscore ("_") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel.

Use the extended port function register (EPFR) to select the pin.

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|----------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 1 | 1 | 1 | C1 | VCC | - | - |
| 2 | 2 | 2 | B2 | PA0 | G | K |
| | | | | RTO20_0 (PPG20_0) | | |
| | | | | TIOA8_0 | | |
| | | | | AIN2_0 | | |
| | | | | INT00_0 | | |
| MADATA00_0 | | | | | | |
| 3 | 3 | 3 | C2 | PA1 | G | I |
| | | | | RTO21_0 (PPG20_0) | | |
| | | | | TIOA9_0 | | |
| | | | | BIN2_0 | | |
| MADATA01_0 | | | | | | |
| 4 | 4 | 4 | C3 | PA2 | G | I |
| | | | | RTO22_0 (PPG22_0) | | |
| | | | | TIOA10_0 | | |
| | | | | ZIN2_0 | | |
| MADATA02_0 | | | | | | |
| 5 | 5 | 5 | D5 | PA3 | G | I |
| | | | | RTO23_0 (PPG22_0) | | |
| | | | | TIOA11_0 | | |
| MADATA03_0 | | | | | | |
| 6 | 6 | 6 | D2 | PA4 | G | I |
| | | | | RTO24_0 (PPG24_0) | | |
| | | | | TIOA12_0 | | |
| MADATA04_0 | | | | | | |
| 7 | 7 | 7 | D1 | PA5 | G | K |
| | | | | SIN1_0 | | |
| | | | | RTO25_0 (PPG24_0) | | |
| | | | | TIOA13_0 | | |
| | | | | INT01_0 | | |
| MADATA05_0 | | | | | | |
| 8 | 8 | 8 | D3 | PA6 | E | I |
| | | | | SOT1_0 (SDA1_0)) | | |
| | | | | DTTI2X_0 | | |
| MADATA06_0 | | | | | | |
| 9 | 9 | 9 | D4 | PA7 | E | I |
| | | | | SCK1_0 (SCL1_0) | | |
| | | | | IC20_0 | | |
| | | | | MADATA07_0 | | |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|-----------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 10 | 10 | - | E2 | P50 | E | I |
| | | | | SCS72_0 | | |
| | | | | RTO00_1 (PPG00_1) | | |
| | | | | TIOA8_2 | | |
| | | | | MADATA16_0 | | |
| 11 | 11 | - | E3 | P51 | E | I |
| | | | | SCS73_0 | | |
| | | | | RTO01_1 (PPG00_1) | | |
| | | | | TIOB8_2 MADATA17_0 | | |
| 12 | 12 | - | E4 | P52 | E | I |
| | | | | RTO02_1 (PPG02_1) | | |
| | | | | TIOA9_2 | | |
| | | | | MADATA18_0 | | |
| 13 | - | - | - | P53 | E | I |
| | | | | RTO03_1 (PPG02_1) | | |
| | | | | TIOB9_2 | | |
| | | | | MADATA19_0 | | |
| 14 | 13 | 10 | E5 | PA8 | I | Q |
| | | | | SIN7_0 | | |
| | | | | IC21_0 | | |
| | | | | INT02_0 | | |
| | | | | WKUP1 | | |
| | | | | MADATA08_0 | | |
| 15 | 14 | 11 | F1 | PA9 | N | I |
| | | | | SOT7_0 (SDA7_0) | | |
| | | | | IC22_0 | | |
| | | | | MADATA09_0 | | |
| 16 | 15 | 12 | F2 | PAA | N | I |
| | | | | SCK7_0 (SCL7_0) | | |
| | | | | IC23_0 | | |
| | | | | MADATA10_0 | | |
| 17 | 16 | 13 | F3 | PAB | E | K |
| | | | | SCS70_0 | | |
| | | | | FRCK2_0 | | |
| | | | | INT03_0 MADATA11_0 | | |
| 18 | 17 | 14 | F4 | PAC | E | I |
| | | | | SCS71_0 | | |
| | | | | TIOB8_0 | | |
| | | | | AIN3_0 MADATA12_0 | | |
| 19 | - | - | - | P54 | E | K |
| | | | | SIN15_1 | | |
| | | | | RTO04_1 (PPG04_1) | | |
| | | | | TIOA10_2 | | |
| | | | | INT00_2 | | |
| | | | | MADATA20_0 | | |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|----------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 20 | - | - | - | P55 | E | I |
| | | | | SOT15_1 (SDA15_1) | | |
| | | | | RTO05_1 (PPG04_1) | | |
| | | | | TIOB10_2 | | |
| | | | | MADATA21_0 | | |
| 21 | - | - | - | P56 | E | I |
| | | | | SCK15_1 (SCL15_1) | | |
| | | | | DTTIOX_1 | | |
| | | | | TIOB0_1 | | |
| | | | | MADATA22_0 | | |
| 22 | - | - | - | P57 | E | I |
| | | | | IC00_1 | | |
| | | | | TIOB1_1 | | |
| | | | | MADATA23_0 | | |
| 23 | 18 | 15 | F5 | PAD | N | I |
| | | | | SCK3_0 (SCL3_0) | | |
| | | | | TIOB9_0 | | |
| | | | | BIN3_0 | | |
| | | | | MADATA13_0 | | |
| 24 | 19 | 16 | F6 | PAE | N | I |
| | | | | ADTG_0 | | |
| | | | | SOT3_0 (SDA3_0) | | |
| | | | | TIOB10_0 | | |
| | | | | ZIN3_0 | | |
| | | | | MADATA14_0 | | |
| 25 | 20 | 17 | G2 | PAF | I | K |
| | | | | SIN3_0 | | |
| | | | | TIOB11_0 | | |
| | | | | INT16_0 | | |
| | | | | MADATA15_0 | | |
| 26 | - | - | - | P58 | E | K |
| | | | | SIN11_1 | | |
| | | | | IC01_1 | | |
| | | | | TIOB2_1 | | |
| | | | | INT02_2 | | |
| | | | | MADATA24_0 | | |
| 27 | - | - | - | P59 | E | I |
| | | | | SOT11_1 (SDA11_1) | | |
| | | | | IC02_1 | | |
| | | | | TIOB3_1 | | |
| | | | | MADATA25_0 | | |
| 28 | - | - | - | P5A | E | I |
| | | | | SCK11_1 (SCL11_1) | | |
| | | | | IC03_1 | | |
| | | | | TIOB4_1 | | |
| | | | | MADATA26_0 | | |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|----------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 29 | - | - | - | P5B | E | I |
| | | | | FRCK0_1 | | |
| | | | | TIOB5_1 | | |
| | | | | MADATA27_0 | | |
| 30 | 21 | 18 | G3 | P08 | E | K |
| | | | | SIN14_0 | | |
| | | | | TIOB12_0 | | |
| | | | | INT17_0 | | |
| 31 | 22 | 19 | G4 | P09 | E | K |
| | | | | SOT14_0 (SDA14_0) | | |
| | | | | TIOB13_0 | | |
| | | | | INT18_0 | | |
| 32 | 23 | 20 | G5 | P0A | L | I |
| | | | | ADTG_1 | | |
| | | | | SCK14_0 (SCL14_0) | | |
| | | | | AIN2_1 | | |
| 33 | - | - | - | MCLKOUT_0 | E | I |
| | | | | P5C | | |
| | | | | TIOA11_2 | | |
| | | | | MADATA28_0 | | |
| 34 | 24 | - | G6 | RTCCO_1 | E | K |
| | | | | SUBOUT_1 | | |
| | | | | P30 | | |
| | | | | TIOA13_2 | | |
| 35 | 25 | - | H4 | INT03_2 | E | I |
| | | | | MDQM2_0 | | |
| | | | | I2SDI0_0 | | |
| | | | | P31 | | |
| 36 | 26 | 21 | H2 | TIOB13_2 | L | K |
| | | | | MDQM3_0 | | |
| | | | | I2SCK0_0 | | |
| | | | | P32 | | |
| 37 | 27 | 22 | J1 | BIN2_1 | L | I |
| | | | | INT19_0 | | |
| | | | | S_DATA1_0 | | |
| | | | | P33 | | |
| 38 | 28 | 23 | H3 | FRCK0_0 | L | K |
| | | | | ZIN2_1 | | |
| | | | | S_DATA0_0 | | |
| | | | | P34 | | |
| 39 | 29 | 24 | H1 | IC03_0 | - | - |
| | | | | INT00_1 | | |
| | | | | S_CLK_0 | | |
| 40 | 30 | 25 | H5 | VCC | - | - |
| 41 | 31 | 26 | H6 | VSS | L | K |
| | | | | P35 | | |
| | | | | IC02_0 | | |
| | | | | INT01_1 | | |
| | | | | S_CMD_0 | | |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|----------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 42 | 32 | 27 | J5 | P36 | L | K |
| | | | | IC01_0 | | |
| | | | | INT02_1 | | |
| | | | | S_DATA3_0 | | |
| 43 | 33 | 28 | J4 | P37 | L | K |
| | | | | IC00_0 | | |
| | | | | INT03_1 | | |
| | | | | S_DATA2_0 | | |
| 44 | 34 | 29 | J3 | P38 | E | I |
| | | | | ADTG_2 | | |
| | | | | DTTIOX_0 | | |
| | | | | S_WP_0 | | |
| 45 | 35 | 30 | J2 | P39 | G | K |
| | | | | SIN2_1 | | |
| | | | | RTO00_0 (PPG00_0) | | |
| | | | | TIOA0_1 | | |
| | | | | AIN3_1 | | |
| | | | | INT16_1 | | |
| | | | | S_CD_0 | | |
| MAD24_0 | | | | | | |
| 46 | 36 | 31 | K1 | P3A | G | K |
| | | | | SOT2_1 (SDA2_1) | | |
| | | | | RTO01_0 (PPG00_0) | | |
| | | | | TIOA1_1 | | |
| | | | | BIN3_1 | | |
| | | | | INT17_1 | | |
| | | | | MAD23_0 | | |
| 47 | 37 | 32 | K2 | P3B | G | K |
| | | | | SCK2_1 (SCL2_1) | | |
| | | | | RTO02_0 (PPG02_0) | | |
| | | | | TIOA2_1 | | |
| | | | | ZIN3_1 | | |
| | | | | INT18_1 | | |
| | | | | MAD22_0 | | |
| | | | | MNALE_0 | | |
| 48 | 38 | 33 | K3 | P3C | G | K |
| | | | | SIN13_0 | | |
| | | | | RTO03_0 (PPG02_0) | | |
| | | | | TIOA3_1 | | |
| | | | | INT19_1 | | |
| | | | | MAD21_0 | | |
| | | | | MNCLE_0 | | |
| 49 | 39 | 34 | K4 | P3D | G | I |
| | | | | SOT13_0 (SDA13_0) | | |
| | | | | RTO04_0 (PPG04_0) | | |
| | | | | TIOA4_1 | | |
| | | | | MAD20_0 | | |
| | | | | MNWEX_0 | | |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|----------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 50 | 40 | 35 | L1 | P3E | G | I |
| | | | | SCK13_0 (SCL13_0) | | |
| | | | | RTO05_0 (PPG04_0) | | |
| | | | | TIOA5_1 | | |
| | | | | MAD19_0 | | |
| MNREX_0 | | | | | | |
| 51 | 41 | - | L2 | P5D | E | K |
| | | | | SIN10_1 | | |
| | | | | TIOB11_2 | | |
| | | | | INT01_2 | | |
| | | | | MADATA29_0 | | |
| I2SMCLK0_0 | | | | | | |
| 52 | 42 | - | L3 | P5E | E | I |
| | | | | SOT10_1 (SDA10_1) | | |
| | | | | TIOA12_2 | | |
| | | | | MADATA30_0 | | |
| | | | | I2SDO0_0 | | |
| 53 | 43 | - | M2 | P5F | E | I |
| | | | | SCK10_1 (SCL10_1) | | |
| | | | | TIOB12_2 | | |
| | | | | MADATA31_0 | | |
| | | | | I2SWS0_0 | | |
| 54 | 44 | 36 | M1 | VSS | - | - |
| 55 | 45 | 37 | N1 | VCC | - | - |
| 56 | 46 | 38 | N2 | P40 | G | K |
| | | | | SIN3_1 | | |
| | | | | RTO10_0 (PPG10_0) | | |
| | | | | TIOA0_0 | | |
| | | | | AIN0_0 | | |
| | | | | INT23_0 | | |
| | | | | MCSX7_0 | | |
| 57 | 47 | 39 | N3 | P41 | G | I |
| | | | | SOT3_1 (SDA3_1) | | |
| | | | | RTO11_0 (PPG10_0) | | |
| | | | | TIOA1_0 | | |
| | | | | BIN0_0 | | |
| | | | | MCSX6_0 | | |
| 58 | 48 | 40 | M3 | P42 | G | I |
| | | | | SCK3_1 (SCL3_1) | | |
| | | | | RTO12_0 (PPG12_0) | | |
| | | | | TIOA2_0 | | |
| | | | | ZIN0_0 | | |
| | | | | MCSX5_0 | | |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|----------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 59 | 49 | 41 | L4 | P43 | G | K |
| | | | | SIN15_0 | | |
| | | | | RTO13_0 (PPG12_0) | | |
| | | | | TIOA3_0 | | |
| | | | | INT04_0 | | |
| MCSX4_0 | | | | | | |
| 60 | 50 | 42 | M4 | P44 | G | I |
| | | | | SOT15_0 (SDA15_0) | | |
| | | | | RTO14_0 (PPG14_0) | | |
| | | | | TIOA4_0 | | |
| MCSX3_0 | | | | | | |
| 61 | 51 | 43 | N4 | P45 | G | I |
| | | | | SCK15_0 (SCL15_0) | | |
| | | | | RTO15_0 (PPG14_0) | | |
| | | | | TIOA5_0 | | |
| MCSX2_0 | | | | | | |
| 62 | 52 | 44 | P2 | C | - | - |
| 63 | 53 | 45 | P3 | VSS | - | - |
| 64 | 54 | 46 | P4 | VCC | - | - |
| 65 | - | - | - | P4A | E | K |
| | | | | SIN12_1 | | |
| | | | | AIN0_1 | | |
| INT04_2 | | | | | | |
| 66 | - | - | - | P4B | E | I |
| | | | | SOT12_1 (SDA12_1) | | |
| | | | | BIN0_1 | | |
| 67 | - | - | - | P4C | E | I |
| | | | | SCK12_1 (SCL12_1) | | |
| | | | | ZIN0_1 | | |
| 68 | - | - | - | P4D | E | K |
| | | | | SCS72_1 | | |
| | | | | INT05_2 | | |
| 69 | - | - | - | P4E | E | I |
| | | | | SCS73_1 | | |
| 70 | 55 | 47 | L5 | P7D | L | Q |
| | | | | SCK1_1 (SCL1_1) | | |
| | | | | DTTI1X_0 | | |
| | | | | INT05_0 | | |
| | | | | WKUP2 | | |
| MCSX1_0 | | | | | | |
| 71 | 56 | 48 | M5 | P7E | L | I |
| | | | | ADTG_7 | | |
| | | | | FRCK1_0 | | |
| | | | | MCSX0_0 | | |
| 72 | 57 | 49 | N5 | INITX | B | C |
| 73 | 58 | 50 | P5 | P46 | P | S |
| | | | | X0A | | |
| 74 | 59 | 51 | P6 | P47 | Q | T |
| | | | | X1A | | |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|----------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 75 | 60 | 52 | P8 | VBAT | - | - |
| 76 | 61 | 53 | N6 | P48 | O | U |
| | | | | VREGCTL | | |
| 77 | 62 | 54 | M6 | P49 | O | U |
| | | | | VWAKEUP | | |
| 78 | 63 | - | K5 | PF0 | E | K |
| | | | | SCS63_0 | | |
| | | | | FRCK1_1 | | |
| | | | | TIOA15_1 | | |
| 79 | 64 | - | K6 | INT22_1 | E | K |
| | | | | PF1 | | |
| | | | | SCS62_0 | | |
| | | | | TIOB15_1 | | |
| 80 | 65 | 55 | L6 | INT23_1 | I | K |
| | | | | P70 | | |
| | | | | ADTG_8 | | |
| | | | | SIN1_1 | | |
| 81 | 66 | 56 | J6 | INT06_0 | E | I |
| | | | | MRDY_0 | | |
| | | | | P71 | | |
| | | | | SOT1_1 (SDA1_1) | | |
| 82 | 67 | 57 | L8 | MAD00_0 | E | K |
| | | | | P72 | | |
| | | | | SIN9_0 | | |
| | | | | TIOB0_0 | | |
| 83 | 68 | 58 | K8 | INT07_0 | E | I |
| | | | | MAD01_0 | | |
| | | | | P73 | | |
| | | | | SOT9_0 (SDA9_0) | | |
| 84 | 69 | 59 | J8 | TIOB1_0 | E | I |
| | | | | MAD02_0 | | |
| | | | | P74 | | |
| | | | | SCK9_0 (SCL9_0) | | |
| 85 | 70 | - | N8 | TIOB2_0 | L | I |
| | | | | MAD03_0 | | |
| | | | | PF2 | | |
| 86 | 71 | - | M8 | RTO10_1 (PPG10_1) | L | K |
| | | | | TIOA6_1 | | |
| | | | | MRASX_0 | | |
| | | | | PF3 | | |
| | | | | RTO11_1 (PPG10_1) | L | K |
| | | | | TIOB6_1 | | |
| | | | | INT05_1 | | |
| | | | | MCASX_0 | | |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|----------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 87 | 72 | - | N9 | PF4 | L | K |
| | | | | RTO12_1 (PPG12_1) | | |
| | | | | TIOA7_1 | | |
| | | | | INT06_1 | | |
| | | | | MSDWEX_0 | | |
| 88 | 73 | - | P9 | PF5 | L | K |
| | | | | RTO13_1 (PPG12_1) | | |
| | | | | TIOB7_1 | | |
| | | | | INT07_1 | | |
| 89 | 74 | - | M9 | MCSX8_0 | L | K |
| | | | | PF6 | | |
| | | | | RTO14_1 (PPG14_1) | | |
| | | | | TIOA14_1 | | |
| 90 | 75 | - | L9 | INT20_1 | L | K |
| | | | | MSDCKE_0 | | |
| | | | | PF7 | | |
| | | | | RTO15_1 (PPG14_1) | | |
| 91 | 76 | 60 | K9 | TIOB14_1 | E | K |
| | | | | INT21_1 | | |
| | | | | MSDCLK_0 | | |
| | | | | P75 | | |
| | | | | SIN8_0 | | |
| 92 | 77 | 61 | P10 | TIOB3_0 | E | I |
| | | | | AIN1_0 | | |
| | | | | INT20_0 | | |
| | | | | MAD04_0 | | |
| | | | | P76 | | |
| 93 | 78 | 62 | N10 | SOT8_0 (SDA8_0) | E | I |
| | | | | TIOB4_0 | | |
| | | | | BIN1_0 | | |
| | | | | MAD05_0 | | |
| | | | | P77 | | |
| 94 | - | - | - | SCK8_0 (SCL8_0) | E | I |
| | | | | TIOB5_0 | | |
| | | | | ZIN1_0 | | |
| | | | | MAD06_0 | | |
| 95 | - | - | - | PF8 | E | I |
| | | | | SCS70_1 | | |
| | | | | DTTI1X_1 | | |
| | | | | AIN1_1 | | |
| 96 | 79 | 63 | L10 | PF9 | E | K |
| | | | | SCS71_1 | | |
| | | | | IC10_1 | | |
| | | | | BIN1_1 | | |
| 96 | 79 | 63 | L10 | P78 | E | K |
| | | | | SIN6_0 | | |
| | | | | IC10_0 | | |
| | | | | INT21_0 | | |
| | | | | MAD07_0 | | |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|--------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 97 | 80 | 64 | K10 | P79 | L | I |
| | | | | SOT6_0 (SDA6_0) | | |
| | | | | IC11_0 | | |
| | | | | MAD08_0 | | |
| 98 | 81 | 65 | M10 | P7A | L | I |
| | | | | SCK6_0 (SCL6_0) | | |
| | | | | IC12_0 | | |
| | | | | MAD09_0 | | |
| 99 | 82 | 66 | N11 | P7B | R | J |
| | | | | DA1 | | |
| | | | | SCS60_0 | | |
| | | | | IC13_0 | | |
| 100 | 83 | 67 | M11 | P7C | R | J |
| | | | | DA0 | | |
| | | | | SCS61_0 | | |
| | | | | INT04_1 | | |
| 101 | - | - | - | PFA | E | I |
| | | | | SCK7_1 (SCL7_1) | | |
| | | | | IC11_1 | | |
| | | | | ZIN1_1 | | |
| 102 | - | - | - | PFB | E | K |
| | | | | SOT7_1 (SDA7_1) | | |
| | | | | IC12_1 | | |
| | | | | INT07_2 | | |
| 103 | - | - | - | PFC | E | K |
| | | | | SIN7_1 | | |
| | | | | IC13_1 | | |
| | | | | INT06_2 | | |
| 104 | 84 | 68 | N13 | PE0 | C | E |
| 105 | 85 | 69 | N12 | MD1 | J | D |
| 106 | 86 | 70 | P12 | MD0 | A | A |
| | | | | PE2 X0 | | |
| 107 | 87 | 71 | P13 | PE3 | A | B |
| | | | | X1 | | |
| 108 | 88 | 72 | N14 | VSS | - | - |
| 109 | 89 | 73 | M14 | VCC | - | - |
| 110 | 90 | 74 | M13 | AVCC | - | - |
| 111 | 91 | 75 | M12 | AVSS | - | - |
| 112 | 92 | 76 | L13 | AVRL | - | - |
| 113 | 93 | 77 | L12 | AVRH | - | - |
| 114 | 94 | 78 | L11 | P10 | F | M |
| | | | | AN00 | | |
| | | | | SIN10_0 | | |
| | | | | TIOA0_2 | | |
| | | | | AIN0_2 | | |
| INT08_0 | | | | | | |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|----------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 115 | 95 | 79 | K13 | P11 | F | L |
| | | | | AN01 | | |
| | | | | SOT10_0 (SDA10_0) | | |
| | | | | TIOB0_2 | | |
| | | | | BIN0_2 | | |
| 116 | 96 | 80 | K12 | P12 | F | L |
| | | | | AN02 | | |
| | | | | SCK10_0 (SCL10_0) | | |
| | | | | TIOA1_2 | | |
| 117 | 97 | 81 | K14 | ZIN0_2 | F | M |
| | | | | P13 | | |
| | | | | AN03 | | |
| | | | | SIN6_1 | | |
| 118 | 98 | 82 | K11 | INT25_1 | F | L |
| | | | | P14 | | |
| | | | | AN04 | | |
| | | | | SOT6_1 (SDA6_1) | | |
| 119 | - | - | - | PB8 | E | O |
| | | | | ADTG_6 | | |
| | | | | SCS63_1 | | |
| | | | | INT08_2 | | |
| 120 | - | - | - | TRACED8 | E | O |
| | | | | PB9 | | |
| | | | | SIN9_1 | | |
| | | | | AIN2_2 | | |
| 121 | - | - | - | INT09_2 | E | N |
| | | | | TRACED9 | | |
| | | | | PBA | | |
| | | | | SOT9_1 (SDA9_1) | | |
| 122 | - | - | - | BIN2_2 | E | N |
| | | | | TRACED10 | | |
| | | | | PBB | | |
| | | | | SCK9_1 (SCL9_1) | | |
| 123 | 99 | 83 | J13 | ZIN2_2 | F | M |
| | | | | TRACED11 | | |
| | | | | P15 | | |
| | | | | AN05 | | |
| | | | | SIN11_0 | | |
| 124 | 100 | 84 | J12 | TIOB1_2 | F | L |
| | | | | AIN1_2 | | |
| | | | | INT09_0 | | |
| | | | | P16 | | |
| | | | | AN06 | | |
| | | | | SOT11_0 (SDA11_0) | F | L |
| | | | | TIOA2_2 | | |
| | | | | BIN1_2 | | |
| | | | | | | |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|----------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 125 | 101 | 85 | J11 | P17 | F | L |
| | | | | AN07 | | |
| | | | | SCK11_0 (SCL11_0) | | |
| | | | | TIOB2_2 | | |
| | | | | ZIN1_2 | | |
| 126 | 102 | - | J10 | PB0 | F | L |
| | | | | AN16 | | |
| | | | | SCK6_1 (SCL6_1) | | |
| | | | | TIOA9_1 | | |
| 127 | 103 | - | J9 | PB1 | F | M |
| | | | | AN17 | | |
| | | | | SCS60_1 | | |
| | | | | TIOB9_1 | | |
| | | | | INT08_1 | | |
| 128 | 104 | - | H10 | PB2 | F | M |
| | | | | AN18 | | |
| | | | | SCS61_1 | | |
| | | | | TIOA10_1 | | |
| 129 | 105 | - | J14 | PB3 | F | L |
| | | | | AN19 | | |
| | | | | SCS62_1 | | |
| | | | | TIOB10_1 | | |
| 130 | 106 | 86 | H9 | P18 | F | M |
| | | | | AN08 | | |
| | | | | SIN2_0 | | |
| | | | | TIOA3_2 | | |
| 131 | 107 | 87 | H12 | INT10_0 | F | O |
| | | | | P19 | | |
| | | | | AN09 | | |
| | | | | SOT2_0 (SDA2_0) | | |
| | | | | TIOB3_2 | | |
| | | | | INT24_1 | | |
| TRACED0 | | | | | | |
| 132 | 108 | 88 | H14 | P1A | F | N |
| | | | | AN10 | | |
| | | | | SCK2_0 (SCL2_0) | | |
| | | | | TIOA4_2 | | |
| | | | | TRACED0 | | |
| 133 | 109 | 89 | G14 | P1B | F | O |
| | | | | AN11 | | |
| | | | | SIN12_0 | | |
| | | | | TIOB4_2 | | |
| | | | | INT11_0 | | |
| 134 | 110 | 90 | H13 | TRACED1 | F | N |
| | | | | P1C | | |
| | | | | AN12 | | |
| | | | | SOT12_0 (SDA12_0) | | |
| | | | | TIOA5_2 | | |
| TRACED2 | | | | | | |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|----------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 135 | 111 | 91 | H11 | P1D | F | N |
| | | | | AN13 | | |
| | | | | SCK12_0 (SCL12_0) | | |
| | | | | TIOB5_2 | | |
| | | | | TRACED3 | | |
| 136 | - | - | - | VSS | - | - |
| 137 | - | - | - | VCC | - | - |
| 138 | 112 | - | G13 | PB4 | F | O |
| | | | | AN20 | | |
| | | | | SIN8_1 | | |
| | | | | TIOA11_1 | | |
| | | | | INT10_1 | | |
| | | | | TRACED4 | | |
| 139 | 113 | - | F14 | PB5 | F | O |
| | | | | AN21 | | |
| | | | | SOT8_1 (SDA8_1) | | |
| | | | | TIOB11_1 | | |
| | | | | INT11_1 | | |
| | | | | TRACED5 | | |
| 140 | 114 | - | G12 | PB6 | F | N |
| | | | | AN22 | | |
| | | | | SCK8_1 (SCL8_1) | | |
| | | | | TIOA12_1 | | |
| | | | | TRACED6 | | |
| 141 | 115 | - | G11 | PB7 | F | N |
| | | | | AN23 | | |
| | | | | TIOB12_1 | | |
| | | | | TRACED7 | | |
| 142 | 116 | 92 | G10 | P1E | F | M |
| | | | | AN14 | | |
| | | | | TIOA8_1 | | |
| | | | | INT26_1 | | |
| | | | | MAD10_0 | | |
| 143 | 117 | 93 | G9 | P1F | F | M |
| | | | | AN15 | | |
| | | | | RTS5_0 | | |
| | | | | TIOB8_1 | | |
| | | | | INT27_1 | | |
| | | | | MAD11_0 | | |
| 144 | 118 | 94 | F10 | P2A | F | L |
| | | | | AN24 | | |
| | | | | CTS5_0 | | |
| | | | | MAD12_0 | | |
| | | | | | | |
| 145 | 119 | 95 | F11 | P29 | F | L |
| | | | | AN25 | | |
| | | | | SCK5_0 (SCL5_0) | | |
| | | | | | | |
| | | | | MAD13_0 | | |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|--------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 146 | 120 | 96 | F12 | P28 | F | L |
| | | | | AN26 | | |
| | | | | SOT5_0 (SDA5_0) | | |
| | | | | MAD14_0 | | |
| 147 | 121 | 97 | F13 | P27 | F | M |
| | | | | AN27 | | |
| | | | | SIN5_0 | | |
| | | | | INT24_0 | | |
| 148 | - | - | - | PBC | E | N |
| | | | | TRACED12 | | |
| 149 | - | - | - | PBD | E | O |
| | | | | SCK0_1 (SCL0_1) | | |
| | | | | AIN3_2 | | |
| | | | | INT10_2 | | |
| 150 | - | - | - | TRACED13 | E | N |
| | | | | PBE | | |
| | | | | SOT0_1 (SDA0_1) | | |
| | | | | BIN3_2 | | |
| 151 | - | - | - | TRACED14 | E | O |
| | | | | PBF | | |
| | | | | SIN0_1 | | |
| | | | | ZIN3_2 | | |
| 152 | 122 | 98 | E10 | INT11_2 | E | I |
| | | | | TRACED15 | | |
| 153 | 123 | 99 | E11 | P26 | F | M |
| | | | | MAD16_0 | | |
| | | | | P25 | | |
| | | | | AN28 | | |
| 154 | 124 | 100 | E12 | INT25_0 | F | L |
| | | | | MAD17_0 | | |
| | | | | P24 | | |
| | | | | AN29 | | |
| 155 | 125 | 101 | E13 | TIOA13_1 | F | L |
| | | | | MAD18_0 | | |
| | | | | P23 | | |
| | | | | UHCONX1 | | |
| 156 | 126 | 102 | D12 | AN30 | F | M |
| | | | | SCK0_0 (SCL0_0) | | |
| | | | | TIOB13_1 | | |
| | | | | P22 | | |
| 157 | 127 | 103 | D13 | AN31 | I | K |
| | | | | SOT0_0 (SDA0_0) | | |
| | | | | INT26_0 | | |
| | | | | P21 | | |
| 157 | 127 | 103 | D13 | ADTG_4 | I | K |
| | | | | SIN0_0 | | |
| | | | | INT27_0 | | |
| | | | | CROUT_0 | | |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|--------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 158 | 128 | 104 | C13 | P20 | I | F |
| | | | | NMIX | | |
| | | | | WKUP0 | | |
| 159 | 129 | 105 | E14 | USBVCC1 | - | - |
| 160 | 130 | 106 | D14 | P82 | H | R |
| | | | | UDM1 | | |
| 161 | 131 | 107 | C14 | P83 | H | R |
| | | | | UDP1 | | |
| 162 | 132 | 108 | B14 | VSS | - | - |
| 163 | 133 | 109 | A13 | VCC | - | - |
| 164 | 134 | 110 | B13 | P00 | E | G |
| | | | | TRSTX | | |
| 165 | 135 | 111 | A12 | P01 | E | G |
| | | | | TCK | | |
| | | | | SWCLK | | |
| 166 | 136 | 112 | C12 | P02 | E | G |
| | | | | TDI | | |
| 167 | 137 | 113 | B12 | P03 | E | G |
| | | | | TMS | | |
| | | | | SWDIO | | |
| 168 | 138 | 114 | B11 | P04 | E | G |
| | | | | TDO | | |
| | | | | SWO | | |
| 169 | 139 | - | C11 | P90 | S | K |
| | | | | INT12_1 | | |
| | | | | Q_IO3_0 | | |
| 170 | 140 | - | D11 | P91 | S | K |
| | | | | SIN5_1 | | |
| | | | | INT13_1 | | |
| | | | | Q_IO2_0 | | |
| 171 | 141 | - | B10 | P92 | S | K |
| | | | | SOT5_1 (SDA5_1) | | |
| | | | | INT14_1 | | |
| | | | | Q_IO1_0 | | |
| 172 | 142 | - | C10 | P93 | S | K |
| | | | | SCK5_1 (SCL5_1) | | |
| | | | | INT15_1 | | |
| | | | | Q_IO0_0 | | |
| 173 | 143 | - | D10 | P94 | S | I |
| | | | | CTS5_1 | | |
| | | | | Q_SCK_0 | | |
| 174 | 144 | - | B9 | P95 | S | I |
| | | | | RTS5_1 | | |
| | | | | Q_CS0_0 | | |
| 175 | - | - | - | P96 | S | K |
| | | | | INT12_2 | | |
| | | | | Q_CS1_0 | | |
| 176 | - | - | - | P97 | S | K |
| | | | | INT13_2 | | |
| | | | | Q_CS2_0 | | |
| 177 | 145 | 115 | C9 | PC0 | K | V |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|--------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 178 | 146 | 116 | B8 | PC1 | K | V |
| | | | | TIOB6_0 | | |
| 179 | 147 | 117 | D9 | PC2 | K | V |
| | | | | TIOA6_0 | | |
| 180 | 148 | 118 | E9 | PC3 | K | V |
| | | | | TIOB7_0 | | |
| 181 | 149 | 119 | F9 | PC4 | K | V |
| | | | | TIOA7_0 | | |
| 182 | 150 | 120 | C8 | PC5 | K | V |
| | | | | TIOB14_0 | | |
| 183 | 151 | 121 | D8 | PC6 | K | V |
| | | | | TIOA14_0 | | |
| 184 | 152 | 122 | E8 | PC7 | E | W |
| | | | | INT13_0 | | |
| | | | | CROUT_1 | | |
| 185 | 153 | 123 | A10 | PC8 | K | V |
| 186 | 154 | 124 | F8 | PC9 | K | V |
| | | | | TIOB15_0 | | |
| 187 | 155 | 125 | B7 | PCA | K | V |
| | | | | TIOA15_0 | | |
| 188 | 156 | 126 | A9 | VCC | - | - |
| 189 | 157 | 127 | A8 | VSS | - | - |
| 190 | 158 | 128 | A7 | PCB | L | W |
| | | | | INT28_0 | | |
| 191 | 159 | 129 | C7 | PCC | K | V |
| 192 | 160 | 130 | A6 | PCD | L | W |
| | | | | SOT4_1 (SDA4_1) | | |
| | | | | INT14_0 | | |
| 193 | 161 | 131 | D7 | PCE | L | W |
| | | | | SIN4_1 | | |
| | | | | INT15_0 | | |
| 194 | 162 | 132 | E7 | PCF | L | W |
| | | | | RTS4_1 | | |
| | | | | INT12_0 | | |
| 195 | 163 | 133 | F7 | PD0 | L | W |
| | | | | INT30_1 | | |
| 196 | 164 | 134 | B6 | PD1 | L | W |
| | | | | INT31_1 | | |
| 197 | 165 | 135 | C6 | PD2 | L | V |
| | | | | CTS4_1 | | |
| | | | | FRCK2_1 | | |
| 198 | 166 | 136 | D6 | P6E | E | W |
| | | | | ADTG_5 | | |
| | | | | SCK4_1 (SCL4_1) | | |
| | | | | IC23_1 | | |
| | | | | INT29_0 | | |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|----------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 199 | - | - | - | P6D | E | I |
| | | | | SCK14_1 (SCL14_1) | | |
| | | | | IC22_1 | | |
| | | | | TIOB6_2 | | |
| 200 | - | - | - | P6C | E | I |
| | | | | SOT14_1 (SDA14_1) | | |
| | | | | IC21_1 | | |
| | | | | TIOA6_2 | | |
| 201 | - | - | - | P6B | E | K |
| | | | | SIN14_1 | | |
| | | | | IC20_1 | | |
| | | | | TIOB7_2 | | |
| 202 | - | - | - | P6A | E | I |
| | | | | DTTI2X_1 | | |
| | | | | TIOA7_2 | | |
| 203 | - | - | - | P69 | E | I |
| | | | | RTO20_1 (PPG20_1) | | |
| | | | | TIOB14_2 | | |
| 204 | - | - | - | P68 | E | I |
| | | | | SCK13_1 (SCL13_0) | | |
| | | | | RTO21_1 (PPG20_1) | | |
| | | | | TIOA14_2 | | |
| 205 | - | - | - | P67 | E | I |
| | | | | SOT13_1 (SDA13_1) | | |
| | | | | RTO22_1 (PPG22_1) | | |
| | | | | TIOB15_2 | | |
| 206 | - | - | - | P66 | E | K |
| | | | | SIN13_1 | | |
| | | | | RTO23_1 (PPG22_1) | | |
| | | | | TIOA15_2 | | |
| 207 | 167 | - | E6 | P65 | E | K |
| | | | | RTO24_1 (PPG24_1) | | |
| | | | | INT28_1 | | |
| 208 | 168 | - | B5 | P64 | I | K |
| | | | | CTS4_0 | | |
| | | | | RTO25_1 (PPG24_1) | | |
| 209 | 169 | 137 | C5 | P63 | L | K |
| | | | | ADTG_3 | | |
| | | | | RTS4_0 | | |
| | | | | INT30_0 | | |
| | | | | MOEX_0 | | |

| Pin Number | | | | Pin Name | I/O Circuit Type | Pin State Type |
|------------|--------|--------|--------|---------------------|------------------|----------------|
| LQQ216 | LQP176 | LQS144 | LBE192 | | | |
| 210 | 170 | 138 | B4 | P62 | L | I |
| | | | | SCK4_0 (SCL4_0) | | |
| | | | | MWEX_0 | | |
| 211 | 171 | 139 | C4 | P61 | L | I |
| | | | | UHCONX0 | | |
| | | | | SOT4_0 (SDA4_0) | | |
| | | | | MALE_0 | | |
| | | | | RTCCO_0 SUBOUT_0 | | |
| 212 | 172 | 140 | B3 | P60 | I | Q |
| | | | | SIN4_0 | | |
| | | | | INT31_0 | | |
| | | | | WKUP3 | | |
| 213 | 173 | 141 | A4 | USBVCC0 | - | - |
| 214 | 174 | 142 | A3 | P80 | H | R |
| | | | | UDM0 | | |
| 215 | 175 | 143 | A2 | P81 | H | R |
| | | | | UDP0 | | |
| 216 | 176 | 144 | B1 | VSS | - | - |
| - | - | - | E1 | | - | - |
| - | - | - | G1 | | - | - |
| - | - | - | P7 | | - | - |
| - | - | - | P11 | | - | - |
| - | - | - | L14 | | - | - |
| - | - | - | A11 | | - | - |
| - | - | - | A5 | | - | - |
| - | - | - | N7 | | - | - |
| - | - | - | M7 | | - | - |
| - | - | - | L7 | | - | - |
| - | - | - | K7 | | - | - |
| - | - | - | J7 | | - | - |
| -- | - | - | G7 | | - | - |
| - | - | - | H7 | | - | - |
| - | - | - | H8 | | - | - |
| - | - | - | G8 | | - | - |

Signal Descriptions

The number after the underscore ("_") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel.

Use the extended port function register (EPFR) to select the pin.

| Module | Pin Name | Function | Pin Number | | | |
|------------------|----------|--|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| A/D converter | ADTG_0 | A/D converter external trigger input pin | 24 | 19 | 16 | F6 |
| | ADTG_1 | | 32 | 23 | 20 | G5 |
| | ADTG_2 | | 44 | 34 | 29 | J3 |
| | ADTG_3 | | 209 | 169 | 137 | C5 |
| | ADTG_4 | | 157 | 127 | 103 | D13 |
| | ADTG_5 | | 198 | 166 | 136 | D6 |
| | ADTG_6 | | 119 | - | - | - |
| | ADTG_7 | | 71 | 56 | 48 | M5 |
| | ADTG_8 | | 80 | 65 | 55 | L6 |
| | AN00 | A/D converter analog input pin. ANxx describes A/D converter ch xx. | 114 | 94 | 78 | L11 |
| | AN01 | | 115 | 95 | 79 | K13 |
| | AN02 | | 116 | 96 | 80 | K12 |
| | AN03 | | 117 | 97 | 81 | K14 |
| | AN04 | | 118 | 98 | 82 | K11 |
| | AN05 | | 123 | 99 | 83 | J13 |
| | AN06 | | 124 | 100 | 84 | J12 |
| | AN07 | | 125 | 101 | 85 | J11 |
| | AN08 | | 130 | 106 | 86 | H9 |
| | AN09 | | 131 | 107 | 87 | H12 |
| | AN10 | | 132 | 108 | 88 | H14 |
| | AN11 | | 133 | 109 | 89 | G14 |
| | AN12 | | 134 | 110 | 90 | H13 |
| | AN13 | | 135 | 111 | 91 | H11 |
| | AN14 | | 142 | 116 | 92 | G10 |
| | AN15 | | 143 | 117 | 93 | G9 |
| | AN16 | | 126 | 102 | - | J10 |
| | AN17 | | 127 | 103 | - | J9 |
| | AN18 | | 128 | 104 | - | H10 |
| | AN19 | | 129 | 105 | - | J14 |
| | AN20 | | 138 | 112 | - | G13 |
| | AN21 | | 139 | 113 | - | F14 |
| AN22 | 140 | | 114 | - | G12 | |
| AN23 | 141 | | 115 | - | G11 | |
| AN24 | 144 | | 118 | 94 | F10 | |
| AN25 | 145 | | 119 | 95 | F11 | |
| AN26 | 146 | | 120 | 96 | F12 | |
| AN27 | 147 | | 121 | 97 | F13 | |
| AN28 | 153 | | 123 | 99 | E11 | |
| AN29 | 154 | | 124 | 100 | E12 | |
| AN30 | 155 | | 125 | 101 | E13 | |
| AN31 | 156 | 126 | 102 | D12 | | |

| Module | Pin Name | Function | Pin Number | | | |
|-----------------|----------|--------------------------|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Base Timer 0 | TIOA0_0 | Base Timer ch 0 TIOA pin | 56 | 46 | 38 | N2 |
| | TIOA0_1 | | 45 | 35 | 30 | J2 |
| | TIOA0_2 | | 114 | 94 | 78 | L11 |
| | TIOB0_0 | Base Timer ch 0 TIOB pin | 82 | 67 | 57 | L8 |
| | TIOB0_1 | | 21 | - | - | - |
| | TIOB0_2 | | 115 | 95 | 79 | K13 |
| Base Timer 1 | TIOA1_0 | Base Timer ch 1 TIOA pin | 57 | 47 | 39 | N3 |
| | TIOA1_1 | | 46 | 36 | 31 | K1 |
| | TIOA1_2 | | 116 | 96 | 80 | K12 |
| | TIOB1_0 | Base Timer ch 1 TIOB pin | 83 | 68 | 58 | K8 |
| | TIOB1_1 | | 22 | - | - | - |
| | TIOB1_2 | | 123 | 99 | 83 | J13 |
| Base Timer 2 | TIOA2_0 | Base Timer ch 2 TIOA pin | 58 | 48 | 40 | M3 |
| | TIOA2_1 | | 47 | 37 | 32 | K2 |
| | TIOA2_2 | | 124 | 100 | 84 | J12 |
| | TIOB2_0 | Base Timer ch 2 TIOB pin | 84 | 69 | 59 | J8 |
| | TIOB2_1 | | 26 | - | - | - |
| | TIOB2_2 | | 125 | 101 | 85 | J11 |
| Base Timer 3 | TIOA3_0 | Base Timer ch 3 TIOA pin | 59 | 49 | 41 | L4 |
| | TIOA3_1 | | 48 | 38 | 33 | K3 |
| | TIOA3_2 | | 130 | 106 | 86 | H9 |
| | TIOB3_0 | Base Timer ch 3 TIOB pin | 91 | 76 | 60 | K9 |
| | TIOB3_1 | | 27 | - | - | - |
| | TIOB3_2 | | 131 | 107 | 87 | H12 |
| Base Timer 4 | TIOA4_0 | Base Timer ch 4 TIOA pin | 60 | 50 | 42 | M4 |
| | TIOA4_1 | | 49 | 39 | 34 | K4 |
| | TIOA4_2 | | 132 | 108 | 88 | H14 |
| | TIOB4_0 | Base Timer ch 4 TIOB pin | 92 | 77 | 61 | P10 |
| | TIOB4_1 | | 28 | - | - | - |
| | TIOB4_2 | | 133 | 109 | 89 | G14 |
| Base Timer 5 | TIOA5_0 | Base Timer ch 5 TIOA pin | 61 | 51 | 43 | N4 |
| | TIOA5_1 | | 50 | 40 | 35 | L1 |
| | TIOA5_2 | | 134 | 110 | 90 | H13 |
| | TIOB5_0 | Base Timer ch 5 TIOB pin | 93 | 78 | 62 | N10 |
| | TIOB5_1 | | 29 | - | - | - |
| | TIOB5_2 | | 135 | 111 | 91 | H11 |
| Base Timer 6 | TIOA6_0 | Base Timer ch 6 TIOA pin | 179 | 147 | 117 | D9 |
| | TIOA6_1 | | 85 | 70 | - | N8 |
| | TIOA6_2 | | 200 | - | - | - |
| | TIOB6_0 | Base Timer ch 6 TIOB pin | 178 | 146 | 116 | B8 |
| | TIOB6_1 | | 86 | 71 | - | M8 |
| | TIOB6_2 | | 199 | - | - | - |

| Module | Pin Name | Function | Pin Number | | | |
|------------------|----------|---------------------------------------|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Base Timer 7 | TIOA7_0 | Base Timer ch 7 TIOA pin | 181 | 149 | 119 | F9 |
| | TIOA7_1 | | 87 | 72 | - | N9 |
| | TIOA7_2 | | 202 | - | - | - |
| | TIOB7_0 | Base Timer ch 7 TIOB pin | 180 | 148 | 118 | E9 |
| | TIOB7_1 | | 88 | 73 | - | P9 |
| | TIOB7_2 | | 201 | - | - | - |
| Base Timer 8 | TIOA8_0 | Base Timer ch 8 TIOA pin | 2 | 2 | 2 | B2 |
| | TIOA8_1 | | 142 | 116 | 92 | G10 |
| | TIOA8_2 | | 10 | 10 | - | E2 |
| | TIOB8_0 | Base Timer ch 8 TIOB pin | 18 | 17 | 14 | F4 |
| | TIOB8_1 | | 143 | 117 | 93 | G9 |
| | TIOB8_2 | | 11 | 11 | - | E3 |
| Base Timer 9 | TIOA9_0 | Base Timer ch 9 TIOA pin | 3 | 3 | 3 | C2 |
| | TIOA9_1 | | 126 | 102 | - | J10 |
| | TIOA9_2 | | 12 | 12 | - | E4 |
| | TIOB9_0 | Base Timer ch 9 TIOB pin | 23 | 18 | 15 | F5 |
| | TIOB9_1 | | 127 | 103 | - | J9 |
| | TIOB9_2 | | 13 | - | - | - |
| Base Timer 10 | TIOA10_0 | Base Timer ch 10 TIOA pin | 4 | 4 | 4 | C3 |
| | TIOA10_1 | | 128 | 104 | - | H10 |
| | TIOA10_2 | | 19 | - | - | - |
| | TIOB10_0 | Base Timer ch 10 TIOB pin | 24 | 19 | 16 | F6 |
| | TIOB10_1 | | 129 | 105 | - | J14 |
| | TIOB10_2 | | 20 | - | - | - |
| Base Timer 11 | TIOA11_0 | Base Timer ch 11 \emptyset TIOA pin | 5 | 5 | 5 | D5 |
| | TIOA11_1 | | 138 | 112 | - | G13 |
| | TIOA11_2 | | 33 | - | - | - |
| | TIOB11_0 | Base Timer ch 11 TIOB pin | 25 | 20 | 17 | G2 |
| | TIOB11_1 | | 139 | 113 | - | F14 |
| | TIOB11_2 | | 51 | 41 | - | L2 |
| Base Timer 12 | TIOA12_0 | Base Timer ch 12 TIOA pin | 6 | 6 | 6 | D2 |
| | TIOA12_1 | | 140 | 114 | - | G12 |
| | TIOA12_2 | | 52 | 42 | - | L3 |
| | TIOB12_0 | Base Timer ch 12 TIOB pin | 30 | 21 | 18 | G3 |
| | TIOB12_1 | | 141 | 115 | - | G11 |
| | TIOB12_2 | | 53 | 43 | - | M2 |

| Module | Pin Name | Function | Pin Number | | | |
|------------------|----------|---|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Base Timer 13 | TIOA13_0 | Base Timer ch 13 TIOA pin | 7 | 7 | 7 | D1 |
| | TIOA13_1 | | 154 | 124 | 100 | E12 |
| | TIOA13_2 | | 34 | 24 | - | G6 |
| | TIOB13_0 | Base Timer ch 13 TIOB pin | 31 | 22 | 19 | G4 |
| | TIOB13_1 | | 155 | 125 | 101 | E13 |
| | TIOB13_2 | | 35 | 25 | - | H4 |
| Base Timer 14 | TIOA14_0 | Base Timer ch 14 TIOA pin | 183 | 151 | 121 | D8 |
| | TIOA14_1 | | 89 | 74 | - | M9 |
| | TIOA14_2 | | 204 | - | - | - |
| | TIOB14_0 | Base Timer ch 14 TIOB pin | 182 | 150 | 120 | C8 |
| | TIOB14_1 | | 90 | 75 | - | L9 |
| | TIOB14_2 | | 203 | - | - | - |
| Base Timer 15 | TIOA15_0 | Base Timer ch 15 TIOA pin | 187 | 155 | 125 | B7 |
| | TIOA15_1 | | 78 | 63 | - | K5 |
| | TIOA15_2 | | 206 | - | - | - |
| | TIOB15_0 | Base timer ch 15 TIOB pin | 186 | 154 | 124 | F8 |
| | TIOB15_1 | | 79 | 64 | - | K6 |
| | TIOB15_2 | | 205 | - | - | - |
| Debugger | SWCLK | Serial wire debug interface clock input pin | 165 | 135 | 111 | A12 |
| | SWDIO | Serial wire debug interface data input/output pin | 167 | 137 | 113 | B12 |
| | SWO | Serial wire viewer output pin | 168 | 138 | 114 | B11 |
| | TCK | JTAG test clock input pin | 165 | 135 | 111 | A12 |
| | TDI | JTAG test data input pin | 166 | 136 | 112 | C12 |
| | TDO | JTAG debug data output pin | 168 | 138 | 114 | B11 |
| | TMS | JTAG test mode state input/output pin | 167 | 137 | 113 | B12 |
| | TRACECLK | Trace CLK output pin of ETM/HTM | 131 | 107 | 87 | H12 |
| | TRACED0 | Trace data output pin of ETM/ Trace data output pin of HTM | 132 | 108 | 88 | H14 |
| | TRACED1 | | 133 | 109 | 89 | G14 |
| | TRACED2 | | 134 | 110 | 90 | H13 |
| | TRACED3 | | 135 | 111 | 91 | H11 |
| | TRACED4 | Trace data output pin of HTM | 138 | 112 | - | G13 |
| | TRACED5 | | 139 | 113 | - | F14 |
| | TRACED6 | | 140 | 114 | - | G12 |
| | TRACED7 | | 141 | 115 | - | G11 |
| | TRACED8 | | 119 | - | - | - |
| | TRACED9 | | 120 | - | - | - |
| TRACED10 | 121 | | - | - | - | |
| TRACED11 | 122 | | - | - | - | |

| Module | Pin Name | Function | Pin Number | | | |
|--------------|----------|---|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Debugger | TRACED12 | Trace data output pin of HTM | 148 | - | - | - |
| | TRACED13 | | 149 | - | - | - |
| | TRACED14 | | 150 | - | - | - |
| | TRACED15 | | 151 | - | - | - |
| | TRSTX | JTAG test reset Input pin | 164 | 134 | 110 | B13 |
| External bus | MAD00_0 | External bus interface address bus | 81 | 66 | 56 | J6 |
| | MAD01_0 | | 82 | 67 | 57 | L8 |
| | MAD02_0 | | 83 | 68 | 58 | K8 |
| | MAD03_0 | | 84 | 69 | 59 | J8 |
| | MAD04_0 | | 91 | 76 | 60 | K9 |
| | MAD05_0 | | 92 | 77 | 61 | P10 |
| | MAD06_0 | | 93 | 78 | 62 | N10 |
| | MAD07_0 | | 96 | 79 | 63 | L10 |
| | MAD08_0 | | 97 | 80 | 64 | K10 |
| | MAD09_0 | | 98 | 81 | 65 | M10 |
| | MAD10_0 | | 142 | 116 | 92 | G10 |
| | MAD11_0 | | 143 | 117 | 93 | G9 |
| | MAD12_0 | | 144 | 118 | 94 | F10 |
| | MAD13_0 | | 145 | 119 | 95 | F11 |
| | MAD14_0 | | 146 | 120 | 96 | F12 |
| | MAD15_0 | | 147 | 121 | 97 | F13 |
| | MAD16_0 | | 152 | 122 | 98 | E10 |
| | MAD17_0 | | 153 | 123 | 99 | E11 |
| | MAD18_0 | | 154 | 124 | 100 | E12 |
| | MAD19_0 | | 50 | 40 | 35 | L1 |
| | MAD20_0 | | 49 | 39 | 34 | K4 |
| | MAD21_0 | | 48 | 38 | 33 | K3 |
| | MAD22_0 | | 47 | 37 | 32 | K2 |
| | MAD23_0 | | 46 | 36 | 31 | K1 |
| | MAD24_0 | 45 | 35 | 30 | J2 | |
| | MCSX0_0 | External bus interface chip select output pin | 71 | 56 | 48 | M5 |
| | MCSX1_0 | | 70 | 55 | 47 | L5 |
| | MCSX2_0 | | 61 | 51 | 43 | N4 |
| | MCSX3_0 | | 60 | 50 | 42 | M4 |
| | MCSX4_0 | | 59 | 49 | 41 | L4 |
| | MCSX5_0 | | 58 | 48 | 40 | M3 |
| | MCSX6_0 | | 57 | 47 | 39 | N3 |
| MCSX7_0 | 56 | | 46 | 38 | N2 | |
| MCSX8_0 | 88 | | 73 | - | P9 | |

| Module | Pin Name | Function | Pin Number | | | |
|-----------------|---|---|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| External bus | MADATA00_0 | External bus interface data bus (address/data multiplex bus) | 2 | 2 | 2 | B2 |
| | MADATA01_0 | | 3 | 3 | 3 | C2 |
| | MADATA02_0 | | 4 | 4 | 4 | C3 |
| | MADATA03_0 | | 5 | 5 | 5 | D5 |
| | MADATA04_0 | | 6 | 6 | 6 | D2 |
| | MADATA05_0 | | 7 | 7 | 7 | D1 |
| | MADATA06_0 | | 8 | 8 | 8 | D3 |
| | MADATA07_0 | | 9 | 9 | 9 | D4 |
| | MADATA08_0 | | 14 | 13 | 10 | E5 |
| | MADATA09_0 | | 15 | 14 | 11 | F1 |
| | MADATA10_0 | | 16 | 15 | 12 | F2 |
| | MADATA11_0 | | 17 | 16 | 13 | F3 |
| | MADATA12_0 | | 18 | 17 | 14 | F4 |
| | MADATA13_0 | | 23 | 18 | 15 | F5 |
| | MADATA14_0 | | 24 | 19 | 16 | F6 |
| | MADATA15_0 | | 25 | 20 | 17 | G2 |
| | MADATA16_0 | | 10 | - | - | - |
| | MADATA17_0 | | 11 | - | - | - |
| | MADATA18_0 | | 12 | - | - | - |
| | MADATA19_0 | | 13 | - | - | - |
| | MADATA20_0 | | 19 | - | - | - |
| | MADATA21_0 | | 20 | - | - | - |
| | MADATA22_0 | | 21 | - | - | - |
| | MADATA23_0 | | 22 | - | - | - |
| | MADATA24_0 | | 26 | - | - | - |
| | MADATA25_0 | 27 | - | - | - | |
| | MADATA26_0 | 28 | - | - | - | |
| | MADATA27_0 | 29 | - | - | - | |
| | MADATA28_0 | 33 | - | - | - | |
| | MADATA29_0 | 51 | - | - | - | |
| | MADATA30_0 | 52 | - | - | - | |
| | MADATA31_0 | 53 | - | - | - | |
| | MDQM0_0 | External bus interface byte mask signal output pin | 30 | 21 | 18 | G3 |
| MDQM1_0 | 31 | | 22 | 19 | G4 | |
| MDQM2_0 | 34 | | - | - | - | |
| MDQM3_0 | 35 | | - | - | - | |
| MALE_0 | External bus interface address latch enable output signal for multiplex | 211 | 171 | 139 | C4 | |
| MRDY_0 | External bus interface external RDY input signal | 80 | 65 | 55 | L6 | |

| Module | Pin Name | Function | Pin Number | | | |
|--------------------|-----------|--|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| External bus | MCLKOUT_0 | External bus interface external clock output pin | 32 | 23 | 20 | G5 |
| | MNALE_0 | External bus interface ALE signal to control NAND flash output pin | 47 | 37 | 32 | K2 |
| | MNCLE_0 | External bus interface CLE signal to control NAND flash output pin | 48 | 38 | 33 | K3 |
| | MNREX_0 | External bus interface read enable signal to control NAND flash | 50 | 40 | 35 | L1 |
| | MNWEX_0 | External bus interface write enable signal to control NAND flash | 49 | 39 | 34 | K4 |
| | MOEX_0 | External bus interface read enable signal for SRAM | 209 | 169 | 137 | C5 |
| | MWEX_0 | External bus interface write enable signal for SRAM | 210 | 170 | 138 | B4 |
| | MSDCLK_0 | SDRAM interface SDRAM clock output pin | 90 | 75 | - | L9 |
| | MSDCKE_0 | SDRAM interface SDRAM clock enable pin | 89 | 74 | - | M9 |
| | MRASX_0 | SDRAM interface SDRAM column active strobe pin | 85 | 70 | - | N8 |
| | MCASX_0 | SDRAM interface SDRAM row active strobe pin | 86 | 71 | - | M8 |
| | MSDWEX_0 | SDRAM interface SDRAM write enable pin | 87 | 72 | - | N9 |
| External interrupt | INT00_0 | External interrupt request 00 input pin | 2 | 2 | 2 | B2 |
| | INT00_1 | | 38 | 28 | 23 | H3 |
| | INT00_2 | | 19 | - | - | - |
| | INT01_0 | External interrupt request 01 input pin | 7 | 7 | 7 | D1 |
| | INT01_1 | | 41 | 31 | 26 | H6 |
| | INT01_2 | | 51 | 41 | - | L2 |
| | INT02_0 | External interrupt request 02 input pin | 14 | 13 | 10 | E5 |
| | INT02_1 | | 42 | 32 | 27 | J5 |
| | INT02_2 | | 26 | - | - | - |
| | INT03_0 | External interrupt request 03 input pin | 17 | 16 | 13 | F3 |
| | INT03_1 | | 43 | 33 | 28 | J4 |
| | INT03_2 | | 34 | 24 | - | G6 |
| | INT04_0 | External interrupt request 04 input pin | 59 | 49 | 41 | L4 |
| | INT04_1 | | 100 | 83 | 67 | M11 |
| | INT04_2 | | 65 | - | - | - |
| | INT05_0 | External interrupt request 05 input pin | 70 | 55 | 47 | L5 |
| | INT05_1 | | 86 | 71 | - | M8 |
| | INT05_2 | | 68 | - | - | - |

| Module | Pin Name | Function | Pin Number | | | |
|--------------------|---|---|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| External interrupt | INT06_0 | External interrupt request 06 input pin | 80 | 65 | 55 | L6 |
| | INT06_1 | | 87 | 72 | - | N9 |
| | INT06_2 | | 103 | - | - | - |
| | INT07_0 | External interrupt request 07 input pin | 82 | 67 | 57 | L8 |
| | INT07_1 | | 88 | 73 | - | P9 |
| | INT07_2 | | 102 | - | - | - |
| | INT08_0 | External interrupt request 08 input pin | 114 | 94 | 78 | L11 |
| | INT08_1 | | 127 | 103 | - | J9 |
| | INT08_2 | | 119 | - | - | - |
| | INT09_0 | External interrupt request 09 input pin | 123 | 99 | 83 | J13 |
| | INT09_1 | | 128 | 104 | - | H10 |
| | INT09_2 | | 120 | - | - | - |
| | INT10_0 | External interrupt request 10 input pin | 130 | 106 | 86 | H9 |
| | INT10_1 | | 138 | 112 | - | G13 |
| | INT10_2 | | 149 | - | - | - |
| | INT11_0 | External interrupt request 11 input pin | 133 | 109 | 89 | G14 |
| | INT11_1 | | 139 | 113 | - | F14 |
| | INT11_2 | | 151 | - | - | - |
| | INT12_0 | External interrupt request 12 input pin | 194 | 162 | 132 | E7 |
| | INT12_1 | | 169 | 139 | - | C11 |
| | INT12_2 | | 175 | - | - | - |
| | INT13_0 | External interrupt request 13 input pin | 184 | 152 | 122 | E8 |
| | INT13_1 | | 170 | 140 | - | D11 |
| | INT13_2 | | 176 | - | - | - |
| | INT14_0 | External interrupt request 14 input pin | 192 | 160 | 130 | A6 |
| | INT14_1 | | 171 | 141 | - | B10 |
| | INT14_2 | | 201 | - | - | - |
| | INT15_0 | External interrupt request 15 input pin | 193 | 161 | 131 | D7 |
| | INT15_1 | | 172 | 142 | - | C10 |
| | INT15_2 | | 206 | - | - | - |
| INT16_0 | External interrupt request 16 input pin | 25 | 20 | 17 | G2 | |
| INT16_1 | | 45 | 35 | 30 | J2 | |
| INT17_0 | External interrupt request 17 input pin | 30 | 21 | 18 | G3 | |
| INT17_1 | | 46 | 36 | 31 | K1 | |
| INT18_0 | External interrupt request 18 input pin | 31 | 22 | 19 | G4 | |
| INT18_1 | | 47 | 37 | 32 | K2 | |
| INT19_0 | External interrupt request 19 input pin | 36 | 26 | 21 | H2 | |
| INT19_1 | | 48 | 38 | 33 | K3 | |

| Module | Pin Name | Function | Pin Number | | | |
|--------------------|---|---|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| External interrupt | INT20_0 | External interrupt request 20 input pin | 91 | 76 | 60 | K9 |
| | INT20_1 | | 89 | 74 | - | M9 |
| | INT21_0 | External interrupt request 21 input pin | 96 | 79 | 63 | L10 |
| | INT21_1 | | 90 | 75 | - | L9 |
| | INT22_0 | External interrupt request 22 input pin | 99 | 82 | 66 | N11 |
| | INT22_1 | | 78 | 63 | - | K5 |
| | INT23_0 | External interrupt request 23 input pin | 56 | 46 | 38 | N2 |
| | INT23_1 | | 79 | 64 | - | K6 |
| | INT24_0 | External interrupt request 24 input pin | 147 | 121 | 97 | F13 |
| | INT24_1 | | 131 | 107 | 87 | H12 |
| | INT25_0 | External interrupt request 25 input pin | 153 | 123 | 99 | E11 |
| | INT25_1 | | 117 | 97 | 81 | K14 |
| | INT26_0 | External interrupt request 26 input pin | 156 | 126 | 102 | D12 |
| | INT26_1 | | 142 | 116 | 92 | G10 |
| | INT27_0 | External interrupt request 27 input pin | 157 | 127 | 103 | D13 |
| | INT27_1 | | 143 | 117 | 93 | G9 |
| | INT28_0 | External interrupt request 28 input pin | 190 | 158 | 128 | A7 |
| | INT28_1 | | 207 | 167 | - | E6 |
| | INT29_0 | External interrupt request 29 input pin | 198 | 166 | 136 | D6 |
| | INT29_1 | | 208 | 168 | - | B5 |
| | INT30_0 | External interrupt request 30 input pin | 209 | 169 | 137 | C5 |
| INT30_1 | 195 | | 163 | 133 | F7 | |
| INT31_0 | External interrupt request 31 input pin | 212 | 172 | 140 | B3 | |
| INT31_1 | | 196 | 164 | 134 | B6 | |
| | NMIX | Non-maskable interrupt input pin | 158 | 128 | 104 | C13 |

| Module | Pin Name | Function | Pin Number | | | |
|--------|----------|----------------------------|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| GPIO | P00 | General-purpose I/O port 0 | 164 | 134 | 110 | B13 |
| | P01 | | 165 | 135 | 111 | A12 |
| | P02 | | 166 | 136 | 112 | C12 |
| | P03 | | 167 | 137 | 113 | B12 |
| | P04 | | 168 | 138 | 114 | B11 |
| | P08 | | 30 | 21 | 18 | G3 |
| | P09 | | 31 | 22 | 19 | G4 |
| | P0A | | 32 | 23 | 20 | G5 |
| | P10 | General-purpose I/O port 1 | 114 | 94 | 78 | L11 |
| | P11 | | 115 | 95 | 79 | K13 |
| | P12 | | 116 | 96 | 80 | K12 |
| | P13 | | 117 | 97 | 81 | K14 |
| | P14 | | 118 | 98 | 82 | K11 |
| | P15 | | 123 | 99 | 83 | J13 |
| | P16 | | 124 | 100 | 84 | J12 |
| | P17 | | 125 | 101 | 85 | J11 |
| | P18 | | 130 | 106 | 86 | H9 |
| | P19 | | 131 | 107 | 87 | H12 |
| | P1A | | 132 | 108 | 88 | H14 |
| | P1B | | 133 | 109 | 89 | G14 |
| | P1C | | 134 | 110 | 90 | H13 |
| | P1D | | 135 | 111 | 91 | H11 |
| | P1E | 142 | 116 | 92 | G10 | |
| | P1F | 143 | 117 | 93 | G9 | |
| | P20 | General-purpose I/O port 2 | 158 | 128 | 104 | C13 |
| | P21 | | 157 | 127 | 103 | D13 |
| | P22 | | 156 | 126 | 102 | D12 |
| | P23 | | 155 | 125 | 101 | E13 |
| | P24 | | 154 | 124 | 100 | E12 |
| | P25 | | 153 | 123 | 99 | E11 |
| P26 | 152 | | 122 | 98 | E10 | |
| P27 | 147 | | 121 | 97 | F13 | |
| P28 | 146 | | 120 | 96 | F12 | |
| P29 | 145 | | 119 | 95 | F11 | |
| P2A | 144 | 118 | 94 | F10 | | |

| Module | Pin Name | Function | Pin Number | | | |
|--------|----------|----------------------------|----------------------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| GPIO | P30 | General-purpose I/O port 3 | 34 | 24 | - | G6 |
| | P31 | | 35 | 25 | - | H4 |
| | P32 | | 36 | 26 | 21 | H2 |
| | P33 | | 37 | 27 | 22 | J1 |
| | P34 | | 38 | 28 | 23 | H3 |
| | P35 | | 41 | 31 | 26 | H6 |
| | P36 | | 42 | 32 | 27 | J5 |
| | P37 | | 43 | 33 | 28 | J4 |
| | P38 | | 44 | 34 | 29 | J3 |
| | P39 | | 45 | 35 | 30 | J2 |
| | P3A | | 46 | 36 | 31 | K1 |
| | P3B | | 47 | 37 | 32 | K2 |
| | P3C | | 48 | 38 | 33 | K3 |
| | P3D | | 49 | 39 | 34 | K4 |
| | P3E | | 50 | 40 | 35 | L1 |
| | P40 | 56 | General-purpose I/O port 4 | 46 | 38 | N2 |
| | P41 | 57 | | 47 | 39 | N3 |
| | P42 | 58 | | 48 | 40 | M3 |
| | P43 | 59 | | 49 | 41 | L4 |
| | P44 | 60 | | 50 | 42 | M4 |
| | P45 | 61 | | 51 | 43 | N4 |
| | P46 | 73 | | 58 | 50 | P5 |
| | P47 | 74 | | 59 | 51 | P6 |
| | P48 | 76 | | 61 | 53 | N6 |
| | P49 | 77 | | 62 | 54 | M6 |
| | P4A | 65 | | - | - | - |
| | P4B | 66 | | - | - | - |
| | P4C | 67 | | - | - | - |
| | P4D | 68 | | - | - | - |
| | P4E | 69 | | - | - | - |

| Module | Pin Name | Function | Pin Number | | | |
|--------|----------|----------------------------|----------------------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| GPIO | P50 | General-purpose I/O port 5 | 10 | 10 | - | E2 |
| | P51 | | 11 | 11 | - | E3 |
| | P52 | | 12 | 12 | - | E4 |
| | P53 | | 13 | - | - | - |
| | P54 | | 19 | - | - | - |
| | P55 | | 20 | - | - | - |
| | P56 | | 21 | - | - | - |
| | P57 | | 22 | - | - | - |
| | P58 | | 26 | - | - | - |
| | P59 | | 27 | - | - | - |
| | P5A | | 28 | - | - | - |
| | P5B | | 29 | - | - | - |
| | P5C | | 33 | - | - | - |
| | P5D | | 51 | 41 | - | L2 |
| | P5E | | 52 | 42 | - | L3 |
| | P5F | | 53 | 43 | - | M2 |
| | P60 | | General-purpose I/O port 6 | 212 | 172 | 140 |
| | P61 | 211 | | 171 | 139 | C4 |
| | P62 | 210 | | 170 | 138 | B4 |
| | P63 | 209 | | 169 | 137 | C5 |
| | P64 | 208 | | 168 | - | B5 |
| | P65 | 207 | | 167 | - | E6 |
| | P66 | 206 | | - | - | - |
| | P67 | 205 | | - | - | - |
| | P68 | 204 | | - | - | - |
| | P69 | 203 | | - | - | - |
| | P6A | 202 | | - | - | - |
| | P6B | 201 | | - | - | - |
| | P6C | 200 | | - | - | - |
| | P6D | 199 | - | - | - | |
| P6E | 198 | 166 | 136 | D6 | | |

| Module | Pin Name | Function | Pin Number | | | |
|--------|----------|----------------------------|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| GPIO | P70 | General-purpose I/O port 7 | 80 | 65 | 55 | L6 |
| | P71 | | 81 | 66 | 56 | J6 |
| | P72 | | 82 | 67 | 57 | L8 |
| | P73 | | 83 | 68 | 58 | K8 |
| | P74 | | 84 | 69 | 59 | J8 |
| | P75 | | 91 | 76 | 60 | K9 |
| | P76 | | 92 | 77 | 61 | P10 |
| | P77 | | 93 | 78 | 62 | N10 |
| | P78 | | 96 | 79 | 63 | L10 |
| | P79 | | 97 | 80 | 64 | K10 |
| | P7A | | 98 | 81 | 65 | M10 |
| | P7B | | 99 | 82 | 66 | N11 |
| | P7C | | 100 | 83 | 67 | M11 |
| | P7D | | 70 | 55 | 47 | L5 |
| | P7E | 71 | 56 | 48 | M5 | |
| | P80 | General-purpose I/O port 8 | 214 | 174 | 142 | A3 |
| | P81 | | 215 | 175 | 143 | A2 |
| | P82 | | 160 | 130 | 106 | D14 |
| | P83 | | 161 | 131 | 107 | C14 |
| | P90 | General-purpose I/O port 9 | 169 | 139 | - | C11 |
| | P91 | | 170 | 140 | - | D11 |
| | P92 | | 171 | 141 | - | B10 |
| | P93 | | 172 | 142 | - | C10 |
| | P94 | | 173 | 143 | - | D10 |
| | P95 | | 174 | 144 | - | B9 |
| | P96 | | 175 | - | - | - |
| | P97 | | 176 | - | - | - |

| Module | Pin Name | Function | Pin Number | | | |
|--------|----------|----------------------------|----------------------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| GPIO | PA0 | General-purpose I/O port A | 2 | 2 | 2 | B2 |
| | PA1 | | 3 | 3 | 3 | C2 |
| | PA2 | | 4 | 4 | 4 | C3 |
| | PA3 | | 5 | 5 | 5 | D5 |
| | PA4 | | 6 | 6 | 6 | D2 |
| | PA5 | | 7 | 7 | 7 | D1 |
| | PA6 | | 8 | 8 | 8 | D3 |
| | PA7 | | 9 | 9 | 9 | D4 |
| | PA8 | | 14 | 13 | 10 | E5 |
| | PA9 | | 15 | 14 | 11 | F1 |
| | PAA | | 16 | 15 | 12 | F2 |
| | PAB | | 17 | 16 | 13 | F3 |
| | PAC | | 18 | 17 | 14 | F4 |
| | PAD | | 23 | 18 | 15 | F5 |
| | PAE | | 24 | 19 | 16 | F6 |
| | PAF | | 25 | 20 | 17 | G2 |
| | PB0 | | General-purpose I/O port B | 126 | 102 | - |
| | PB1 | 127 | | 103 | - | J9 |
| | PB2 | 128 | | 104 | - | H10 |
| | PB3 | 129 | | 105 | - | J14 |
| | PB4 | 138 | | 112 | - | G13 |
| | PB5 | 139 | | 113 | - | F14 |
| | PB6 | 140 | | 114 | - | G12 |
| | PB7 | 141 | | 115 | - | G11 |
| | PB8 | 119 | | - | - | - |
| | PB9 | 120 | | - | - | - |
| | PBA | 121 | | - | - | - |
| | PBB | 122 | | - | - | - |
| | PBC | 148 | | - | - | - |
| | PBD | 149 | - | - | - | |
| PBE | 150 | - | - | - | | |
| PBF | 151 | - | - | - | | |

| Module | Pin Name | Function | Pin Number | | | |
|--------|----------|----------------------------|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| GPIO | PC0 | General-purpose I/O port C | 177 | 145 | 115 | C9 |
| | PC1 | | 178 | 146 | 116 | B8 |
| | PC2 | | 179 | 147 | 117 | D9 |
| | PC3 | | 180 | 148 | 118 | E9 |
| | PC4 | | 181 | 149 | 119 | F9 |
| | PC5 | | 182 | 150 | 120 | C8 |
| | PC6 | | 183 | 151 | 121 | D8 |
| | PC7 | | 184 | 152 | 122 | E8 |
| | PC8 | | 185 | 153 | 123 | A10 |
| | PC9 | | 186 | 154 | 124 | F8 |
| | PCA | | 187 | 155 | 125 | B7 |
| | PCB | | 190 | 158 | 128 | A7 |
| | PCC | | 191 | 159 | 129 | C7 |
| | PCD | | 192 | 160 | 130 | A6 |
| | PCE | | 193 | 161 | 131 | D7 |
| | PCF | | 194 | 162 | 132 | E7 |
| | PD0 | General-purpose I/O port D | 195 | 163 | 133 | F7 |
| | PD1 | | 196 | 164 | 134 | B6 |
| | PD2 | | 197 | 165 | 135 | C6 |
| | PE0 | General-purpose I/O port E | 104 | 84 | 68 | N13 |
| | PE2 | | 106 | 86 | 70 | P12 |
| | PE3 | | 107 | 87 | 71 | P13 |
| | PF0 | General-purpose I/O port F | 78 | 63 | - | K5 |
| | PF1 | | 79 | 64 | - | K6 |
| | PF2 | | 85 | 70 | - | N8 |
| | PF3 | | 86 | 71 | - | M8 |
| | PF4 | | 87 | 72 | - | N9 |
| | PF5 | | 88 | 73 | - | P9 |
| | PF6 | | 89 | 74 | - | M9 |
| | PF7 | | 90 | 75 | - | L9 |
| PF8 | 94 | | - | - | - | |
| PF9 | 95 | | - | - | - | |
| PFA | 101 | | - | - | - | |
| PFB | 102 | | - | - | - | |
| PFC | 103 | | - | - | - | |

| Module | Pin Name | Function | Pin Number | | | |
|-------------------------|-----------------|---|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Multi-Function Serial 0 | SIN0_0 | Multi-function serial interface ch 0 input pin | 157 | 127 | 103 | D13 |
| | SIN0_1 | | 151 | - | - | - |
| | SOT0_0 (SDA0_0) | Multi-function serial interface ch 0 output pin | 156 | 126 | 102 | D12 |
| | SOT0_1 (SDA0_1) | This pin operates as SOT0 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA0 when it is used in an I ² C (operation mode 4). | 150 | - | - | - |
| | SCK0_0 (SCL0_0) | Multi-function serial interface ch 0 clock I/O pin. This pin operates as SCK0 when it is used in a CSIO (operation mode 2) and as SCL0 when it is used in an I ² C (operation mode 4) | 155 | 125 | 101 | E13 |
| | SCK0_1 (SCL0_1) | | 149 | - | - | - |
| Multi-Function Serial 1 | SIN1_0 | Multi-function serial interface ch 1 input pin | 7 | 7 | 7 | D1 |
| | SIN1_1 | | 80 | 65 | 55 | L6 |
| | SOT1_0 (SDA1_0) | Multi-function serial interface ch 1 output pin. | 8 | 8 | 8 | D3 |
| | SOT1_1 (SDA1_1) | This pin operates as SOT1 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA1 when it is used in an I ² C (operation mode 4). | 81 | 66 | 56 | J6 |
| | SCK1_0 (SCL1_0) | Multi-function serial interface ch 1 clock I/O pin. | 9 | 9 | 9 | D4 |
| | SCK1_1 (SCL1_1) | This pin operates as SCK1 when it is used in a CSIO (operation mode 2) and as SCL1 when it is used in an I ² C (operation mode 4). | 70 | 55 | 47 | L5 |
| Multi-Function Serial 2 | SIN2_0 | Multi-function serial interface ch 2 input pin | 130 | 106 | 86 | H9 |
| | SIN2_1 | | 45 | 35 | 30 | J2 |
| | SOT2_0 (SDA2_0) | Multi-function serial interface ch 2 output pin. | 131 | 107 | 87 | H12 |
| | SOT2_1 (SDA2_1) | This pin operates as SOT2 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA2 when it is used in an I ² C (operation mode 4). | 46 | 36 | 31 | K1 |
| | SCK2_0 (SCL2_0) | Multi-function serial interface ch 2 clock I/O pin. | 132 | 108 | 88 | H14 |
| | SCK2_1 (SCL2_1) | This pin operates as SCK2 when it is used in a CSIO (operation mode 2) and as SCL2 when it is used in an I ² C (operation mode 4). | 47 | 37 | 32 | K2 |

| Module | Pin Name | Function | Pin Number | | | |
|-------------------------|--------------------|--|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Multi-Function Serial 3 | SIN3_0 | Multi-function serial interface ch 3 input pin | 25 | 20 | 17 | G2 |
| | SIN3_1 | | 56 | 46 | 38 | N2 |
| | SOT3_0 (SDA3_0) | Multi-function serial interface ch 3 output pin. | 24 | 19 | 16 | F6 |
| | SOT3_1 (SDA3_1) | This pin operates as SOT3 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA3 when it is used in an I ² C (operation mode 4). | 57 | 47 | 39 | N3 |
| | SCK3_0 (SCL3_0) | Multi-function serial interface ch 3 clock I/O pin. | 23 | 18 | 15 | F5 |
| | SCK3_1 (SCL3_1) | This pin operates as SCK3 when it is used in a CSIO (operation modes 2) and as SCL3 when it is used in an I ² C (operation mode 4). | 58 | 48 | 40 | M3 |
| Multi-Function Serial 4 | SIN4_0 | Multi-function serial interface ch 4 input pin | 212 | 172 | 140 | B3 |
| | SIN4_1 | | 193 | 161 | 131 | D7 |
| | SOT4_0 (SDA4_0) | Multi-function serial interface ch 4 output pin. | 211 | 171 | 139 | C4 |
| | SOT4_1 (SDA4_1) | This pin operates as SOT4 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA4 when it is used in an I ² C (operation mode 4). | 192 | 160 | 130 | A6 |
| | SCK4_0 (SCL4_0) | Multi-function serial interface ch 4 clock I/O pin. | 210 | 170 | 138 | B4 |
| | SCK4_1 (SCL4_1) | This pin operates as SCK4 when it is used in a CSIO (operation mode 2) and as SCL4 when it is used in an I ² C (operation mode 4). | 198 | 166 | 136 | D6 |
| | CTS4_0 | Multi-function serial interface ch 4 CTS input pin | 208 | 168 | - | B5 |
| | CTS4_1 | | 197 | 165 | 135 | C6 |
| | RTS4_0 | Multi-function serial interface ch 4 RTS output pin | 209 | 169 | 137 | C5 |
| | RTS4_1 | | 194 | 162 | 132 | E7 |

| Module | Pin Name | Function | Pin Number | | | |
|-------------------------|-----------------|--|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Multi-Function Serial 5 | SIN5_0 | Multi-function serial interface ch 5 input pin | 147 | 121 | 97 | F13 |
| | SIN5_1 | | 170 | 140 | - | D11 |
| | SOT5_0 (SDA5_0) | Multi-function serial interface ch 5 output pin. | 146 | 120 | 96 | F12 |
| | SOT5_1 (SDA5_1) | This pin operates as SOT5 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA5 when it is used in an I ² C (operation mode 4). | 171 | 141 | - | B10 |
| | SCK5_0 (SCL5_0) | Multi-function serial interface ch 5 clock I/O pin. | 145 | 119 | 95 | F11 |
| | SCK5_1 (SCL5_1) | This pin operates as SCK5 when it is used in a CSIO (operation mode 2) and as SCL5 when it is used in an I ² C (operation mode 4). | 172 | 142 | - | C10 |
| | CTS5_0 | Multi-function serial interface ch 5 CTS input pin | 144 | 118 | 94 | F10 |
| | CTS5_1 | | 173 | 143 | - | D10 |
| | RTS5_0 | Multi-function serial interface ch 5 RTS output pin | 143 | 117 | 93 | G9 |
| | RTS5_1 | | 174 | 144 | - | B9 |
| Multi-Function Serial 6 | SIN6_0 | Multi-function serial interface ch 6 input pin | 96 | 79 | 63 | L10 |
| | SIN6_1 | | 117 | 97 | 81 | K14 |
| | SOT6_0 (SDA6_0) | Multi-function serial interface ch 6 output pin. | 97 | 80 | 64 | K10 |
| | SOT6_1 (SDA6_1) | This pin operates as SOT6 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA6 when it is used in an I ² C (operation mode 4). | 118 | 98 | 82 | K11 |
| | SCK6_0 (SCL6_0) | Multi-function serial interface ch 6 clock I/O pin. | 98 | 81 | 65 | M10 |
| | SCK6_1 (SCL6_1) | This pin operates as SCK6 when it is used in a CSIO (operation mode 2) and as SCL6 when it is used in an I ² C (operation mode 4). | 126 | 102 | - | J10 |
| | SCS60_0 | Multi-function serial interface ch 6 chip select 0 input/output pin | 99 | 82 | 66 | N11 |
| | SCS60_1 | | 127 | 103 | - | J9 |
| | SCS61_0 | Multi-function serial interface ch 6 chip select1 input/output pin | 100 | 83 | 67 | M11 |
| | SCS61_1 | | 128 | 104 | - | H10 |
| | SCS62_0 | Multi-function serial interface ch 6 chip select2 input/output pin | 79 | 64 | - | K6 |
| | SCS62_1 | | 129 | 105 | - | J14 |
| | SCS63_0 | Multi-function serial interface ch 6 chip select3 input/output pin | 78 | 63 | - | K5 |
| | SCS63_1 | | 119 | - | - | - |

| Module | Pin Name | Function | Pin Number | | | |
|-------------------------|--------------------|--|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Multi-Function Serial 7 | SIN7_0 | Multi-function serial interface ch 7 input pin | 14 | 13 | 10 | E5 |
| | SIN7_1 | | 103 | - | - | - |
| | SOT7_0 (SDA7_0) | Multi-function serial interface ch 7 output pin. | 15 | 14 | 11 | F1 |
| | SOT7_1 (SDA7_1) | This pin operates as SOT7 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA7 when it is used in an I ² C (operation mode 4). | 102 | - | - | - |
| | SCK7_0 (SCL7_0) | Multi-function serial interface ch 7 clock I/O pin. | 16 | 15 | 12 | F2 |
| | SCK7_1 (SCL7_1) | This pin operates as SCK7 when it is used in a CSIO (operation mode 2) and as SCL7 when it is used in an I ² C (operation mode 4). | 101 | - | - | - |
| | SCS70_0 | Multi-function serial interface ch 7 chip select 0 input/output pin | 17 | 16 | 13 | F3 |
| | SCS70_1 | | 94 | - | - | - |
| | SCS71_0 | Multi-function serial interface ch 7 chip select 1 input/output pin | 18 | 17 | 14 | F4 |
| | SCS71_1 | | 95 | - | - | - |
| | SCS72_0 | Multi-function serial interface ch 7 chip select 2 input/output pin | 10 | 10 | - | E2 |
| | SCS72_1 | | 68 | - | - | - |
| | SCS73_0 | Multi-function serial interface ch 7 chip select 3 input/output pin | 11 | 11 | - | E3 |
| | SCS73_1 | | 69 | - | - | - |
| Multi-Function Serial 8 | SIN8_0 | Multi-function serial interface ch 8 input pin | 91 | 76 | 60 | K9 |
| | SIN8_1 | | 138 | 112 | - | G13 |
| | SOT8_0 (SDA8_0) | Multi-function serial interface ch 8 output pin. | 92 | 77 | 61 | P10 |
| | SOT8_1 (SDA8_1) | This pin operates as SOT8 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA8 when it is used in an I ² C (operation mode 4). | 139 | 113 | - | F14 |
| | SCK8_0 (SCL8_0) | Multi-function serial interface ch 8 clock I/O pin. | 93 | 78 | 62 | N10 |
| | SCK8_1 (SCL8_1) | This pin operates as SCK8 when it is used in a CSIO (operation mode 2) and as SCL8 when it is used in an I ² C (operation mode 4). | 140 | 114 | - | G12 |

| Module | Pin Name | Function | Pin Number | | | |
|--------------------------|----------------------|--|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Multi-Function Serial 9 | SIN9_0 | Multi-function serial interface ch 9 input pin | 82 | 67 | 57 | L8 |
| | SIN9_1 | | 120 | - | - | - |
| | SOT9_0 (SDA9_0) | Multi-function serial interface ch 9 output pin. | 83 | 68 | 58 | K8 |
| | SOT9_1 (SDA9_1) | This pin operates as SOT9 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA9 when it is used in an I ² C (operation mode 4). | 121 | - | - | - |
| | SCK9_0 (SCL9_0) | Multi-function serial interface ch 9 clock I/O pin. | 84 | 69 | 59 | J8 |
| | SCK9_1 (SCL9_1) | This pin operates as SCK9 when it is used in a CSIO (operation mode 2) and as SCL9 when it is used in an I ² C (operation mode 4). | 122 | - | - | - |
| Multi-Function Serial 10 | SIN10_0 | Multi-function serial interface ch 10 input pin | 114 | 94 | 78 | L11 |
| | SIN10_1 | | 51 | 41 | - | L2 |
| | SOT10_0 (SDA10_0) | Multi-function serial interface ch 10 output pin. | 115 | 95 | 79 | K13 |
| | SOT10_1 (SDA10_1) | This pin operates as SOT10 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA10 when it is used in an I ² C (operation mode 4). | 52 | 42 | - | L3 |
| | SCK10_0 (SCL10_0) | Multi-function serial interface ch 10 clock I/O pin. | 116 | 96 | 80 | K12 |
| | SCK10_1 (SCL10_1) | This pin operates as SCK10 when it is used in a CSIO (operation mode 2) and as SCL10 when it is used in an I ² C (operation mode 4). | 53 | 43 | - | M2 |
| Multi-Function Serial 11 | SIN11_0 | Multi-function serial interface ch 11 input pin | 123 | 99 | 83 | J13 |
| | SIN11_1 | | 26 | - | - | - |
| | SOT11_0 (SDA11_0) | Multi-function serial interface ch 11 output pin. | 124 | 100 | 84 | J12 |
| | SOT11_1 (SDA11_1) | This pin operates as SOT11 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA11 when it is used in an I ² C (operation mode 4). | 27 | - | - | - |
| | SCK11_0 (SCL11_0) | Multi-function serial interface ch 11 clock I/O pin. | 125 | 101 | 85 | J11 |
| | SCK11_1 (SCL11_1) | This pin operates as SCK11 when it is used in a CSIO (operation mode 2) and as SCL11 when it is used in an I ² C (operation mode 4). | 28 | - | - | - |

| Module | Pin Name | Function | Pin Number | | | |
|--------------------------|-------------------|--|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Multi-Function Serial 12 | SIN12_0 | Multi-function serial interface ch 12 input pin | 133 | 109 | 89 | G14 |
| | SIN12_1 | | 65 | - | - | - |
| | SOT12_0 (SDA12_0) | Multi-function serial interface ch 12 output pin. | 134 | 110 | 90 | H13 |
| | SOT12_1 (SDA12_1) | This pin operates as SOT12 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA12 when it is used in an I ² C (operation mode 4). | 66 | - | - | - |
| | SCK12_0 (SCL12_0) | Multi-function serial interface ch 12 clock I/O pin. | 135 | 111 | 91 | H11 |
| | SCK12_1 (SCL12_1) | This pin operates as SCK12 when it is used in a CSIO (operation mode 2) and as SCL12 when it is used in an I ² C (operation mode 4). | 67 | - | - | - |
| Multi-Function Serial 13 | SIN13_0 | Multi-function serial interface ch 13 input pin | 48 | 38 | 33 | K3 |
| | SIN13_1 | | 206 | - | - | - |
| | SOT13_0 (SDA13_0) | Multi-function serial interface ch 13 output pin. | 49 | 39 | 34 | K4 |
| | SOT13_1 (SDA13_1) | This pin operates as SOT13 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA13 when it is used in an I ² C (operation mode 4). | 205 | - | - | - |
| | SCK13_0 (SCL13_0) | Multi-function serial interface ch 13 clock I/O pin. | 50 | 40 | 35 | L1 |
| | SCK13_1 (SCL13_1) | This pin operates as SCK13 when it is used in a CSIO (operation mode 2) and as SCL13 when it is used in an I ² C (operation mode 4). | 204 | - | - | - |
| Multi-Function Serial 14 | SIN14_0 | Multi-function serial interface ch 14 input pin | 30 | 21 | 18 | G3 |
| | SIN14_1 | | 201 | - | - | - |
| | SOT14_0 (SDA14_0) | Multi-function serial interface ch 14 output pin. | 31 | 22 | 19 | G4 |
| | SOT14_1 (SDA14_1) | This pin operates as SOT14 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA14 when it is used in an I ² C (operation mode 4). | 200 | - | - | - |
| | SCK14_0 (SCL14_0) | Multi-function serial interface ch 14 clock I/O pin. | 32 | 23 | 20 | G5 |
| | SCK14_1 (SCL14_1) | This pin operates as SCK14 when it is used in a CSIO (operation mode 2) and as SCL14 when it is used in an I ² C (operation mode 4). | 199 | - | - | - |

| Module | Pin Name | Function | Pin Number | | | |
|--------------------------------|----------------------|--|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Multi-Function Serial 15 | SIN15_0 | Multi-function serial interface ch 15 input pin | 59 | 49 | 41 | L4 |
| | SIN15_1 | | 19 | - | - | - |
| | SOT15_0 (SDA15_0) | Multi-function serial interface ch 15 output pin. | 60 | 50 | 42 | M4 |
| | SOT15_1 (SDA15_1) | This pin operates as SOT15 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA15 when it is used in an I ² C (operation mode 4). | 20 | - | - | - |
| | SCK15_0 (SCL15_0) | Multi-function serial interface ch 15 clock I/O pin. | 61 | 51 | 43 | N4 |
| | SCK15_1 (SCL15_1) | This pin operates as SCK15 when it is used in a CSIO (operation mode 2) and as SCL15 when it is used in an I ² C (operation mode 4). | 21 | - | - | - |

| Module | Pin Name | Function | Pin Number | | | |
|------------------------|---|---|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Multi-Function Timer 0 | DTTIOX_0 | Input signal controlling waveform generator outputs RTO00 to RTO05 of Multi-Function Timer 0. | 44 | 34 | 29 | J3 |
| | DTTIOX_1 | | 21 | - | - | - |
| | FRCK0_0 | 16-bit free-run timer ch 0 external clock input pin | 37 | 27 | 22 | J1 |
| | FRCK0_1 | | 29 | - | - | - |
| | IC00_0 | 16-bit input capture input pin of Multi-Function Timer 0. ICxx describes channel number. | 43 | 33 | 28 | J4 |
| | IC00_1 | | 22 | - | - | - |
| | IC01_0 | | 42 | 32 | 27 | J5 |
| | IC01_1 | | 26 | - | - | - |
| | IC02_0 | | 41 | 31 | 26 | H6 |
| | IC02_1 | | 27 | - | - | - |
| | IC03_0 | | 38 | 28 | 23 | H3 |
| | IC03_1 | | 28 | - | - | - |
| | RTO00_0 (PPG00_0) | Waveform generator output pin of Multi-Function Timer 0. This pin operates as PPG00 when it is used in PPG0 output modes. | 45 | 35 | 30 | J2 |
| | RTO00_1 (PPG00_1) | | 10 | 10 | - | E2 |
| | RTO01_0 (PPG00_0) | Waveform generator output pin of Multi-Function Timer 0. This pin operates as PPG00 when it is used in PPG0 output modes. | 46 | 36 | 31 | K1 |
| | RTO01_1 (PPG00_1) | | 11 | 11 | - | E3 |
| | RTO02_0 (PPG02_0) | Waveform generator output pin of Multi-Function Timer 0. This pin operates as PPG02 when it is used in PPG0 output modes. | 47 | 37 | 32 | K2 |
| | RTO02_1 (PPG02_1) | | 12 | 12 | - | E4 |
| | RTO03_0 (PPG02_0) | Waveform generator output pin of Multi-Function Timer 0. This pin operates as PPG02 when it is used in PPG0 output modes. | 48 | 38 | 33 | K3 |
| | RTO03_1 (PPG02_1) | | 13 | - | - | - |
| RTO04_0 (PPG04_0) | Waveform generator output pin of Multi-Function Timer 0. This pin operates as PPG04 when it is used in PPG0 output modes. | 49 | 39 | 34 | K4 | |
| RTO04_1 (PPG04_1) | | 19 | - | - | - | |
| RTO05_0 (PPG04_0) | Waveform generator output pin of Multi-Function Timer 0. This pin operates as PPG04 when it is used in PPG0 output modes. | 50 | 40 | 35 | L1 | |
| RTO05_1 (PPG04_1) | | 20 | - | - | - | |

| Module | Pin Name | Function | Pin Number | | | |
|------------------------|--|---|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Multi-Function Timer 1 | DTTI1X_0 | Input signal controlling waveform generator outputs RTO10 to RTO15 of Multi-Function Timer 1. | 70 | 55 | 47 | L5 |
| | DTTI1X_1 | | 94 | - | - | - |
| | FRCK1_0 | 16-bit free-run timer ch 1 external clock input pin | 71 | 56 | 48 | M5 |
| | FRCK1_1 | | 78 | 63 | - | K5 |
| | IC10_0 | 16-bit input capture input pin of Multi-Function Timer 1. ICxx describes channel number. | 96 | 79 | 63 | L10 |
| | IC10_1 | | 95 | - | - | - |
| | IC11_0 | | 97 | 80 | 64 | K10 |
| | IC11_1 | | 101 | - | - | - |
| | IC12_0 | | 98 | 81 | 65 | M10 |
| | IC12_1 | | 102 | - | - | - |
| | IC13_0 | | 99 | 82 | 66 | N11 |
| | IC13_1 | | 103 | - | - | - |
| | RTO10_0 (PPG10_0) | Waveform generator output pin of Multi-Function Timer 1. | 56 | 46 | 38 | N2 |
| | RTO10_1 (PPG10_1) | This pin operates as PPG10 when it is used in PPG1 output modes. | 85 | 70 | - | N8 |
| | RTO11_0 (PPG10_0) | Waveform generator output pin of Multi-Function Timer 1. | 57 | 47 | 39 | N3 |
| | RTO11_1 (PPG10_1) | This pin operates as PPG10 when it is used in PPG1 output modes. | 86 | 71 | - | M8 |
| | RTO12_0 (PPG12_0) | Waveform generator output pin of Multi-Function Timer 1. | 58 | 48 | 40 | M3 |
| | RTO12_1 (PPG12_1) | This pin operates as PPG12 when it is used in PPG1 output modes. | 87 | 72 | - | N9 |
| | RTO13_0 (PPG12_0) | Waveform generator output pin of Multi-Function Timer 1. | 59 | 49 | 41 | L4 |
| | RTO13_1 (PPG12_1) | This pin operates as PPG12 when it is used in PPG1 output modes. | 88 | 73 | - | P9 |
| RTO14_0 (PPG14_0) | Waveform generator output pin of Multi-Function Timer 1. | 60 | 50 | 42 | M4 | |
| RTO14_1 (PPG14_1) | This pin operates as PPG14 when it is used in PPG1 output modes. | 89 | 74 | - | M9 | |
| RTO15_0 (PPG14_0) | Waveform generator output pin of Multi-Function Timer 1. | 61 | 51 | 43 | N4 | |
| RTO15_1 (PPG14_1) | This pin operates as PPG14 when it is used in PPG1 output modes. | 90 | 75 | - | L9 | |

| Module | Pin Name | Function | Pin Number | | | | |
|------------------------|---|---|---|------------|------------|------------|----|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 | |
| Multi-Function Timer 2 | DTTI2X_0 | Input signal controlling waveform generator outputs RTO20 to RTO25 of Multi-Function Timer 1. | 8 | 8 | 8 | D3 | |
| | DTTI2X_1 | | 202 | - | - | - | |
| | FRCK2_0 | 16-bit free-run timer ch 2 external clock input pin | 17 | 16 | 13 | F3 | |
| | FRCK2_1 | | 197 | 165 | 135 | C6 | |
| | IC20_0 | 16-bit input capture input pin of Multi-Function Timer 2. ICxx describes channel number. | 9 | 9 | 9 | D4 | |
| | IC20_1 | | 201 | - | - | - | |
| | IC21_0 | | 14 | 13 | 10 | E5 | |
| | IC21_1 | | 200 | - | - | - | |
| | IC22_0 | | 15 | 14 | 11 | F1 | |
| | IC22_1 | | 199 | - | - | - | |
| | IC23_0 | | 16 | 15 | 12 | F2 | |
| | IC23_1 | | 198 | 166 | 136 | D6 | |
| | RTO20_0 (PPG20_0) | | Waveform generator output pin of Multi-Function Timer 2. This pin operates as PPG20 when it is used in PPG2 output modes. | 2 | 2 | 2 | B2 |
| | RTO20_1 (PPG20_1) | | | 203 | - | - | - |
| | RTO21_0 (PPG20_0) | Waveform generator output pin of Multi-Function Timer 2. This pin operates as PPG20 when it is used in PPG2 output modes. | 3 | 3 | 3 | C2 | |
| | RTO21_1 (PPG20_1) | | 204 | - | - | - | |
| | RTO22_0 (PPG22_0) | Waveform generator output pin of Multi-Function Timer 2. This pin operates as PPG22 when it is used in PPG2 output modes. | 4 | 4 | 4 | C3 | |
| | RTO22_1 (PPG22_1) | | 205 | - | - | - | |
| | RTO23_0 (PPG22_0) | Waveform generator output pin of Multi-Function Timer 2. This pin operates as PPG22 when it is used in PPG2 output modes. | 5 | 5 | 5 | D5 | |
| | RTO23_1 (PPG22_1) | | 206 | - | - | - | |
| RTO24_0 (PPG24_0) | Waveform generator output pin of Multi-Function Timer 2. This pin operates as PPG24 when it is used in PPG2 output modes. | 6 | 6 | 6 | D2 | | |
| RTO24_1 (PPG24_1) | | 207 | 167 | - | E6 | | |
| RTO25_0 (PPG24_0) | Waveform generator output pin of Multi-Function Timer 2. This pin operates as PPG24 when it is used in PPG2 output modes. | 7 | 7 | 7 | D1 | | |
| RTO25_1 (PPG24_1) | | 208 | 168 | - | B5 | | |

| Module | Pin Name | Function | Pin Number | | | |
|---|----------|-------------------------|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Quadrature Position/ Revolution Counter 0 | AIN0_0 | QPRC ch 0 AIN input pin | 56 | 46 | 38 | N2 |
| | AIN0_1 | | 65 | - | - | - |
| | AIN0_2 | | 114 | 94 | 78 | L11 |
| | BIN0_0 | QPRC ch 0 BIN input pin | 57 | 47 | 39 | N3 |
| | BIN0_1 | | 66 | - | - | - |
| | BIN0_2 | | 115 | 95 | 79 | K13 |
| | ZIN0_0 | QPRC ch 0 ZIN input pin | 58 | 48 | 40 | M3 |
| | ZIN0_1 | | 67 | - | - | - |
| | ZIN0_2 | | 116 | 96 | 80 | K12 |
| Quadrature Position/ Revolution Counter 1 | AIN1_0 | QPRC ch 1 AIN input pin | 91 | 76 | 60 | K9 |
| | AIN1_1 | | 94 | - | - | - |
| | AIN1_2 | | 123 | 99 | 83 | J13 |
| | BIN1_0 | QPRC ch 1 BIN input pin | 92 | 77 | 61 | P10 |
| | BIN1_1 | | 45 | - | - | - |
| | BIN1_2 | | 124 | 100 | 84 | J12 |
| | ZIN1_0 | QPRC ch 1 ZIN input pin | 93 | 78 | 62 | N10 |
| | ZIN1_1 | | 101 | - | - | - |
| ZIN1_2 | 125 | | 101 | 85 | J11 | |
| Quadrature Position/ Revolution Counter 2 | AIN2_0 | QPRC ch 2 AIN input pin | 2 | 2 | 2 | B2 |
| | AIN2_1 | | 32 | 23 | 20 | G5 |
| | AIN2_2 | | 120 | - | - | - |
| | BIN2_0 | QPRC ch 2 BIN input pin | 3 | 3 | 3 | C2 |
| | BIN2_1 | | 36 | 26 | 21 | H2 |
| | BIN2_2 | | 121 | - | - | - |
| | ZIN2_0 | QPRC ch 2 ZIN input pin | 4 | 4 | 4 | C3 |
| | ZIN2_1 | | 37 | 27 | 22 | J1 |
| | ZIN2_2 | | 122 | - | - | - |
| Quadrature Position/ Revolution Counter 3 | AIN3_0 | QPRC ch 3 AIN input pin | 18 | 17 | 14 | F4 |
| | AIN3_1 | | 45 | 35 | 30 | J2 |
| | AIN3_2 | | 149 | - | - | - |
| | BIN3_0 | QPRC ch 3 BIN input pin | 23 | 18 | 15 | F5 |
| | BIN3_1 | | 46 | 36 | 31 | K1 |
| | BIN3_2 | | 150 | - | - | - |
| | ZIN3_0 | QPRC ch 3 ZIN input pin | 24 | 19 | 16 | F6 |
| | ZIN3_1 | | 47 | 37 | 32 | K2 |
| | ZIN3_2 | | 151 | - | - | - |

| Module | Pin Name | Function | Pin Number | | | |
|----------------------------|---|---|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Real-time clock | RTCCO_0 | 0.5 seconds pulse output pin of real-time clock | 211 | 171 | 139 | C4 |
| | RTCCO_1 | | 33 | - | - | - |
| | SUBOUT_0 | Sub-clock output pin | 211 | 171 | 139 | C4 |
| | SUBOUT_1 | | 33 | - | - | - |
| USB0 | UDM0 | USB ch 0 device/host D – pin | 214 | 174 | 142 | A3 |
| | UDP0 | USB ch 0 device/host D + pin | 215 | 175 | 143 | A2 |
| | UHCONX0 | USB ch 0 external pull-up control pin | 211 | 171 | 139 | C4 |
| USB1 | UDM1 | USB ch 1 device/host D – pin | 160 | 130 | 106 | D14 |
| | UDP1 | USB ch 1 device/host D + pin | 161 | 131 | 107 | C14 |
| | UHCONX1 | USB ch 1 external pull-up control pin | 155 | 125 | 101 | E13 |
| Low power consumption mode | WKUP0 | Deep standby mode return signal input pin 0 | 158 | 128 | 104 | C13 |
| | WKUP1 | Deep standby mode return signal input pin 1 | 14 | 13 | 10 | E5 |
| | WKUP2 | Deep standby mode return signal input pin 2 | 70 | 55 | 47 | L5 |
| | WKUP3 | Deep standby mode return signal input pin 3 | 212 | 172 | 140 | B3 |
| D/A converter | DA0 | D/A converter ch 0 analog output pin | 100 | 83 | 67 | M11 |
| | DA1 | D/A converter ch 1 analog output pin | 99 | 82 | 66 | N11 |
| VBAT | VREGCTL | On-board regulator control pin | 76 | 61 | 53 | N6 |
| | VWAKEUP | The return signal input pin from a hibernation state | 77 | 62 | 54 | M6 |
| SD I/F | S_CLK_0 | SD memory card interface SD memory card clock output pin | 38 | 28 | 23 | H3 |
| | S_CMD_0 | SD memory card interface SD memory card command output | 41 | 31 | 26 | H6 |
| | S_DATA1_0 | SD memory card interface SD memory card data bus | 36 | 26 | 21 | H2 |
| | S_DATA0_0 | | 37 | 27 | 22 | J1 |
| | S_DATA3_0 | | 42 | 32 | 27 | J5 |
| | S_DATA2_0 | | 43 | 33 | 28 | J4 |
| | S_CD_0 | SD memory card interface SD memory card detection pin | 45 | 35 | 30 | J2 |
| S_WP_0 | SD memory card interface SD memory card write protection | 44 | 34 | 29 | J3 | |

| Module | Pin Name | Function | Pin Number | | | |
|------------------------|------------|--|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| I ² S | I2SMCLK0_0 | I ² S external clock pin | 51 | 41 | - | L2 |
| | I2SDO0_0 | I ² S serial transition data output pin | 52 | 42 | - | L3 |
| | I2SWS0_0 | I ² S frame synchronization signal pin | 53 | 43 | - | M2 |
| | I2SDI0_0 | I ² S serial received data input pin | 34 | 24 | - | G6 |
| | I2SCK0_0 | I ² S bit clock pin | 35 | 25 | - | H4 |
| High-speed quad SPI | Q_SCK_0 | SPI clock output pin | 173 | 143 | - | D10 |
| | Q_IO0_0 | SPI data input/output pin | 172 | 142 | - | C10 |
| | Q_IO1_0 | | 171 | 141 | - | B10 |
| | Q_IO2_0 | | 170 | 140 | - | D11 |
| | Q_IO3_0 | | 169 | 139 | - | C11 |
| | Q_CS0_0 | SPI chip select output pin | 174 | 144 | - | B9 |
| | Q_CS1_0 | | 175 | - | - | - |
| | Q_CS2_0 | | 176 | - | - | - |

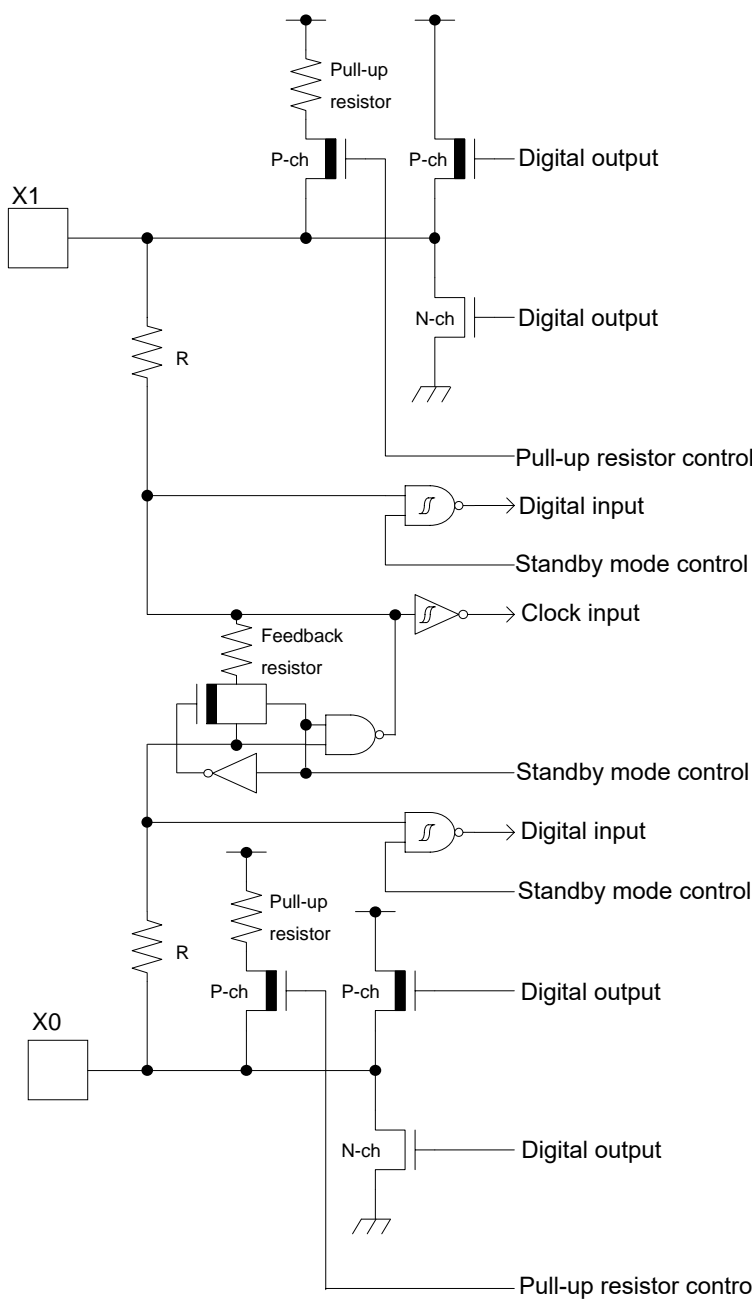
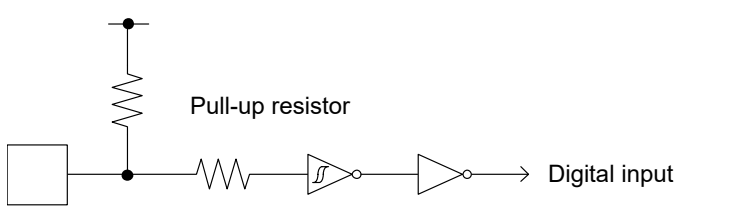
| Module | Pin Name | Function | Pin Number | | | |
|---------|----------|---|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Reset | INITX | External reset Input pin A reset is valid when INITX = L. | 72 | 57 | 49 | N5 |
| Mode | MD1 | Mode 1 pin During serial programming to flash memory, MD1 = L must be input. | 104 | 84 | 68 | N13 |
| | MD0 | Mode 0 pin During normal operation, MD0 = L must be input. During serial programming to flash memory, MD0 = H must be input. | 105 | 85 | 69 | N12 |
| Power | VCC | Power supply pin | 1 | 1 | 1 | C1 |
| | | | 39 | 29 | 24 | H1 |
| | | | 55 | 45 | 37 | N1 |
| | | | 64 | 54 | 46 | P4 |
| | | | 109 | 89 | 73 | M14 |
| | | | 137 | - | - | - |
| | | | 163 | 133 | 109 | A13 |
| | | | 188 | 156 | 126 | A9 |
| | USBVCC0 | 3.3 V power supply port for USB I/O | 213 | 173 | 141 | A4 |
| USBVCC1 | 159 | | 129 | 105 | E14 | |
| GND | VSS | GND pin | 40 | 30 | 25 | H5 |
| | | | 54 | 44 | 36 | M1 |
| | | | 63 | 53 | 45 | P3 |
| | | | 108 | 88 | 72 | N14 |
| | | | 136 | - | - | - |
| | | | 162 | 132 | 108 | B14 |
| | | | 189 | 157 | 127 | A8 |
| | | | 216 | 176 | 144 | B1 |
| | | | - | - | - | E1 |
| | | | - | - | - | G1 |
| | | | - | - | - | P7 |
| | | | - | - | - | P11 |
| | | | - | - | - | L14 |
| | | | - | - | - | A11 |
| | | | - | - | - | A5 |
| | | | - | - | - | N7 |
| | | | - | - | - | M7 |
| | | | - | - | - | K7 |
| | | | - | - | - | J7 |
| | | | - | - | - | G7 |
| - | - | - | H7 | | | |
| - | - | - | H8 | | | |
| - | - | - | G8 | | | |

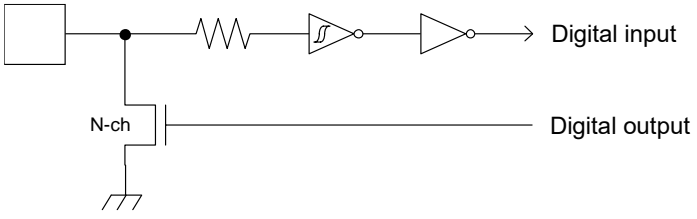
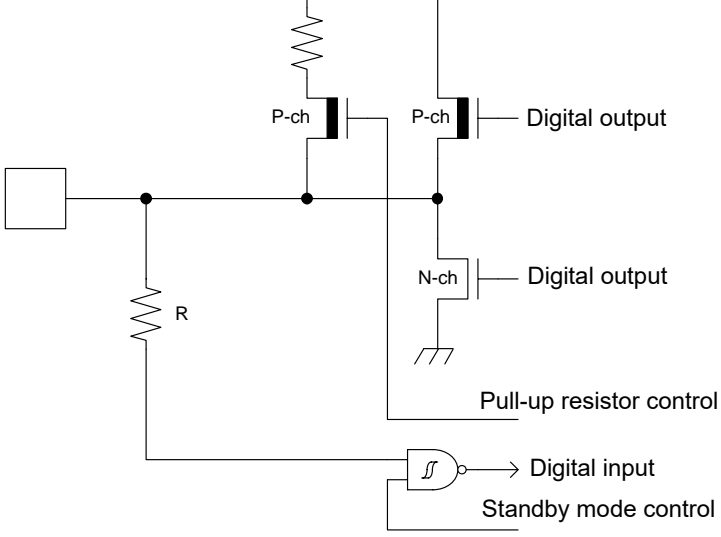
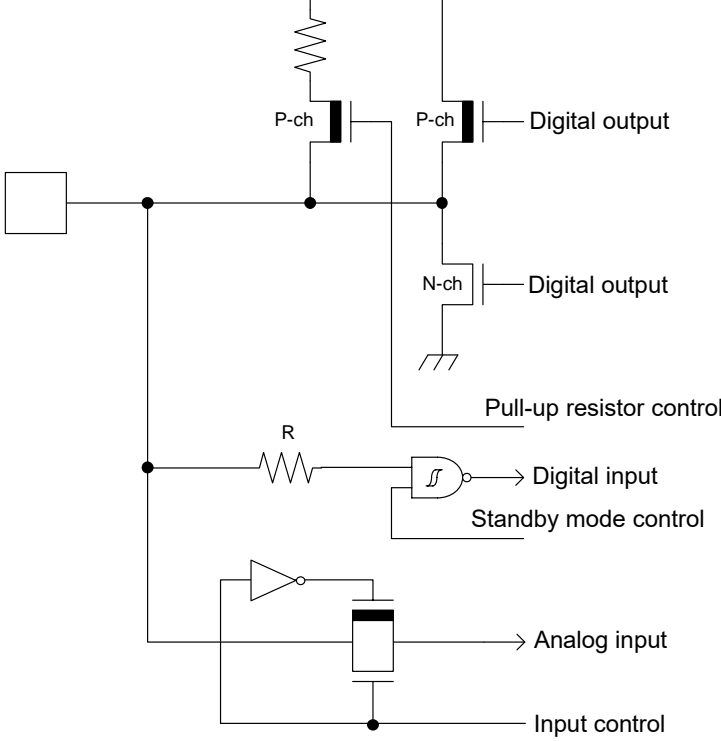
| Module | Pin Name | Function | Pin Number | | | |
|--------------|----------|---|------------|------------|------------|------------|
| | | | LQQ 216 | LQP 176 | LQS 144 | LBE 192 |
| Clock | X0 | Main clock (oscillation) input pin | 106 | 86 | 70 | P12 |
| | X1 | Main clock (oscillation) I/O pin | 107 | 87 | 71 | P13 |
| | X0A | Sub clock (oscillation) input pin | 73 | 58 | 50 | P5 |
| | X1A | Sub clock (oscillation) I/O pin | 74 | 59 | 51 | P6 |
| | CROUT_0 | Built-in High-speed CR-oscillation clock output port | 157 | 127 | 103 | D13 |
| | CROUT_1 | | 184 | 152 | 122 | E8 |
| Analog Power | AVCC | A/D converter and D/A converter analog power-supply pin | 110 | 90 | 74 | M13 |
| | AVRL | A/D converter analog reference voltage input pin | 112 | 92 | 76 | L13 |
| | AVRH | A/D converter analog reference voltage input pin | 113 | 93 | 77 | L12 |
| VBAT Power | VBAT | VBAT power supply pin Backup power supply (battery etc.) and system power supply | 75 | 60 | 52 | P8 |
| Analog GND | AVSS | A/D converter and D/A converter GND pin | 111 | 91 | 75 | M12 |
| C pin | C | Power supply stabilization capacity pin | 62 | 52 | 44 | P2 |

Note:

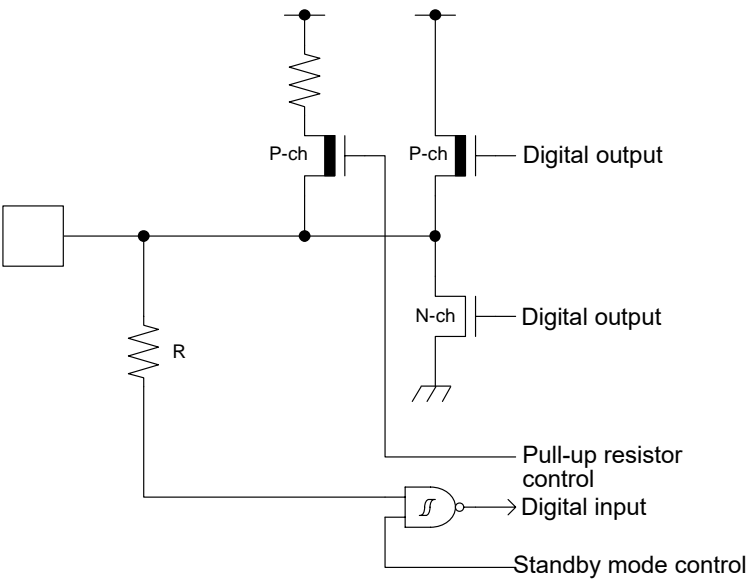
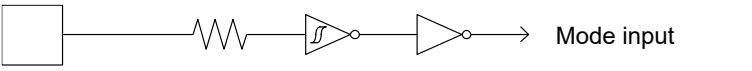
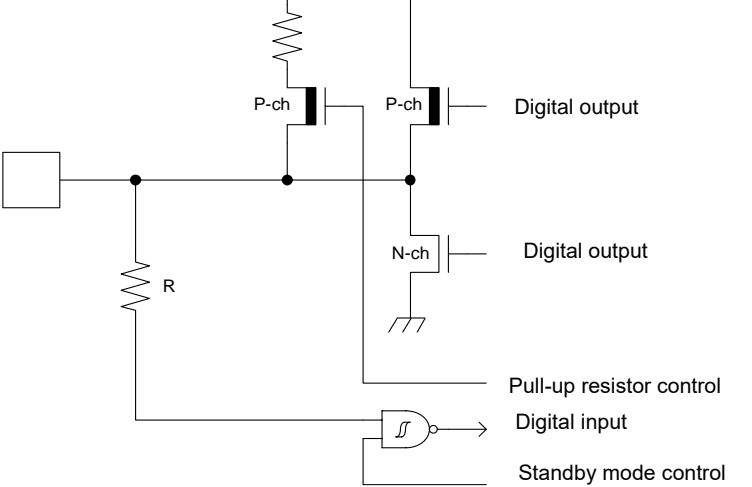
- While this device contains a Test Access Port (TAP) based on the IEEE 1149.1-2001 JTAG standard, it is not fully compliant to all requirements of that standard. This device may contain a 32-bit device ID that is the same as the 32-bit device ID in other devices with different functionality. The TAP pins may also be configurable for purposes other than access to the TAP controller.

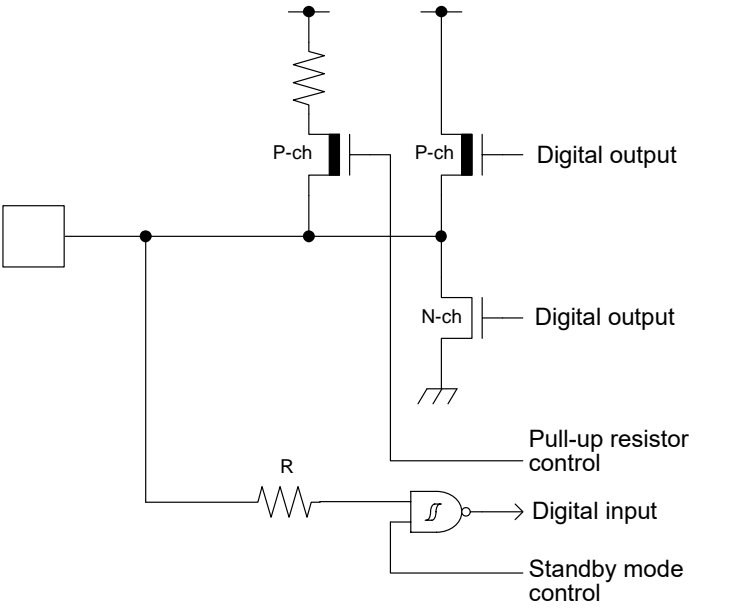
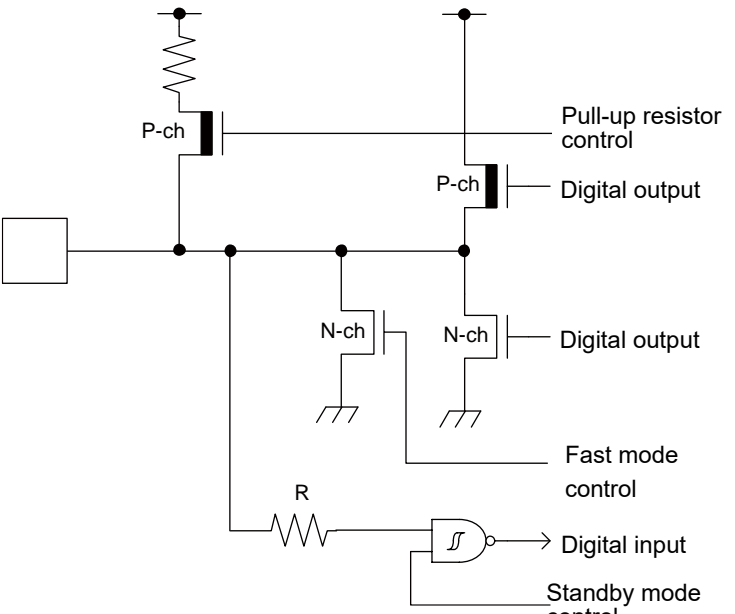
5. I/O Circuit Type

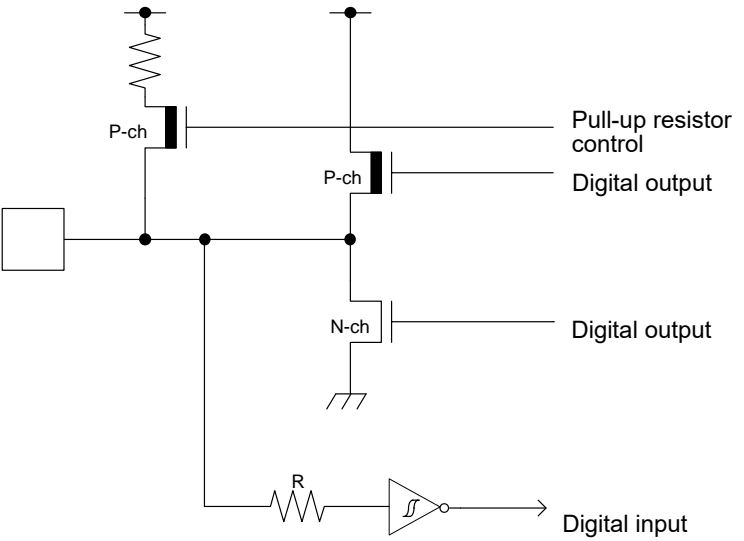
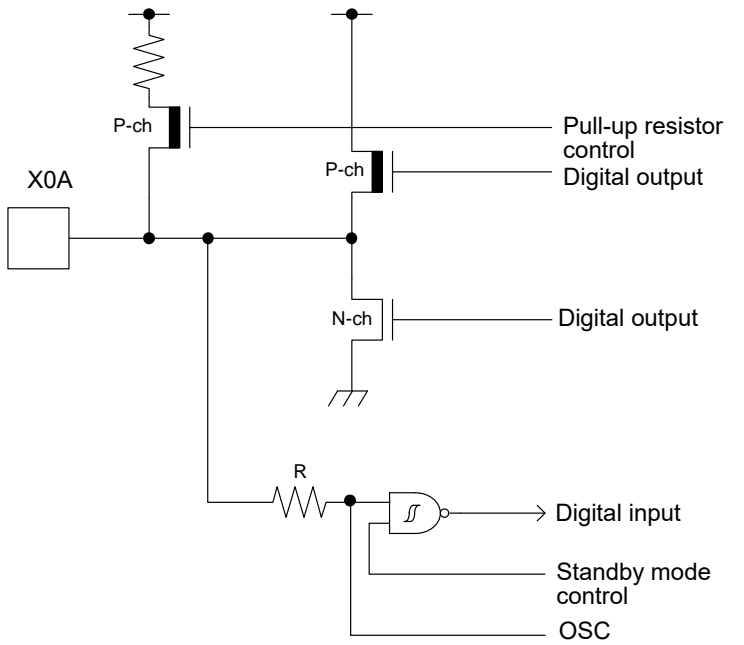
| Type | Circuit | Remarks |
|------|---|---|
| A |  | <p>It is possible to select the main oscillation/GPIO function.</p> <p>When the main oscillation is selected:</p> <ul style="list-style-type: none"> • Oscillation feedback resistor: approximately 1 MΩ • Standby mode control <p>When the GPIO is selected:</p> <ul style="list-style-type: none"> • CMOS level output. • CMOS level hysteresis input • Pull-up resistor control • Standby mode control • Pull-up resistor: approximately 50 kΩ • $I_{OH} = -4 \text{ mA}$, $I_{OL} = 4 \text{ mA}$ |
| B |  | <ul style="list-style-type: none"> • CMOS level hysteresis input • Pull-up resistor: approximately 50 kΩ |

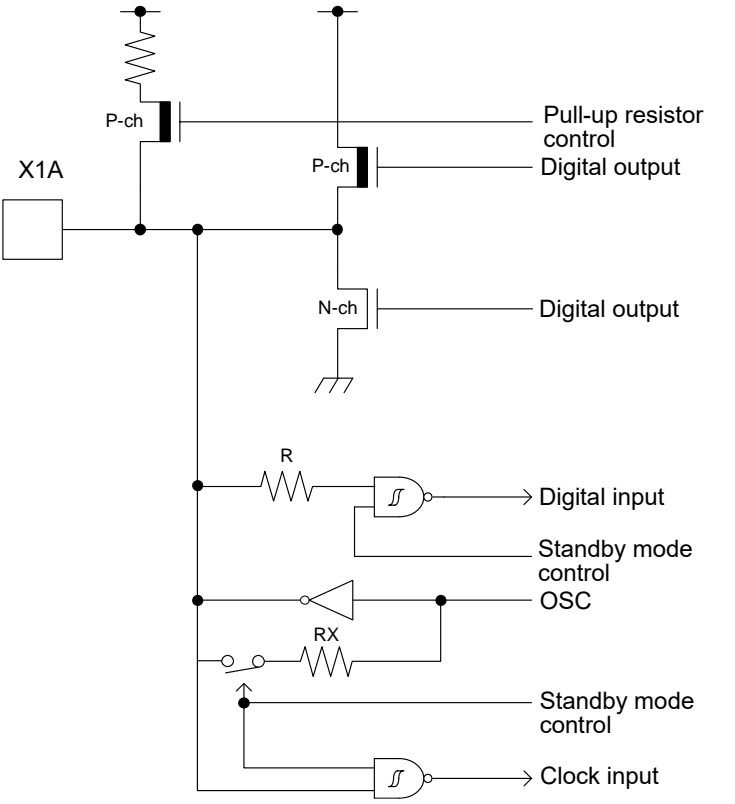
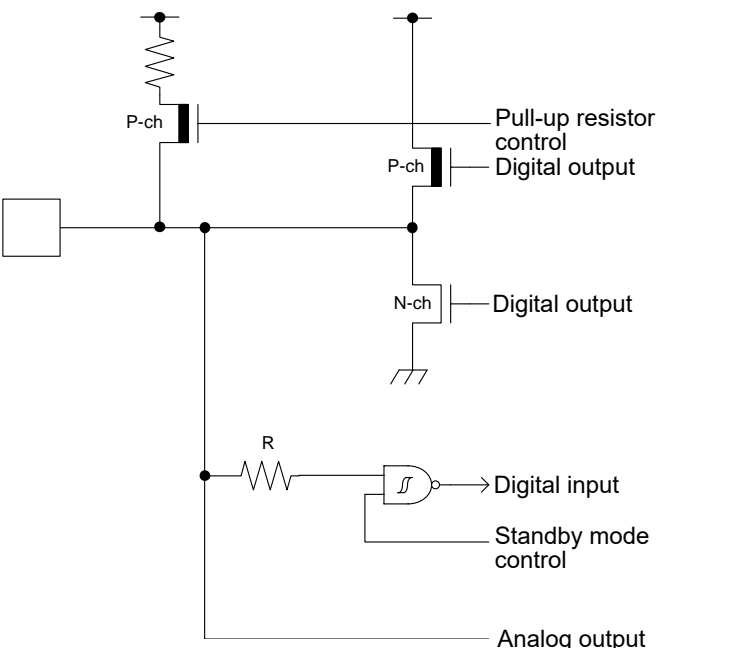
| Type | Circuit | Remarks |
|------|---|--|
| C |  | <ul style="list-style-type: none"> • Open drain output • CMOS level hysteresis input |
| E |  | <ul style="list-style-type: none"> • CMOS level output • CMOS level hysteresis input • Pull-up resistor control • Standby mode control • Pull-up resistor: approximately 50 kΩ • $I_{OH} = -4$ mA, $I_{OL} = 4$ mA • When this pin is used as an I²C pin, the digital output P-ch transistor is always off. |
| F |  | <ul style="list-style-type: none"> • CMOS level output • CMOS level hysteresis input • Input control • Analog input • Pull-up resistor control • Standby mode control • Pull-up resistor: approximately 50 kΩ • $I_{OH} = -4$ mA, $I_{OL} = 4$ mA • When this pin is used as an I²C pin, the digital output P-ch transistor is always off. |

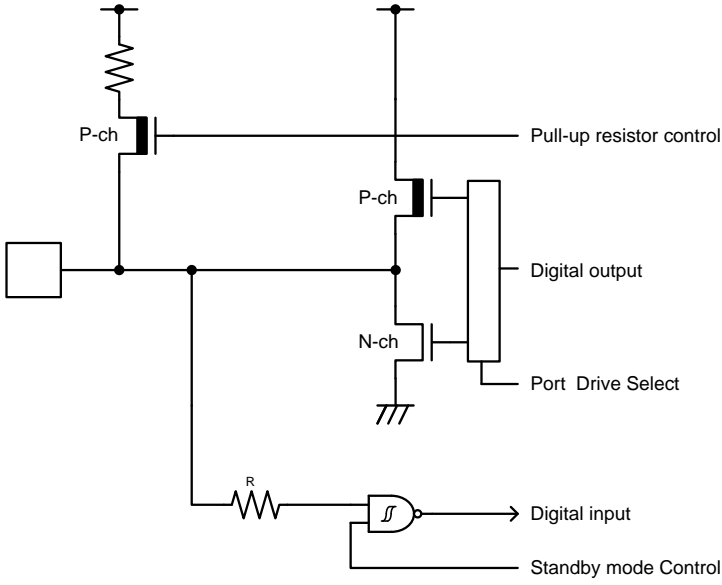
| Type | Circuit | Remarks |
|------|--|---|
| G | <p>The diagram shows a pull-up resistor R connected to a node. This node is connected to the gates of two transistors: a P-channel MOSFET (P-ch) and an N-channel MOSFET (N-ch). The P-ch transistor's source is connected to the node, and its drain is connected to a digital output. The N-ch transistor's source is connected to ground, and its drain is also connected to the node. A digital input signal is connected to the gates of both transistors. A standby mode control signal is connected to the gates of both transistors through an inverter. Labels include: Digital output (top), Digital output (bottom), Pull-up resistor control, Digital input, and Standby mode control.</p> | <ul style="list-style-type: none"> • CMOS level output • CMOS level hysteresis input • Pull-up resistor control • Standby mode control • Pull-up resistor: approximately 50 kΩ • $I_{OH} = -12 \text{ mA}$, $I_{OL} = 12 \text{ mA}$ • When this pin is used as an I²C pin, the digital output P-ch transistor is always off. |
| H | <p>The diagram shows a complex logic circuit with multiple multiplexers and logic gates. On the left, there are two multiplexers labeled UDP/Pxx and UDM/Pxx. The circuit includes several inverters, AND gates, OR gates, and NAND gates. Labels on the right side include: GPIO Digital output, GPIO Digital input/output direction, GPIO Digital input, GPIO Digital input circuit control, UDP output, USB Full-speed/Low-speed control, UDP input, Differential input, USB/GPIO select, UDM input, UDM output, USB Digital input/output direction, GPIO Digital output, GPIO Digital input/output direction, GPIO Digital input, and GPIO Digital input circuit control.</p> | <p>It is possible to select either USB I/O or GPIO function.</p> <p>When the USB I/O is selected:</p> <ul style="list-style-type: none"> • Full-speed, low-speed control <p>When the GPIO is selected:</p> <ul style="list-style-type: none"> • CMOS level output • CMOS level hysteresis input • Standby mode control • $I_{OH} = -20.5 \text{ mA}$, $I_{OL} = 18.5 \text{ mA}$ |

| Type | Circuit | Remarks |
|------|---|---|
| I |  | <ul style="list-style-type: none"> • CMOS level output • CMOS level hysteresis input • 5V tolerant • Pull-up resistor control • Standby mode control • Pull-up resistor: approximately 50 kΩ • $I_{OH} = -4 \text{ mA}$, $I_{OL} = 4 \text{ mA}$ • Available to control of PZR registers (pseudo-open drain control) • For PZR registers, refer to GPIO in the “FM4 Family Peripheral Manual Main Part (002-04856)”. |
| J |  | <p>CMOS level hysteresis input</p> |
| K |  | <ul style="list-style-type: none"> • CMOS level output • TTL level hysteresis input • Pull-up resistor control • Standby mode control • Pull-up resistor: approximately 50 kΩ • $I_{OH} = -4 \text{ mA}$, $I_{OL} = 4 \text{ mA}$ |

| Type | Circuit | Remarks |
|------|--|--|
| L |  | <ul style="list-style-type: none"> • CMOS level output • CMOS level hysteresis input • Pull-up resistor control • Standby mode control • Pull-up resistor: approximately 50 kΩ • $I_{OH} = -8 \text{ mA}$, $I_{OL} = 8 \text{ mA}$ • When this pin is used as an I²C pin, the digital output P-ch transistor is always off. |
| N |  | <ul style="list-style-type: none"> • CMOS level output • CMOS level hysteresis input • 5V tolerant • Pull-up resistor control • Standby mode control • Pull-up resistor: approximately 50 kΩ • $I_{OH} = -4 \text{ mA}$, $I_{OL} = 4 \text{ mA}$ (GPIO) • $I_{OL} = 20 \text{ mA}$ (Fast mode Plus) • Available to control of PZR register (pseudo-open drain control) • For PZR registers, refer to GPIO in the "FM4 Family Peripheral Manual Main Part (002-04856)". • When this pin is used as an I²C pin, the digital output P-ch transistor is always off. |

| Type | Circuit | Remarks |
|------|--|--|
| O |  | <ul style="list-style-type: none"> • CMOS level output • CMOS level hysteresis input • 5V tolerant • Pull-up resistor control • Pull-up resistor: approximately 50 kΩ • $I_{OH} = -4 \text{ mA}$, $I_{OL} = 4 \text{ mA}$ • Available to control of PZR register (pseudo-open drain control) • For PZR registers, refer to GPIO in the "FM4 Family Peripheral Manual Main Part (002-04856)". • For I/O setting, refer to VBAT Domain in the "FM4 Family Peripheral Manual Main Part (002-04856)." |
| P |  | <ul style="list-style-type: none"> • CMOS level output • CMOS level hysteresis input • Pull-up resistor control • Pull-up resistor: approximately 50 kΩ • $I_{OH} = -4 \text{ mA}$, $I_{OL} = 4 \text{ mA}$ • For I/O setting, refer to VBAT Domain in the "FM4 Family Peripheral Manual Main Part (002-04856)." |

| Type | Circuit | Remarks |
|------|---|--|
| Q |  | <p>It is possible to select the sub oscillation/GPIO function.</p> <p>When the sub oscillation is selected:</p> <ul style="list-style-type: none"> Oscillation feedback resistor: approximately 10 MΩ <p>When the GPIO is selected:</p> <ul style="list-style-type: none"> CMOS level output. CMOS level hysteresis input Pull-up resistor control Pull-up resistor: approximately 50 kΩ $I_{OH} = -4 \text{ mA}$, $I_{OL} = 4 \text{ mA}$ For I/O setting, refer to VBAT Domain in the "FM4 Family Peripheral Manual Main Part (002-04856)." |
| R |  | <ul style="list-style-type: none"> CMOS level output CMOS level hysteresis input Analog output Pull-up resistor control Standby mode control Pull-up resistor: approximately 50 kΩ $I_{OH} = -4 \text{ mA}$, $I_{OL} = 4 \text{ mA}$ (4.5 V to 5.5 V) $I_{OH} = -2 \text{ mA}$, $I_{OL} = 2 \text{ mA}$ (2.7 V to 4.5 V) |

| Type | Circuit | Remarks |
|------|--|---|
| S |  <p>The diagram shows a circuit for a digital pin. A pull-up resistor is connected to the supply rail and the P-ch transistor. The P-ch transistor's gate is controlled by a 'Pull-up resistor control' signal. The P-ch transistor's source is connected to the supply rail, and its drain is connected to the 'Digital output' node. The N-ch transistor's gate is controlled by a 'Port Drive Select' signal, and its source is connected to ground. The 'Digital output' node is also connected to the N-ch transistor's drain. A 'Digital input' is connected to the 'Digital output' node through a resistor 'R'. The 'Digital input' is also connected to a 'Standby mode Control' signal through an AND gate.</p> | <ul style="list-style-type: none"> • CMOS level output • (It is possible to select by port drive capability. Select register [PDSR]) • CMOS level hysteresis input • Pull-up resistor control • Standby mode control • Pull-up resistor: approximately 50 kΩ • $I_{OH} = -10 \text{ mA}$, $I_{OL} = 10 \text{ mA}$ (PDSR = 1) • $I_{OH} = -4 \text{ mA}$, $I_{OL} = 4 \text{ mA}$ (PDSR = 0) • When this pin is used as an I²C pin, the digital output P-ch transistor is always off. |

6. Handling Precautions

Every semiconductor device has a characteristic, inherent rate of failure. The possibility of failure is greatly affected by the conditions in which they are used (circuit conditions, environmental conditions, etc.). This page describes precautions that must be observed to minimize the chance of failure and to obtain higher reliability from your Cypress semiconductor devices.

6.1 Precautions for Product Design

This section describes precautions when designing electronic equipment using semiconductor devices.

Absolute Maximum Ratings

Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of certain established limits, called absolute maximum ratings. Do not exceed these ratings.

Recommended Operating Conditions

Recommended operating conditions are normal operating ranges for the semiconductor device. All the device's electrical characteristics are warranted when operated within these ranges.

Always use semiconductor devices within the recommended operating conditions. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their sales representative beforehand.

Processing and Protection of Pins

These precautions must be followed when handling the pins that connect semiconductor devices to power supply and I/O functions.

1. Preventing Over-Voltage and Over-Current Conditions

Exposure to voltage or current levels in excess of maximum ratings at any pin is likely to cause deterioration within the device, and in extreme cases leads to permanent damage of the device. Try to prevent such overvoltage or over-current conditions at the design stage.

2. Protection of Output Pins

Shorting of output pins to supply pins or other output pins, or connection to large capacitance can cause large current flows. Such conditions, if present for extended periods of time, can damage the device; therefore, avoid this type of connection.

3. Handling of Unused Input Pins

Unconnected input pins with very high impedance levels can adversely affect stability of operation. Such pins should be connected through an appropriate resistance to a power-supply pin or ground pin.

Latch-Up

Semiconductor devices are constructed by the formation of p-type and n-type areas on a substrate. When subjected to abnormally high voltages, internal parasitic pnpn junctions (called thyristor structures) may be formed, causing large current levels in excess of several hundred milliamps to flow continuously at the power supply pin. This condition is called latch-up.

CAUTION: The occurrence of latch-up not only causes loss of reliability in the semiconductor device, but can cause injury or damage from high heat, smoke or flame. To prevent this from happening, do the following:

1. Be sure that voltages applied to pins do not exceed the absolute maximum ratings. This should include attention to abnormal noise, surge levels, etc.
2. Be sure that abnormal current flows do not occur during the power-on sequence.

Observance of Safety Regulations and Standards

Most countries in the world have established standards and regulations regarding safety, protection from electromagnetic interference, etc. Customers are requested to observe applicable regulations and standards in the design of products.

Fail-Safe Design

As previously mentioned, all semiconductor devices have inherent rates of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.

Precautions Related to Usage of Devices

Cypress semiconductor devices are intended for use in standard applications (computers, office automation and other office equipment, industrial, communications, and measurement equipment, personal or household devices, etc.).

CAUTION: Customers considering the use of our products in special applications where failure or abnormal operation may directly affect human lives or cause physical injury or property damage, or where extremely high levels of reliability are demanded (such as aerospace systems, atomic energy controls, sea floor repeaters, vehicle operating controls, medical devices for life support, etc.) are requested to consult with sales representatives before such use. The company will not be responsible for damages arising from such use without prior approval.

6.2 Precautions for Package Mounting

Package mounting may be either lead insertion type or surface mount type. In either case, for heat resistance during soldering, you should only mount under Cypress's recommended conditions. For detailed information about mount conditions, contact your sales representative.

Lead Insertion Type

Mounting of lead insertion type packages onto printed circuit boards may be done by two methods: direct soldering on the board, or mounting by using a socket.

Direct mounting onto boards normally involves processes for inserting leads into through-holes on the board and using the flow soldering (wave soldering) method of applying liquid solder. In this case, the soldering process usually causes leads to be subjected to thermal stress in excess of the absolute ratings for storage temperature. Mounting processes should conform to Cypress recommended mounting conditions.

If socket mounting is used, differences in surface treatment of the socket contacts and IC lead surfaces can lead to contact deterioration after long periods. For this reason it is recommended that the surface treatment of socket contacts and IC leads be verified before mounting.

Surface Mount Type

Surface mount packaging has longer and thinner leads than lead-insertion packaging, and therefore leads are more easily deformed or bent. The use of packages with higher pin counts and narrower pin pitch results in increased susceptibility to open connections caused by deformed pins, or shorting due to solder bridges.

You must use appropriate mounting techniques. Cypress recommends the solder reflow method, and has established a ranking of mounting conditions for each product. Users are advised to mount packages in accordance with Cypress ranking of recommended conditions.

Lead-Free Packaging

CAUTION: When ball grid array (BGA) packages with Sn-Ag-Cu balls are mounted using Sn-Pb eutectic soldering, junction strength may be reduced under some conditions of use.

Storage of Semiconductor Devices

Because plastic chip packages are formed from plastic resins, exposure to natural environmental conditions will cause absorption of moisture. During mounting, the application of heat to a package that has absorbed moisture can cause surfaces to peel, reducing moisture resistance and causing packages to crack. To prevent this, do the following:

1. Avoid exposure to rapid temperature changes, which can cause moisture to condense inside the product. Store products in locations where temperature changes are slight.
2. Use dry boxes for product storage. Products should be stored below 70% relative humidity, and at temperatures between 5°C and 30°C.
3. When Dry Packages are opened, it is recommended to have humidity between 40% and 70%.
4. When necessary, Cypress packages semiconductor devices in highly moisture-resistant aluminum laminate bags, with a silica gel desiccant. Devices should be sealed in these aluminum laminate bags for storage.
5. Avoid storing packages where they are exposed to corrosive gases or high levels of dust.

Baking

Packages that have absorbed moisture may be de-moisturized by baking (heat drying). Follow the Cypress recommended conditions for baking.

Condition: 125 °C/24 h

Static Electricity

Because semiconductor devices are particularly susceptible to damage by static electricity, you must take the following precautions:

1. Maintain relative humidity in the working environment between 40% and 70%. Use of an apparatus for ion generation may be needed to remove electricity.
2. Electrically ground all conveyors, solder vessels, soldering irons, and peripheral equipment.
3. Eliminate static body electricity by the use of rings or bracelets connected to ground through high resistance (on the level of 1 MΩ). Wearing of conductive clothing and shoes, and the use of conductive floor mats and other measures to minimize shock loads is recommended.
4. Ground all fixtures and instruments, or protect with anti-static measures.
5. Avoid the use of Styrofoam or other highly static-prone materials for storage of completed board assemblies.

6.3 Precautions for Use Environment

Reliability of semiconductor devices depends on ambient temperature and other conditions as described above.

For reliable performance, do the following:

1. Humidity

Prolonged use in high humidity can lead to leakage in devices as well as printed circuit boards. If high humidity levels are anticipated, consider anti-humidity processing.

2. Discharge of static electricity

When high-voltage charges exist close to semiconductor devices, discharges can cause abnormal operation. In such cases, use anti-static measures or processing to prevent discharges.

3. Corrosive gases, dust, or oil

Exposure to corrosive gases or contact with dust or oil may lead to chemical reactions that will adversely affect the device. If you use devices in such conditions, consider ways to prevent such exposure or to protect the devices.

4. Radiation, including cosmic radiation

Most devices are not designed for environments involving exposure to radiation or cosmic radiation. Users should provide shielding as appropriate.

5. Smoke, flame

CAUTION: Plastic molded devices are flammable and therefore should not be used near combustible substances. If devices begin to smoke or burn, there is danger of the release of toxic gases.

Customers considering the use of Cypress products in other special environmental conditions should consult with sales representatives.

7. Handling Devices

Power-Supply Pins

In products with multiple VCC and VSS pins, respective pins at the same potential are interconnected within the device in order to prevent malfunctions such as latch-up. All of these pins should be connected externally to the power supply or ground lines, however, in order to reduce electromagnetic emission levels, to prevent abnormal operation of strobe signals caused by the rise in the ground level, and to conform to the total output current rating.

Be sure to connect the current-supply source with the power pins and GND pins of this device at low impedance. It is also advisable that a ceramic capacitor of approximately 0.1 μF be connected as a bypass capacitor between VCC and VSS near this device.

A malfunction may occur when the power-supply voltage fluctuates rapidly even though the fluctuation is within the guaranteed operating range of the VCC power supply voltage. As a rule of voltage stabilization, suppress voltage fluctuation so that the fluctuation in VCC ripple (peak-to-peak value) at the commercial frequency (50 Hz/60 Hz) does not exceed 10% of the standard VCC value, and the transient fluctuation rate does not exceed 0.1 V/ μs at a momentary fluctuation such as switching the power supply.

Crystal Oscillator Circuit

Noise near the X0/X1 and X0A/X1A pins may cause the device to malfunction. Design the printed circuit board so that X0/X1, X0A/X1A pins, the crystal oscillator (or ceramic oscillator), and the bypass capacitor to ground are located as close to the device as possible.

It is strongly recommended that the PC board artwork be designed such that the X0/X1 and X0A/X1A pins are surrounded by ground plane, as this is expected to produce stable operation.

Evaluate the oscillation introduced by the use of the crystal oscillator by your mount board.

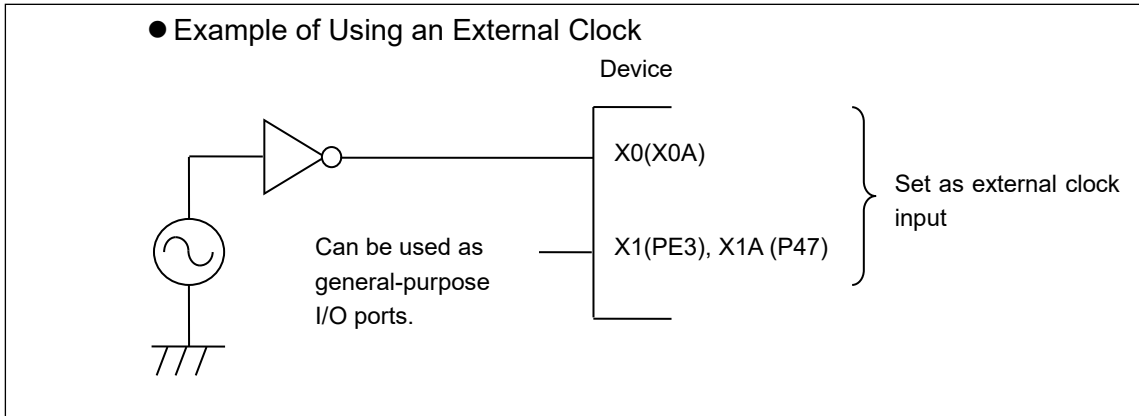
Sub Crystal Oscillator

The sub-oscillator circuit for devices in this family is low gain to keep current consumption low. To stabilize the oscillation, Cypress recommends a crystal oscillator that meets the following conditions:

- Surface mount type
 - Size: More than 3.2 mm \times 1.5 mm
 - Load capacitance: approximately 6 pF to 7 pF
- Lead type
 - Load capacitance: approximately 6 pF to 7 pF

Using an External Clock

When using an external clock as an input of the main clock, set X0/X1 to the external clock input, and input the clock to X0. X1(PE3) can be used as a general-purpose I/O port. Similarly, when using an external clock as an input of the sub clock, set X0A/X1A to the external clock input and input the clock to X0A. X1A (P47) can be used as a general-purpose I/O port.

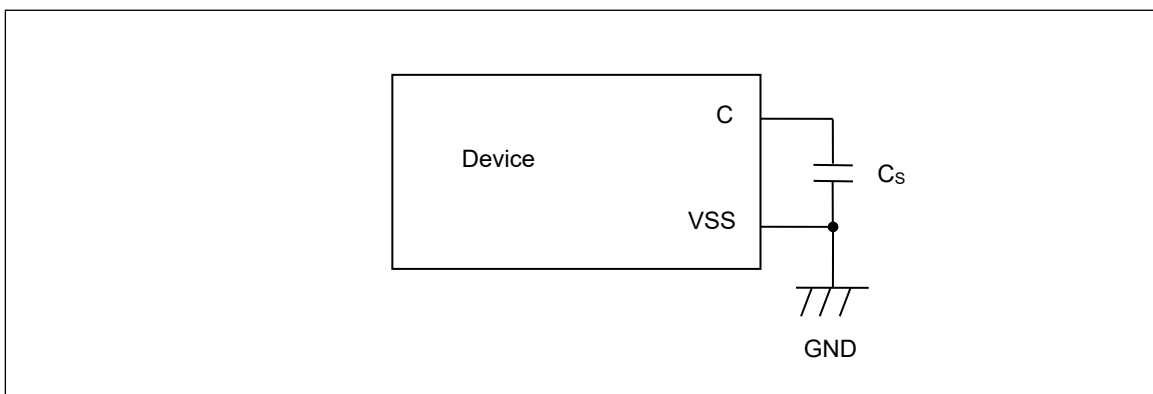


Handling When Using Multi-Function Serial Pin as I²C Pin

If the application uses the multi-function serial pin as an I²C pin, the P-channel transistor of the digital output must be disabled. I²C pins need to conform to electrical limitations like other pins, however, and avoid connecting to live external systems with the MCU power off.

C Pin

Devices in this series contain a regulator. Be sure to connect a smoothing capacitor (C_s) for the regulator between the C pin and the GND pin. Please use a ceramic capacitor or a capacitor of equivalent frequency characteristics as a smoothing capacitor. Some laminated ceramic capacitors have a large capacitance variation due to thermal fluctuation. Please select a capacitor that meets the specifications in the operating conditions to use by evaluating the temperature characteristics of the device. A smoothing capacitor of about 4.7 μF would be recommended for this series.



Mode Pins (MD0)

Connect the MD pin (MD0) directly to VCC or VSS pins. Design the printed circuit board such that the pull-up/down resistance stays low, the distance between the mode pins and VCC pins or VSS pins is as short as possible, and the connection impedance is low when the pins are pulled up/down such as for switching the pin level and rewriting the flash memory data. This is important to prevent the device from erroneously switching to test mode as a result of noise.

Notes on Power-on

Turn power on/off in the following order or at the same time. The device operates normally after all power on.

VBAT only Power-on is possible when VBAT and VCC turns Power-on and Hibernation control is setting and then VCC turns Power-off. About Hibernation control, see Chapter 7-2: VBAT Domain(B) in FM4 Family Peripheral Manual Main Part(002-04856).

Turning on: VBAT → VCC → USBVCC0
VBAT → VCC → USBVCC1
VCC → AVCC → AVRH
Turning off: AVRH → AVCC → VCC
USBVCC1 → VCC → VBAT
USBVCC0 → VCC → VBAT

Serial Communication

There is a possibility of receiving incorrect data as a result of noise or other issues introduced by the serial communication. Take care to design the printed circuit board to minimize noise.

Consider the case of introducing error as a result of noise, perform error detection such as by applying a checksum of data at the end. If an error is detected, retransmit the data.

Differences in Characteristics within the Product Line

The electric characteristics including power consumption, ESD, latch-up, noise, and oscillation differ among members of the product line because chip layout and memory structures are not the same; for example, different sizes, flash versus ROM, etc. If you are switching to a different product of the same series, please make sure to evaluate the electric characteristics.

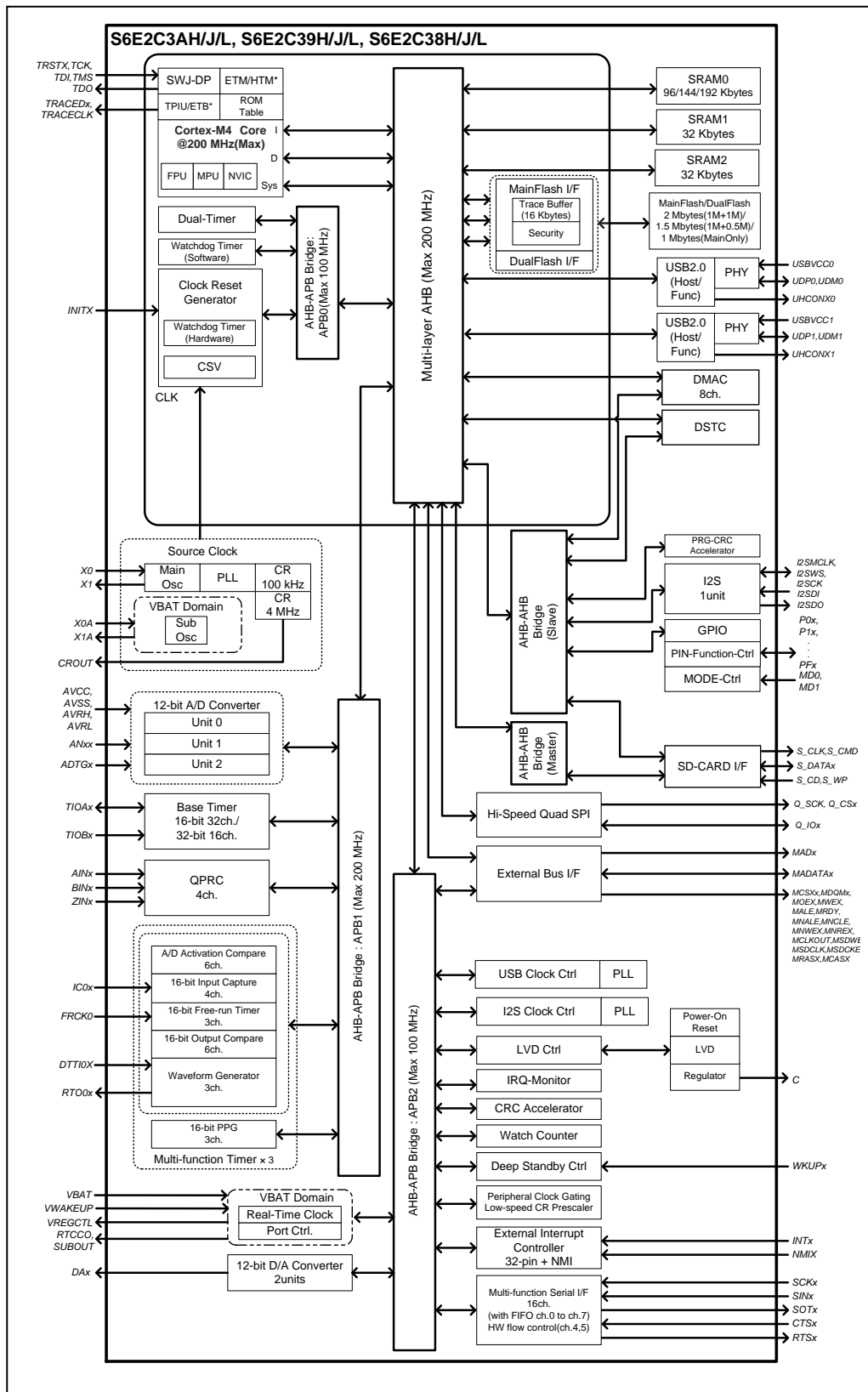
Pull-Up Function of 5 V Tolerant I/O

Please do not input the signal more than VCC voltage at the time of Pull-Up function use of 5 V tolerant I/O.

Pin Doubled as Debug Function

The pin doubled as TDO/TMS/TDI/TCK/TRSTX, SWO/SWDIO/SWCLK should be used as output only. Do not use as input.

8. Block Diagram

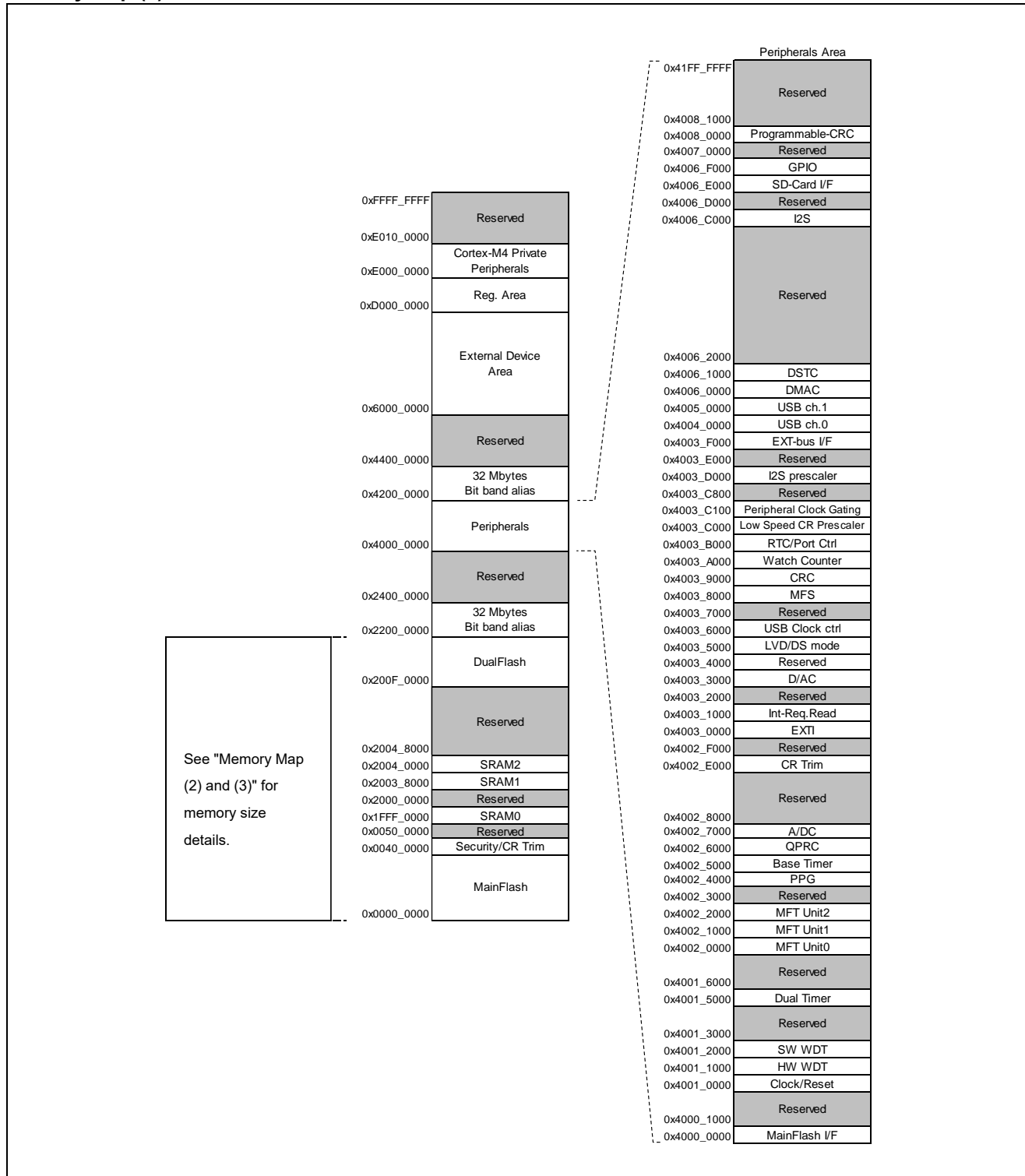


9. Memory Size

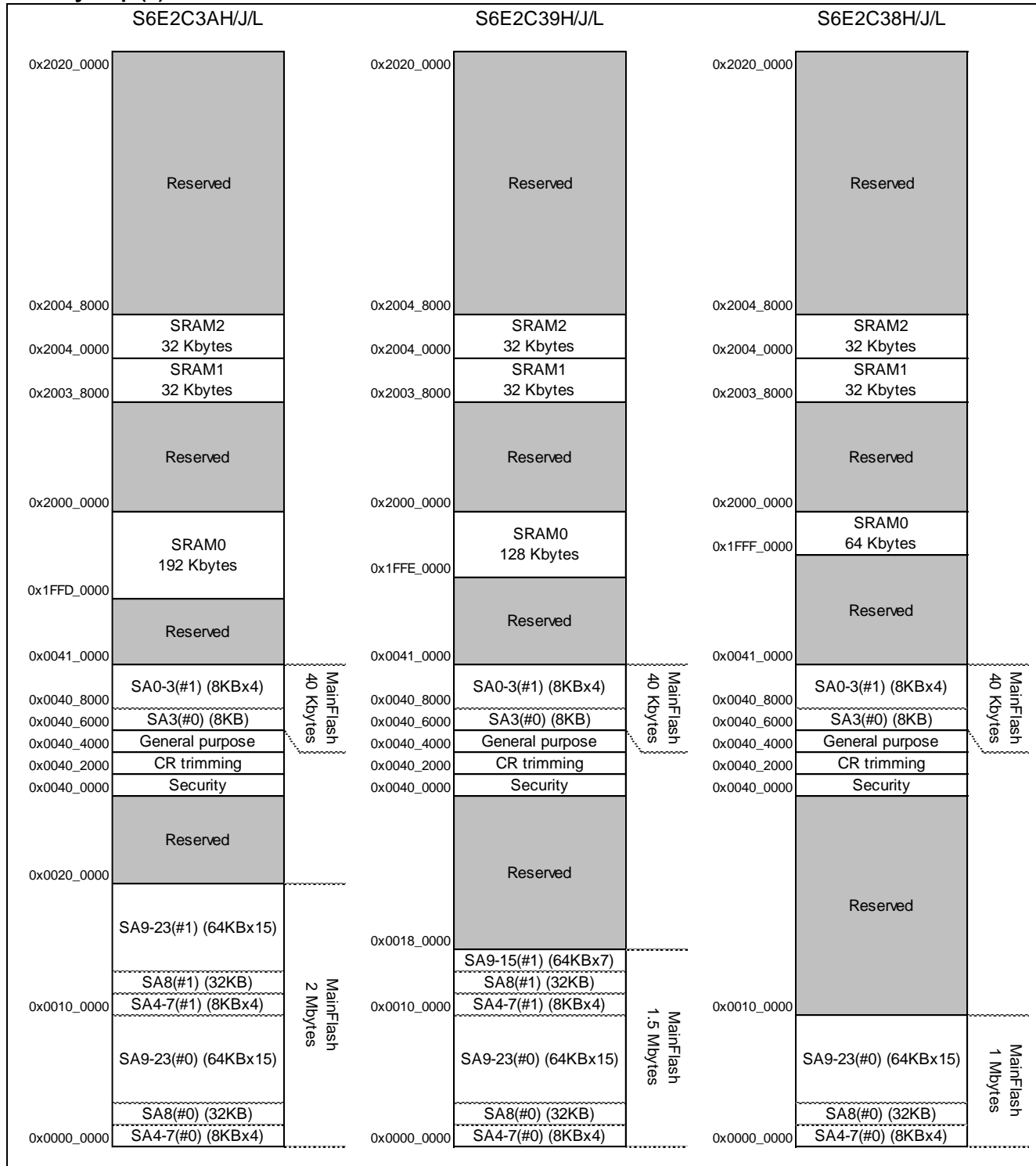
See Memory size in 1. Product Lineup to confirm the memory size.

10. Memory Map

Memory Map (1)

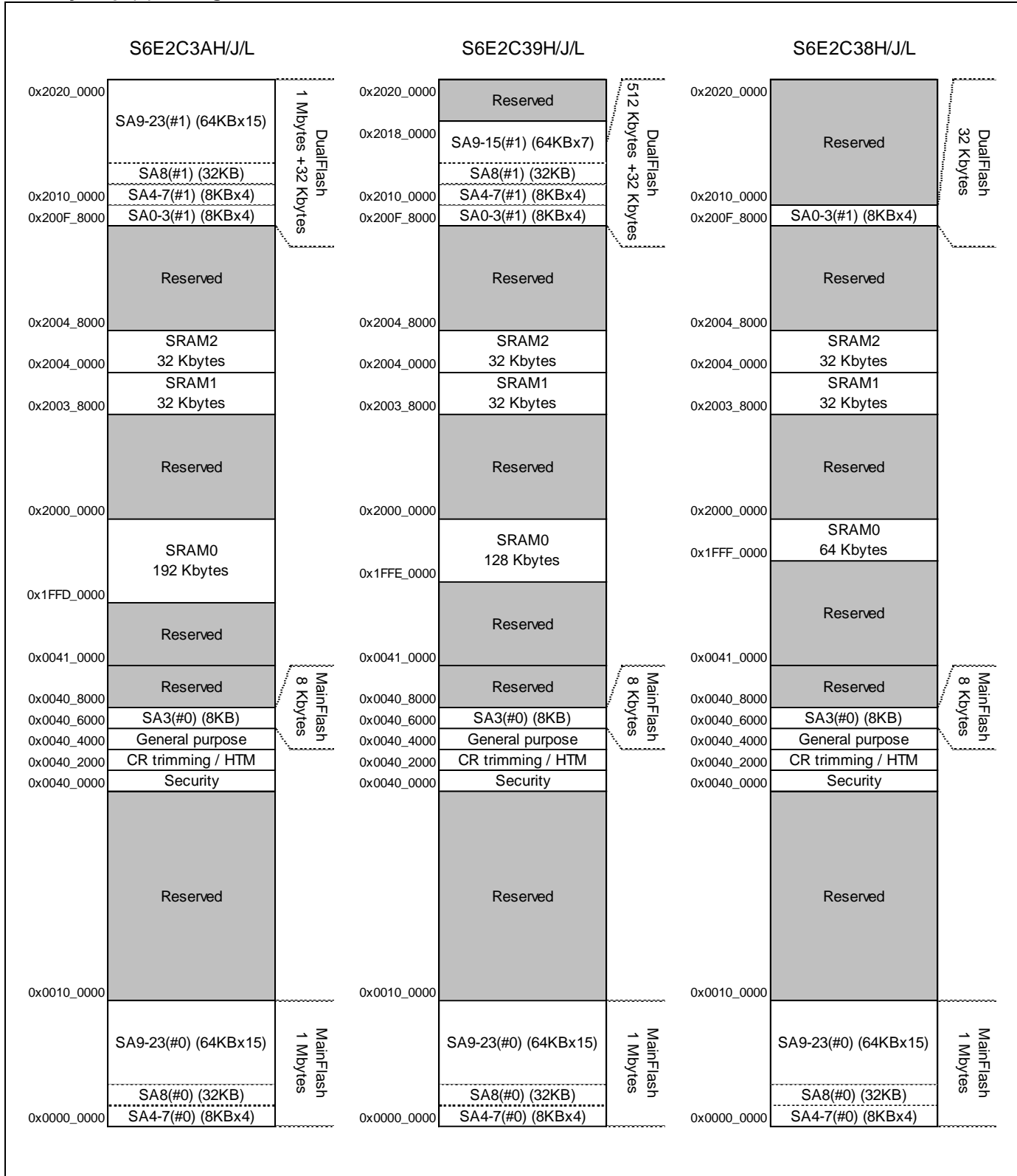


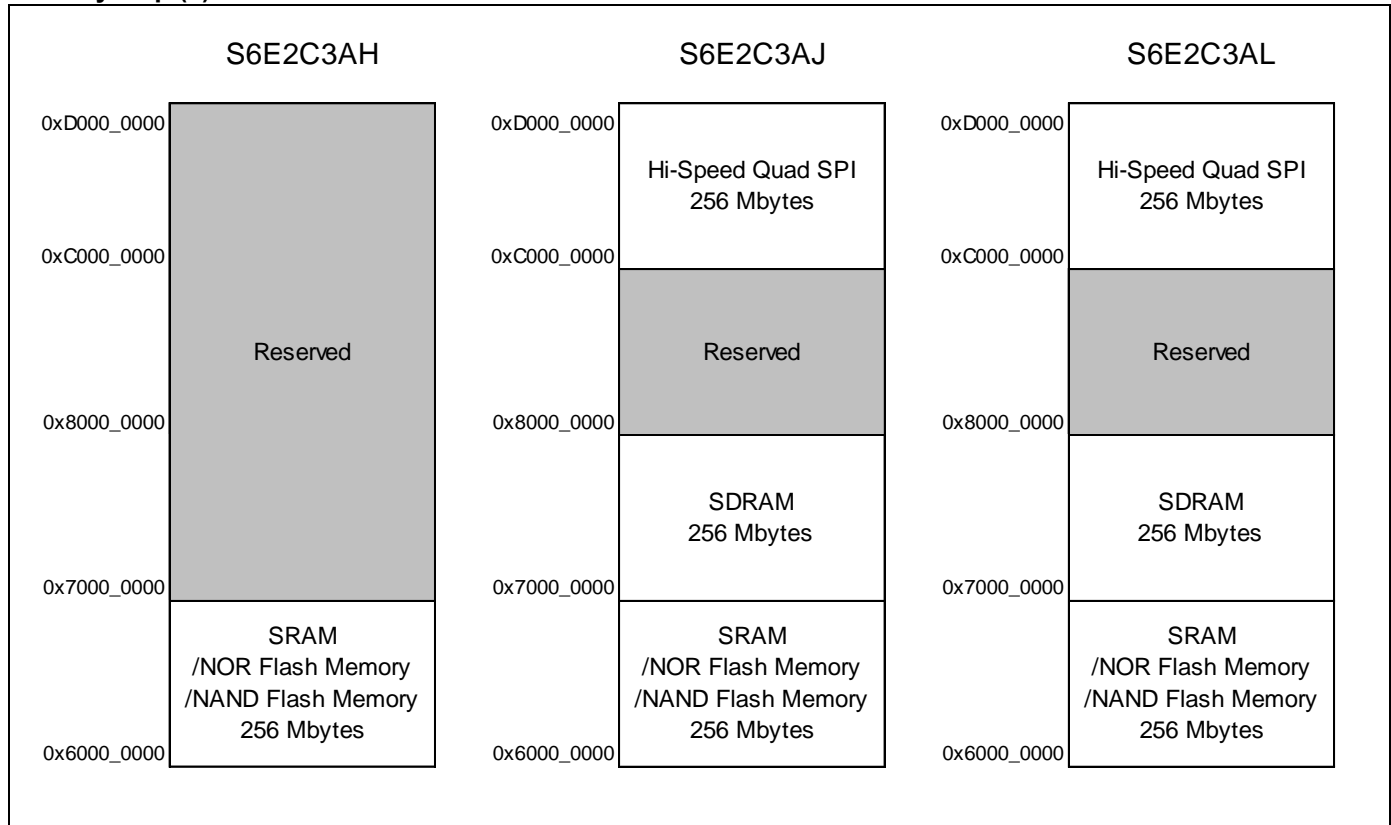
Memory Map (2)



*: See S6E2CC/S6E2C5/S6E2C4/S6E2C3/S6E2C2/S6E2C1 Series Flash Programming Manual to confirm the detail of flash Memory.

Memory Map (2) During Dual Flash Mode



Memory Map (3)


Peripheral Address Map

| Start Address | End Address | Bus | Peripherals | |
|---------------|-------------|--|---------------------------------|---------------------------------------|
| 0x4000_0000 | 0x4000_0FFF | AHB | MainFlash I/F register | |
| 0x4000_1000 | 0x4000_FFFF | | Reserved | |
| 0x4001_0000 | 0x4001_0FFF | APB0 | Clock/reset control | |
| 0x4001_1000 | 0x4001_1FFF | | Hardware watchdog timer | |
| 0x4001_2000 | 0x4001_2FFF | | Software watchdog timer | |
| 0x4001_3000 | 0x4001_4FFF | | Reserved | |
| 0x4001_5000 | 0x4001_5FFF | | Dual-timer | |
| 0x4001_6000 | 0x4001_FFFF | | Reserved | |
| 0x4002_0000 | 0x4002_0FFF | | APB1 | Multi-Function Timer unit 0 |
| 0x4002_1000 | 0x4002_1FFF | Multi-Function Timer unit 1 | | |
| 0x4002_2000 | 0x4002_2FFF | Multi-Function Timer unit 2 | | |
| 0x4002_3000 | 0x4002_3FFF | Reserved | | |
| 0x4002_4000 | 0x4002_4FFF | PPG | | |
| 0x4002_5000 | 0x4002_5FFF | Base timer | | |
| 0x4002_6000 | 0x4002_6FFF | Quadrature position/revolution counter | | |
| 0x4002_7000 | 0x4002_7FFF | A/D converter | | |
| 0x4002_8000 | 0x4002_DFFF | Reserved | | |
| 0x4002_E000 | 0x4002_EFFF | Internal CR trimming | | |
| 0x4002_F000 | 0x4002_FFFF | Reserved | | |
| 0x4003_0000 | 0x4003_0FFF | APB2 | | External interrupt controller |
| 0x4003_1000 | 0x4003_1FFF | | | Interrupt request batch-read function |
| 0x4003_2000 | 0x4003_2FFF | | | Reserved |
| 0x4003_3000 | 0x4003_3FFF | | | D/A converter |
| 0x4003_4000 | 0x4003_4FFF | | Reserved | |
| 0x4003_5000 | 0x4003_57FF | | Low voltage detector | |
| 0x4003_5800 | 0x4003_5FFF | | Deep standby mode Controller | |
| 0x4003_6000 | 0x4003_6FFF | | USB clock generator | |
| 0x4003_7000 | 0x4003_7FFF | | Reserved | |
| 0x4003_8000 | 0x4003_8FFF | | Multi-function serial interface | |
| 0x4003_9000 | 0x4003_9FFF | | CRC | |
| 0x4003_A000 | 0x4003_AFFF | | Watch counter | |
| 0x4003_B000 | 0x4003_BFFF | | RTC/port control | |
| 0x4003_C000 | 0x4003_C0FF | | Low-speed CR prescaler | |
| 0x4003_C100 | 0x4003_C7FF | | Peripheral clock gating | |
| 0x4003_C800 | 0x4003_CFFF | | Reserved | |
| 0x4003_D000 | 0x4003_DFFF | | I ² S prescaler | |
| 0x4003_E000 | 0x4003_EFFF | | Reserved | |
| 0x4003_F000 | 0x4003_FFFF | | External memory interface | |
| 0x4004_0000 | 0x4004_FFFF | | AHB | USB ch 0 |
| 0x4005_0000 | 0x4005_FFFF | | | USB ch 1 |
| 0x4006_0000 | 0x4006_0FFF | | | DMAC register |
| 0x4006_1000 | 0x4006_1FFF | | | DSTC register |
| 0x4006_2000 | 0x4006_BFFF | Reserved | | |
| 0x4006_C000 | 0x4006_CFFF | I ² S | | |
| 0x4006_D000 | 0x4006_DFFF | Reserved | | |
| 0x4006_E000 | 0x4006_EFFF | SD card I/F | | |
| 0x4006_F000 | 0x4006_FFFF | GPIO | | |
| 0x4007_0000 | 0x4007_FFFF | Reserved | | |
| 0x4008_0000 | 0x4008_0FFF | Programmable-CRC | | |
| 0x4008_1000 | 0x41FF_FFFF | Reserved | | |
| 0x200E_0000 | 0x200E_FFFF | Workflash I/F register | | |
| 0xD000_0000 | 0xDFFF_FFFF | High-speed quad SPI control register | | |

11. Pin Status in Each CPU State

The terms used for pin status have the following meanings:

■ **INITX = 0**

This is the period when the INITX pin is at the L level.

■ **INITX = 1**

This is the period when the INITX pin is at the H level.

■ **SPL = 0**

This is the status that the standby pin level setting bit (SPL) in the standby mode control register (STB_CTL) is set to 0.

■ **SPL = 1**

This is the status that the standby pin level setting bit (SPL) in the standby mode control register (STB_CTL) is set to 1.

■ **Input enabled**

Indicates that the input function can be used.

■ **Internal input fixed at 0**

This is the status that the input function cannot be used. Internal input is fixed at L.

■ **Hi-Z**

Indicates that the pin drive transistor is disabled and the pin is put in the Hi-Z state.

■ **Setting disabled**

Indicates that the setting is disabled.

■ **Maintain previous state**

Maintains the state that was immediately prior to entering the current mode.
If a built-in peripheral function is operating, the output follows the peripheral function.
If the pin is being used as a port, that output is maintained.

■ **Analog input is enabled**

Indicates that the analog input is enabled.

■ **Trace output**

Indicates that the trace function can be used.

■ **GPIO selected**

In Deep standby mode, pins switch to the general-purpose I/O port.

■ **Setting prohibition**

Prohibition of a setting by specification limitation

List of Pin Behavior by Mode State

| Pin Status Type | Function Group | Power-On Reset or Low-Voltage Detection State | INITX Input State | Device Internal Reset State | Run mode or Sleep mode State | Timer mode, RTC mode, or Stop mode State | | Deep Standby RTC Mode or Deep Standby Stop mode State | | Return from Deep Standby Mode State |
|-----------------|---|--|---------------------------------|---------------------------------|---|--|--------------------------------|---|--------------------------------|-------------------------------------|
| | | Power Supply Unstable | Power Supply Stable | | Power Supply Stable | Power Supply Stable | | Power Supply Stable | | Power Supply Stable |
| | | - | INITX = 0 | INITX = 1 | INITX = 1 | INITX = 1 | | INITX = 1 | | INITX = 1 |
| | | - | - | - | - | SPL = 0 | SPL = 1 | SPL = 0 | SPL = 1 | - |
| A | GPIO selected | Setting disabled | Setting disabled | Setting disabled | Maintain previous state | Maintain previous state | Hi-Z/internal input fixed at 0 | GPIO selected, internal input fixed at 0 | Hi-Z/internal input fixed at 0 | GPIO selected |
| | Main crystal oscillator input pin/ external main clock input selected | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Input Enabled |
| B | GPIO selected | Setting disabled | Setting disabled | Setting disabled | Maintain previous state | Maintain previous state | Hi-Z/internal input fixed at 0 | GPIO selected, internal input fixed at 0 | Hi-Z/internal input fixed at 0 | GPIO selected |
| | External main clock input selected | Setting disabled | Setting disabled | Setting disabled | Maintain previous state | Maintain previous state | Hi-Z/internal input fixed at 0 | Maintain previous state | Hi-Z/internal input fixed at 0 | Maintain previous State |
| | Main crystal oscillator output pin | Hi-Z/ internal input fixed at 0/ or input enable | Hi-Z/ internal input fixed at 0 | Hi-Z/ internal input fixed at 0 | Maintain previous state while oscillator active/ When oscillation stops*1, it will be Hi-Z/ Internal input fixed at 0 | | | | | |
| C | INITX input pin | Pull-up/ input enabled | Pull-up/ Input enabled | Pull-up/ Input enabled | Pull-up/ Input enabled | Pull-up/ Input enabled | Pull-up/ Input enabled | Pull-up/ Input enabled | Pull-up/ Input enabled | Pull-up/ Input enabled |
| D | Mode input pin | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled |
| E | Mode input pin | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled |
| | GPIO selected | Setting disabled | Setting disabled | Setting disabled | Maintain previous state | Maintain previous state | Hi-Z/ input enabled | GPIO selected | Hi-Z/ input enabled | GPIO selected |

| Pin Status Type | Function Group | Power-On Reset or Low-Voltage Detection State | INITX Input State | Device Internal Reset State | Run mode or Sleep mode State | Timer mode, RTC mode, or Stop mode State | | Deep Standby RTC Mode or Deep Standby Stop mode State | | Return from Deep Standby Mode State | | |
|-----------------|------------------------------------|---|------------------------|-----------------------------|------------------------------|--|---------------------------------|---|--------------------------------|--|---------------------------------|---------------|
| | | Power Supply Unstable | Power Supply Stable | | Power Supply Stable | Power Supply Stable | | Power Supply Stable | | Power Supply Stable | | |
| | | - | INITX = 0 | INITX = 1 | INITX = 1 | INITX = 1 | | INITX = 1 | | INITX = 1 | | |
| | | - | - | - | - | SPL = 0 | SPL = 1 | SPL = 0 | SPL = 1 | - | | |
| F | NMIX selected | Setting disabled | Setting disabled | Setting disabled | Maintain previous state | Maintain previous state | Maintain previous state | WKUP input enabled | Hi-Z/ WKUP input enabled | Maintain previous state | | |
| | Resource other than above selected | Hi-Z | Hi-Z/ input enabled | Hi-Z/ input enabled | | | Hi-Z/ internal input fixed at 0 | | | GPIO selected | | |
| | GPIO selected | | | | | | | | | | | |
| G | JTAG selected | Hi-Z | Pull-up/ input enabled | Pull-up/ input enabled | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | | |
| | GPIO selected | Setting disabled | Setting disabled | Setting disabled | | | Hi-Z/ internal input fixed at 0 | | | GPIO selected, internal input fixed at 0 | Hi-Z/ internal input fixed at 0 | GPIO selected |
| H | JTAG selected | Hi-Z | Pull-up/ input enabled | Pull-up/ input enabled | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | | |
| | Resource other than above selected | Setting disabled | Setting disabled | Setting disabled | | | Hi-Z/Internal input fixed at 0 | | | GPIO selected, internal input fixed at 0 | Hi-Z/Internal input fixed at 0 | GPIO selected |
| | GPIO selected | | | | | | | | | | | |
| I | Resource selected | Hi-Z | Hi-Z/ input enabled | Hi-Z/ input enabled | Maintain previous state | Maintain previous state | Hi-Z/Internal input fixed at 0 | GPIO selected, internal input fixed at 0 | Hi-Z/internal input fixed at 0 | GPIO selected | | |
| | GPIO selected | | | | | | | | | | | |

| Pin Status Type | Function Group | Power-On Reset or Low-Voltage Detection State | INITX Input State | Device Internal Reset State | Run mode or Sleep mode State | Timer mode, RTC mode, or Stop mode State | | Deep Standby RTC Mode or Deep Standby Stop mode State | | Return from Deep Standby Mode State | |
|-----------------|------------------------------------|---|---|---|---|---|---|---|---|---|---------------|
| | | Power Supply Unstable | Power Supply Stable | | Power Supply Stable | Power Supply Stable | | Power Supply Stable | | Power Supply Stable | |
| | | - | INITX = 0 | INITX = 1 | INITX = 1 | INITX = 1 | | INITX = 1 | | INITX = 1 | |
| | | - | - | - | - | SPL = 0 | SPL = 1 | SPL = 0 | SPL = 1 | - | |
| J | Analog output selected | Hi-Z | Hi-Z/ input enabled | Hi-Z/ input enabled | Maintain previous state | *2 | *3 | GPIO selected, internal input fixed at 0 | Hi-Z/internal input fixed at 0 | GPIO selected | |
| | External interrupt enable selected | | | | | Maintain previous state | Maintain previous state | | | | |
| | Resource other than above selected | | | | | | Hi-Z/internal input fixed at 0 | | | | |
| | GPIO selected | | | | | | | | | | |
| K | External interrupt enable selected | Setting disabled | Setting disabled | Setting disabled | Maintain previous state | Maintain previous state | Maintain previous state | GPIO selected, internal input fixed at 0 | Hi-Z/internal input fixed at 0 | GPIO selected | |
| | Resource other than above selected | Hi-Z | Hi-Z/ input enabled | Hi-Z/ input enabled | | | Hi-Z/internal input fixed at 0 | | | | |
| | GPIO selected | | | | | | | | | | |
| L | Analog input selected | Hi-Z | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | |
| | Resource other than above selected | | Setting disabled | Setting disabled | Setting disabled | Maintain previous state | Maintain previous state | Hi-Z/internal input fixed at 0 | GPIO selected, internal input fixed at 0 | Hi-Z/internal input fixed at 0 | GPIO selected |
| | GPIO selected | | | | | | | | | | |

| Pin Status Type | Function Group | Power-On Reset or Low-Voltage Detection State | INITX Input State | Device Internal Reset State | Run mode or Sleep mode State | Timer mode, RTC mode, or Stop mode State | | Deep Standby RTC Mode or Deep Standby Stop mode State | | Return from Deep Standby Mode State |
|-----------------|------------------------------------|---|---|---|---|---|---|---|---|---|
| | | Power Supply Unstable | Power Supply Stable | | Power Supply Stable | Power Supply Stable | | Power Supply Stable | | Power Supply Stable |
| | | - | INITX = 0 | INITX = 1 | INITX = 1 | INITX = 1 | | INITX = 1 | | INITX = 1 |
| | | - | - | - | - | SPL = 0 | SPL = 1 | SPL = 0 | SPL = 1 | - |
| M | Analog input selected | Hi-Z | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled |
| | External interrupt enable selected | Setting disabled | Setting disabled | Setting disabled | Maintain previous state | Maintain previous state | Maintain previous state | GPIO selected, internal input fixed at 0 | Hi-Z/internal input fixed at 0 | GPIO selected |
| | Resource other than above selected | | | | | | Hi-Z/internal input fixed at 0 | | | |
| | GPIO selected | | | | | | | | | |
| N | Analog input selected | Hi-Z | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled |
| | Trace selected | Setting disabled | Setting disabled | Setting disabled | Maintain previous state | Maintain previous state | Trace output | GPIO selected, internal input fixed at 0 | Hi-Z/internal input fixed at 0 | GPIO selected |
| | Resource other than above selected | | | | | | Hi-Z/internal input fixed at 0 | | | |
| | GPIO selected | | | | | | | | | |

| Pin Status Type | Function Group | Power-On Reset or Low-Voltage Detection State | INITX Input State | Device Internal Reset State | Run mode or Sleep mode State | Timer mode, RTC mode, or Stop mode State | | Deep Standby RTC Mode or Deep Standby Stop mode State | | Return from Deep Standby Mode State |
|-----------------|------------------------------------|---|---|---|---|---|---|---|---|---|
| | | Power Supply Unstable | Power Supply Stable | | Power Supply Stable | Power Supply Stable | | Power Supply Stable | | Power Supply Stable |
| | | - | INITX = 0 | INITX = 1 | INITX = 1 | INITX = 1 | | INITX = 1 | | INITX = 1 |
| | | - | - | - | - | SPL = 0 | SPL = 1 | SPL = 0 | SPL = 1 | - |
| O | Analog input selected | Hi-Z | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled |
| | Trace selected | Setting disabled | Setting disabled | Setting disabled | Maintain previous state | Maintain previous state | Trace output | GPIO selected, internal input fixed at 0 | Hi-Z/internal input fixed at 0 | GPIO selected |
| | External interrupt enable selected | | | | | | Maintain previous state | | | |
| | Resource other than above selected | | | | | | Hi-Z/internal input fixed at 0 | | | |
| | GPIO selected | | | | | | | | | |
| P | Analog input selected | Hi-Z | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled | Hi-Z/ internal input fixed at 0/ analog input enabled |
| | WKUP enabled | Setting disabled | Setting disabled | Setting disabled | Maintain previous state | Maintain previous state | Maintain previous state | WKUP input enabled | Hi-Z/ WKUP input enabled | GPIO selected |
| | Resource other than above selected | | | | | | Hi-Z/internal input fixed at 0 | GPIO selected, internal input fixed at 0 | Hi-Z/internal input fixed at 0 | |
| | GPIO selected | | | | | | | | | |

| Pin Status Type | Function Group | Power-On Reset or Low-Voltage Detection State | INITX Input State | Device Internal Reset State | Run mode or Sleep mode State | Timer mode, RTC mode, or Stop mode State | | Deep Standby RTC Mode or Deep Standby Stop mode State | | Return from Deep Standby Mode State |
|-----------------|------------------------------------|---|---------------------|-----------------------------|---|---|---|---|---------------------------------|-------------------------------------|
| | | Power Supply Unstable | Power Supply Stable | | Power Supply Stable | Power Supply Stable | | Power Supply Stable | | Power Supply Stable |
| | | - | INITX = 0 | INITX = 1 | INITX = 1 | INITX = 1 | | INITX = 1 | | INITX = 1 |
| | | - | - | - | - | SPL = 0 | SPL = 1 | SPL = 0 | SPL = 1 | - |
| Q | WKUP enabled | Setting disabled | Setting disabled | Setting disabled | Maintain previous state | Maintain previous state | Maintain previous state | WKUP input enabled | Hi-Z/ WKUP input enabled | WKUP input enabled |
| | External interrupt enable selected | | | | | | | GPIO selected, internal input fixed at 0 | Hi-Z/ internal input fixed at 0 | GPIO selected |
| | Resource other than above selected | Hi-Z | Hi-Z/ input enabled | Hi-Z/ input enabled | | | | | | |
| | GPIO selected | | | | | | | | | |
| R | GPIO selected | Hi-Z | Hi-Z/ input enabled | Hi-Z/ input enabled | Maintain previous state | Maintain previous state | Hi-Z/ internal input fixed at 0 | GPIO selected, internal input fixed at 0 | Hi-Z/ internal input fixed at 0 | GPIO selected |
| | USB I/O pin | Setting disabled | Setting disabled | Setting disabled | Hi-Z at transmission/ input enabled/ internal input fixed at 0 at reception | Hi-Z at transmission/ input enabled/ internal input fixed at 0 at reception | Hi-Z at transmission/ input enabled/ internal input fixed at 0 at reception | Hi-Z/ input enabled | Hi-Z/ input enabled | Hi-Z/ input enabled |

*1: Oscillation is stopped at sub Timer mode, sub CR Timer mode, RTC mode, Stop mode, Deep Standby RTC mode, and Deep Standby Stop mode.

*2: Maintain previous state at Timer mode. GPIO selected internal input fixed at 0 at RTC mode, Stop mode.

*3: Maintain previous state at Timer mode. Hi-Z/internal input fixed at 0 at RTC mode, Stop mode.

*4: It shows the case selected by EPFR14.E_SPLC register.

List of VBAT Domain Pin Status

| VBAT Pin Status Type | Function Group | Power-on reset*1 | INITX Input State | Device Internal Reset State | Run mode or Sleep mode State | Timer mode, RTC mode, or Stop mode State | | Deep Standby RTC mode or Deep Standby Stop mode State | | Return From Deep Standby Mode State | VBAT RTC Mode State | Return From VBAT RTC Mode State |
|----------------------|---|--|-------------------------|-----------------------------|------------------------------|---|---|---|---|-------------------------------------|-------------------------|---------------------------------|
| | | Power Supply Unstable | Power Supply Stable | | Power Supply Stable | Power Supply Stable | | Power Supply Stable | | Power Supply Stable | Power Supply Stable | Power Supply Stable |
| | | - | INITX = 0 | INITX = 1 | INITX = 1 | INITX = 1 | | INITX = 1 | | INITX = 1 | - | - |
| | | - | - | - | - | SPL = 0 | SPL = 1 | SPL = 0 | SPL = 1 | - | - | - |
| S | GPIO selected | Setting disabled | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Setting prohibition | - |
| | Sub crystal oscillator input pin/ external sub clock input selected | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Input enabled | Maintain previous state | Maintain previous state |
| T | GPIO selected | Setting disabled | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Setting prohibition | - |
| | External sub clock input selected | Setting disabled | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state |
| | Sub crystal oscillator output pin | Hi-Z/ internal input fixed at 0/ or input enable | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state/ When oscillation stops, Hi-Z*2 | Maintain previous state/ When oscillation stops, Hi-Z*2 | Maintain previous state/ When oscillation stops, Hi-Z*2 | Maintain previous state/ When oscillation stops, Hi-Z*2 | Maintain previous state | Maintain previous state | Maintain previous state |
| U | Resource selected | Hi-Z | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state |
| | GPIO selected | | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state | Maintain previous state |

*1: When VBAT and VCC power on.

*2: When the SOSCNTL bit in the WTOSCCNT register is 0, the sub crystal oscillator output pin is maintained in the previous state. When the SOSCNTL bit in the WTOSCCNT register is 1, oscillation is stopped at Stop mode and Deep Standby Stop mode

12. Electrical Characteristics

12.1 Absolute Maximum Ratings

| Parameter | Symbol | Rating | | Unit | Remarks |
|--|---------------------|-----------------------|--|------|----------------------|
| | | Min | Max | | |
| Power supply voltage ^{*1,*2} | V _{CC} | V _{SS} - 0.5 | V _{SS} + 6.5 | V | |
| Power supply voltage (for USB) ^{*1,*3} | USBV _{CC0} | V _{SS} - 0.5 | V _{SS} + 6.5 | V | |
| Power supply voltage (for USB) ^{*1,*3} | USBV _{CC1} | V _{SS} - 0.5 | V _{SS} + 6.5 | V | |
| Power supply voltage (VBAT) ^{*1,*4} | V _{BAT} | V _{SS} - 0.5 | V _{SS} + 6.5 | V | |
| Analog power supply voltage ^{*1,*5} | AV _{CC} | V _{SS} - 0.5 | V _{SS} + 6.5 | V | |
| Analog reference voltage ^{*1,*5} | AV _{RH} | V _{SS} - 0.5 | V _{SS} + 6.5 | V | |
| Input voltage ^{*1} | V _I | V _{SS} - 0.5 | V _{CC} + 0.5 (≤ 6.5 V) | V | Except for USB pin |
| | | V _{SS} - 0.5 | USBV _{CC0} + 0.5 (≤ 6.5 V) | V | USB ch 0 pin |
| | | V _{SS} - 0.5 | USBV _{CC1} + 0.5 (≤ 6.5 V) | V | USB ch 1 pin |
| | | V _{SS} - 0.5 | V _{SS} + 6.5 | V | 5V tolerant |
| Analog pin input voltage ^{*1} | V _{IA} | V _{SS} - 0.5 | AV _{CC} + 0.5 (≤ 6.5 V) | V | |
| Output voltage ^{*1} | V _O | V _{SS} - 0.5 | V _{CC} + 0.5 (≤ 6.5 V) | V | |
| L level maximum output current ^{*6} | I _{OL} | - | 10 | mA | 4 mA type |
| | | | 20 | mA | 8 mA type |
| | | | 10 | mA | 10 mA type |
| | | | 20 | mA | 12 mA type |
| | | | 22.4 | mA | I ² C Fm+ |
| L level average output current ^{*7} | I _{OLAV} | - | 4 | mA | 4 mA type |
| | | | 8 | mA | 8 mA type |
| | | | 10 | mA | 10 mA type |
| | | | 12 | mA | 12 mA type |
| | | | 20 | mA | I ² C Fm+ |
| L level total maximum output current | ∑I _{OL} | - | 100 | mA | |
| L level total maximum output current ^{*8} | ∑I _{OLAV} | - | 50 | mA | |
| H level maximum output current ^{*6} | I _{OH} | - | -10 | mA | 4 mA type |
| | | | -20 | mA | 8 mA type |
| | | | -20 | mA | 10 mA type |
| | | | -20 | mA | 12 mA type |
| H level average output current ^{*7} | I _{OHAV} | - | -4 | mA | 4 mA type |
| | | | -8 | mA | 8 mA type |
| | | | -10 | mA | 10 mA type |
| | | | -12 | mA | 12 mA type |
| H level total maximum output current | ∑I _{OH} | - | -100 | mA | |
| H level total average output current ^{*8} | ∑I _{OHAV} | - | -50 | mA | |
| Power consumption | P _D | - | 200 | mW | |
| Storage temperature | T _{STG} | -55 | + 150 | °C | |

*1: These parameters are based on the condition that V_{SS} = AV_{SS} = 0.0 V.

*2: V_{CC} must not drop below V_{SS} - 0.5 V.

*3: USBV_{CC0}, USBV_{CC1} must not drop below V_{SS} - 0.5 V.

*4: V_{BAT} must not drop below V_{SS} - 0.5 V.

*5: Ensure that the voltage does not exceed V_{CC} + 0.5 V, for example, when the power is turned on.

*6: The maximum output current is defined as the value of the peak current flowing through any one of the corresponding pins.

- *7: The average output current is defined as the average current value flowing through any one of the corresponding pins for a 100-ms period.
- *8: The total average output current is defined as the average current value flowing through all of corresponding pins for a 100-ms period.

WARNING:

- *Semiconductor devices may be permanently damaged by application of stress (including, without limitation, voltage, current or temperature) in excess of absolute maximum ratings. Do not exceed any of these ratings.*

12.2 Recommended Operating Conditions

| Parameter | Symbol | Conditions | Value | | Unit | Remarks |
|-------------------------------------|----------------------|----------------|-------------------|----------------------------|-------|------------------------------------|
| | | | Min | Max | | |
| Power supply voltage | V _{CC} | - | 2.7 ^{*7} | 5.5 | V | |
| Power supply voltage (for USB ch 0) | USBV _{CC0} | - | 3.0 | 3.6 (≤V _{CC}) | V | *1 |
| | | | 2.7 | 5.5 (≤V _{CC}) | | *2 |
| Power supply voltage (for USB ch 1) | USBV _{CC1} | - | 3.0 | 3.6 (≤V _{CC}) | V | *3 |
| | | | 2.7 | 5.5 (≤V _{CC}) | | *4 |
| Power supply voltage (VBAT) | V _{BAT} | - | 1.65 | 5.5 | V | |
| Analog power supply voltage | AV _{CC} | - | 2.7 | 5.5 | V | AV _{CC} = V _{CC} |
| Analog reference voltage | AVRH | - | *6 | AV _{CC} | V | |
| | AVRL | - | AV _{SS} | AV _{SS} | V | |
| Operating temperature | Junction temperature | T _J | - | -40 | + 125 | °C |
| | Ambient temperature | T _A | - | -40 | *5 | °C |

*1: When P81/UDP0 and P80/UDM0 pins are used as USB (UDP0, UDM0)

*2: When P81/UDP0 and P80/UDM0 pins are used as GPIO (P81, P80)

*3: When P83/UDP1 and P82/UDM1 pins are used as USB (UDP1, UDM1)

*4: When P83/UDP1 and P82/UDM1 pins are used as GPIO (P83, P82)

*5: The maximum temperature of the ambient temperature (T_A) can guarantee a range that does not exceed the junction temperature (T_J).

The calculation formula of the ambient temperature (T_A) is:

$$T_A (\text{Max}) = T_J(\text{Max}) - P_d(\text{Max}) \times \theta_{JA}$$

P_d: Power dissipation (W)

θ_{JA}: Package thermal resistance (°C/W)

$$P_d (\text{Max}) = V_{CC} \times I_{CC} (\text{Max}) + \sum (I_{OL} \times V_{OL}) + \sum ((V_{CC} - V_{OH}) \times (-I_{OH}))$$

I_{OL}: L level output current

I_{OH}: H level output current

V_{OL}: L level output voltage

V_{OH}: H level output voltage

*6: The minimum value of analog reference voltage depends on the value of compare clock cycle (t_{CC}). See 12.5. 12-bit A/D Converter for the details.

*7: For the voltage range between V_{CC}(min) and the low voltage detection reset (VDH), the MCU must be clocked from either the High-speed CR or the low-speed CR."

Package thermal resistance and maximum permissible power for each package are shown below. The operation is guaranteed maximum permissible power or less for semiconductor devices.

Table for Package Thermal Resistance and Maximum Permissible Power

| Package | Printed Circuit Board | Thermal Resistance θ_{JA} (°C/W) | Maximum Permissible Power (mW) | |
|--------------------------|---------------------------|---|--------------------------------|--------------------------|
| | | | T _A = +85 °C | T _A = +105 °C |
| LQS144 (0.5-mm pitch) | Single-layered both sides | 48 | 833 | 417 |
| | 4 layers | 33 | 1212 | 606 |
| LQP176 (0.5-mm pitch) | Single-layered both sides | 45 | 889 | 444 |
| | 4 layers | 31 | 1290 | 645 |
| LQQ216 (0.4-mm pitch) | Single-layered both sides | 46 | 870 | 435 |
| | 4 layers | 32 | 1250 | 625 |
| LBE192 (0.8-mm pitch) | Single-layered both sides | - | - | - |
| | 4 layers | 35 | 1143 | 571 |

WARNING:

1. The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.
2. Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.
3. No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet.
4. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

Calculation Method of Power Dissipation (Pd)

The power dissipation is shown in the following formula.

$$P_d = V_{CC} \times I_{CC} + \sum (I_{OL} \times V_{OL}) + \sum ((V_{CC} - V_{OH}) \times (-I_{OH}))$$

I_{OL} : L level output current

I_{OH} : H level output current

V_{OL} : L level output voltage

V_{OH} : H level output voltage

I_{CC} is the current drawn by the device.

It can be analyzed as follows.

$$I_{CC} = I_{CC}(\text{INT}) + \sum I_{CC}(\text{IO})$$

$I_{CC}(\text{INT})$: Current drawn by internal logic and memory, etc. through the regulator

$\sum I_{CC}(\text{IO})$: Sum of current (I/O switching current) drawn by the output pin

For $I_{CC}(\text{INT})$, it can be anticipated by (1) Current Rating in 12.3. DC Characteristics (This rating value does not include $I_{CC}(\text{IO})$ for a value at pin fixed).

For $I_{CC}(\text{IO})$, it depends on system used by customers.

The calculation formula is shown below.

$$I_{CC}(\text{IO}) = (C_{\text{INT}} + C_{\text{EXT}}) \times V_{CC} \times f_{\text{SW}}$$

C_{INT} : Pin internal load capacitance
 C_{EXT} : External load capacitance of output pin
 f_{SW} : Pin switching frequency

| Parameter | Symbol | Conditions | Capacitance Value |
|-------------------------------|------------------|------------|-------------------|
| Pin internal load capacitance | C_{INT} | 4 mA type | 1.93 pF |
| | | 8 mA type | 3.45 pF |
| | | 12 mA type | 3.42 pF |

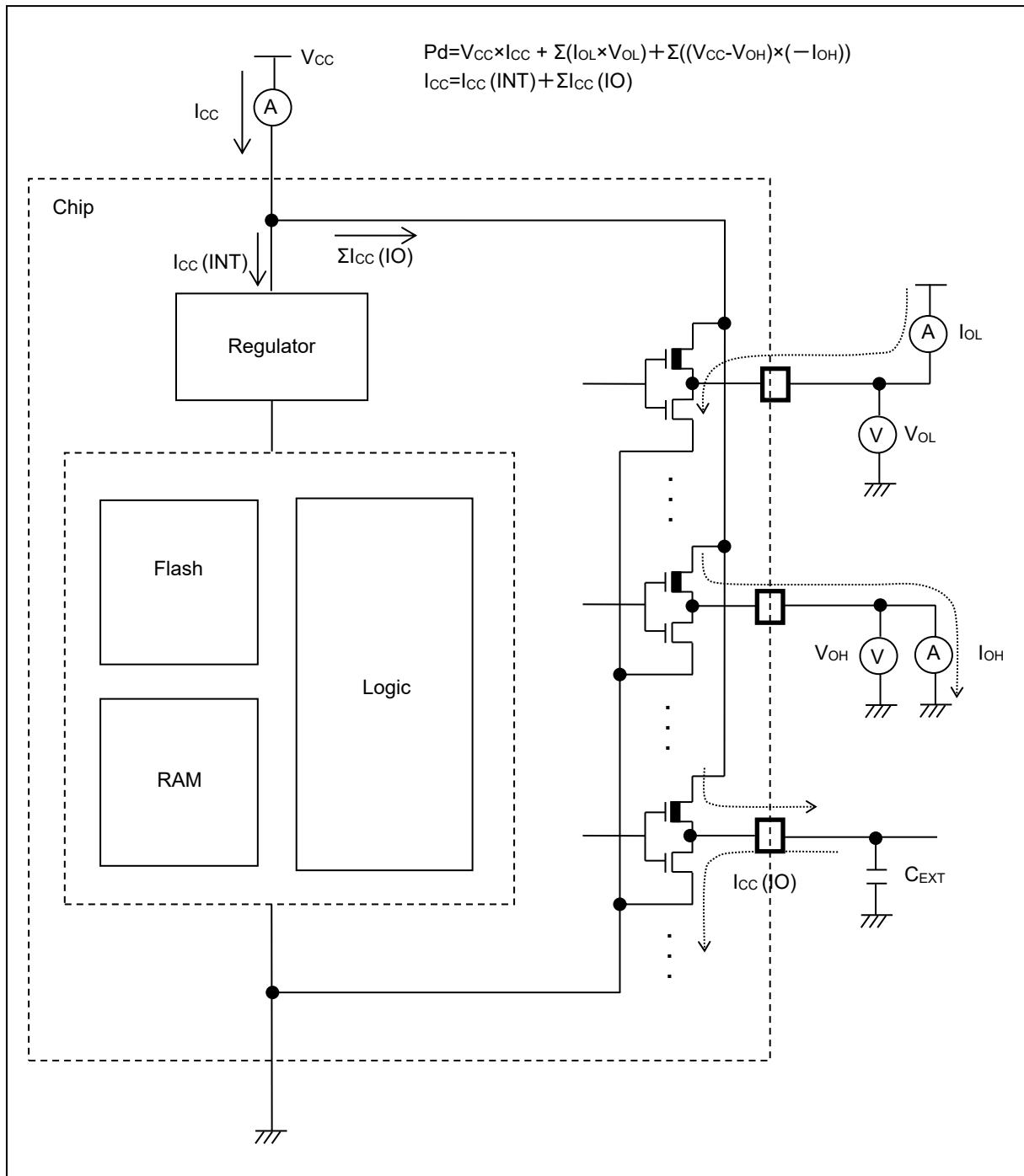
Calculate $I_{CC}(\text{Max})$ as follows when the power dissipation can be evaluated by yourself:

Measure current value $I_{CC}(\text{Typ})$ at normal temperature (+25 °C).

Add maximum leakage current value $I_{CC}(\text{leak_max})$ at operating on a value in (1).

$$I_{CC}(\text{Max}) = I_{CC}(\text{Typ}) + I_{CC}(\text{leak_max})$$

| Parameter | Symbol | Conditions | Current Value |
|--------------------------------------|----------------------------|------------------------|---------------|
| Maximum leakage current at operating | $I_{CC}(\text{leak_max})$ | $T_J = +125\text{ °C}$ | 79.2 mA |
| | | $T_J = +105\text{ °C}$ | 39.4 mA |
| | | $T_J = +85\text{ °C}$ | 26.5 mA |

Current Explanation Diagram


12.3 DC Characteristics

12.3.1 Current Rating

Table 12-1 Typical and Maximum Current Consumption in Normal Operation (PLL), Code Running from Flash Memory (Flash Accelerator Mode and Trace Buffer Function Enabled)

| Parameter | Symbol | Pin Name | Conditions | Frequency*4 | Value | | Unit | Remarks | | |
|----------------------|-----------------|-----------------|------------------------------|-------------|---------|---------|------|---------|---|--|
| | | | | | Typ*1 | Max*2 | | | | |
| Power supply current | I _{CC} | V _{CC} | Normal operation *7,*8 (PLL) | *5 | 200 MHz | 117 | 224 | mA | *3 When all peripheral clocks are on | |
| | | | | | 192 MHz | 113 | 219 | mA | | |
| | | | | | 180 MHz | 106 | 211 | mA | | |
| | | | | *6 | 160 MHz | 95 | 197 | mA | | |
| | | | | | 144 MHz | 86 | 186 | mA | | |
| | | | | | 120 MHz | 73 | 169 | mA | | |
| | | | | | 100 MHz | 61 | 155 | mA | | |
| | | | | | 80 MHz | 50 | 140 | mA | | |
| | | | | | 60 MHz | 39 | 126 | mA | | |
| | | | | | 40 MHz | 27 | 112 | mA | | |
| | | | | *6 | 20 MHz | 16 | 97 | mA | | |
| | | | | | 8 MHz | 8.7 | 88.9 | mA | | |
| | | | | | 4 MHz | 6.4 | 86.1 | mA | | |
| | | | | | *5 | 200 MHz | 71 | 168 | mA | *3 When all peripheral clocks are off |
| | | | | 192 MHz | | 68 | 165 | mA | | |
| | | | | 180 MHz | | 64 | 159 | mA | | |
| | | | | *6 | | 160 MHz | 58 | 151 | mA | |
| | | | | | | 144 MHz | 52 | 144 | mA | |
| | | | | | | 120 MHz | 44 | 134 | mA | |
| | | | | *6 | | 100 MHz | 38 | 126 | mA | |
| 80 MHz | 31 | 117 | mA | | | | | | | |
| 60 MHz | 24 | 109 | mA | | | | | | | |
| 40 MHz | 17 | 100 | mA | | | | | | | |
| 20 MHz | 10 | 91 | mA | | | | | | | |
| *6 | 8 MHz | 6.3 | 86.1 | mA | | | | | | |
| | 4 MHz | 5.0 | 84.5 | mA | | | | | | |

*1: T_A = +25 °C, V_{CC} = 3.3 V

*2: T_J = +125 °C, V_{CC} = 5.5 V

*3: When all ports are fixed

*4: Frequency is a value of HCLK when PCLK0 = PCLK1 = PCLK2 = HCLK

*5: When stopping flash accelerator mode and trace buffer function (FRWTR.RWT = 11, FBFCR.BE = 1)

*6: When stopping flash accelerator mode and trace buffer function (FRWTR.RWT = 10, FBFCR.BE = 1)

*7: Firmware being executed during data collection for this table is not being accessed from the MainFlash memory.”

*8: When using the crystal oscillator of 4 MHz (including the current consumption of the oscillation circuit)

Table 12-2 Typical and Maximum Current Consumption in Normal Operation (PLL), Code with Data Accessing Running from Flash Memory (Flash Accelerator Mode and Trace Buffer Function Disabled)

| Parameter | Symbol | Pin Name | Conditions | Frequency*4 | Value | | Unit | Remarks | | |
|----------------------|-----------------|-----------------|------------------------------|-------------|---------|---------|------|---------|--|----|
| | | | | | Typ*1 | Max*2 | | | | |
| Power supply current | I _{CC} | V _{CC} | Normal operation *7,*8 (PLL) | *5 | 200 MHz | 128 | 236 | mA | *3 When all peripheral clocks are on | |
| | | | | | 192 MHz | 123 | 230 | mA | | |
| | | | | | 180 MHz | 116 | 221 | mA | | |
| | | | | *6 | 160 MHz | 102 | 205 | mA | | |
| | | | | | 144 MHz | 93 | 193 | mA | | |
| | | | | | 120 MHz | 79 | 175 | mA | | |
| | | | | | 100 MHz | 67 | 161 | mA | | |
| | | | | | 80 MHz | 54 | 145 | mA | | |
| | | | | | 60 MHz | 42 | 130 | mA | | |
| | | | | | 40 MHz | 30 | 115 | mA | | |
| | | | | | 20 MHz | 17 | 99 | mA | | |
| | | | | | 8 MHz | 9.2 | 90.0 | mA | | |
| | | | | 4 MHz | 6.7 | 86.9 | mA | | | |
| | | | | *5 | 200 MHz | 74 | 170 | mA | *3 When all peripheral clocks are off | |
| | | | | | 192 MHz | 71 | 167 | mA | | |
| | | | | | 180 MHz | 67 | 162 | mA | | |
| | | | | | *6 | 160 MHz | 59 | 152 | | mA |
| | | | | | | 144 MHz | 53 | 145 | | mA |
| | | | | | | 120 MHz | 45 | 135 | | mA |
| | | | | | | 100 MHz | 39 | 127 | | mA |
| | | | | | | 80 MHz | 32 | 118 | | mA |
| | | | | | | 60 MHz | 25 | 110 | | mA |
| | | | | | | 40 MHz | 18 | 101 | | mA |
| | | | | | | 20 MHz | 11 | 92 | | mA |
| 8 MHz | 6.5 | 86.8 | mA | | | | | | | |
| 4 MHz | 5.1 | 85.0 | mA | | | | | | | |

*1: T_A = +25 °C, V_{CC} = 3.3 V

*2: T_J = +125 °C, V_{CC} = 5.5 V

*3: When all ports are fixed

*4: Frequency is a value of HCLK when PCLK0 = PCLK1 = PCLK2 = HCLK

*5: When stopping flash accelerator mode and trace buffer function (FRWTR.RWT = 11, FBFCR.BE = 0)

*6: When stopping flash accelerator mode and trace buffer function (FRWTR.RWT = 10, FBFCR.BE = 0)

*7: With data access to a MainFlash memory.

*8: When using the crystal oscillator of 4 MHz (including the current consumption of the oscillation circuit)

Table 12-3 Typical and Maximum Current Consumption in Normal Operation (PLL), Code with Data Accessing Running from Flash Memory (Flash 0 Wait-cycle Mode and Read Access 0 Wait)

| Parameter | Symbol | Pin Name | Conditions | Frequency*4 | Value | | Unit | Remarks | |
|----------------------|-----------------|----------|------------------------------|-------------|--------|-------|------|---------|--|
| | | | | | Typ*1 | Max*2 | | | |
| Power supply current | I _{CC} | VCC | Normal operation *6,*7 (PLL) | *5 | 72 MHz | 71 | 161 | mA | *3 When all peripheral clocks are on |
| | | | | | 60 MHz | 62 | 150 | mA | |
| | | | | | 48 MHz | 51 | 138 | mA | |
| | | | | | 36 MHz | 40 | 125 | mA | |
| | | | | | 24 MHz | 29 | 112 | mA | |
| | | | | | 12 MHz | 17 | 98 | mA | |
| | | | | | 8 MHz | 13 | 93 | mA | |
| | | | | 4 MHz | 8.4 | 88.5 | mA | | |
| | | | | *5 | 72 MHz | 46 | 132 | mA | *3 When all peripheral clocks are off |
| | | | | | 60 MHz | 41 | 125 | mA | |
| | | | | | 48 MHz | 34 | 118 | mA | |
| | | | | | 36 MHz | 27 | 110 | mA | |
| | | | | | 24 MHz | 20 | 102 | mA | |
| | | | | | 12 MHz | 12 | 93 | mA | |
| 8 MHz | 9.4 | 89.7 | mA | | | | | | |
| 4 MHz | 6.5 | 86.4 | mA | | | | | | |

*1: T_A = +25 °C, V_{CC} = 3.3 V

*2: T_J = +125 °C, V_{CC} = 5.5 V

*3: When all ports are fixed

*4: Frequency is a value of HCLK when PCLK0 = PCLK1 = PCLK2 = HCLK

*5: When operating flash 0 wait-cycle mode and read access 0 wait (FRWTR.RWT = 00, FBFCR.SD = 000)

*6: With data access to a MainFlash memory.

*7: When using the crystal oscillator of 4 MHz (including the current consumption of the oscillation circuit)

Table 12-4 Typical and Maximum Current Consumption in Normal Operation (Other Than PLL), Code with Data Accessing Running from Flash Memory (Flash 0 Wait-cycle Mode and Read Access 0 Wait)

| Parameter | Symbol | Pin Name | Conditions | | Frequency* ⁴ | Value | | Unit | Remarks |
|----------------------|-----------------|-----------------|--|----|-------------------------|-------------------|-------------------|------|--|
| | | | | | | Typ* ¹ | Max* ² | | |
| Power supply current | I _{CC} | V _{CC} | Normal operation *6, *7 (main oscillation) | *5 | 4 MHz | 4.7 | 84.9 | mA | *3 When all peripheral clocks are on |
| | | | | | | 3.9 | 83.8 | mA | *3 When all peripheral clocks are off |
| | | | Normal operation *6 (built-in High-speed CR) | *5 | 4 MHz | 3.0 | 83.2 | mA | *3 When all peripheral clocks are on |
| | | | | | | 2.1 | 82.0 | mA | *3 When all peripheral clocks are off |
| | | | Normal operation *6, *8 (sub oscillation) | *5 | 32 kHz | 0.78 | 80.37 | mA | *3 When all peripheral clocks are on |
| | | | | | | 0.77 | 80.36 | mA | *3 When all peripheral clocks are off |
| | | | Normal operation *6 (built-in low-speed CR) | *5 | 100 kHz | 0.81 | 80.39 | mA | *3 When all peripheral clocks are on |
| | | | | | | 0.78 | 80.38 | mA | *3 When all peripheral clocks are off |

*1: T_A = +25 °C, V_{CC} = 3.3 V

*2: T_J = +125 °C, V_{CC} = 5.5 V

*3: When all ports are fixed

*4: Frequency is a value of HCLK when PCLK0 = PCLK1 = PCLK2 = HCLK/2

*5: When operating flash 0 wait-cycle mode and read access 0 wait (FRWTR.RWT = 00, FBFCR.SD = 000)

*6: With data access to a MainFlash memory.

*7: When using the crystal oscillator of 4 kHz (including the current consumption of the oscillation circuit)

*8: When using the crystal oscillator of 32 kHz (including the current consumption of the oscillation circuit)

Table 12-5 Typical and Maximum Current Consumption in Sleep Operation (PLL), when PCLK0 = PCLK1 = PCLK2 = HCLK/2

| Parameter | Symbol | Pin Name | Conditions | Frequency* ⁴ | Value | | Unit | Remarks |
|----------------------|------------------|-----------------|-------------------------------------|-------------------------|-------------------|-------------------|------|--|
| | | | | | Typ* ¹ | Max* ² | | |
| Power supply current | I _{CCS} | V _{CC} | Sleep operation* ⁵ (PLL) | 200 MHz | 88 | 188 | mA | * ₃ When all peripheral clocks are on |
| | | | | 192 MHz | 85 | 184 | mA | |
| | | | | 180 MHz | 80 | 178 | mA | |
| | | | | 160 MHz | 72 | 164 | mA | |
| | | | | 144 MHz | 65 | 156 | mA | |
| | | | | 120 MHz | 55 | 144 | mA | |
| | | | | 100 MHz | 47 | 134 | mA | |
| | | | | 80 MHz | 38 | 124 | mA | |
| | | | | 60 MHz | 30 | 114 | mA | |
| | | | | 40 MHz | 21 | 104 | mA | |
| | | | | 20 MHz | 12 | 93 | mA | |
| | | | | 8 MHz | 7.4 | 87.2 | mA | |
| | | | | 4 MHz | 5.8 | 85.2 | mA | |
| | | | | 200 MHz | 44 | 134 | mA | * ₃ When all peripheral clocks are off |
| | | | | 192 MHz | 42 | 132 | mA | |
| | | | | 180 MHz | 40 | 129 | mA | |
| | | | | 160 MHz | 36 | 123 | mA | |
| | | | | 144 MHz | 33 | 119 | mA | |
| | | | | 120 MHz | 28 | 113 | mA | |
| | | | | 100 MHz | 24 | 108 | mA | |
| | | | | 80 MHz | 20 | 103 | mA | |
| | | | | 60 MHz | 16 | 98 | mA | |
| | | | | 40 MHz | 12 | 93 | mA | |
| | | | | 20 MHz | 7.6 | 87.6 | mA | |
| 8 MHz | 5.2 | 84.7 | mA | | | | | |
| 4 MHz | 4.4 | 83.7 | mA | | | | | |

*1: T_A = +25 °C, V_{CC} = 3.3 V

*2: T_J = +125 °C, V_{CC} = 5.5 V

*3: When all ports are fixed

*4: Frequency is a value of HCLK when PCLK0 = PCLK1 = PCLK2 = HCLK/2

*5: When using the crystal oscillator of 4 MHz (including the current consumption of the oscillation circuit)

Table 12-6 Typical and Maximum Current Consumption in Sleep Operation (PLL), when PCLK0 = PCLK1 = PCLK2 = HCLK

| Parameter | Symbol | Pin Name | Conditions | Frequency* ⁴ | Value | | Unit | Remarks |
|----------------------|------------------|----------|-------------------------------------|-------------------------|-------------------|-------------------|------|--|
| | | | | | Typ* ¹ | Max* ² | | |
| Power supply current | I _{CCS} | VCC | Sleep operation* ⁵ (PLL) | 72 MHz | 45 | 130 | mA | * ³ When all peripheral clocks are on |
| | | | | 60 MHz | 38 | 122 | mA | |
| | | | | 48 MHz | 31 | 114 | mA | |
| | | | | 36 MHz | 24 | 106 | mA | |
| | | | | 24 MHz | 18 | 99 | mA | |
| | | | | 12 MHz | 11 | 91 | mA | |
| | | | | 8 MHz | 8.6 | 88.3 | mA | |
| | | | | 4 MHz | 6.3 | 85.7 | mA | |
| | | | | 72 MHz | 20 | 103 | mA | * ³ When all peripheral clocks are off |
| | | | | 60 MHz | 18 | 99 | mA | |
| | | | | 48 MHz | 15 | 96 | mA | |
| | | | | 36 MHz | 12 | 93 | mA | |
| | | | | 24 MHz | 9.1 | 89.3 | mA | |
| | | | | 12 MHz | 6.5 | 86.1 | mA | |
| | | | | 8 MHz | 5.5 | 84.9 | mA | |
| | | | | 4 MHz | 4.6 | 83.8 | mA | |

*1: T_A = +25 °C, V_{CC} = 3.3 V

*2: T_J = +125 °C, V_{CC} = 5.5 V

*3: When all ports are fixed

*4: Frequency is a value of HCLK when PCLK0 = PCLK1 = PCLK2 = HCLK

*5: When using the crystal oscillator of 4 MHz (including the current consumption of the oscillation circuit)

Table 12-7 Typical and Maximum Current Consumption in Sleep Operation (Other Than PLL), when PCLK0 = PCLK1 = PCLK2 = HCLK/2

| Parameter | Symbol | Pin Name | Conditions | Frequency*4 | Value | | Unit | Remarks |
|----------------------|------------------|-----------------|---|-------------|-------|-------|------|--|
| | | | | | Typ*1 | Max*2 | | |
| Power supply current | I _{CCS} | V _{CC} | Sleep operation*5 (main oscillation) | 4 MHz | 3.4 | 82.6 | mA | *3 When all peripheral clocks are on |
| | | | | | 2.5 | 81.7 | mA | *3 When all peripheral clocks are off |
| | | | Sleep operation (built-in High-speed CR) | 4 MHz | 2.5 | 81.7 | mA | *3 When all peripheral clocks are on |
| | | | | | 1.7 | 80.9 | mA | *3 When all peripheral clocks are off |
| | | | Sleep operation*6 (sub oscillation) | 32 kHz | 0.75 | 79.97 | mA | *3 When all peripheral clocks are on |
| | | | | | 0.74 | 79.96 | mA | *3 When all peripheral clocks are off |
| | | | Sleep operation (built-in low-speed CR) | 100 kHz | 0.79 | 80.01 | mA | *3 When all peripheral clocks are on |
| | | | | | 0.76 | 79.98 | mA | *3 When all peripheral clocks are off |

*1: T_A = +25 °C, V_{CC} = 3.3 V

*2: T_J = +125 °C, V_{CC} = 5.5 V

*3: When all ports are fixed.

*4: Frequency is a value of HCLK when PCLK0 = PCLK1 = PCLK2 = HCLK/2

*5: When using the crystal oscillator of 4 MHz (including the current consumption of the oscillation circuit)

*6: When using the crystal oscillator of 32 kHz (including the current consumption of the oscillation circuit)

Table 12-8 Typical and Maximum Current Consumption in Stop Mode, Timer Mode and RTC Mode

| Parameter | Symbol | Pin Name | Conditions | Frequency | Value | | Unit | Remarks |
|----------------------|---------------------------------------|-----------------|--|-----------|-------|-------|------------------------------------|------------------------------------|
| | | | | | Typ*1 | Max*2 | | |
| Power supply current | I _{CC} H | V _{CC} | Stop mode | - | 0.56 | 3.01 | mA | *3, *4 T _A = +25 °C |
| | | | | | - | 27.03 | mA | *3, *4 T _A = +85 °C |
| | | | | | - | 39.92 | mA | *3, *4 T _A = +105 °C |
| | I _{CC} T | | Timer mode* ⁵ (main oscillation) | 4 MHz | 1.40 | 3.85 | mA | *3, *4 T _A = +25 °C |
| | | | | | - | 27.87 | mA | *3, *4 T _A = +85 °C |
| | | | | | - | 40.76 | mA | *3, *4 T _A = +105 °C |
| | | | Timer mode (built-in High-speed CR) | 4 MHz | 0.95 | 3.40 | mA | *3, *4 T _A = +25 °C |
| | | | | | - | 27.42 | mA | *3, *4 T _A = +85 °C |
| | | | | | - | 40.31 | mA | *3, *4 T _A = +105 °C |
| | | | Timer mode* ⁶ (sub oscillation) | 32 kHz | 0.57 | 3.02 | mA | *3, *4 T _A = +25 °C |
| | | | | | - | 27.04 | mA | *3, *4 T _A = +85 °C |
| | | | | | - | 39.93 | mA | *3, *4 T _A = +105 °C |
| | Timer mode (built-in Low-speed CR) | | 100 kHz | 0.58 | 3.03 | mA | *3, *4 T _A = +25 °C | |
| | | | | - | 27.05 | mA | *3, *4 T _A = +85 °C | |
| | | | | - | 39.94 | mA | *3, *4 T _A = +105 °C | |
| | I _{CC} R | | RTC mode* ⁶ (sub oscillation) | 32 kHz | 0.57 | 3.02 | mA | *3, *4 T _A = +25 °C |
| | | | | | - | 27.04 | mA | *3, *4 T _A = +85 °C |
| | | | | | - | 39.93 | mA | *3, *4 T _A = +105 °C |

*1: V_{CC} = 3.3 V

*2: V_{CC} = 5.5 V

*3: When all ports are fixed

*4: When LVD is off

*5: When using the crystal oscillator of 4 MHz (including the current consumption of the oscillation circuit)

*6: When using the crystal oscillator of 32 kHz (including the current consumption of the oscillation circuit)

Table 12-9 Typical and Maximum Current Consumption in Deep Standby Stop Mode, Deep Standby RTC Mode and VBAT

| Parameter | Symbol | Pin Name | Conditions | Frequency | Value | | Unit | Remarks | |
|----------------------|---------------------|----------|--|---|--------|-------|------|--|------------------------------------|
| | | | | | Typ*1 | Max*2 | | | |
| Power supply current | I _{CCHD} | VCC | Deep Standby Stop mode (When RAM is off) | - | 96 | 248 | μA | *3, *4 T _A = +25 °C | |
| | | | | | - | 3009 | μA | *3, *4 T _A = +85 °C | |
| | | | | | - | 3889 | μA | *3, *4 T _A = +105 °C | |
| | | | Deep Standby Stop mode (When RAM is on) | | 106 | 259 | μA | *3, *4 T _A = +25 °C | |
| | | | | | - | 3020 | μA | *3, *4 T _A = +85 °C | |
| | | | | | - | 3900 | μA | *3, *4 T _A = +105 °C | |
| | I _{CCRD} | | VCC | Deep Standby RTC mode (When RAM is off) | 32 kHz | 96 | 248 | μA | *3, *4 T _A = +25 °C |
| | | | | | | - | 3009 | μA | *3, *4 T _A = +85 °C |
| | | | | | | - | 3889 | μA | *3, *4 T _A = +105 °C |
| | | | | Deep Standby RTC mode (When RAM is on) | | 106 | 259 | μA | *3, *4 T _A = +25 °C |
| | | | | | | - | 3020 | μA | *3, *4 T _A = +85 °C |
| | | | | | | - | 3900 | μA | *3, *4 T _A = +105 °C |
| | I _{CCVBAT} | VBAT | RTC stop*6 | - | 0.058 | 0.1 | μA | *3, *4, *5 T _A = +25 °C | |
| | | | | | - | 1.4 | μA | *3, *4, *5 T _A = +85 °C | |
| | | | | | - | 3.3 | μA | *3, *4, *5 T _A = +105 °C | |
| | | | RTC operation*6 | | 1.0 | 1.8 | μA | *3, *4 T _A = +25 °C | |
| | | | | | - | 3.2 | μA | *3, *4 T _A = +85 °C | |
| | | | | | - | 5.1 | μA | *3, *4 T _A = +105 °C | |

*1: V_{CC} = 3.3 V

*2: V_{CC} = 5.5 V

*3: When all ports are fixed

*4: When LVD is off

*5: When sub oscillation is off

*6: In the case of setting RTC after VCC power on

Table 12-10 Typical and Maximum Current Consumption in Low-voltage Detection Circuit, Main Flash Memory Write/erase

| Parameter | Symbol | Pin Name | Conditions | Value | | | Unit | Remarks |
|--|-----------------------|----------|----------------|-------|------|------|------|-----------------------------|
| | | | | Min | Typ | Max | | |
| Low-voltage detection circuit (LVD) power supply current | I _{CC} LVD | VCC | At operation | - | 4 | 7 | μA | For occurrence of interrupt |
| MainFlash memory write/erase current | I _{CC} FLASH | | At write/erase | - | 13.4 | 15.9 | mA | *1 |

*1: When programming or erase in flash memory, Flash Memory Write/Erase current (I_{CC}FLASH) is added to the Power supply current (I_{CC}).

Peripheral Current Dissipation

| Clock system | Peripheral | Unit | Frequency (MHz) | | | Unit | Remarks |
|--------------|--|-------------|-----------------|------|------|------|---------|
| | | | 50 | 100 | 200 | | |
| HCLK | GPIO | All ports | 0.39 | 0.81 | 1.56 | mA | |
| | DMAC | - | 0.99 | 1.97 | 3.82 | | |
| | DSTC | - | 0.73 | 1.49 | 2.86 | | |
| | External bus I/F | - | 0.25 | 0.48 | 0.97 | | |
| | SD card I/F | - | 0.74 | 1.47 | 2.90 | | |
| | USB | 1 ch | 0.48 | 0.95 | 1.89 | | |
| | I ² S | - | 0.51 | 1.02 | 1.99 | | |
| | High-Speed Quad SPI | - | 0.48 | 0.97 | 1.49 | | |
| | Programmable CRC | - | 0.05 | 0.10 | 0.22 | | |
| PCLK1 | Base timer | 4 ch | 0.21 | 0.42 | 0.83 | mA | |
| | Multi-functional timer/PPG | 1 unit/4 ch | 0.83 | 1.65 | 3.25 | | |
| | Quadrature position/revolution counter | 1 unit | 0.07 | 0.13 | 0.27 | | |
| | A/D converter | 1 unit | 0.31 | 0.60 | 1.17 | | |
| PCLK2 | Multi-function serial | 1 ch | 0.41 | 0.81 | - | mA | |

12.3.2 Pin Characteristics
 $(V_{CC} = USBV_{CC0} = USBV_{CC1} = AV_{CC} = 2.7\text{ V to }5.5\text{ V}, V_{SS} = AV_{SS} = 0\text{ V})$

| Parameter | Symbol | Pin Name | Conditions | Value | | | Unit | Remarks |
|--|-----------|---|---|---------------------|-----|---------------------|------|-----------------|
| | | | | Min | Typ | Max | | |
| H level input voltage (hysteresis input) | V_{IHS} | CMOS hysteresis input pin, MD0, MD1 | - | $V_{CC} \times 0.8$ | - | $V_{CC} + 0.3$ | V | |
| | | MADATAxx | $V_{CC} > 3.0\text{ V}, V_{CC} \leq 3.6\text{ V},$ | 2.4 | - | $V_{CC} + 0.3$ | V | At External Bus |
| | | 5 V tolerant input pin | - | $V_{CC} \times 0.8$ | - | $V_{SS} + 5.5$ | V | |
| | | Input pin doubled as I ² C Fm+ | - | $V_{CC} \times 0.7$ | - | $V_{SS} + 5.5$ | V | |
| | | TTL Schmitt input pin | - | 2.0 | - | $V_{CC} + 0.3$ | V | |
| L level input voltage (hysteresis input) | V_{ILS} | CMOS hysteresis input pin, MD0, MD1 | - | $V_{SS} - 0.3$ | - | $V_{CC} \times 0.2$ | V | |
| | | 5 V tolerant input pin | - | $V_{SS} - 0.3$ | - | $V_{CC} \times 0.2$ | V | |
| | | Input pin doubled as I ² C Fm+ | - | V_{SS} | - | $V_{CC} \times 0.3$ | V | |
| | | TTL Schmitt input pin | - | $V_{SS} - 0.3$ | - | 0.8 | V | |
| H level output voltage | V_{OH} | 4 mA type | $V_{CC} \geq 4.5\text{ V}, I_{OH} = -4\text{ mA}$ | $V_{CC} - 0.5$ | - | V_{CC} | V | |
| | | | $V_{CC} < 4.5\text{ V}, I_{OH} = -2\text{ mA}$ | | | | | |
| | | 8 mA type | $V_{CC} \geq 4.5\text{ V}, I_{OH} = -8\text{ mA}$ | $V_{CC} - 0.5$ | - | V_{CC} | V | |
| | | | $V_{CC} < 4.5\text{ V}, I_{OH} = -4\text{ mA}$ | | | | | |
| | | 10 mA type | $V_{CC} \geq 4.5\text{ V}, I_{OH} = -10\text{ mA}$ | $V_{CC} - 0.5$ | - | V_{CC} | V | |
| | | | $V_{CC} < 4.5\text{ V}, I_{OH} = -8\text{ mA}$ | | | | | |
| | | 12 mA type | $V_{CC} \geq 4.5\text{ V}, I_{OH} = -12\text{ mA}$ | $V_{CC} - 0.5$ | - | V_{CC} | V | |
| | | | $V_{CC} < 4.5\text{ V}, I_{OH} = -8\text{ mA}$ | | | | | |
| | | The pin doubled as USB I/O | $USBV_{CC} \geq 4.5\text{ V}, I_{OH} = -20.5\text{ mA}$ | $USBV_{CC} - 0.4$ | - | $USBV_{CC}$ | V | *1 |
| | | | $USBV_{CC} < 4.5\text{ V}, I_{OH} = -13.0\text{ mA}$ | | | | | |
| | | The pin doubled as I ² C Fm+ | $V_{CC} \geq 4.5\text{ V}, I_{OH} = -4\text{ mA}$ | $V_{CC} - 0.5$ | - | V_{CC} | V | At GPIO |
| | | | $V_{CC} < 4.5\text{ V}, I_{OH} = -3\text{ mA}$ | | | | | |

| Parameter | Symbol | Pin Name | Conditions | Value | | | Unit | Remarks |
|---|-----------------|--|--|-----------------|-----|-----|------|-------------------------|
| | | | | Min | Typ | Max | | |
| L level output voltage | V _{OL} | 4 mA type | V _{CC} ≥ 4.5 V, I _{OL} = 4 mA | V _{SS} | - | 0.4 | V | |
| | | | V _{CC} < 4.5 V, I _{OL} = 2 mA | | | | | |
| | | 8 mA type | V _{CC} ≥ 4.5 V, I _{OL} = 8 mA | V _{SS} | - | 0.4 | V | |
| | | | V _{CC} < 4.5 V, I _{OL} = 4 mA | | | | | |
| | | 10 mA type | V _{CC} ≥ 4.5 V, I _{OL} = 10 mA | V _{SS} | - | 0.4 | V | |
| | | | V _{CC} < 4.5 V, I _{OL} = 8 mA | | | | | |
| | | 12 mA type | V _{CC} ≥ 4.5 V, I _{OL} = 12 mA | V _{SS} | - | 0.4 | V | |
| | | | V _{CC} < 4.5 V, I _{OL} = 8 mA | | | | | |
| | | The pin doubled as USB I/O | USBV _{CC} ≥ 4.5 V, I _{OL} = 18.5 mA | V _{SS} | - | 0.4 | V | *1 |
| | | | USBV _{CC} < 4.5 V, I _{OL} = 10.5 mA | | | | | |
| | | The pin doubled as I ² C Fm+ | V _{CC} ≥ 4.5 V, I _{OL} = 4 mA | V _{SS} | - | 0.4 | V | At GPIO |
| | | | V _{CC} < 4.5 V, I _{OL} = 3 mA | | | | | At I ² C Fm+ |
| V _{CC} ≤ 4.5 V, I _{OL} = 20 mA | | | | | | | | |
| Input leak current | I _{IL} | - | - | - 5 | - | + 5 | μA | |
| Pull-up resistor value | R _{PU} | Pull-up pin | V _{CC} ≥ 4.5 V | 25 | 50 | 100 | kΩ | |
| | | | V _{CC} < 4.5 V | 30 | 80 | 200 | | |
| Input capacitance | C _{IN} | Other than V _{CC} , USBV _{CC0} , USBV _{CC1} , V _{BAT} , V _{SS} , AV _{CC} , AV _{SS} , AV _{RH} | - | - | 5 | 15 | pF | |

*1: USBV_{cc0} and USBV_{cc1} are described as USBV_{cc}.

12.4 AC Characteristics

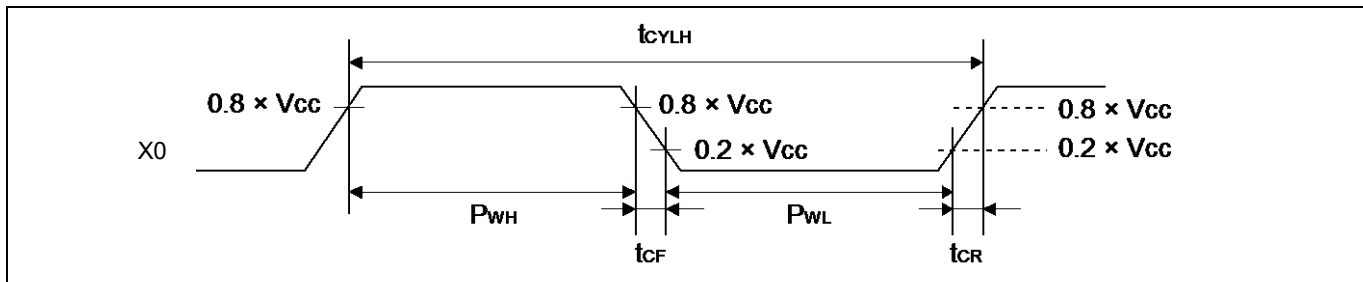
12.4.1 Main Clock Input Characteristics

($V_{CC} = AV_{CC} = 2.7\text{ V to }5.5\text{ V}$, $V_{SS} = AV_{SS} = 0\text{ V}$, $T_a = -40\text{ }^\circ\text{C to }+105\text{ }^\circ\text{C}$)

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|---|------------------------|-----------|--|-------|-----|------|--------------------------------------|
| | | | | Min | Max | | |
| Input frequency | f_{CH} | X0, X1 | $V_{CC} \geq 4.5\text{ V}$ | 4 | 48 | MHz | When crystal oscillator is connected |
| | | | $V_{CC} < 4.5\text{ V}$ | 4 | 20 | | |
| | | | $V_{CC} \geq 4.5\text{ V}$ | 4 | 48 | MHz | When using external clock |
| | | | $V_{CC} < 4.5\text{ V}$ | 4 | 20 | | |
| Input clock cycle | t_{CYLH} | | $V_{CC} \geq 4.5\text{ V}$ | 20.83 | 250 | ns | When using external clock |
| | | | $V_{CC} < 4.5\text{ V}$ | 50 | 250 | | |
| Input clock pulse width | - | | P_{WH}/t_{CYLH} , P_{WL}/t_{CYLH} | 45 | 55 | % | When using external clock |
| Input clock rise time and fall time | t_{CF} , t_{CR} | | - | - | 5 | ns | When using external clock |
| | | | | | | | |
| Internal operating clock *1 frequency | f_{CC} | - | - | - | 200 | MHz | Base clock (HCLK/FCLK) |
| | f_{CP0} | - | - | - | 100 | MHz | APB0bus clock *2 |
| | f_{CP1} | - | - | - | 200 | MHz | APB1bus clock *2 |
| | f_{CP2} | - | - | - | 100 | MHz | APB2bus clock *2 |
| Internal operating clock *1 cycle time | t_{CYCC} | - | - | 5 | - | ns | Base clock (HCLK/FCLK) |
| | t_{CYCP0} | - | - | 10 | - | ns | APB0bus clock *2 |
| | t_{CYCP1} | - | - | 5 | - | ns | APB1bus clock *2 |
| | t_{CYCP2} | - | - | 10 | - | ns | APB2bus clock *2 |

*1: For more information about each internal operating clock, see "CHAPTER 2-1: Clock" in FM4 Family Peripheral Manual Main Part (002-04856).

*2: For more about each APB bus to which each peripheral is connected, see 8. Block Diagram in this data sheet.

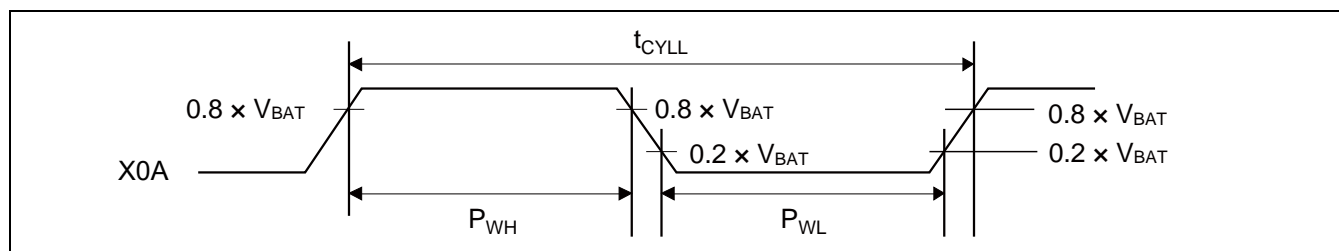


12.4.2 Sub Clock Input Characteristics

 (V_{BAT} = 1.65 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | Value | | | Unit | Remarks |
|-------------------------|---------------------|-------------|--|-------|--------|-------|------|--|
| | | | | Min | Typ | Max | | |
| Input frequency | 1/t _{CYLL} | X0A, X1A | - | - | 32.768 | - | kHz | When crystal oscillator is connected * |
| | | | - | 32 | - | 100 | | kHz |
| Input clock cycle | t _{CYLL} | | - | 10 | - | 31.25 | μs | When using external clock |
| Input clock pulse width | - | | P _{WH} /t _{CYLL} , P _{WL} /t _{CYLL} | 45 | - | 55 | % | When using external clock |

*: For more information about crystal oscillator, see Sub crystal oscillator in 7. Handling Devices.


12.4.3 Built-In CR Oscillation Characteristics
Built-In High-speed CR

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Conditions | Value | | | Unit | Remarks |
|------------------------------|-------------------|----------------------------------|-------|-----|------|------|-------------------|
| | | | Min | Typ | Max | | |
| Clock frequency | f _{CRH} | T _J = -20°C to +105°C | 3.92 | 4 | 4.08 | MHz | When trimming *1 |
| | | T _J = -40°C to +125°C | 3.88 | 4 | 4.12 | | When not trimming |
| | | T _J = -40°C to +125°C | 3 | 4 | 5 | | |
| Frequency stabilization time | t _{CRWT} | - | - | - | 30 | μs | *2 |

*1: In the case of using the values in CR trimming area of flash memory at shipment for frequency/temperature trimming

*2: This is the time to stabilize the frequency of the High-speed CR clock after setting trimming value. During this period, it is able to use the High-speed CR clock as a source clock.

Built-In Low-speed CR

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Condition | Value | | | Unit | Remarks |
|-----------------|------------------|-----------|-------|-----|-----|------|---------|
| | | | Min | Typ | Max | | |
| Clock frequency | f _{CRL} | - | 50 | 100 | 150 | kHz | |

12.4.4 Operating Conditions of Main PLL (in the Case of Using Main Clock for Input Clock of PLL)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Value | | | Unit | Remarks |
|---|---------------------|-------|-----|-----|------------|---------|
| | | Min | Typ | Max | | |
| PLL oscillation stabilization wait time* ¹ (lock up time) | t _{LOCK} | 100 | - | - | μs | |
| PLL input clock frequency | f _{PLLI} | 4 | - | 16 | MHz | |
| PLL multiplication rate | - | 13 | - | 100 | multiplier | |
| PLL macro oscillation clock frequency | f _{PLLO} | 200 | - | 400 | MHz | |
| Main PLL clock frequency* ² | f _{CLKPLL} | - | - | 200 | MHz | |

*1: Time from when the PLL starts operating until the oscillation stabilizes

*2: For more information about Main PLL clock (CLKPLL), see Chapter 2-1: Clock in FM4 Family Peripheral Manual Main Part (002-04856).

12.4.5 Operating Conditions of USB PLL · I²S PLL (in the Case of Using Main Clock for Input Clock of PLL)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Value | | | Unit | Remarks |
|---|---------------------|-------|-----|--------|------------|--------------------------------|
| | | Min | Typ | Max | | |
| PLL oscillation stabilization wait time* ¹ (lock up time) | t _{LOCK} | 100 | - | - | μs | |
| PLL input clock frequency | f _{PLLI} | 4 | - | 16 | MHz | |
| PLL multiplication rate | - | 13 | - | 100 | multiplier | |
| PLL macro oscillation clock frequency | f _{PLLO} | 200 | - | 400 | MHz | USB |
| | | | | 384 | MHz | I ² S |
| USB clock frequency * ² | f _{CLKPLL} | - | - | 50 | MHz | After the M frequency division |
| I ² S clock frequency * ³ | f _{CLKPLL} | - | - | 12.288 | MHz | After the M frequency division |

*1: Time from when the PLL starts operating until the oscillation stabilizes

*2: For more information about USB/Ethernet clock, see Chapter 2-2: USB/Ethernet Clock Generation in FM4 Family Peripheral Manual Communication Macro Part (002-04862).

*3: For more information about I²S clock, see Chapter 7-1: I²S Clock Generation in FM4 Family Peripheral Manual Communication Macro Part (002-04862).

12.4.6 Operating Conditions of Main PLL (in the Case of Using Built-in High-speed CR Clock for Input Clock of Main PLL)
 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Value | | | Unit | Remarks |
|---|---------------------|-------|-----|-----|------------|---------|
| | | Min | Typ | Max | | |
| PLL oscillation stabilization wait time ^{*1} (lock up time) | t _{LOCK} | 100 | - | - | μs | |
| PLL input clock frequency | f _{PLLI} | 3.8 | 4 | 4.2 | MHz | |
| PLL multiplication rate | - | 50 | - | 95 | multiplier | |
| PLL macro oscillation clock frequency | f _{PLO} | 190 | - | 400 | MHz | |
| Main PLL clock frequency ^{*2} | f _{CLKPLL} | - | - | 200 | MHz | |

*1: Time from when the PLL starts operating until the oscillation stabilizes

*2: For more information about Main PLL clock (CLKPLL), see Chapter 2-1: Clock in FM4 Family Peripheral Manual Main Part (002-04856).

Note:

- The High-speed CR clock (CLKHC) should be set with frequency/temperature trimming to act as the source clock of the Main PLL.

12.4.7 Reset Input Characteristics

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|------------------|--------------------|----------|------------|-------|-----|------|---------|
| | | | | Min | Typ | | |
| Reset input time | t _{INITX} | INITX | - | 500 | - | ns | |

12.4.8 Power-On Reset Timing

(V_{SS} = 0 V)

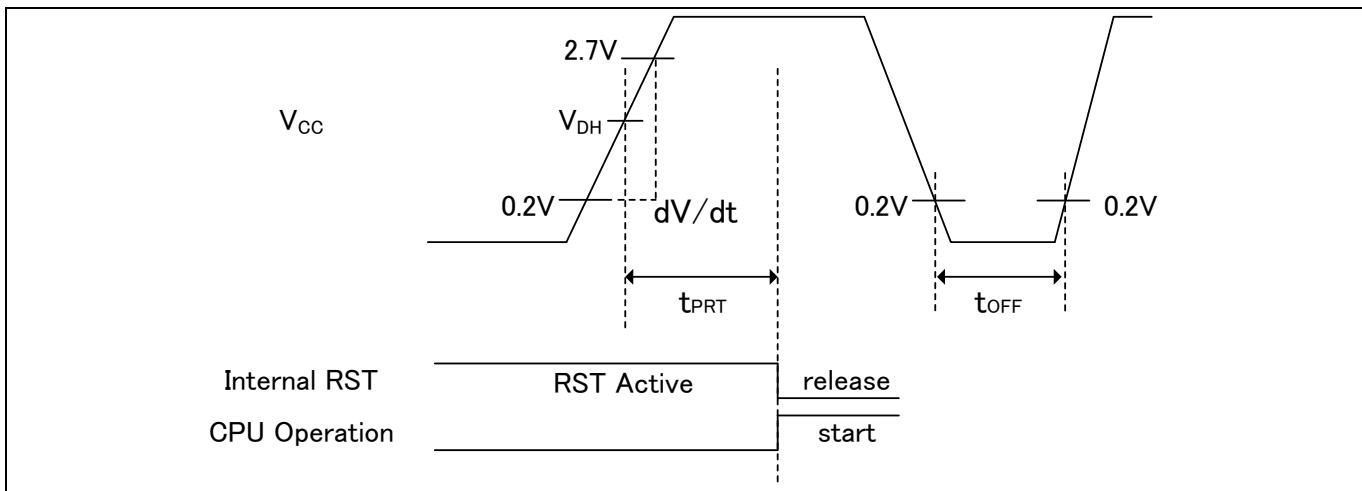
| Parameter | Symbol | Pin Name | Conditions | Value | | | Unit | Remarks |
|-------------------------------------|------------------|----------|-----------------------------------|-------|-----|------|-------|---------|
| | | | | Min | Typ | Max | | |
| Power supply shut down time | t _{OFF} | VCC | - | 1 | - | - | ms | *1 |
| Power ramp rate | dV/dt | | V _{CC} : 0.2 V to 2.70 V | 0.6 | - | 1000 | mV/μs | *2 |
| Time until releasing Power-on reset | t _{PRT} | | - | 0.33 | - | 0.60 | ms | |

*1: V_{CC} must be held below 0.2 V for a minimum period of t_{OFF}. Improper initialization may occur if this condition is not met.

*2: This dV/dt characteristic is applied at the power-on of cold start (t_{OFF}>1ms).

Note:

- If t_{OFF} cannot be satisfied designs must assert external reset(INITX) at power-up and at any brownout event per 12. 4. 7.



Glossary

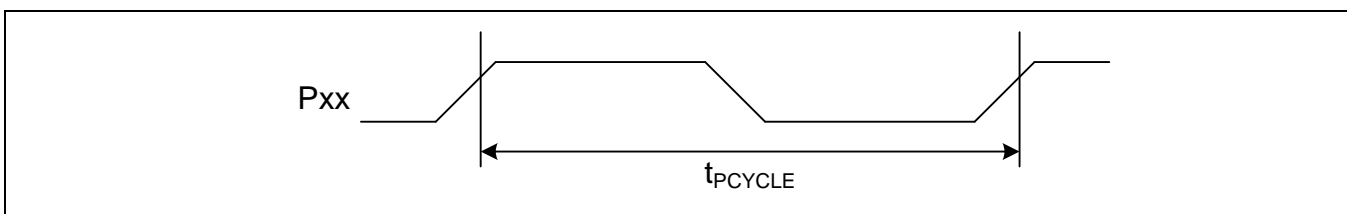
□ V_{DH}: detection voltage of Low Voltage detection reset. See “12.8. Low-Voltage Detection Characteristics”.

12.4.9 GPIO Output Characteristics

(V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|------------------|---------------------|----------|-------------------------|-------|-----|------|---------|
| | | | | Min | Typ | | |
| Output frequency | t _{PCYCLE} | Pxx* | V _{CC} ≥ 4.5 V | - | 50 | MHz | |
| | | | V _{CC} < 4.5 V | - | 32 | MHz | |

*: GPIO is a target.



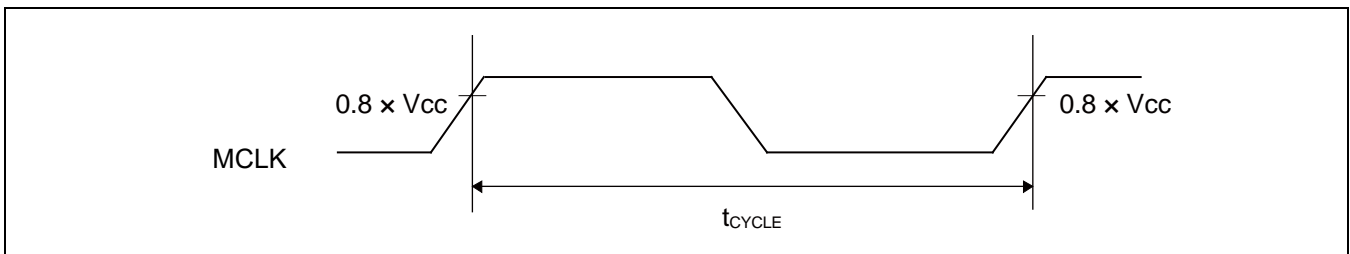
12.4.10 External Bus Timing

External Bus Clock Output Characteristics

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|------------------|--------------------|------------|------------|-------|-------|------|---------|
| | | | | Min | Typ | | |
| Output frequency | t _{CYCLE} | MCLKOUT *1 | | - | 50 *2 | MHz | |

*1: The external bus clock (MCLKOUT) is a divided clock of HCLK.
 For more information about setting of clock divider, see Chapter 14: External Bus Interface in FM4 Family Peripheral Manual Main Part (002-04856).

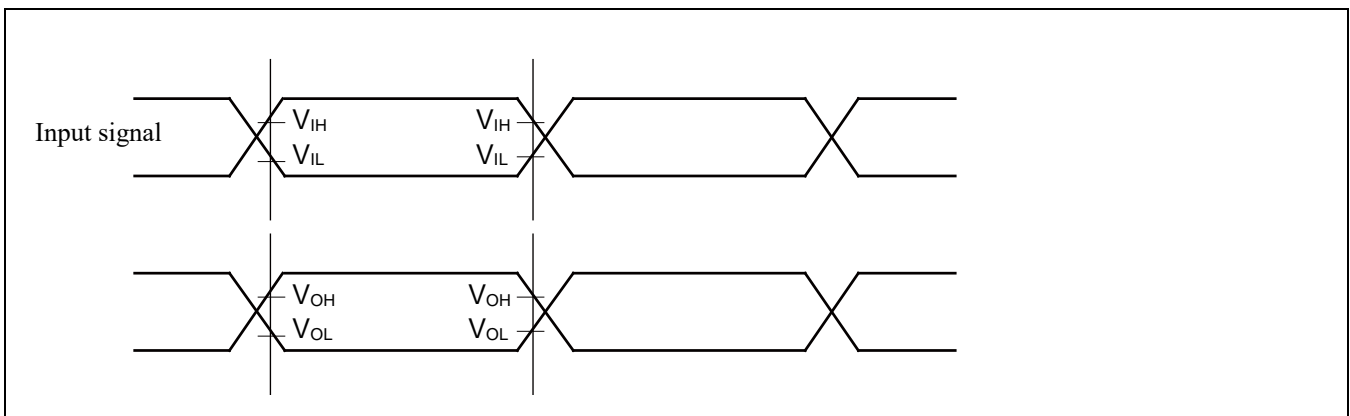
*2: Generate MCLKOUT at setting more than four divisions when the AHB bus clock exceeds 100 MHz.



External Bus Signal I/O Characteristics

(V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Conditions | Value | Unit | Remarks |
|-------------------------------|-----------------|------------|-----------------------|------|---------|
| Signal input characteristics | V _{IH} | - | 0.8 x V _{CC} | V | |
| | V _{IL} | | 0.2 x V _{CC} | V | |
| Signal output characteristics | V _{OH} | | 0.8 x V _{CC} | V | |
| | V _{OL} | | 0.2 x V _{CC} | V | |

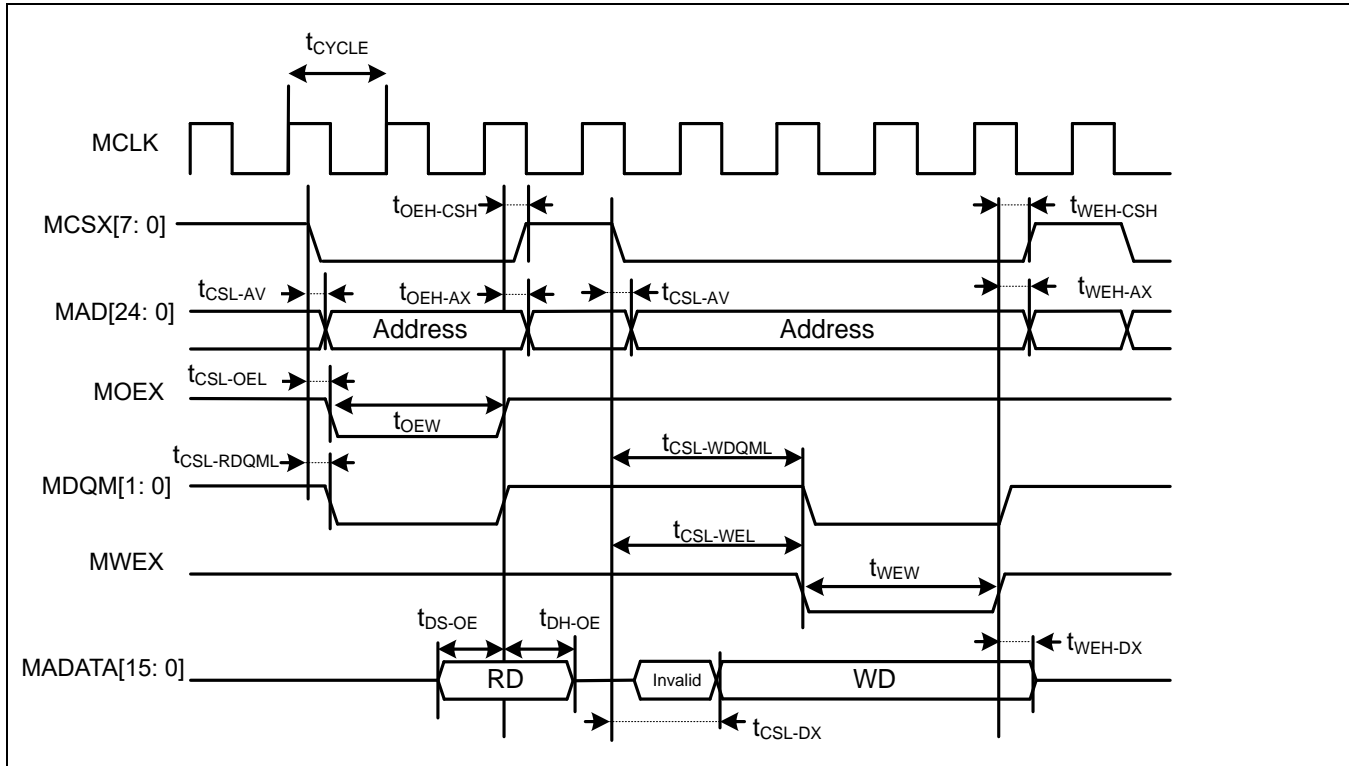


Separate Bus Access Asynchronous SRAM Mode
(V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|---------------------------------------|--------------------------|---------------------------|------------|----------|----------|------|---------|
| | | | | Min | Max | | |
| MOEX Minimum pulse width | t _{OE} | MOEX | - | MCLK×n-3 | - | ns | |
| MCSX ↓ → Address output delay time | t _{CSL - AV} | MCSX[7: 0], MAD[24: 0] | - | -9 | +9 | ns | |
| MOEX ↑ → Address hold time | t _{OE} - AX | MOEX, MAD[24: 0] | - | 0 | MCLK×m+9 | ns | |
| MCSX ↓ → MOEX ↓ delay time | t _{CSL - OEL} | MOEX, MCSX[7: 0] | - | MCLK×m-9 | MCLK×m+9 | ns | |
| MOEX ↑ → MCSX ↑ time | t _{OE} - CSH | | - | 0 | MCLK×m+9 | ns | |
| MCSX ↓ → MDQM ↓ delay time | t _{CSL - RDQML} | MCSX, MDQM[3: 0] | - | MCLK×m-9 | MCLK×m+9 | ns | |
| Data set up → MOEX ↑ time | t _{DS - OE} | MOEX, MADATA[31: 0] | - | 20 | - | ns | |
| MOEX ↑ → Data hold time | t _{DH - OE} | MOEX, MADATA[31: 0] | - | 0 | - | ns | |
| MWEX Minimum pulse width | t _{WE} | MWEX | - | MCLK×n-3 | - | ns | |
| MWEX ↑ → Address output delay time | t _{WE} - AX | MWEX, MAD[24: 0] | - | 0 | MCLK×m+9 | ns | |
| MCSX ↓ → MWEX ↓ delay time | t _{CSL - WEL} | MWEX, MCSX[7: 0] | - | MCLK×n-9 | MCLK×n+9 | ns | |
| MWEX ↑ → MCSX ↑ delay time | t _{WE} - CSH | | - | 0 | MCLK×m+9 | ns | |
| MCSX ↓ → MDQM ↓ delay time | t _{CSL - WDQML} | MCSX, MDQM[3: 0] | - | MCLK×n-9 | MCLK×n+9 | ns | |
| MCSX ↓ → Data output time | t _{CSL - DX} | MCSX, MADATA[31: 0] | - | MCLK-9 | MCLK+9 | ns | |
| MWEX ↑ → Data hold time | t _{WE} - DX | MWEX, MADATA[31: 0] | - | 0 | MCLK×m+9 | ns | |

Note:

- When the external load capacitance C_L = 30 pF (m = 0 to 15, n = 1 to 16)

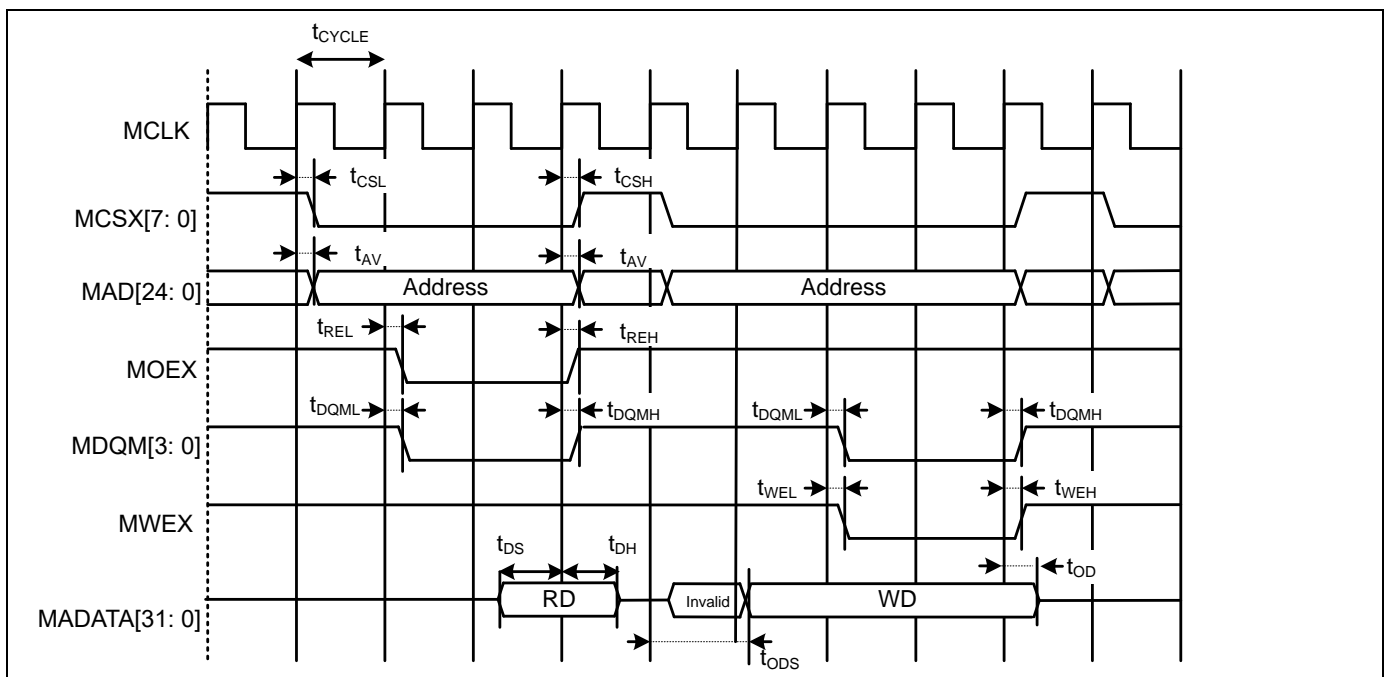


Separate Bus Access Synchronous SRAM Mode
 $(V_{CC} = 2.7\text{ V to } 5.5\text{ V}, V_{SS} = 0\text{ V})$

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|------------------------------|------------|------------------------|------------|----------|-----------|------|---------|
| | | | | Min | Max | | |
| Address delay time | t_{AV} | MCLK, MAD[24: 0] | - | 1 | 9 | ns | |
| MCSX delay time | t_{CSL} | MCLK, MCSX[7: 0] | - | 1 | 9 | ns | |
| | t_{CSH} | | - | 1 | 9 | ns | |
| MOEX delay time | t_{REL} | MCLK, MOEX | - | 1 | 9 | ns | |
| | t_{REH} | | - | 1 | 9 | ns | |
| Data set up →MCLK ↑ time | t_{DS} | MCLK, MADATA[31: 0] | - | 19 | - | ns | |
| MCLK ↑ → Data hold time | t_{DH} | MCLK, MADATA[31: 0] | - | 0 | - | ns | |
| MWEX delay time | t_{WEL} | MCLK, MWEX | - | 1 | 9 | ns | |
| | t_{WEH} | | - | 1 | 9 | ns | |
| MDQM[1: 0] delay time | t_{DQML} | MCLK, MDQM[3: 0] | - | 1 | 9 | ns | |
| | t_{DQMH} | | - | 1 | 9 | ns | |
| MCLK ↑ → Data output time | t_{ODS} | MCLK, MADATA[31: 0] | - | MCLK + 1 | MCLK + 18 | ns | |
| MCLK ↑ → Data hold time | t_{OD} | MCLK, MADATA[31: 0] | - | 1 | 18 | ns | |

Note:

- When the external load capacitance $C_L = 30\text{ pF}$



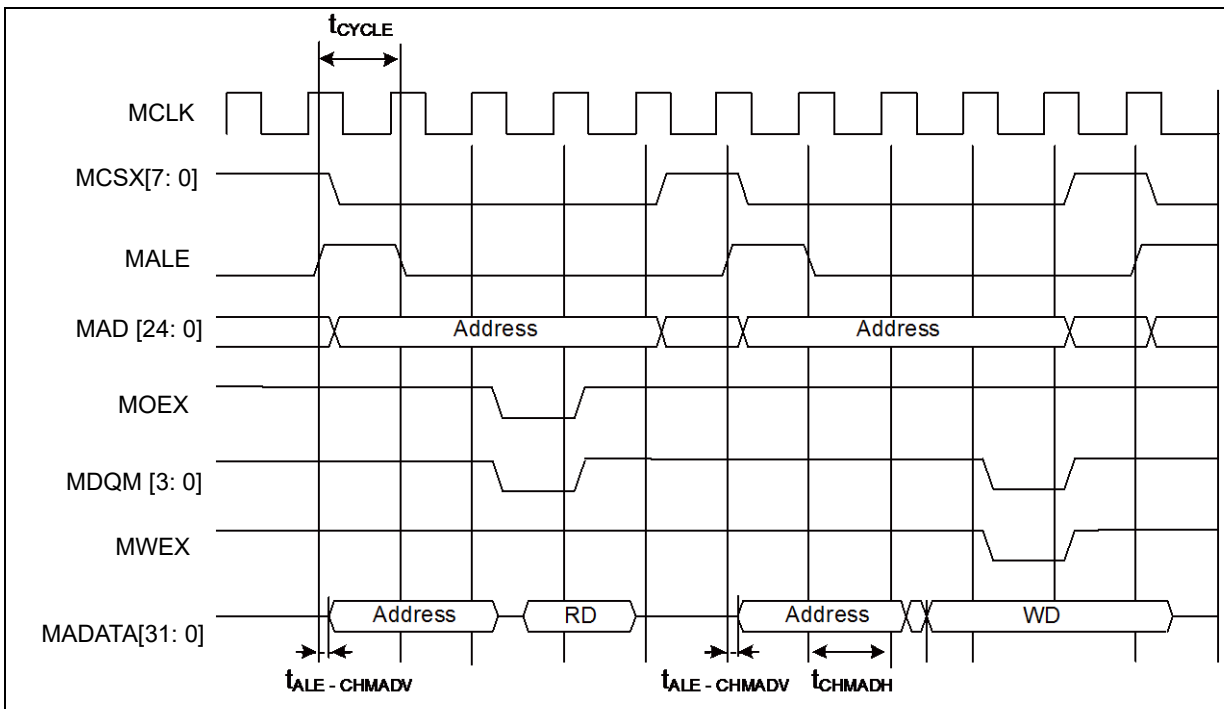
Multiplexed Bus Access Asynchronous SRAM Mode

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|--------------------------------|-------------------------|---------------------|------------|-----------------|------------------|------|---------|
| | | | | Min | Max | | |
| Multiplexed address delay time | t _{ALE-CHMADV} | MALE, MAD[24: 0] | - | 0 | 10 | ns | |
| Multiplexed address hold time | t _{CHMADH} | | - | MCLK × n + 0 | MCLK × n + 10 | ns | |

Note:

- When the external load capacitance C_L = 30 pF (m = 0 to 15, n = 1 to 16)



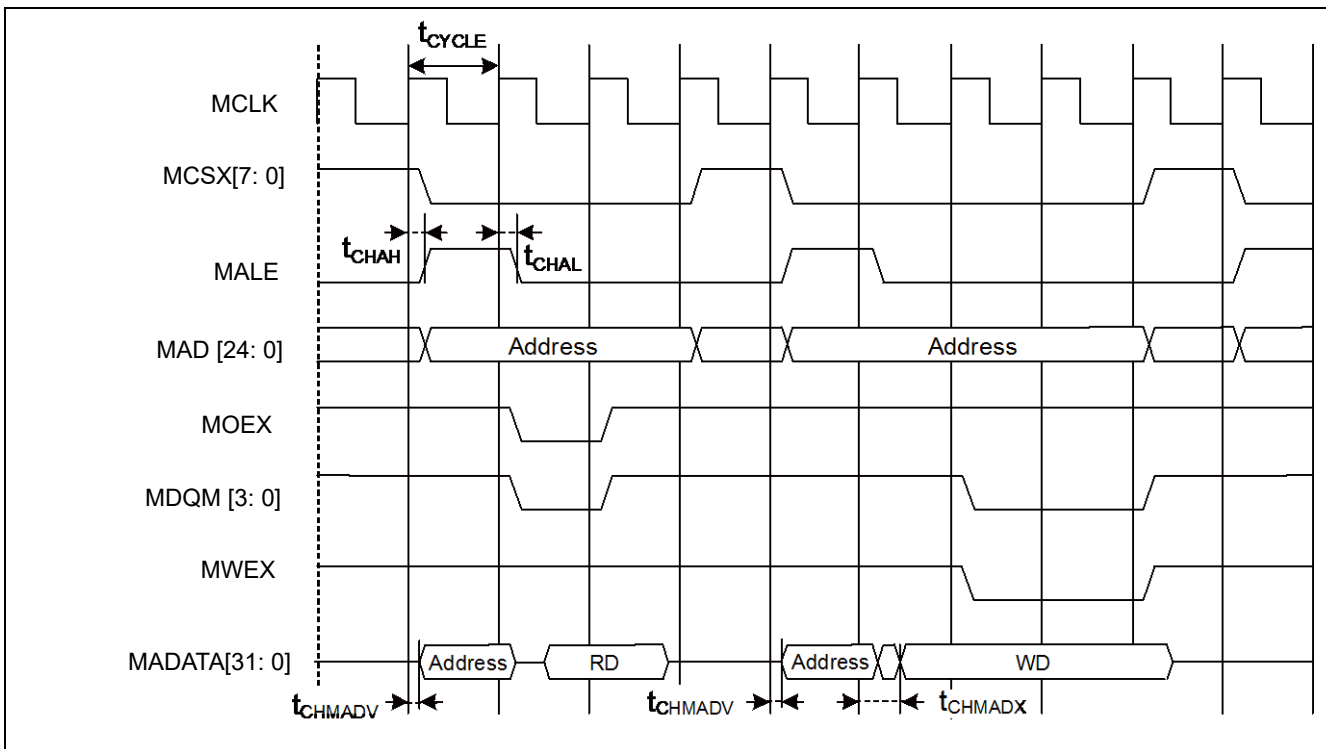
Multiplexed Bus Access Synchronous SRAM Mode

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|---|---------------------|------------------------|------------|-------|-----------------|------|---------|
| | | | | Min | Max | | |
| MALE delay time | t _{CHAL} | MCLK, MALE | - | 1 | 9 | | |
| | t _{CHAH} | | - | 1 | 9 | | |
| MCLK ↑ → Multiplexed address delay time | t _{CHMADV} | MCLK, MADATA[31: 0] | - | 1 | t _{OD} | ns | |
| MCLK ↑ → Multiplexed data output time | t _{CHMADX} | | - | 1 | t _{OD} | ns | |

Note:

- When the external load capacitance C_L = 30 pF



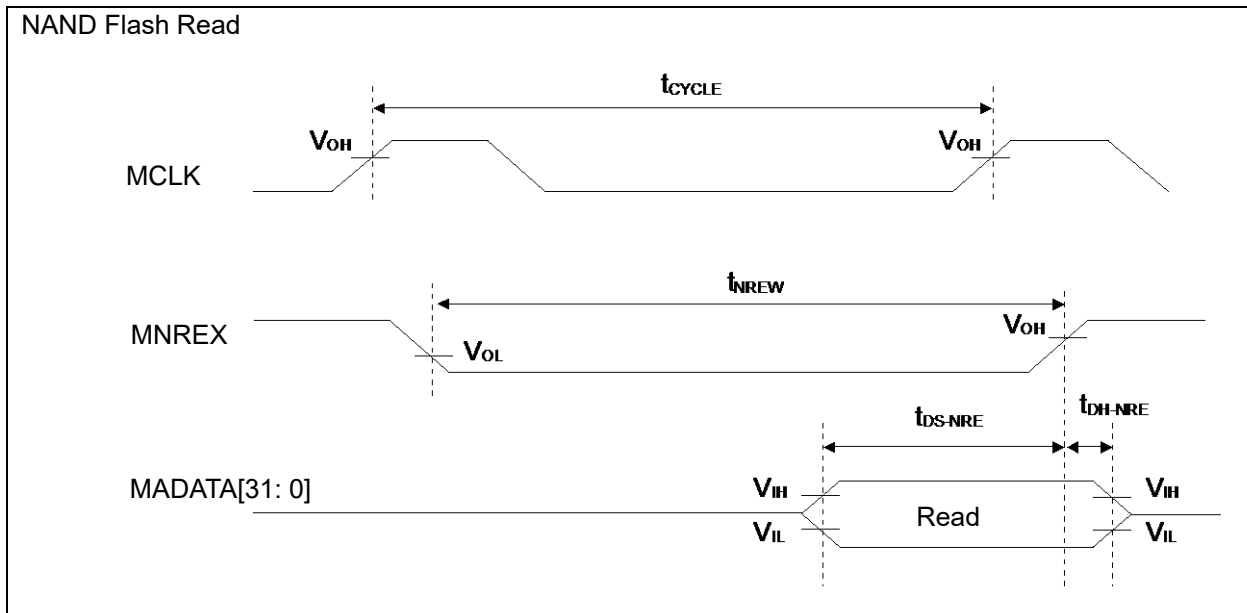
NAND Flash Mode

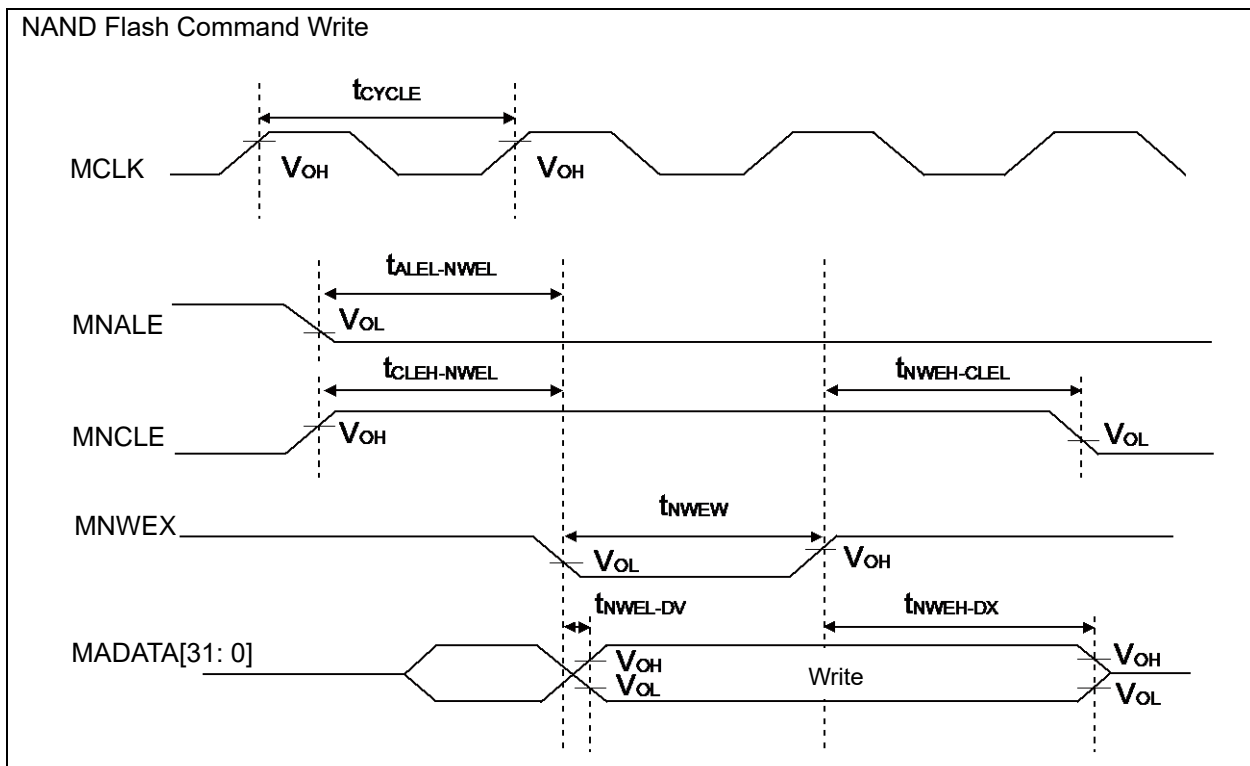
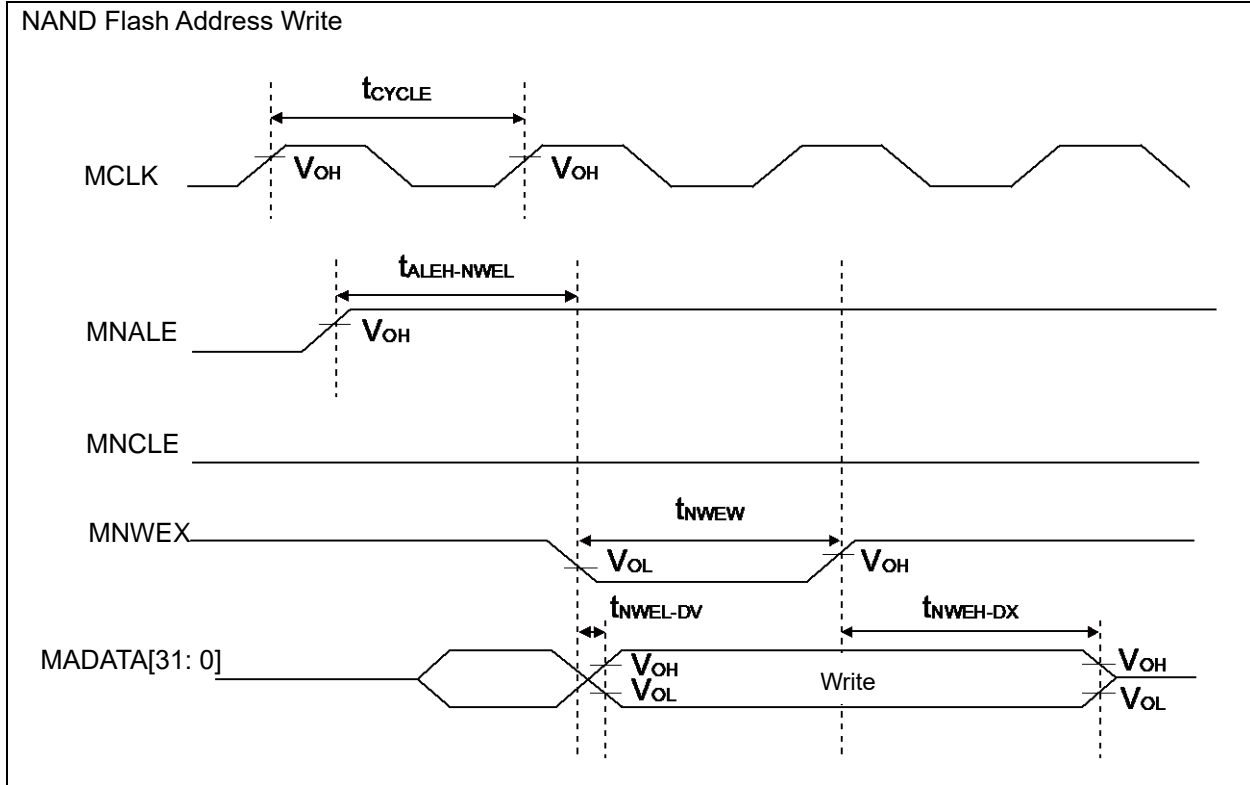
($V_{CC} = 2.7\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$)

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|-------------------------------|-----------------|-------------------------|------------|---------------------|---------------------|------|---------|
| | | | | Min | Max | | |
| MNREX Min pulse width | t_{NREW} | MNREX | - | $MCLK \times n - 3$ | - | ns | |
| Data set up →MNREX ↑ time | t_{DS-NRE} | MNREX, MADATA[31: 0] | - | 20 | - | ns | |
| MNREX ↑ → Data hold time | t_{DH-NRE} | MNREX, MADATA[31: 0] | - | 0 | - | ns | |
| MNALE ↑ → MNWEX delay time | $t_{ALEH-NWEL}$ | MNALE, MNWEX | - | $MCLK \times m - 9$ | $MCLK \times m + 9$ | ns | |
| MNALE ↓ → MNWEX delay time | $t_{ALEL-NWEL}$ | MNALE, MNWEX | - | $MCLK \times m - 9$ | $MCLK \times m + 9$ | ns | |
| MNCLE ↑ → MNWEX delay time | $t_{CLEH-NWEL}$ | MNCLE, MNWEX | - | $MCLK \times m - 9$ | $MCLK \times m + 9$ | ns | |
| MNWEH ↑ → MNCLE delay time | $t_{NWEH-CLEL}$ | MNCLE, MNWEX | - | 0 | $MCLK \times m + 9$ | ns | |
| MNWEH Min pulse width | t_{NWEW} | MNWEH | - | $MCLK \times n - 3$ | - | ns | |
| MNWEH ↓ → Data output time | $t_{NWEH-DV}$ | MNWEH, MADATA[31: 0] | - | -9 | 9 | ns | |
| MNWEH ↑ → Data hold time | $t_{NWEH-DX}$ | MNWEH, MADATA[31: 0] | - | 0 | $MCLK \times m + 9$ | ns | |

Note:

- When the external load capacitance $C_L = 30\text{ pF}$ ($m = 0\text{ to }15$, $n = 1\text{ to }16$)

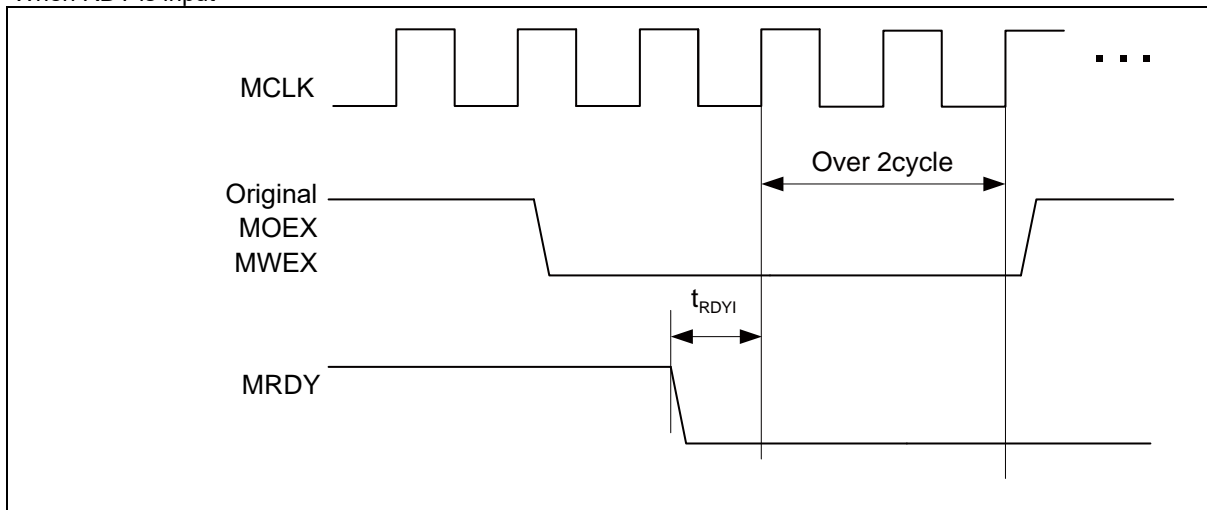
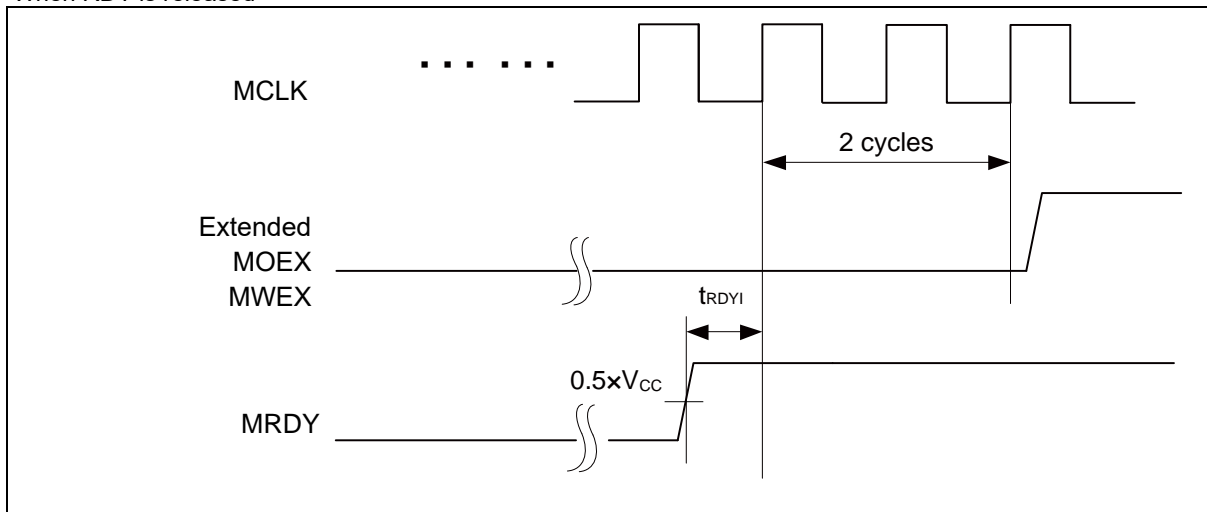




External Ready Input Timing

 ($V_{CC} = 2.7\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$)

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|-----------------------------------|------------|---------------|------------|-------|-----|------|---------|
| | | | | Min | Max | | |
| MCLK↑ MRDY input setup time | t_{RDYI} | MCLK, MRDY | - | 19 | - | ns | |

■ When RDY is input

■ When RDY is released


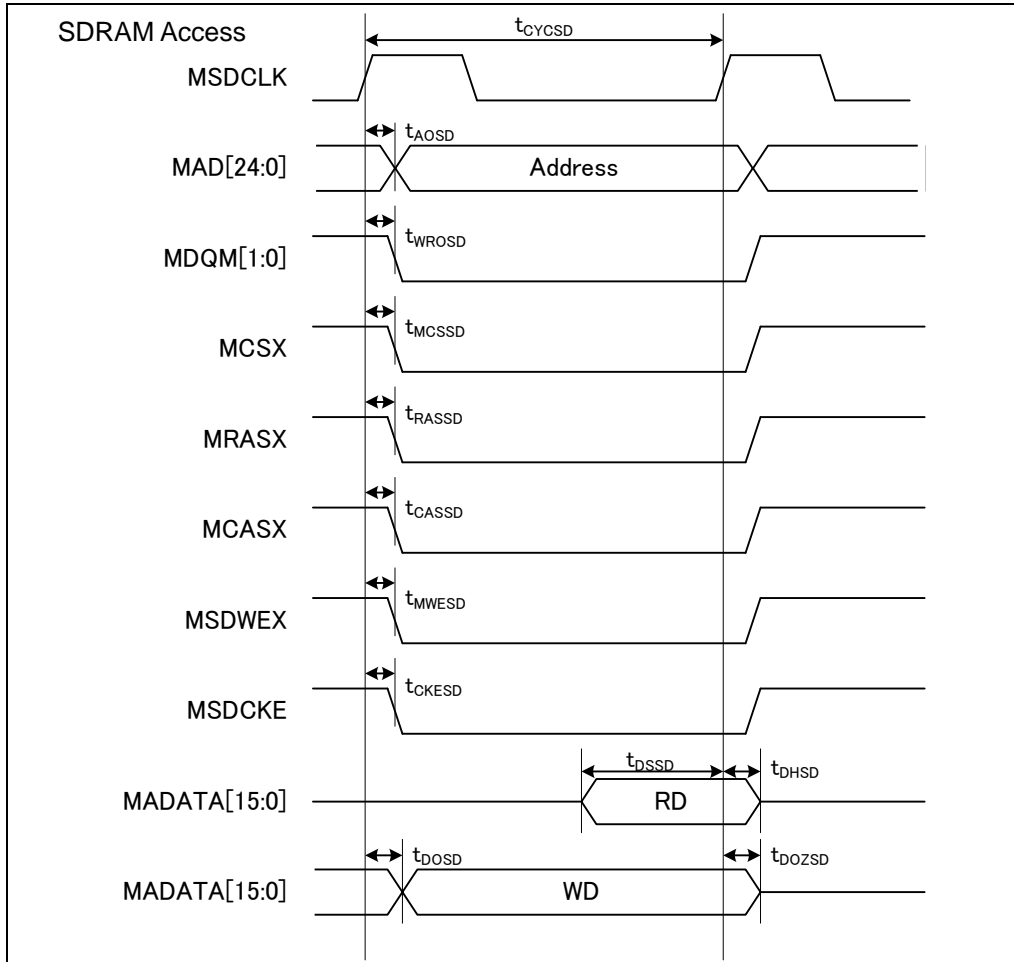
SDRAM Mode

 (V_{CC} = 2.7 V to 3.6 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Value | Unit | | Unit | Remarks |
|--------------------------------------|---------------------|--------------------------|-------|------|------|------|---------|
| | | | | Min | Max | | |
| Output frequency | t _{CYCS} D | MSDCLK | - | - | 50 | MHz | |
| Address delay time | t _{AOS} D | MSDCLK, MAD[15: 0] | - | 2 | 12 | ns | |
| MSDCLK ↑ → Data output delay time | t _{DOS} D | MSDCLK, MADATA[31: 0] | - | 2 | 12 | ns | |
| MSDCLK ↑ → Data output Hi-Z time | t _{DOZ} S | MSDCLK, MADATA[31: 0] | - | 2 | 19.5 | ns | |
| MDQM[3: 0] delay time | t _{WROS} D | MSDCLK, MDQM[1: 0] | - | 1 | 12 | ns | |
| MCSX delay time | t _{MCSS} D | MSDCLK, MCSX8 | - | 2 | 12 | ns | |
| MRASX delay time | t _{RASS} D | MSDCLK, MRASX | - | 2 | 12 | ns | |
| MCASX delay time | t _{CASS} D | MSDCLK, MCASX | - | 2 | 12 | ns | |
| MSDWEX delay time | t _{MWES} D | MSDCLK, MSDWEX | - | 2 | 12 | ns | |
| MSDCKE delay time | t _{CKES} D | MSDCLK, MSDCKE | - | 2 | 12 | ns | |
| Data set up time | t _{DSS} D | MSDCLK, MADATA[31: 0] | - | 19 | - | ns | |
| Data hold time | t _{DHS} D | MSDCLK, MADATA[31: 0] | - | 0 | - | ns | |

Note:

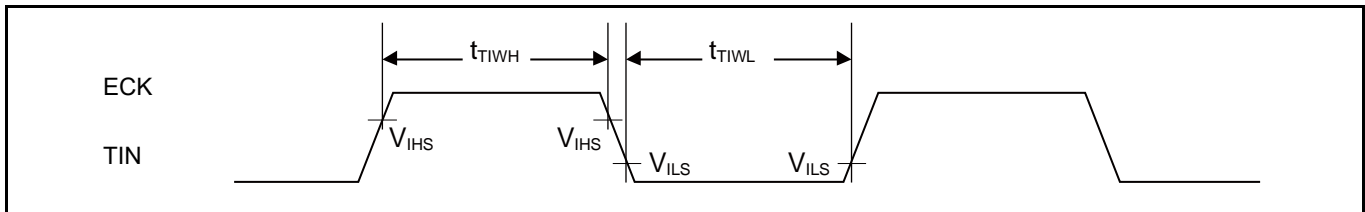
- When the external load capacitance C_L = 30 pF



12.4.11 Base Timer Input Timing
Timer Input Timing

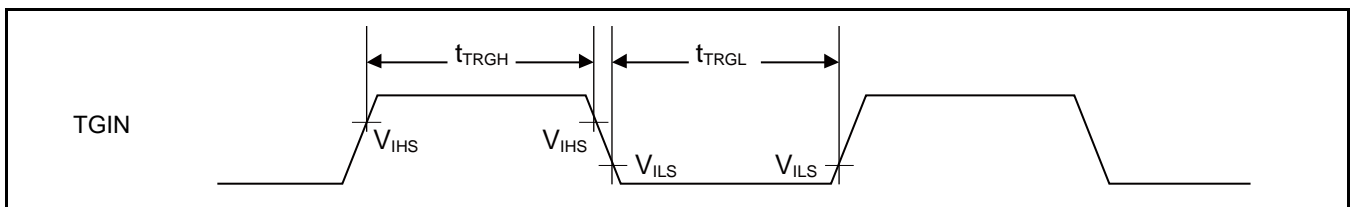
 ($V_{CC} = 2.7\text{ V to } 5.5\text{ V}$, $V_{SS} = 0\text{ V}$)

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|-------------------|-------------------------|---|------------|-------------|-----|------|---------|
| | | | | Min | Max | | |
| Input pulse width | t_{TIWH} , t_{TIWL} | TIOAn/TIOBn (when using as ECK, TIN) | - | $2t_{CYCP}$ | - | ns | |


Trigger Input Timing

 ($V_{CC} = 2.7\text{ V to } 5.5\text{ V}$, $V_{SS} = 0\text{ V}$)

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|-------------------|-------------------------|-------------------------------------|------------|-------------|-----|------|---------|
| | | | | Min | Max | | |
| Input pulse width | t_{TRGH} , t_{TRGL} | TIOAn/TIOBn (when using as TGIN) | - | $2t_{CYCP}$ | - | ns | |


Note:

- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the base timer is connected, see 8. Block Diagram in this data sheet.

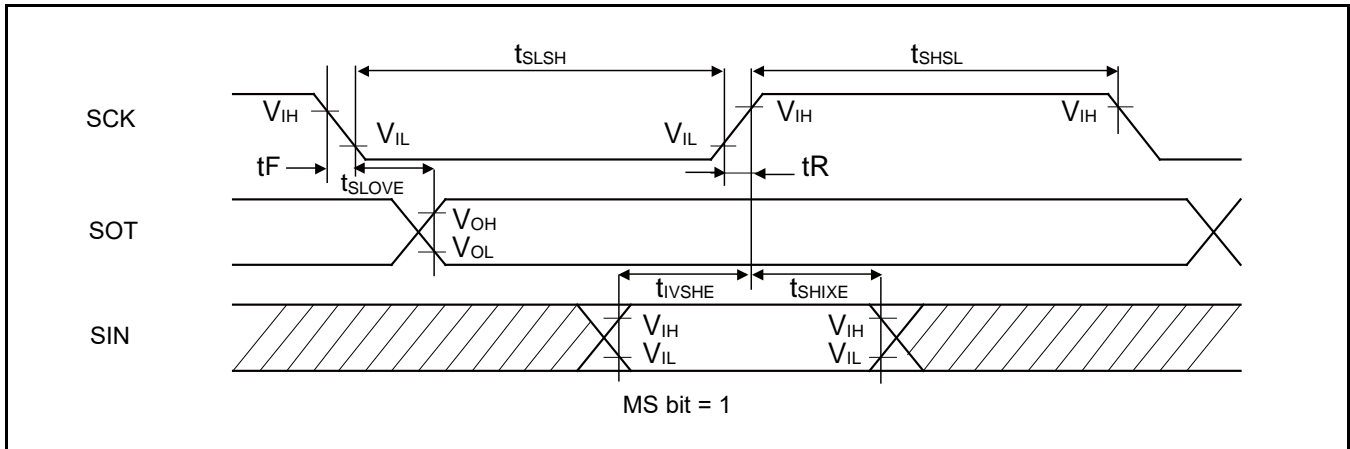
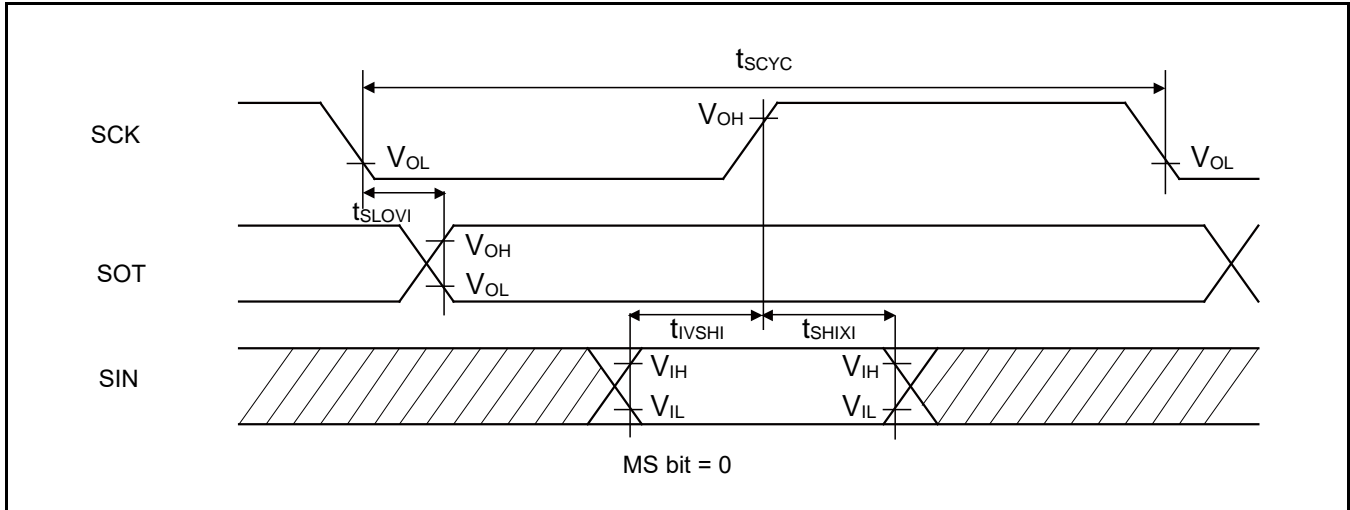
12.4.12 CSIO (SPI) Timing
Synchronous Serial (SPI = 0, SCINV = 0)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | V _{CC} < 4.5 V | | V _{CC} ≥ 4.5 V | | Unit |
|----------------------------|--------------------|------------|--------------------------------|-------------------------|------------------------|-------------------------|-----|------|
| | | | | Min | Max | Min | Max | |
| Baud rate | - | - | | - | 8 | - | 8 | Mbps |
| Serial clock cycle time | t _{SCYC} | SCKx | Internal shift clock operation | 4t _{CYCP} | - | 4t _{CYCP} | - | ns |
| SCK↓→SOT delay time | t _{SLOVI} | SCKx, SOTx | | -30 | +30 | -20 | +20 | ns |
| SIN→SCK↑ setup time | t _{IVSHI} | SCKx, SINx | | 50 | - | 30 | - | ns |
| SCK↑→SIN hold time | t _{SHIXI} | SCKx, SINx | | 0 | - | 0 | - | ns |
| Serial clock L pulse width | t _{SLSH} | SCKx | | 2t _{CYCP} - 10 | - | 2t _{CYCP} - 10 | - | ns |
| Serial clock H pulse width | t _{SHSL} | SCKx | t _{CYCP} + 10 | - | t _{CYCP} + 10 | - | ns | |
| SCK↓→SOT delay time | t _{SLOVE} | SCKx, SOTx | External shift clock operation | - | 50 | - | 30 | ns |
| SIN→SCK↑ setup time | t _{IVSHE} | SCKx, SINx | | 10 | - | 10 | - | ns |
| SCK↑→SIN hold time | t _{SHIXE} | SCKx, SINx | | 20 | - | 20 | - | ns |
| SCK fall time | t _F | SCKx | | - | 5 | - | 5 | ns |
| SCK rise time | t _R | SCKx | | - | 5 | - | 5 | ns |

Notes:

- The above characteristics apply to CLK synchronous mode.
- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- These characteristics only guarantee the same relocate port number; for example, the combination of SCKx_0 and SOTx_1 is not guaranteed.
- When the external load capacitance C_L = 30 pF.



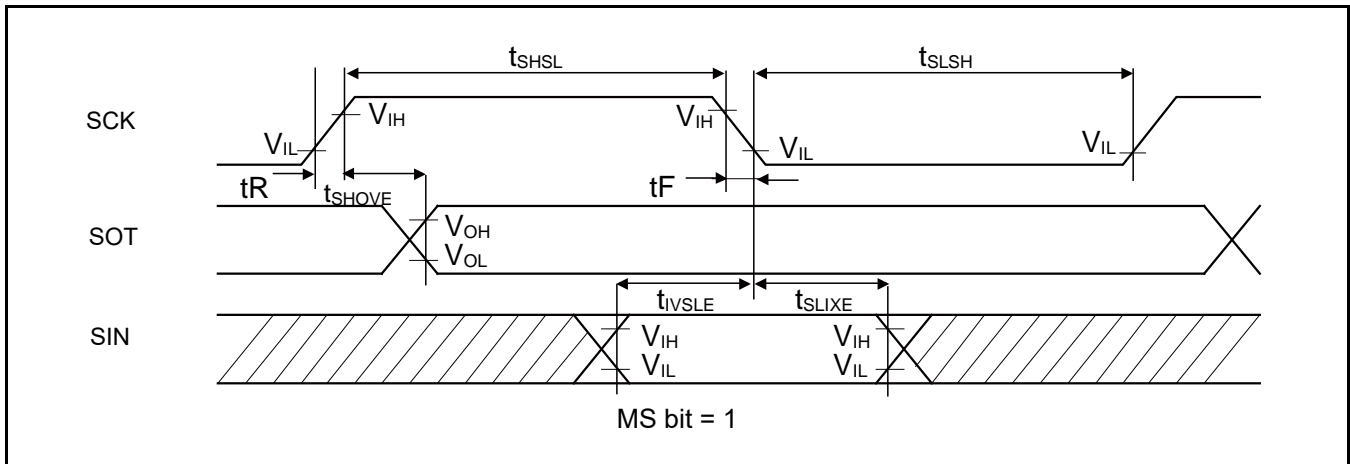
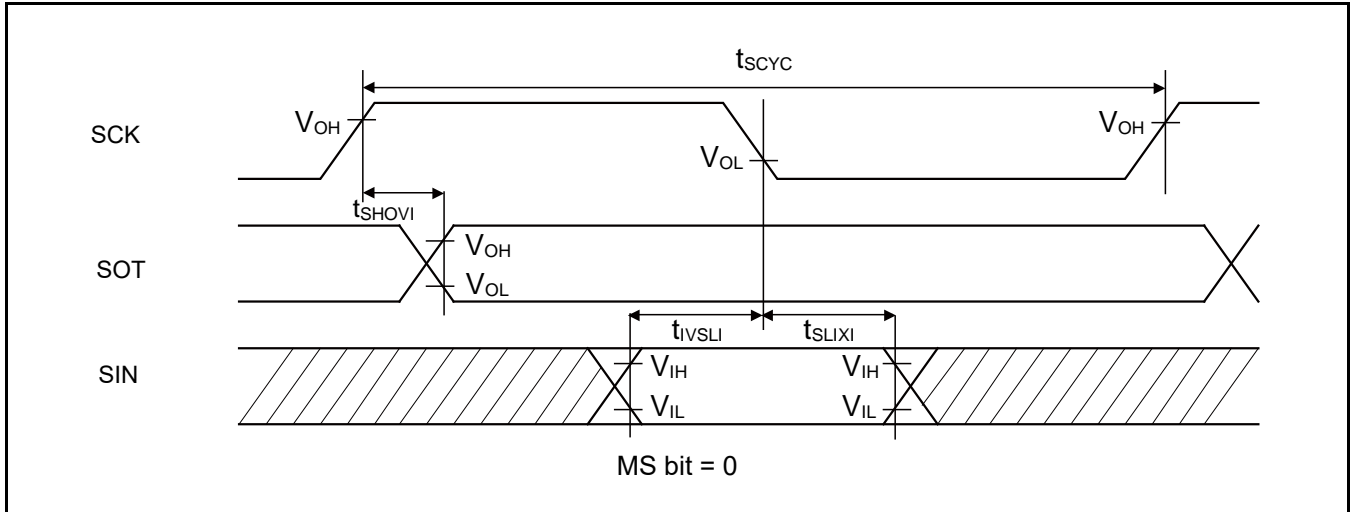
Synchronous Serial (SPI = 0, SCINV = 1)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | V _{CC} < 4.5 V | | V _{CC} ≥ 4.5 V | | Unit |
|----------------------------|--------------------|------------|--------------------------------|-------------------------|------------------------|-------------------------|-----|------|
| | | | | Min | Max | Min | Max | |
| Baud rate | - | - | - | - | 8 | - | 8 | Mbps |
| Serial clock cycle time | t _{SCYC} | SCKx | Internal shift clock operation | 4t _{CYCP} | - | 4t _{CYCP} | - | ns |
| SCK↑→SOT delay time | t _{SHOVI} | SCKx, SOTx | | -30 | +30 | -20 | +20 | ns |
| SIN→SCK↓ setup time | t _{IVSLI} | SCKx, SINx | | 50 | - | 30 | - | ns |
| SCK↓→SIN hold time | t _{SLIXI} | SCKx, SINx | | 0 | - | 0 | - | ns |
| Serial clock L pulse width | t _{SLSH} | SCKx | | 2t _{CYCP} - 10 | - | 2t _{CYCP} - 10 | - | ns |
| Serial clock H pulse width | t _{SHSL} | SCKx | t _{CYCP} + 10 | - | t _{CYCP} + 10 | - | ns | |
| SCK↑→SOT delay time | t _{SHOVE} | SCKx, SOTx | External shift clock operation | - | 50 | - | 30 | ns |
| SIN→SCK↓ setup time | t _{IVSLE} | SCKx, SINx | | 10 | - | 10 | - | ns |
| SCK↓→SIN hold time | t _{SLIXE} | SCKx, SINx | | 20 | - | 20 | - | ns |
| SCK fall time | t _F | SCKx | | - | 5 | - | 5 | ns |
| SCK rise time | t _R | SCKx | | - | 5 | - | 5 | ns |

Notes:

- The above characteristics apply to CLK synchronous mode.
- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- These characteristics only guarantee the same relocate port number; for example, the combination of SCKx_0 and SOTx_1 is not guaranteed.
- When the external load capacitance C_L = 30 pF.



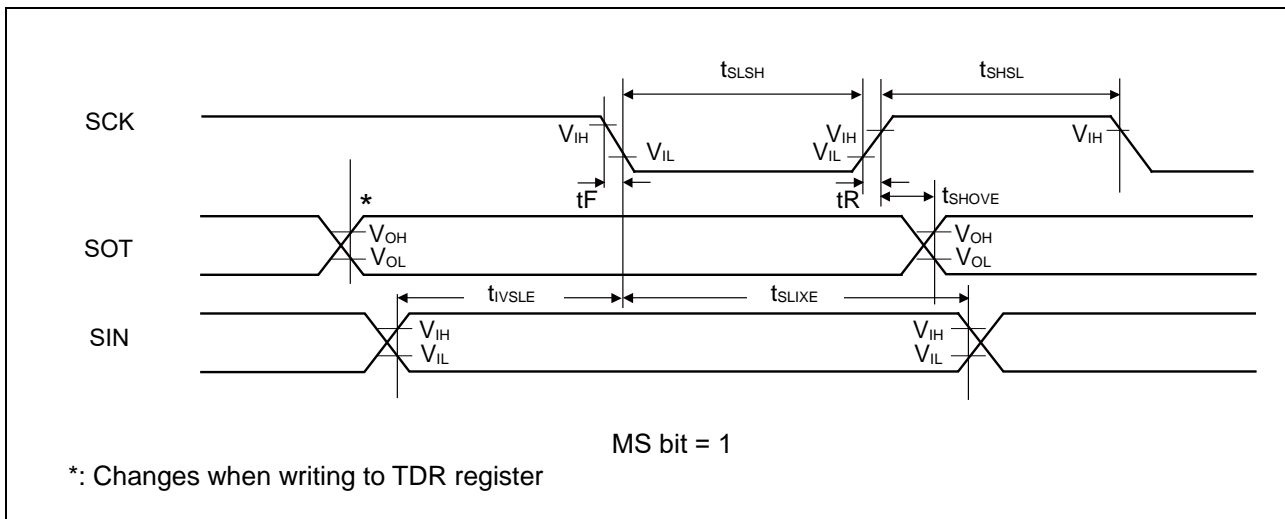
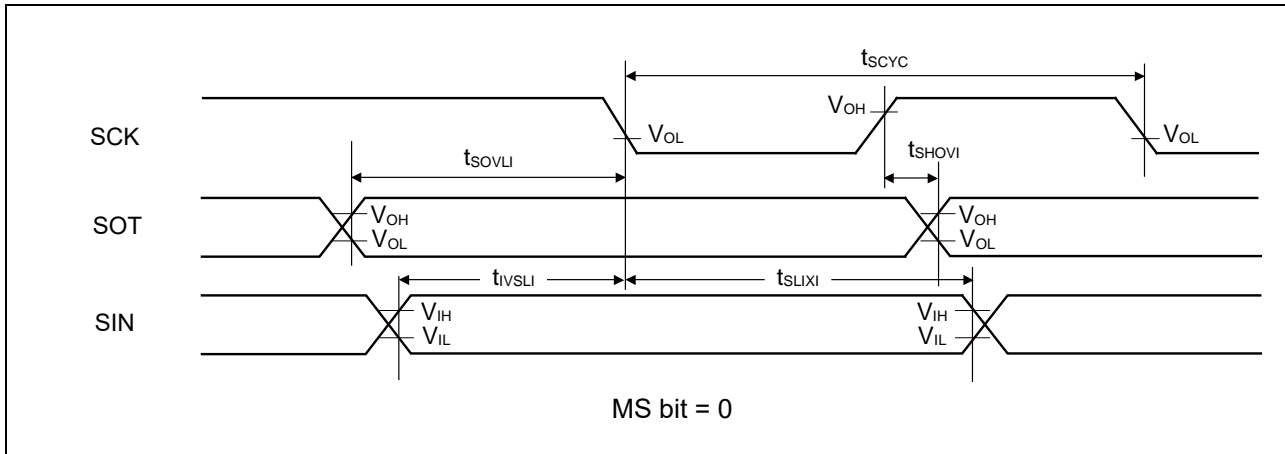
Synchronous Serial (SPI = 1, SCINV = 0)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | V _{CC} < 4.5 V | | V _{CC} ≥ 4.5 V | | Unit |
|----------------------------|--------------------|-------------------------------------|--------------------------------|-------------------------|------------------------|-------------------------|-----|------|
| | | | | Min | Max | Min | Max | |
| Baud rate | - | - | - | - | 8 | - | 8 | Mbps |
| Serial clock cycle time | t _{SCYC} | SCK _X | Internal shift clock operation | 4t _{CYCP} | - | 4t _{CYCP} | - | ns |
| SCK↑→SOT delay time | t _{SHOVI} | SCK _X , SOT _X | | -30 | +30 | -20 | +20 | ns |
| SIN→SCK↓ setup time | t _{IVSLI} | SCK _X , SIN _X | | 50 | - | 30 | - | ns |
| SCK↓→SIN hold time | t _{SLIXI} | SCK _X , SIN _X | | 0 | - | 0 | - | ns |
| SOT→SCK↓ delay time | t _{SOVLI} | SCK _X , SOT _X | | 2t _{CYCP} - 30 | - | 2t _{CYCP} - 30 | - | ns |
| Serial clock L pulse width | t _{LSLH} | SCK _X | | 2t _{CYCP} - 10 | - | 2t _{CYCP} - 10 | - | ns |
| Serial clock H pulse width | t _{SHSL} | SCK _X | t _{CYCP} + 10 | - | t _{CYCP} + 10 | - | ns | |
| SCK↑→SOT delay time | t _{SHOVE} | SCK _X , SOT _X | External shift clock operation | - | 50 | - | 30 | ns |
| SIN→SCK↓ setup time | t _{IVSLE} | SCK _X , SIN _X | | 10 | - | 10 | - | ns |
| SCK↓→SIN hold time | t _{SLIXE} | SCK _X , SIN _X | | 20 | - | 20 | - | ns |
| SCK fall time | t _F | SCK _X | | - | 5 | - | 5 | ns |
| SCK rise time | t _R | SCK _X | | - | 5 | - | 5 | ns |

Notes:

- The above characteristics apply to CLK synchronous mode.
- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- These characteristics only guarantee the same relocate port number; for example, the combination of SCK_{X_0} and SOT_{X_1} is not guaranteed.
- When the external load capacitance C_L = 30 pF.



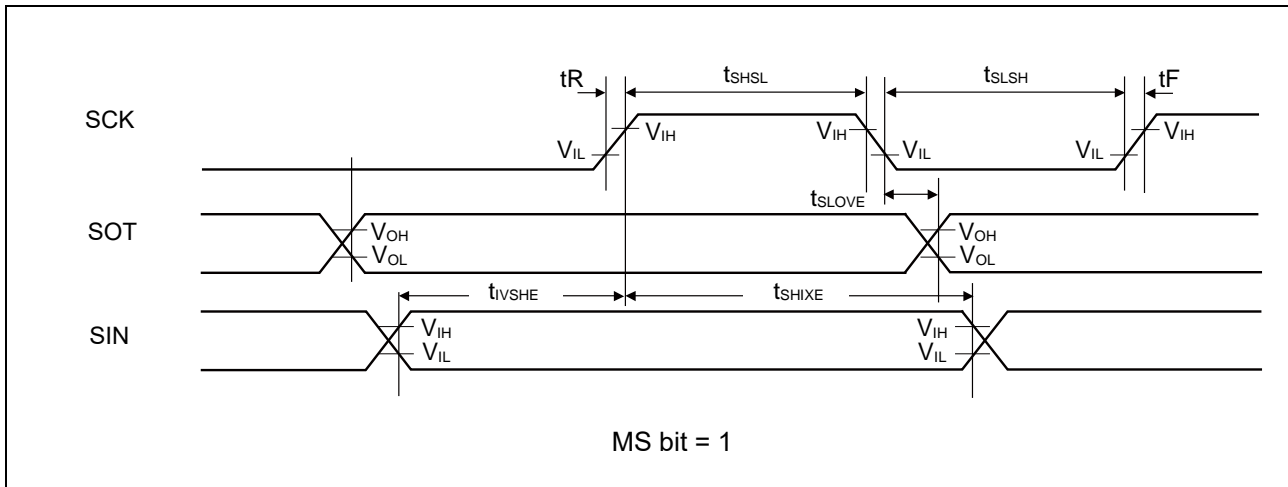
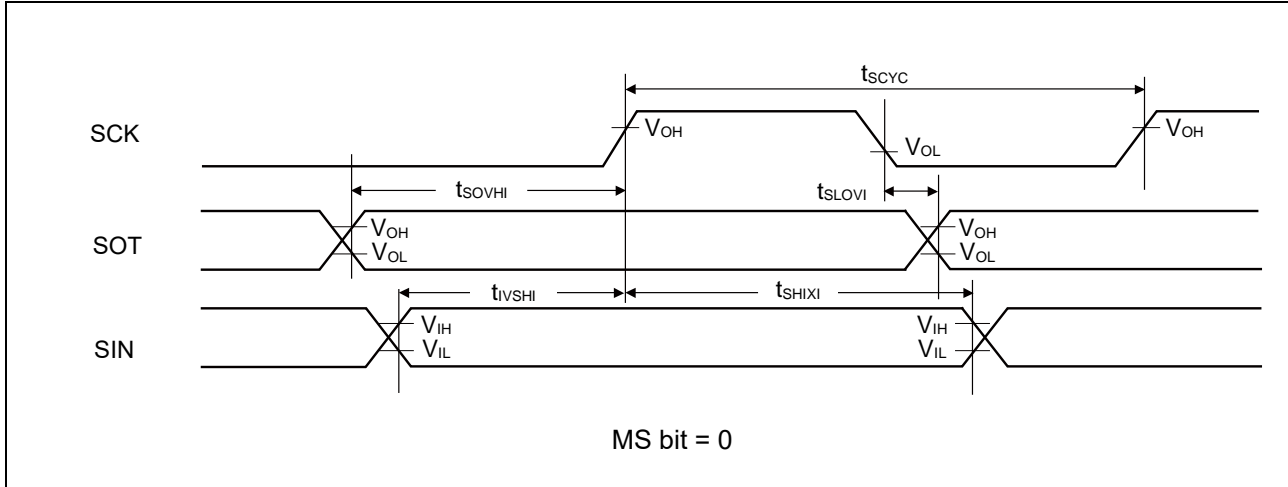
Synchronous Serial (SPI = 1, SCINV = 1)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | V _{CC} < 4.5 V | | V _{CC} ≥ 4.5 V | | Unit |
|----------------------------|--------------------|------------|--------------------------------|-------------------------|------------------------|-------------------------|-----|------|
| | | | | Min | Max | Min | Max | |
| Baud rate | - | - | - | - | 8 | - | 8 | Mbps |
| Serial clock cycle time | t _{SCYC} | SCKx | Internal shift clock operation | 4t _{CYCP} | - | 4t _{CYCP} | - | ns |
| SCK↓→SOT delay time | t _{SLOVI} | SCKx, SOTx | | -30 | +30 | -20 | +20 | ns |
| SIN→SCK↑ setup time | t _{VSHI} | SCKx, SINx | | 50 | - | 30 | - | ns |
| SCK↑→SIN hold time | t _{SHIXI} | SCKx, SINx | | 0 | - | 0 | - | ns |
| SOT→SCK↑ delay time | t _{SOVHI} | SCKx, SOTx | | 2t _{CYCP} - 30 | - | 2t _{CYCP} - 30 | - | ns |
| Serial clock L pulse width | t _{SLSH} | SCKx | | 2t _{CYCP} - 10 | - | 2t _{CYCP} - 10 | - | ns |
| Serial clock H pulse width | t _{SHSL} | SCKx | t _{CYCP} + 10 | - | t _{CYCP} + 10 | - | ns | |
| SCK↓→SOT delay time | t _{SLOVE} | SCKx, SOTx | External shift clock operation | - | 50 | - | 30 | ns |
| SIN→SCK↑ setup time | t _{VSHE} | SCKx, SINx | | 10 | - | 10 | - | ns |
| SCK↑→SIN hold time | t _{SHIXE} | SCKx, SINx | | 20 | - | 20 | - | ns |
| SCK fall time | t _F | SCKx | | - | 5 | - | 5 | ns |
| SCK rise time | t _R | SCKx | | - | 5 | - | 5 | ns |

Notes:

- The above characteristics apply to CLK synchronous mode.
- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- These characteristics only guarantee the same relocate port number; for example, the combination of SCKx_0 and SOTx_1 is not guaranteed.
- When the external load capacitance C_L = 30 pF.



When Using Synchronous Serial Chip Select (SCINV = 0, CSLVL = 1)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Conditions | V _{CC} < 4.5 V | | V _{CC} ≥ 4.5 V | | Unit |
|----------------------|-------------------|--------------------------------|--------------------------------|--------------------------------|--------------------------------|--------------------------------|------|
| | | | Min | Max | Min | Max | |
| SCS↓→SCK↓ setup time | t _{CSSI} | Internal shift clock operation | (*1) - 50 | (*1) + 0 | (*1) - 50 | (*1) + 0 | ns |
| SCK↑→SCS↑ hold time | t _{CShI} | | (*2) + 0 | (*2) + 50 | (*2) + 0 | (*2) + 50 | ns |
| SCS deselect time | t _{CSDI} | | (*3) - 50 + 5t _{CYCP} | (*3) + 50 + 5t _{CYCP} | (*3) - 50 + 5t _{CYCP} | (*3) + 50 + 5t _{CYCP} | ns |
| SCS↓→SCK↓ setup time | t _{CSSE} | External shift clock operation | 3t _{CYCP} + 30 | - | 3t _{CYCP} + 30 | - | ns |
| SCK↑→SCS↑ hold time | t _{CSHE} | | 0 | - | 0 | - | ns |
| SCS deselect time | t _{CSDE} | | 3t _{CYCP} + 30 | - | 3t _{CYCP} + 30 | - | ns |
| SCS↓→SOT delay time | t _{DSE} | | - | 40 | - | 40 | ns |
| SCS↑→SOT delay time | t _{DSE} | | 0 | - | 0 | - | ns |

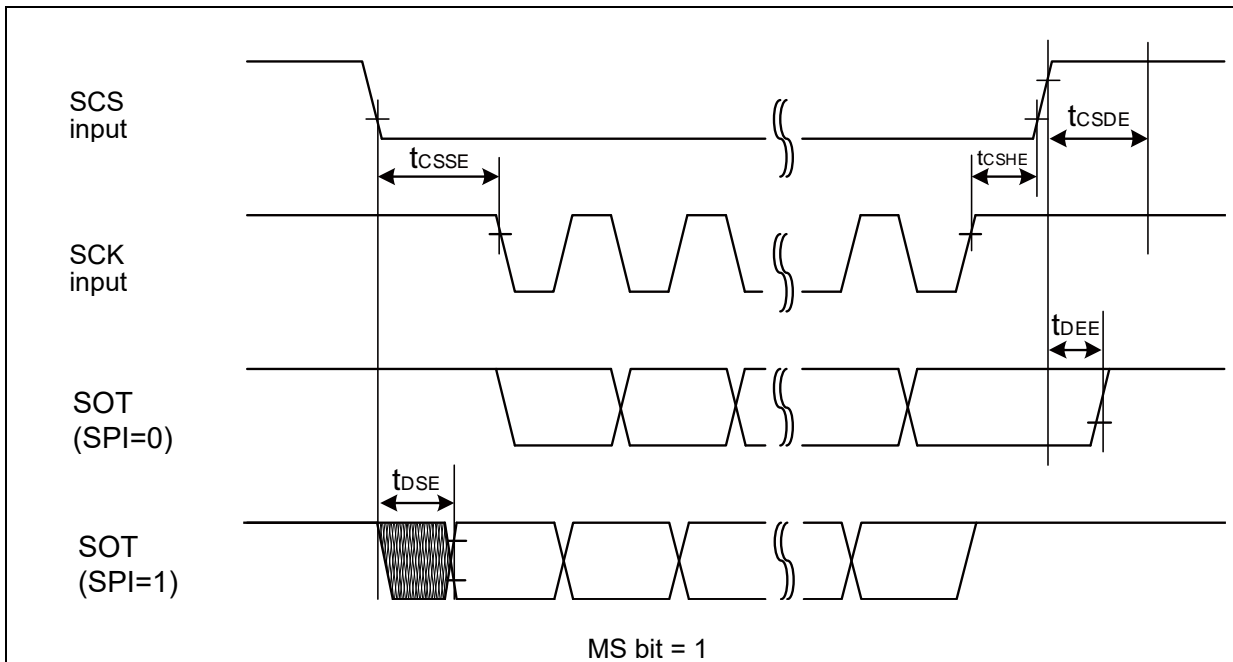
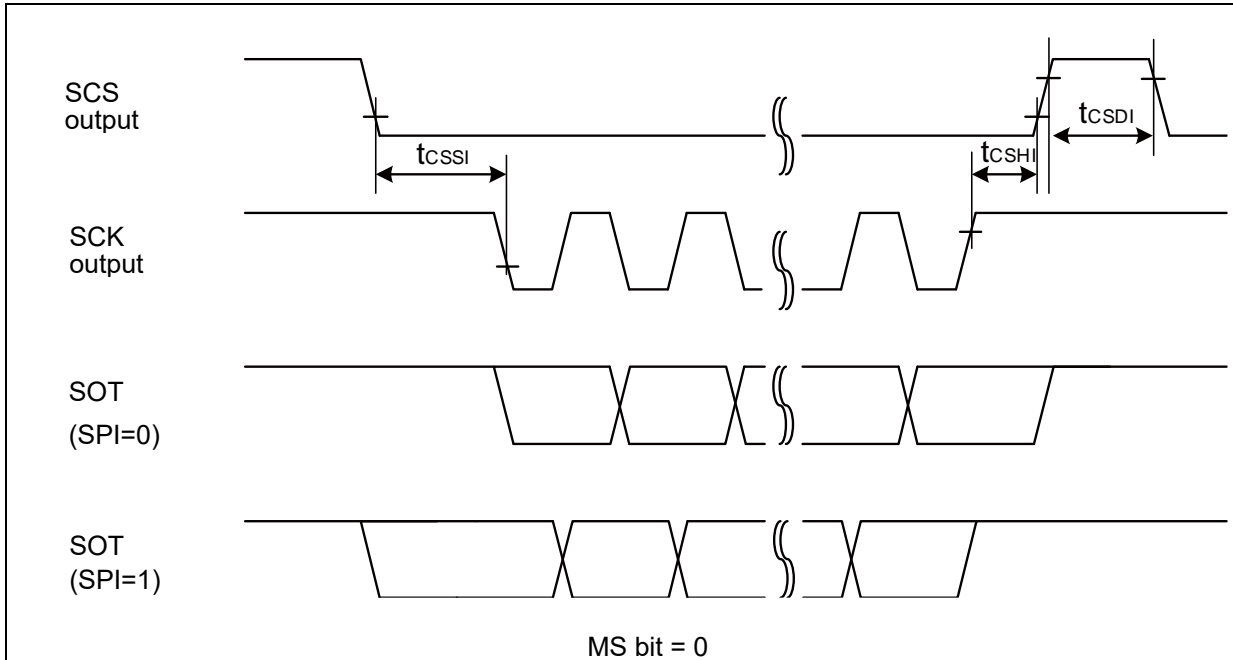
(*1): CSSU bit value×serial chip select timing operating clock cycle [ns]

(*2): CSHD bit value×serial chip select timing operating clock cycle [ns]

(*3): CSDS bit value×serial chip select timing operating clock cycle [ns]

Notes:

- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- For more information about CSSU, CSHD, CSDS, and the serial chip select timing operating clock, see FM4 Family Peripheral Manual Main Part (002-04856).
- When the external load capacitance C_L = 30 pF.



When Using Synchronous Serial Chip Select (SCINV = 1, CSLVL = 1)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Conditions | V _{CC} < 4.5 V | | V _{CC} ≥ 4.5 V | | Unit |
|----------------------|-------------------|--------------------------------|--------------------------------|--------------------------------|--------------------------------|--------------------------------|------|
| | | | Min | Max | Min | Max | |
| SCS↓→SCK↓ setup time | t _{CSSI} | Internal shift clock operation | (*1) - 50 | (*1) + 0 | (*1) - 50 | (*1) + 0 | ns |
| SCK↑→SCS↑ hold time | t _{CShI} | | (*2) + 0 | (*2) + 50 | (*2) + 0 | (*2) + 50 | ns |
| SCS deselect time | t _{CSDI} | | (*3) - 50 + 5t _{CYCP} | (*3) + 50 + 5t _{CYCP} | (*3) - 50 + 5t _{CYCP} | (*3) + 50 + 5t _{CYCP} | ns |
| SCS↓→SCK↓ setup time | t _{CSE} | External shift clock operation | 3t _{CYCP} + 30 | - | 3t _{CYCP} + 30 | - | ns |
| SCK↑→SCS↑ hold time | t _{CSE} | | 0 | - | 0 | - | ns |
| SCS deselect time | t _{CSE} | | 3t _{CYCP} + 30 | - | 3t _{CYCP} + 30 | - | ns |
| SCS↓→SOT delay time | t _{DSE} | | - | 40 | - | 40 | ns |
| SCS↑→SOT delay time | t _{DEE} | | 0 | - | 0 | - | ns |

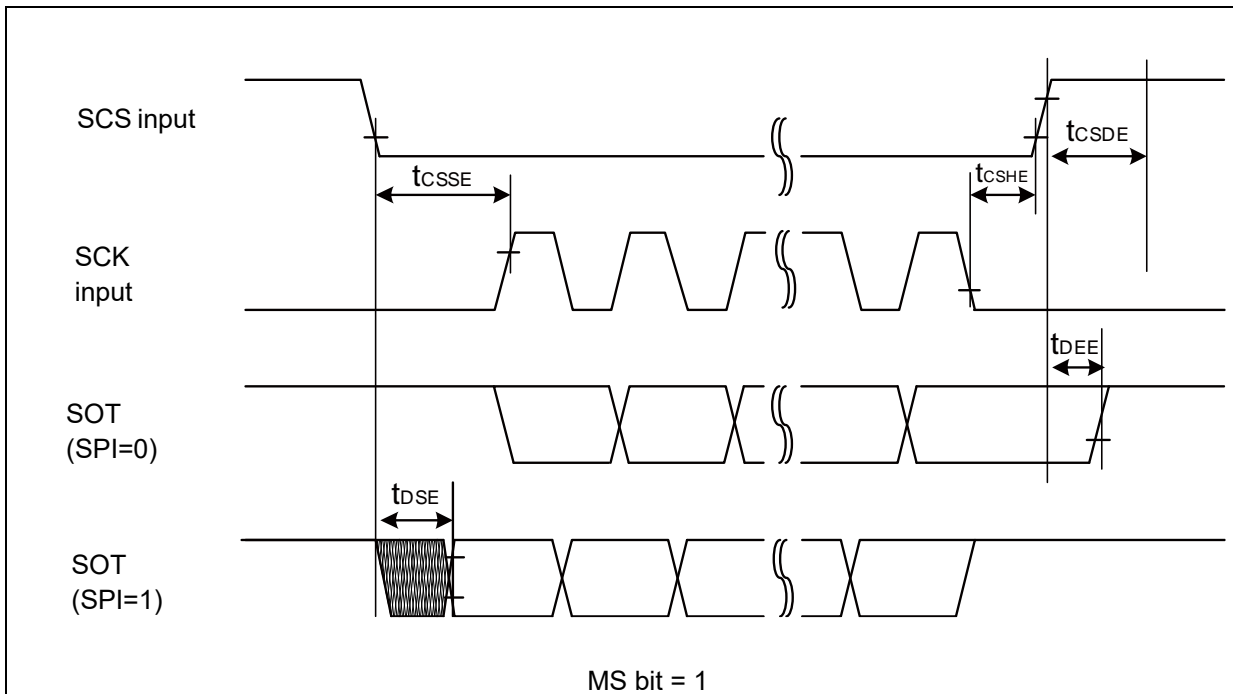
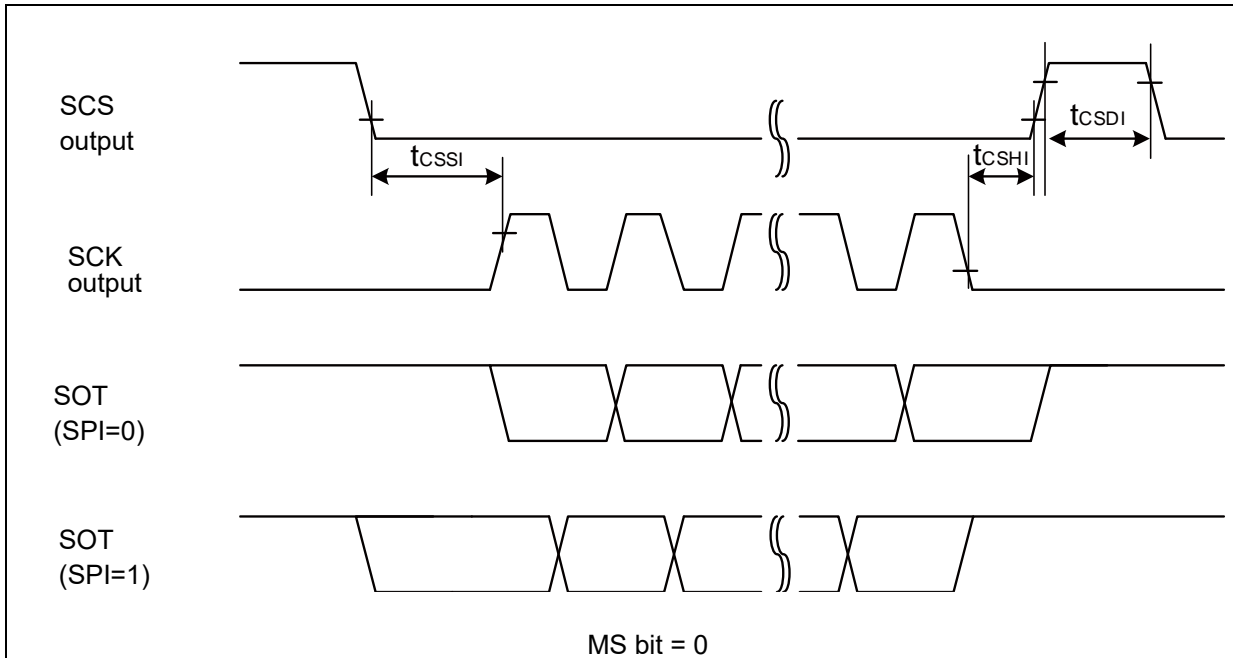
(*1): CSSU bit value×serial chip select timing operating clock cycle [ns]

(*2): CSHD bit value×serial chip select timing operating clock cycle [ns]

(*3): CSDS bit value×serial chip select timing operating clock cycle [ns]

Notes:

- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- For more information about CSSU, CSHD, CSDS, and the serial chip select timing operating clock, see FM4 Family Peripheral Manual Main Part (002-04856).
- When the external load capacitance C_L = 30 pF.



When Using Synchronous Serial Chip Select (SCINV = 0, CSLVL = 0)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Conditions | V _{CC} < 4.5 V | | V _{CC} ≥ 4.5 V | | Unit |
|----------------------|-------------------|--------------------------------|--------------------------------|--------------------------------|--------------------------------|--------------------------------|------|
| | | | Min | Max | Min | Max | |
| SCS↑→SCK↓ setup time | t _{CSSI} | Internal shift clock operation | (*1) - 50 | (*1) + 0 | (*1) - 50 | (*1) + 0 | ns |
| SCK↑→SCS↓ hold time | t _{CSHI} | | (*2) + 0 | (*2) + 50 | (*2) + 0 | (*2) + 50 | ns |
| SCS deselect time | t _{CSDI} | | (*3) - 50 + 5t _{CYCP} | (*3) + 50 + 5t _{CYCP} | (*3) - 50 + 5t _{CYCP} | (*3) + 50 + 5t _{CYCP} | ns |
| SCS↑→SCK↓ setup time | t _{CSSE} | External shift clock operation | 3t _{CYCP} + 30 | - | 3t _{CYCP} + 30 | - | ns |
| SCK↑→SCS↓ hold time | t _{CSHE} | | 0 | - | 0 | - | ns |
| SCS deselect time | t _{CSDE} | | 3t _{CYCP} + 30 | - | 3t _{CYCP} + 30 | - | ns |
| SCS↑→SOT delay time | t _{DSE} | | - | 40 | - | 40 | ns |
| SCS↓→SOT delay time | t _{DEE} | | 0 | - | 0 | - | ns |

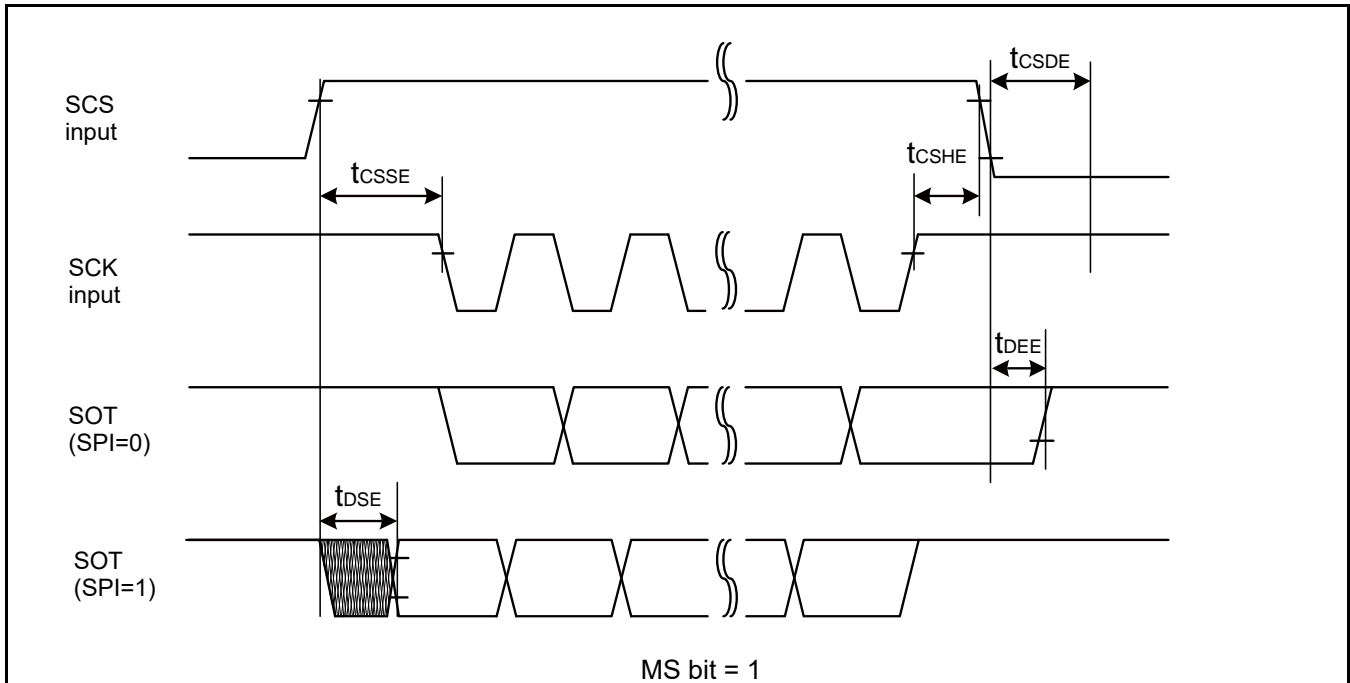
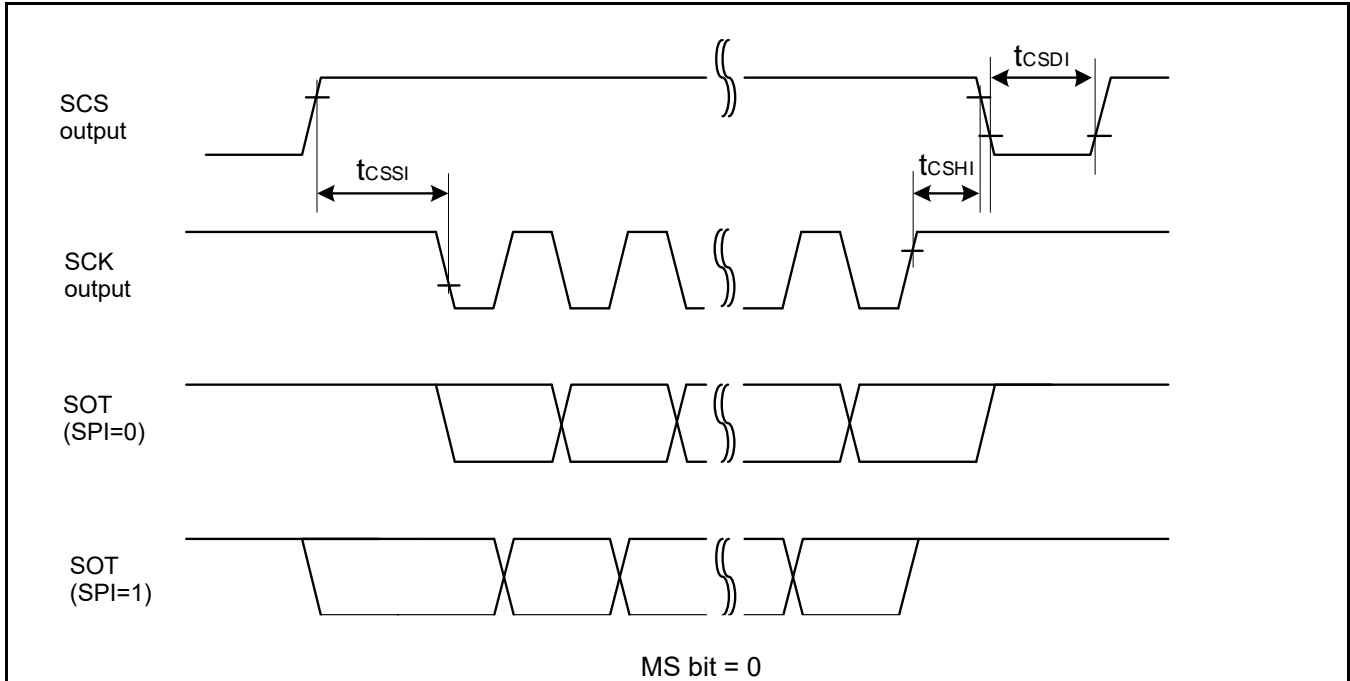
(*1): CSSU bit value×serial chip select timing operating clock cycle [ns]

(*2): CSHD bit value×serial chip select timing operating clock cycle [ns]

(*3): CSDS bit value×serial chip select timing operating clock cycle [ns]

Notes:

- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- For more information about CSSU, CSHD, CSDS, and the serial chip select timing operating clock, see FM4 Family Peripheral Manual Main Part (002-04856).
- When the external load capacitance C_L = 30 pF.



When Using Synchronous Serial Chip Select (SCINV = 1, CSLVL = 0)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Conditions | V _{CC} < 4.5 V | | V _{CC} ≥ 4.5 V | | Units |
|--------------------------|-------------------|--------------------------------|--------------------------------|--------------------------------|--------------------------------|--------------------------------|-------|
| | | | Min | Max | Min | Max | |
| SCS ↑ → SCK ↑ setup time | t _{CSSI} | Internal shift clock operation | (*1) - 50 | (*1) + 0 | (*1) - 50 | (*1) + 0 | ns |
| SCK ↓ → SCS ↓ hold time | t _{CSHI} | | (*2) + 0 | (*2) + 50 | (*2) + 0 | (*2) + 50 | ns |
| SCS deselect time | t _{CSDI} | | (*3) - 50 + 5t _{CYCP} | (*3) + 50 + 5t _{CYCP} | (*3) - 50 + 5t _{CYCP} | (*3) + 50 + 5t _{CYCP} | ns |
| SCS ↑ → SCK ↑ setup time | t _{CSSE} | External shift clock operation | 3t _{CYCP} + 30 | - | 3t _{CYCP} + 30 | - | ns |
| SCK ↓ → SCS ↓ hold time | t _{CSHE} | | 0 | - | 0 | - | ns |
| SCS deselect time | t _{CSDE} | | 3t _{CYCP} + 30 | - | 3t _{CYCP} + 30 | - | ns |
| SCS ↑ → SOT delay time | t _{DSE} | | - | 40 | - | 40 | ns |
| SCS ↓ → SOT delay time | t _{DEE} | | 0 | - | 0 | - | ns |

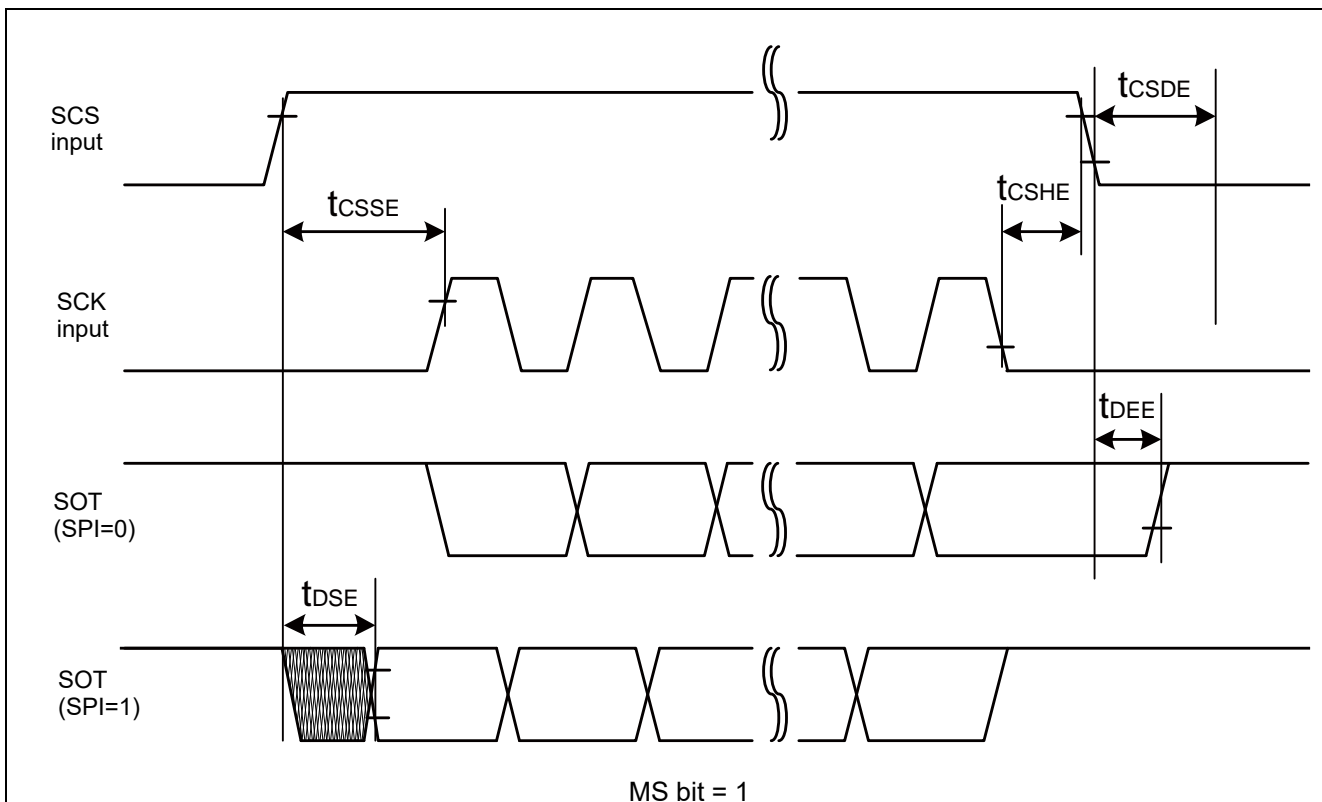
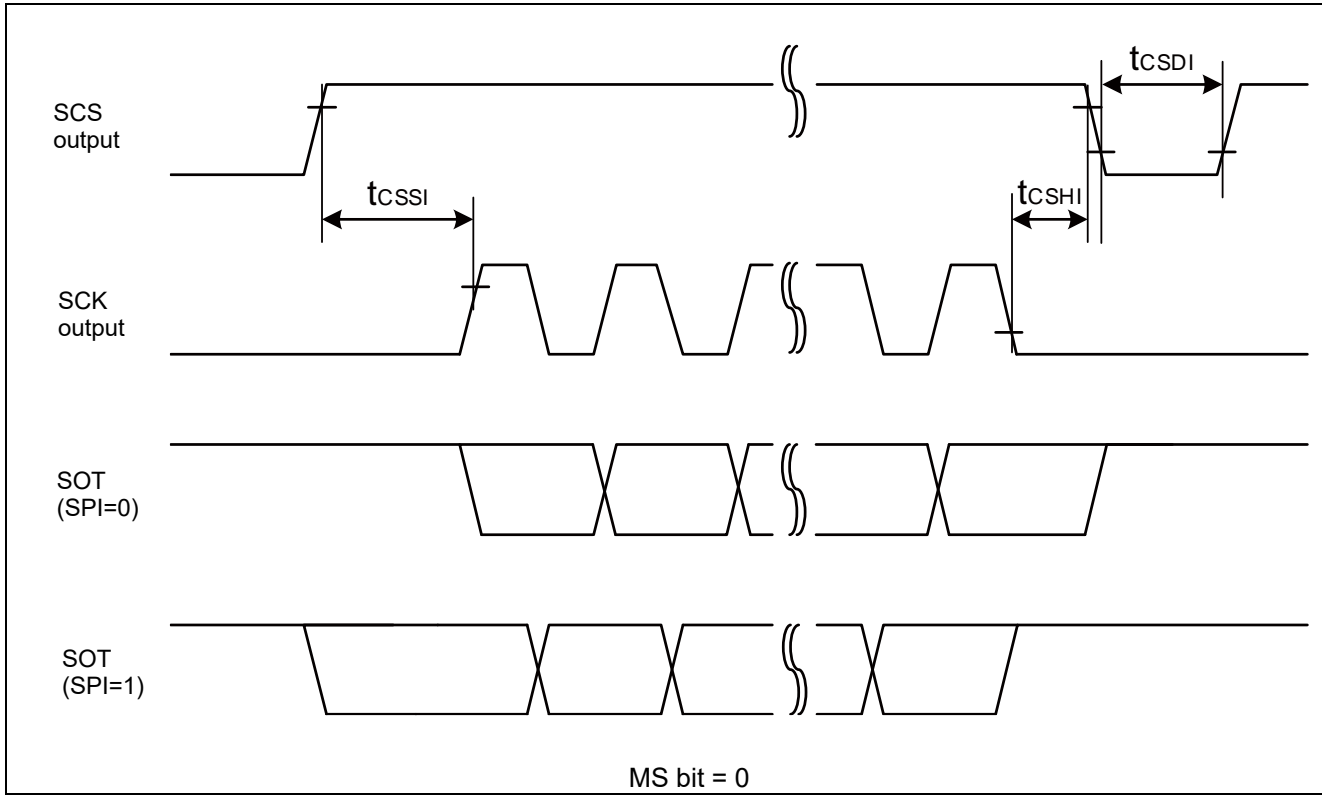
(*1): CSSU bit value × serial chip select timing operating clock cycle [ns]

(*2): CSHD bit value × serial chip select timing operating clock cycle [ns]

(*3): CSDS bit value × serial chip select timing operating clock cycle [ns]

Notes:

- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- For more information about CSSU, CSHD, CSDS, and the serial chip select timing operating clock, see FM4 Family Peripheral Manual Main Part (002-04856).
- When the external load capacitance C_L = 30 pF.



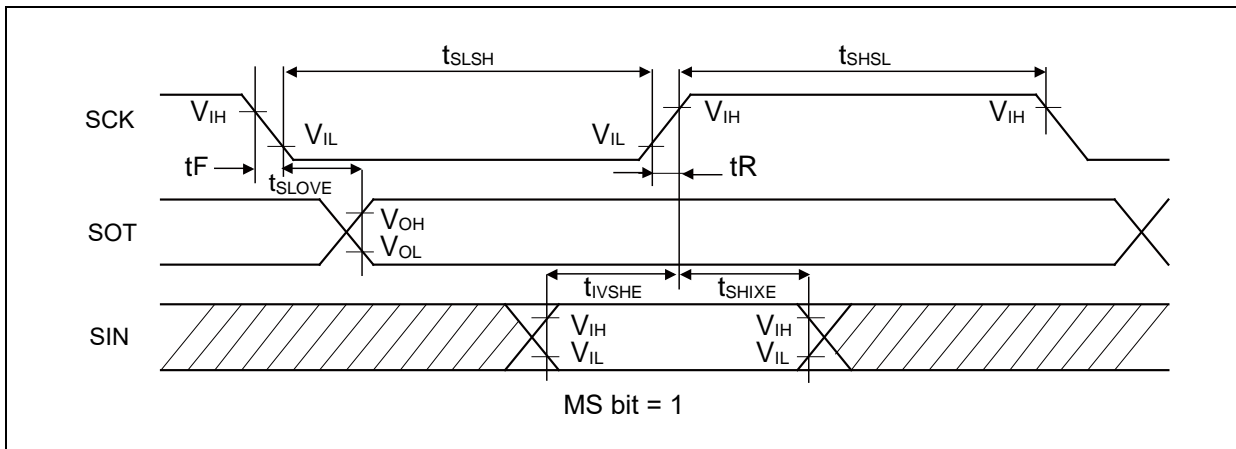
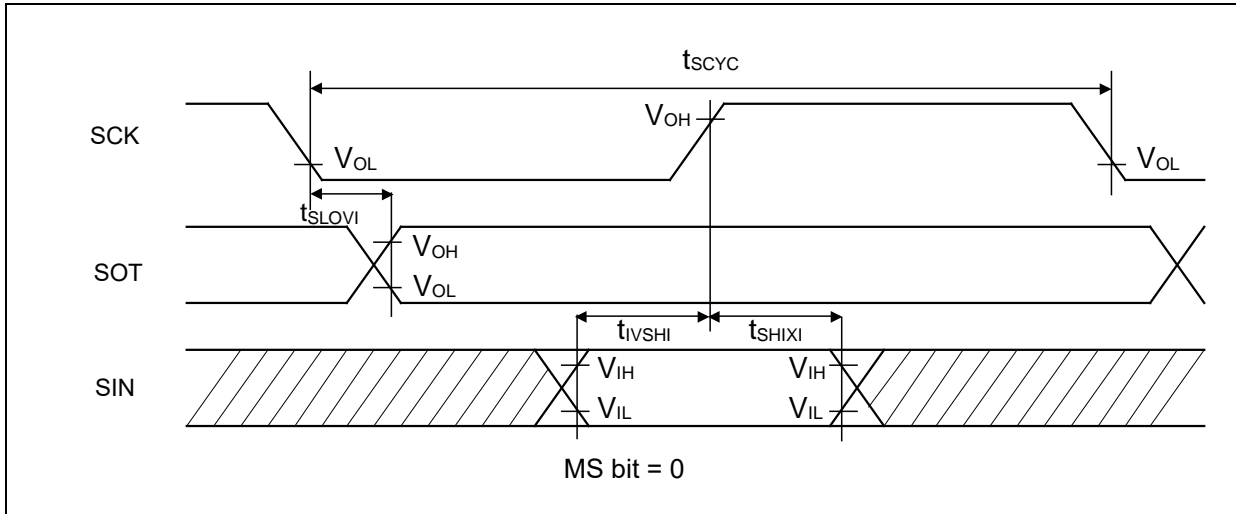
High-Speed Synchronous Serial (SPI = 0, SCINV = 0)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | V _{CC} < 4.5 V | | V _{CC} ≥ 4.5 V | | Unit |
|----------------------------------|--------------------|------------|--------------------------------|-------------------------|-----|-------------------------|-----|------|
| | | | | Min | Max | Min | Max | |
| Serial clock cycle time | t _{SCYC} | SCKx | Internal shift clock operation | 4t _{CYCP} | - | 4t _{CYCP} | - | ns |
| SCK _↓ →SOT delay time | t _{SLOVI} | SCKx, SOTx | | -10 | +10 | -10 | +10 | ns |
| SIN→SCK _↑ setup time | t _{VSHE} | SCKx, SINx | | 14 | - | 12.5 | - | ns |
| | | | | 12.5* | | | | |
| SCK _↑ →SIN hold time | t _{SHIXI} | SCKx, SINx | | 5 | - | 5 | - | ns |
| Serial clock L pulse width | t _{SLSH} | SCKx | External shift clock operation | 2t _{CYCP} - 5 | - | 2t _{CYCP} - 5 | - | ns |
| Serial clock H pulse width | t _{SHSL} | SCKx | | t _{CYCP} + 10 | - | t _{CYCP} + 10 | - | ns |
| SCK _↓ →SOT delay time | t _{SLOVE} | SCKx, SOTx | | - | 15 | - | 15 | ns |
| SIN→SCK _↑ setup time | t _{VSHE} | SCKx, SINx | | 5 | - | 5 | - | ns |
| SCK _↑ →SIN hold time | t _{SHIXE} | SCKx, SINx | | 5 | - | 5 | - | ns |
| SCK fall time | t _F | SCKx | | - | 5 | - | 5 | ns |
| SCK rise time | t _R | SCKx | | - | 5 | - | 5 | ns |

Notes:

- The above characteristics apply to CLK synchronous mode.
- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- These characteristics only guarantee the following pins:
 - No chip select: SIN4_0, SOT4_0, SCK4_0
 - Chip select: SIN6_0, SOT6_0, SCK6_0, SCS60_0, SCS61_0, SCS62_0, SCS63_0
- When the external load capacitance C_L = 30 pF. (For *, when C_L = 10 pF)



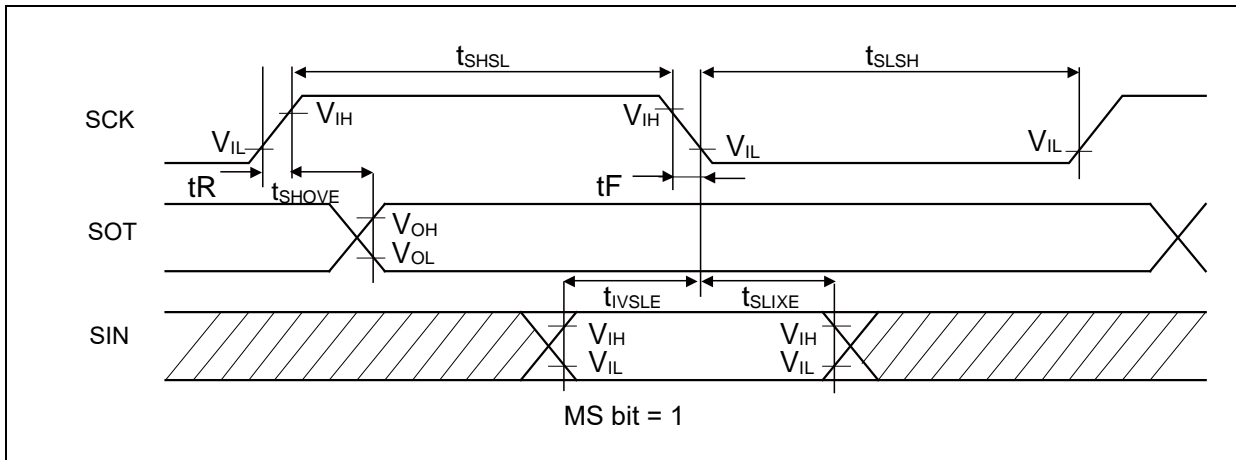
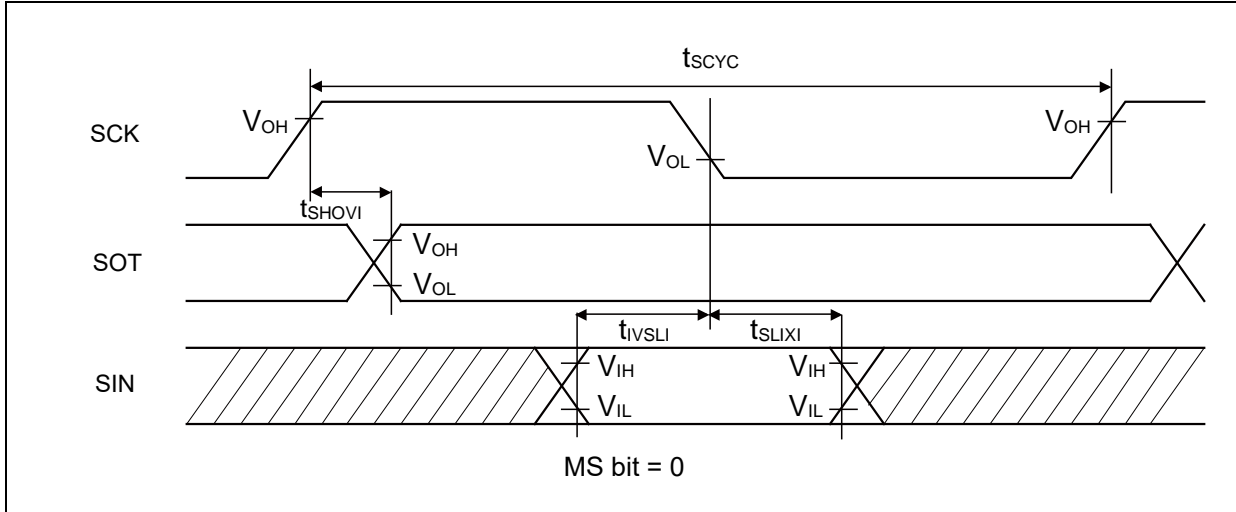
High-Speed Synchronous Serial (SPI = 0, SCINV = 1)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | V _{CC} < 4.5 V | | V _{CC} ≥ 4.5 V | | Unit |
|----------------------------|--------------------|------------|--------------------------------|-------------------------|-----|-------------------------|-----|------|
| | | | | Min | Max | Min | Max | |
| Serial clock cycle time | t _{SCYC} | SCKx | Internal shift clock operation | 4t _{CYCP} | - | 4t _{CYCP} | - | ns |
| SCK↑→SOT delay time | t _{SHOVI} | SCKx, SOTx | | -10 | +10 | -10 | +10 | ns |
| SIN→SCK↓ setup time | t _{IVSLI} | SCKx, SINx | | 14 | - | 12.5 | - | ns |
| | | | | 12.5* | | | | |
| SCK↓→SIN hold time | t _{SLIXI} | SCKx, SINx | | 5 | - | 5 | - | ns |
| Serial clock L pulse width | t _{LSLH} | SCKx | External shift clock operation | 2t _{CYCP} - 5 | - | 2t _{CYCP} - 5 | - | ns |
| Serial clock H pulse width | t _{SHSL} | SCKx | | t _{CYCP} + 10 | - | t _{CYCP} + 10 | - | ns |
| SCK↑→SOT delay time | t _{SHOVE} | SCKx, SOTx | | - | 15 | - | 15 | ns |
| SIN→SCK↓ setup time | t _{IVSLE} | SCKx, SINx | | 5 | - | 5 | - | ns |
| SCK↓→SIN hold time | t _{SLIXE} | SCKx, SINx | | 5 | - | 5 | - | ns |
| SCK fall time | t _F | SCKx | | - | 5 | - | 5 | ns |
| SCK rise time | t _R | SCKx | | - | 5 | - | 5 | ns |

Notes:

- The above characteristics apply to CLK synchronous mode.
- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- These characteristics only guarantee the following pins:
 - No chip select: SIN4_0, SOT4_0, SCK4_0
 - Chip select: SIN6_0, SOT6_0, SCK6_0, SCS60_0, SCS61_0, SCS62_0, SCS63_0
- When the external load capacitance C_L = 30 pF. (For *, when C_L = 10 pF)



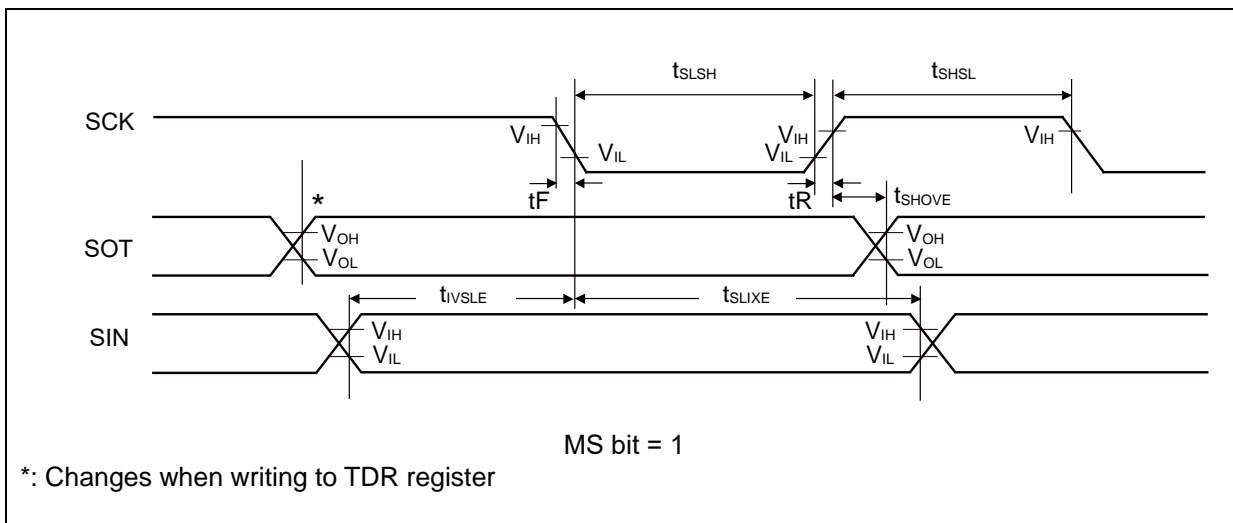
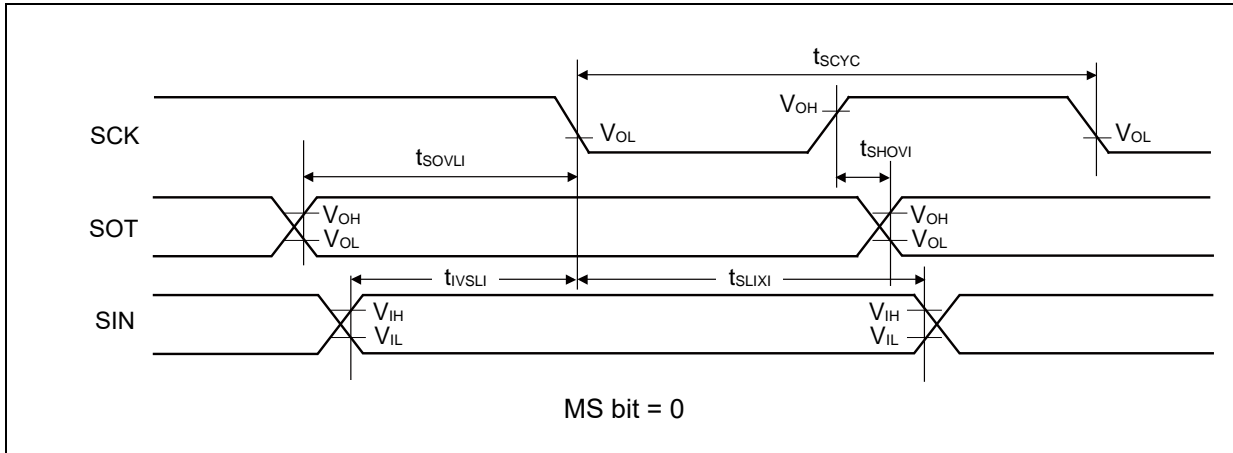
High-Speed Synchronous Serial (SPI = 1, SCINV = 0)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | V _{CC} < 4.5 V | | V _{CC} ≥ 4.5 V | | Unit |
|----------------------------|--------------------|------------|--------------------------------|-------------------------|-----|-------------------------|-----|------|
| | | | | Min | Max | Min | Max | |
| Serial clock cycle time | t _{SCYC} | SCKx | Internal shift clock operation | 4t _{CYCP} | - | 4t _{CYCP} | - | ns |
| SCK↑→SOT delay time | t _{SHOVI} | SCKx, SOTx | | -10 | +10 | -10 | +10 | ns |
| SIN→SCK↓ setup time | t _{IVSLI} | SCKx, SINx | | 14 | - | 12.5 | - | ns |
| | | | | 12.5* | | | | |
| SCK↓→SIN hold time | t _{SLIXI} | SCKx, SINx | | 5 | - | 5 | - | ns |
| SOT→SCK↓ delay time | t _{SOVLI} | SCKx, SOTx | | 2t _{CYCP} - 10 | - | 2t _{CYCP} - 10 | - | ns |
| Serial clock L pulse width | t _{LSLH} | SCKx | External shift clock operation | 2t _{CYCP} - 5 | - | 2t _{CYCP} - 5 | - | ns |
| Serial clock H pulse width | t _{SHSL} | SCKx | | t _{CYCP} + 10 | - | t _{CYCP} + 10 | - | ns |
| SCK↑→SOT delay time | t _{SHOVE} | SCKx, SOTx | | - | 15 | - | 15 | ns |
| SIN→SCK↓ setup time | t _{IVSLE} | SCKx, SINx | | 5 | - | 5 | - | ns |
| SCK↓→SIN hold time | t _{SLIXE} | SCKx, SINx | | 5 | - | 5 | - | ns |
| SCK fall time | t _F | SCKx | | - | 5 | - | 5 | ns |
| SCK rise time | t _R | SCKx | | - | 5 | - | 5 | ns |

Notes:

- The above characteristics apply to CLK synchronous mode.
- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- These characteristics only guarantee the following pins:
 - No chip select: SIN4_0, SOT4_0, SCK4_0
 - Chip select: SIN6_0, SOT6_0, SCK6_0, SCS60_0, SCS61_0, SCS62_0, SCS63_0
- When the external load capacitance C_L = 30 pF. (for *, when C_L = 10 pF)



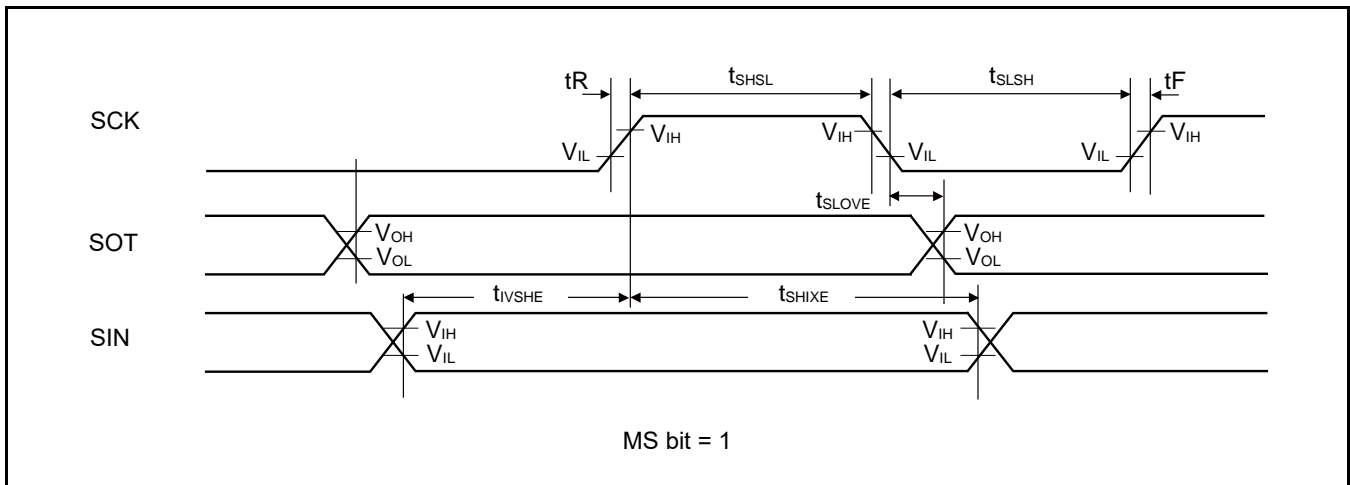
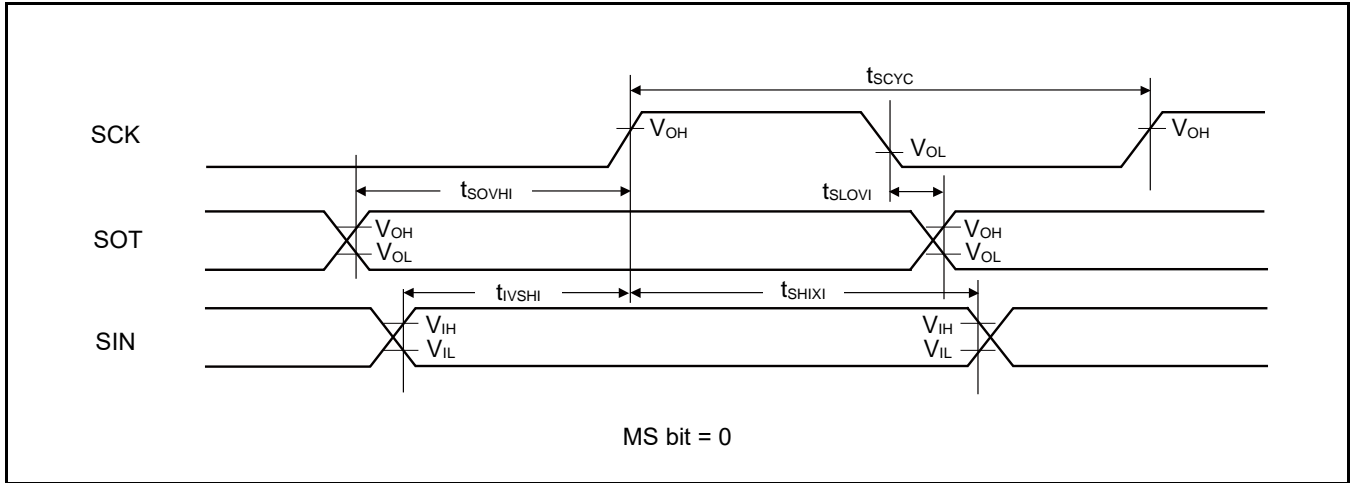
High-Speed Synchronous Serial (SPI = 1, SCINV = 1)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | V _{CC} < 4.5 V | | V _{CC} ≥ 4.5 V | | Unit |
|----------------------------|--------------------|------------|--------------------------------|-------------------------|-----|-------------------------|-----|------|
| | | | | Min | Max | Min | Max | |
| Serial clock cycle time | t _{SCYC} | SCKx | Internal shift clock operation | 4t _{CYCP} | - | 4t _{CYCP} | - | ns |
| SCK↓→SOT delay time | t _{SLOVI} | SCKx, SOTx | | -10 | +10 | -10 | +10 | ns |
| SIN→SCK↑ setup time | t _{VSXI} | SCKx, SINx | | 14 | - | 12.5 | - | ns |
| | | | | 12.5* | | | | |
| SCK↑→SIN hold time | t _{SHXI} | SCKx, SINx | | 5 | - | 5 | - | ns |
| SOT→SCK↑ delay time | t _{SOVHI} | SCKx, SOTx | | 2t _{CYCP} - 10 | - | 2t _{CYCP} - 10 | - | ns |
| Serial clock L pulse width | t _{SLSH} | SCKx | External shift clock operation | 2t _{CYCP} - 5 | - | 2t _{CYCP} - 5 | - | ns |
| Serial clock H pulse width | t _{SHSL} | SCKx | | t _{CYCP} + 10 | - | t _{CYCP} + 10 | - | ns |
| SCK↓→SOT delay time | t _{SLOVE} | SCKx, SOTx | | - | 15 | - | 15 | ns |
| SIN→SCK↑ setup time | t _{VSHE} | SCKx, SINx | | 5 | - | 5 | - | ns |
| SCK↑→SIN hold time | t _{SHXE} | SCKx, SINx | | 5 | - | 5 | - | ns |
| SCK fall time | t _F | SCKx | | - | 5 | - | 5 | ns |
| SCK rise time | t _R | SCKx | | - | 5 | - | 5 | ns |

Notes:

- The above characteristics apply to CLK synchronous mode.
- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- These characteristics only guarantee the following pins:
 No chip select: SIN4_0, SOT4_0, SCK4_0
 Chip select: SIN6_0, SOT6_0, SCK6_0, SCS60_0, SCS61_0, SCS62_0, SCS63_0
- When the external load capacitance C_L = 30 pF. (for *, when C_L = 10 pF)



When Using High-Speed Synchronous Serial Chip Select (SCINV = 0, CSLVL = 1)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Conditions | V _{CC} < 4.5 V | | V _{CC} ≥ 4.5 V | | Unit |
|----------------------|-------------------|--------------------------------|--------------------------------|--------------------------------|--------------------------------|--------------------------------|------|
| | | | Min | Max | Min | Max | |
| SCS↓→SCK↓ setup time | t _{CSSI} | Internal shift clock operation | (*1) - 20 | (*1) + 0 | (*1) - 20 | (*1) + 0 | ns |
| SCK↑→SCS↑ hold time | t _{CShI} | | (*2) + 0 | (*2) + 20 | (*2) + 0 | (*2) + 20 | ns |
| SCS deselect time | t _{CSDI} | | (*3) - 20 + 5t _{CYCP} | (*3) + 20 + 5t _{CYCP} | (*3) - 20 + 5t _{CYCP} | (*3) + 20 + 5t _{CYCP} | ns |
| SCS↓→SCK↓ setup time | t _{CSE} | External shift clock operation | 3t _{CYCP} + 15 | - | 3t _{CYCP} + 15 | - | ns |
| SCK↑→SCS↑ hold time | t _{CSE} | | 0 | - | 0 | - | ns |
| SCS deselect time | t _{CSE} | | 3t _{CYCP} + 15 | - | 3t _{CYCP} + 15 | - | ns |
| SCS↓→SOT delay time | t _{DSE} | | - | 25 | - | 25 | ns |
| SCS↑→SOT delay time | t _{DEE} | | 0 | - | 0 | - | ns |

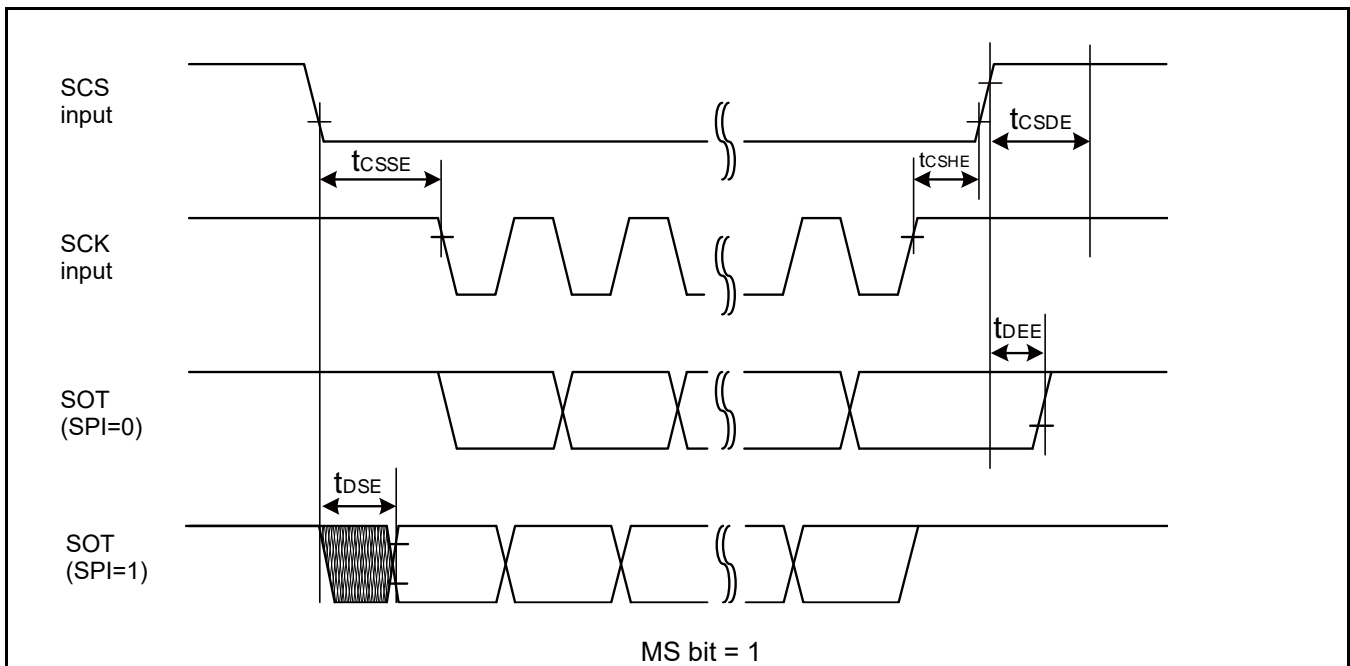
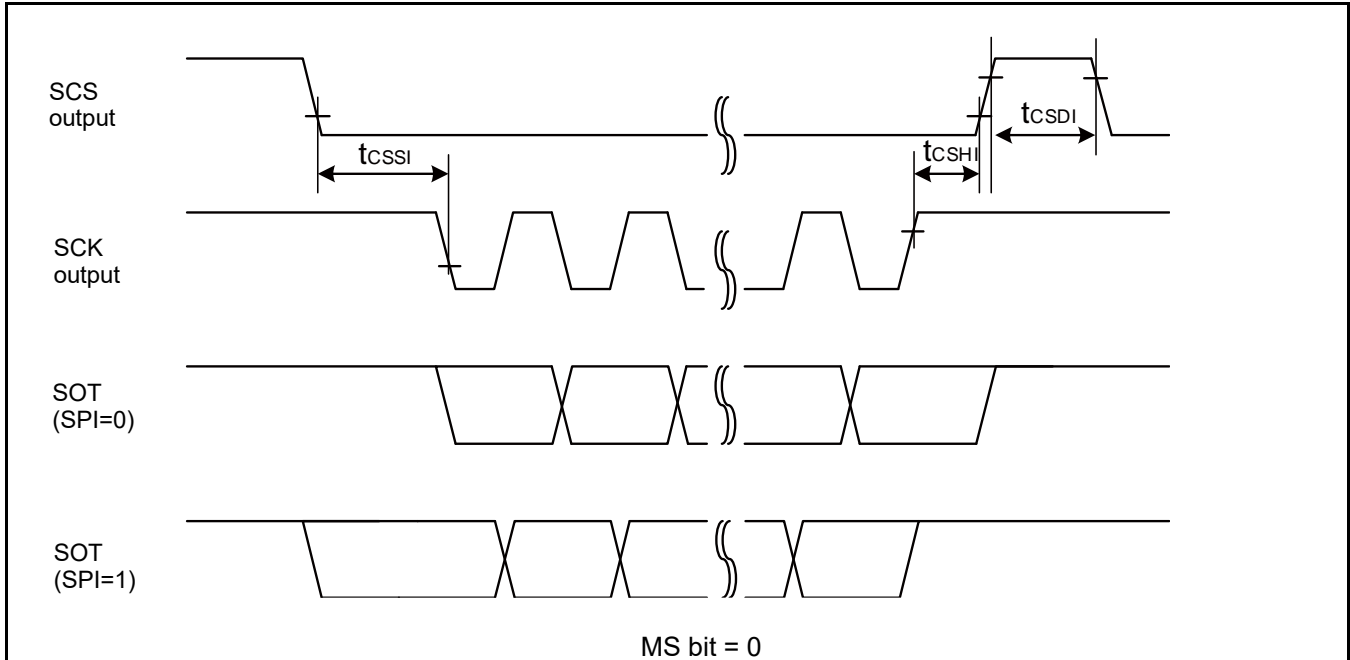
(*1): CSSU bit value × serial chip select timing operating clock cycle [ns]

(*2): CSHD bit value × serial chip select timing operating clock cycle [ns]

(*3): CSDS bit value × serial chip select timing operating clock cycle [ns]

Notes:

- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- For more information about CSSU, CSHD, CSDS, and the serial chip select timing operating clock, see FM4 Family Peripheral Manual Main Part (002-04856).
- When the external load capacitance C_L = 30 pF.



When Using High-Speed Synchronous Serial Chip Select (SCINV = 1, CSLVL = 1)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Conditions | V _{CC} < 4.5 V | | V _{CC} ≥ 4.5 V | | Unit |
|----------------------|--------------------|--------------------------------|--------------------------------|--------------------------------|--------------------------------|--------------------------------|------|
| | | | Min | Min | Min | Max | |
| SCS↓→SCK↓ setup time | t _{CSSI} | Internal shift clock operation | (*1) - 20 | (*1) + 0 | (*1) - 20 | (*1) + 0 | ns |
| SCK↑→SCS↑ hold time | t _{CShI} | | (*2) + 0 | (*2) + 20 | (*2) + 0 | (*2) + 20 | ns |
| SCS deselect time | t _{CSDI} | | (*3) - 20 + 5t _{CYCP} | (*3) + 20 + 5t _{CYCP} | (*3) - 20 + 5t _{CYCP} | (*3) + 20 + 5t _{CYCP} | ns |
| SCS↓→SCK↑ setup time | t _{CSE} | External shift clock operation | 3t _{CYCP} + 15 | - | 3t _{CYCP} + 15 | - | ns |
| SCK↑→SCS↑ hold time | t _{CSEH} | | 0 | - | 0 | - | ns |
| SCS deselect time | t _{CSEDE} | | 3t _{CYCP} + 15 | - | 3t _{CYCP} + 15 | - | ns |
| SCS↓→SOT delay time | t _{DSE} | | - | 25 | - | 25 | ns |
| SCS↑→SOT delay time | t _{DEE} | | 0 | - | 0 | - | ns |

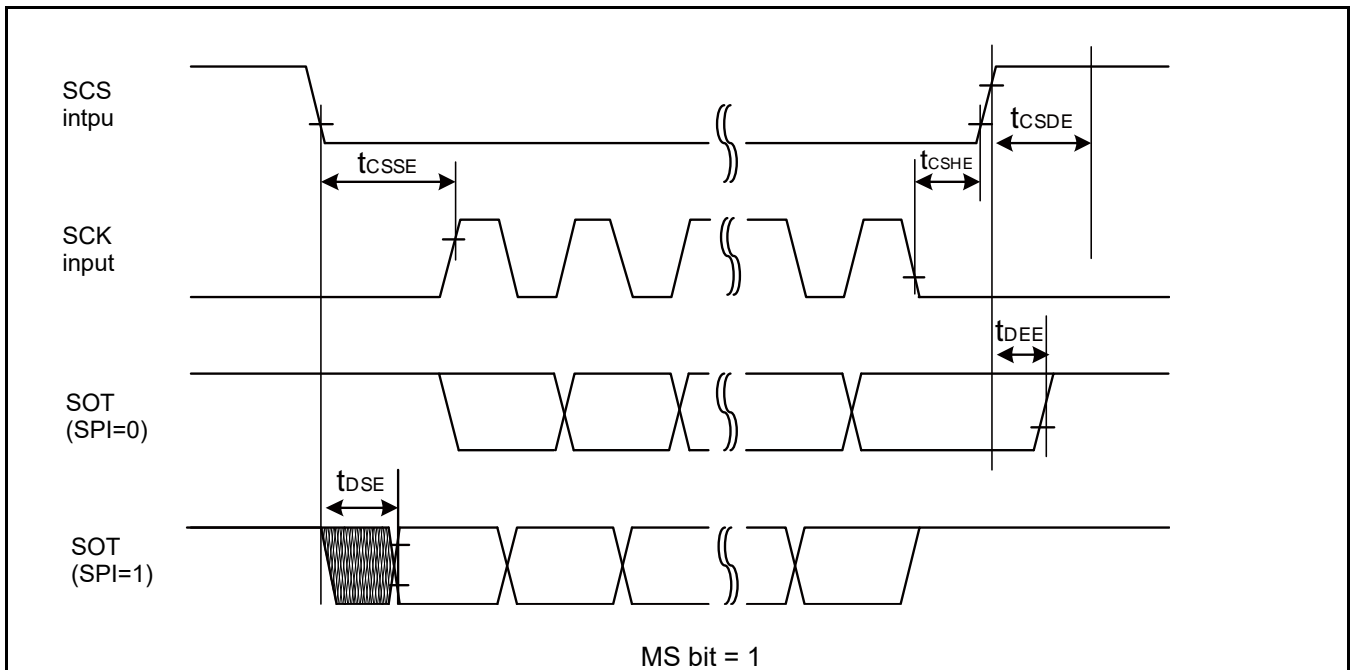
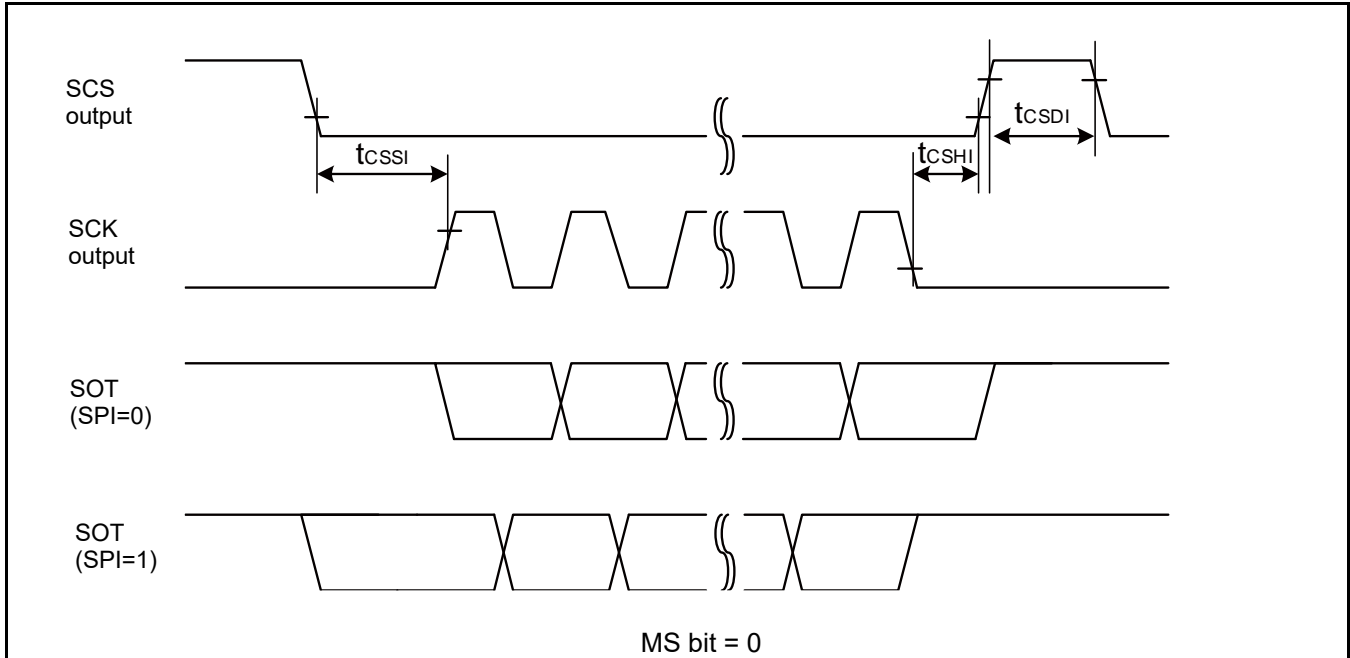
(*1): CSSU bit value × serial chip select timing operating clock cycle [ns]

(*2): CSHD bit value × serial chip select timing operating clock cycle [ns]

(*3): CSDS bit value × serial chip select timing operating clock cycle [ns]

Notes:

- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- For more information about CSSU, CSHD, CSDS, and the serial chip select timing operating clock, see FM4 Family Peripheral Manual Main Part (002-04856).
- When the external load capacitance C_L = 30 pF.



When Using High-Speed Synchronous Serial Chip Select (SCINV = 0, CSLVL = 0)
 $(V_{CC} = 2.7\text{ V to } 5.5\text{ V}, V_{SS} = 0\text{ V})$

| Parameter | Symbol | Conditions | $V_{CC} < 4.5\text{ V}$ | | $V_{CC} \geq 4.5\text{ V}$ | | Unit |
|---|------------|--------------------------------|--------------------------|--------------------------|----------------------------|--------------------------|------|
| | | | Min | Max | Min | Max | |
| SCS \uparrow →SCK \downarrow setup time | t_{CSSI} | Internal shift clock operation | (*1)-20 | (*1)+0 | (*1)-20 | (*1)+0 | ns |
| SCK \uparrow →SCS \downarrow hold time | t_{CSHI} | | (*2)+0 | (*2)+20 | (*2)+0 | (*2)+20 | ns |
| SCS deselect time | t_{CSDI} | | (*3)-20 +5 t_{CYCP} | (*3)+20 +5 t_{CYCP} | (*3)-20 +5 t_{CYCP} | (*3)+20 +5 t_{CYCP} | ns |
| SCS \uparrow →SCK \downarrow setup time | t_{CSSE} | External shift clock operation | 3 t_{CYCP} +15 | - | 3 t_{CYCP} +15 | - | ns |
| SCK \uparrow →SCS \downarrow hold time | t_{CSHE} | | 0 | - | 0 | - | ns |
| SCS deselect time | t_{CSDE} | | 3 t_{CYCP} +15 | - | 3 t_{CYCP} +15 | - | ns |
| SCS \uparrow →SOT delay time | t_{DSE} | | - | 25 | - | 25 | ns |
| SCS \downarrow →SOT delay time | t_{DEE} | | 0 | - | 0 | - | ns |

(*1): CSSU bit value×serial chip select timing operating clock cycle [ns]

(*2): CSHD bit value×serial chip select timing operating clock cycle [ns]

(*3): CSDS bit value×serial chip select timing operating clock cycle [ns]

Notes:

- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- For more information about CSSU, CSHD, CSDS, and the serial chip select timing operating clock, see FM4 Family Peripheral Manual Main Part (002-04856).
- When the external load capacitance $C_L = 30\text{ pF}$.

When Using High-Speed Synchronous Serial Chip Select (SCINV = 1, CSLVL = 0)

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Conditions | V _{CC} < 4.5 V | | V _{CC} ≥ 4.5 V | | Unit |
|----------------------|-------------------|--------------------------------|--------------------------------|--------------------------------|--------------------------------|--------------------------------|------|
| | | | Min | Max | Min | Max | |
| SCS↓→SCK↓ setup time | t _{CSSI} | Internal shift clock operation | (*1)-20 | (*1)+0 | (*1)-20 | (*1)+0 | ns |
| SCK↑→SCS↓ hold time | t _{CSDI} | | (*2)+0 | (*2)+20 | (*2)+0 | (*2)+20 | ns |
| SCS deselect time | t _{CSDI} | | (*3)-20 +5t _{CYCP} | (*3)+20 +5t _{CYCP} | (*3)-20 +5t _{CYCP} | (*3)+20 +5t _{CYCP} | ns |
| SCS↑→SCK↑ setup time | t _{CSSE} | External shift clock operation | 3t _{CYCP} +15 | - | 3t _{CYCP} +15 | - | ns |
| SCK↓→SCS↓ hold time | t _{CSHE} | | 0 | - | 0 | - | ns |
| SCS deselect time | t _{CSDE} | | 3t _{CYCP} +15 | - | 3t _{CYCP} +15 | - | ns |
| SCS↑→SOT delay time | t _{DSE} | | - | 40 | - | 40 | ns |
| SCS↓→SOT delay time | t _{DEE} | | 0 | - | 0 | - | ns |

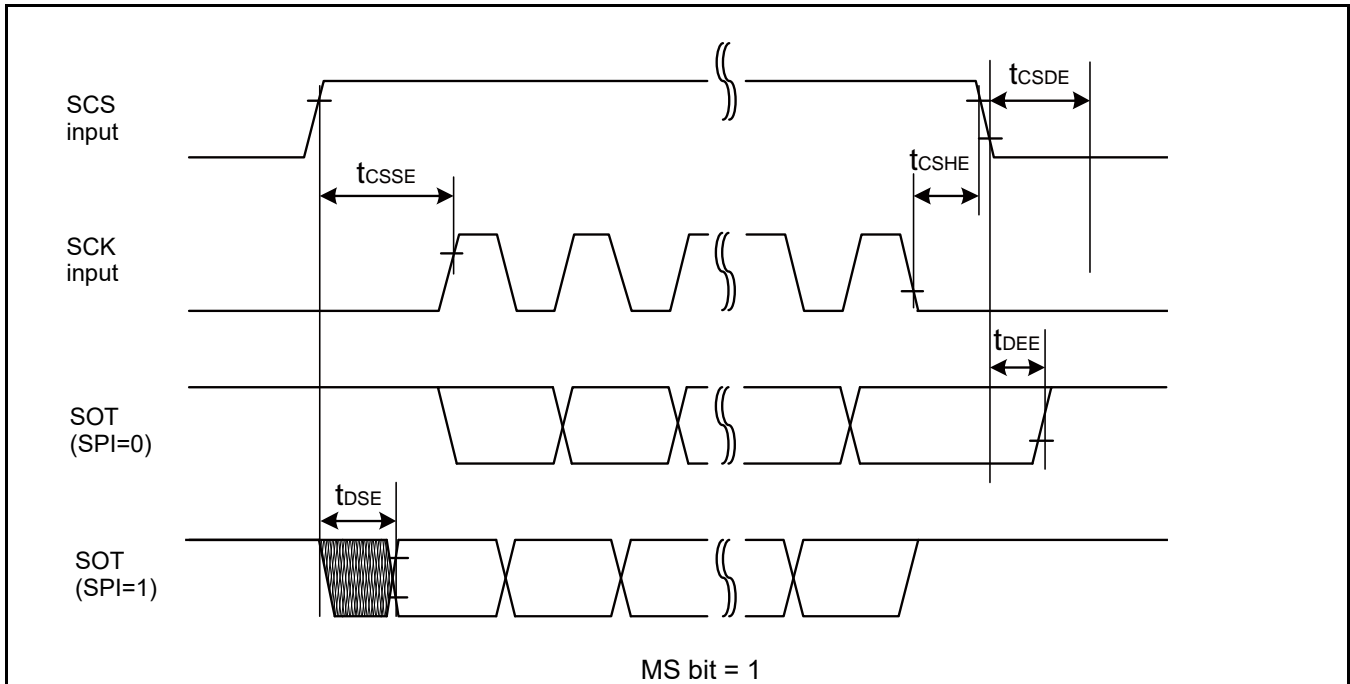
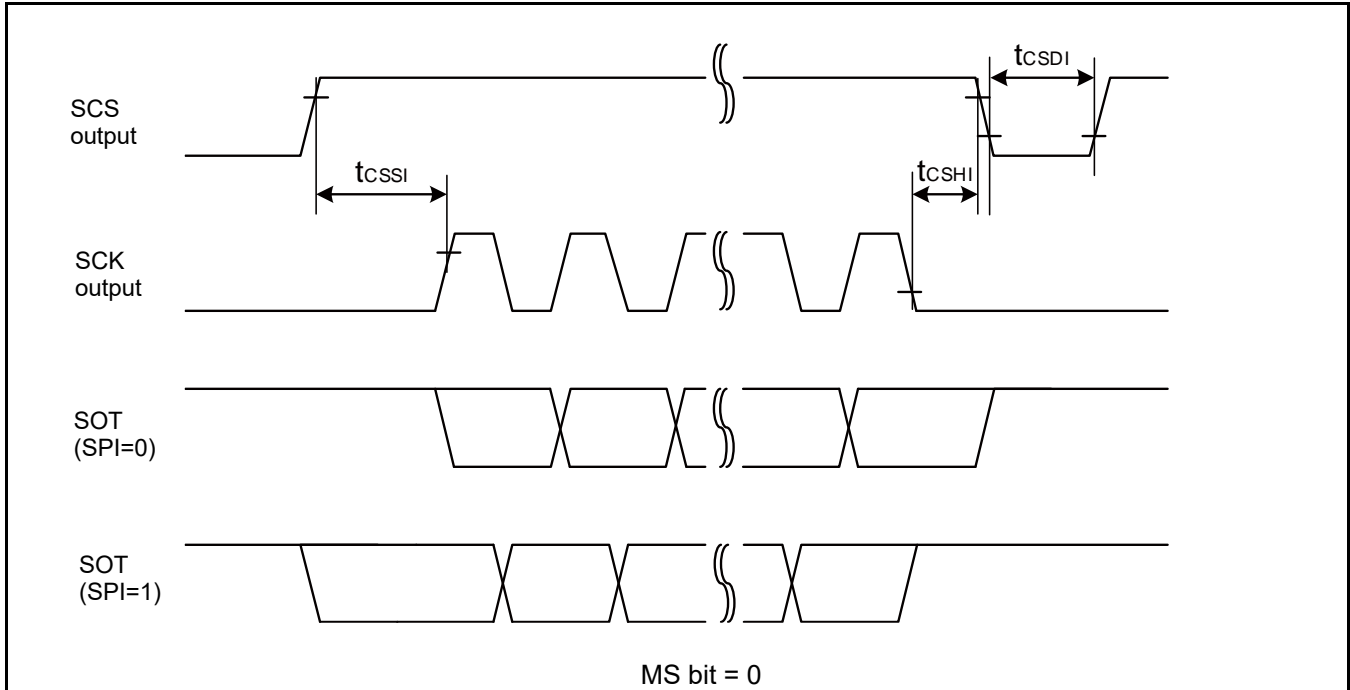
(*1): CSSU bit value×serial chip select timing operating clock cycle [ns]

(*2): CSHD bit value×serial chip select timing operating clock cycle [ns]

(*3): CSDS bit value×serial chip select timing operating clock cycle [ns]

Notes:

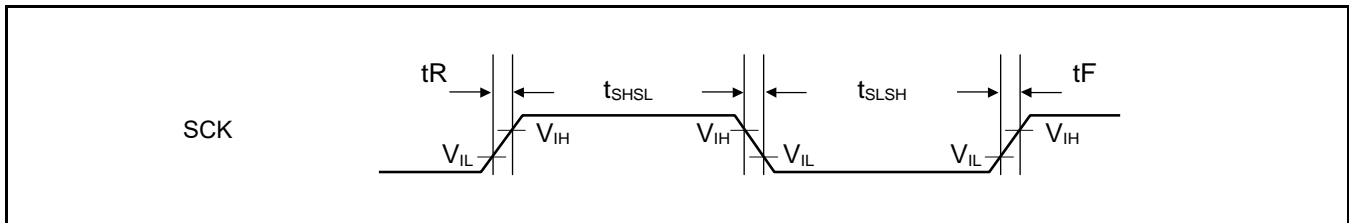
- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- For more information about CSSU, CSHD, CSDS, and the serial chip select timing operating clock, see FM4 Family Peripheral Manual Main Part (002-04856).
- When the external load capacitance C_L = 30 pF.



External clock (EXT = 1): When in Asynchronous Mode Only

 ($V_{CC} = 2.7\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$)

| Parameter | Symbol | Condition | Value | | Unit | Remarks |
|----------------------------|------------|----------------------|-----------------|-----|------|---------|
| | | | Min | Max | | |
| Serial clock L pulse width | t_{SLSH} | $C_L = 30\text{ pF}$ | $t_{CYCP} + 10$ | - | ns | |
| Serial clock H pulse width | t_{SHSL} | | $t_{CYCP} + 10$ | - | ns | |
| SCK fall time | t_F | | - | 5 | ns | |
| SCK rise time | t_R | | - | 5 | ns | |

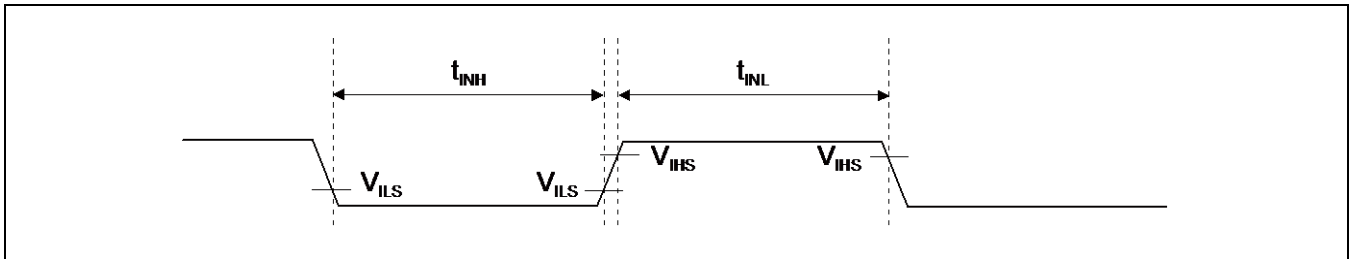


12.4.13 External Input Timing

(V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|-------------------|-------------------------------------|----------------------|------------|--|----------------------|------|-----------------------------|
| | | | | Min | Max | | |
| Input pulse width | t _{INH} , t _{INL} | ADTGx | - | 2t _{CYCP} ^{*1} | - | ns | A/D converter trigger input |
| | | FRCKx | | | | | Free-run timer input clock |
| | | ICxx | | | | | Input capture |
| | | DTTixX | - | 2t _{CYCP} ^{*1} | - | ns | Waveform generator |
| | | INT00 to INT31, NMIX | - | 2t _{CYCP} + 100 ^{*1} | - | ns | External interrupt, NMI |
| | | 500 ^{*2} | | - | ns | | |
| WKUPx | - | 500 ^{*3} | - | ns | Deep standby wake up | | |

- 1: t_{CYCP} indicates the APB bus clock cycle time except stop when in Stop mode, in Timer mode. For more information about the APB bus number to which the A/D converter, multi-function timer, and external interrupt are connected, see 8. Block Diagram in this data sheet.
- 2: When in Stop mode, in Timer mode
- 3: When in Deep Standby RTC mode, in Deep Standby Stop mode

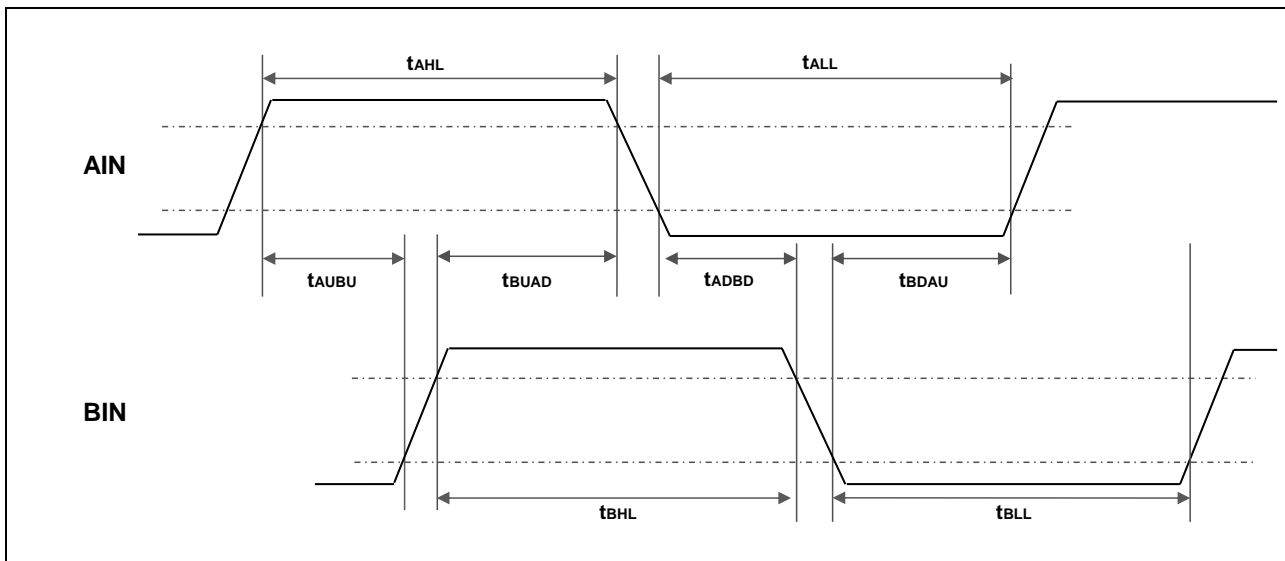


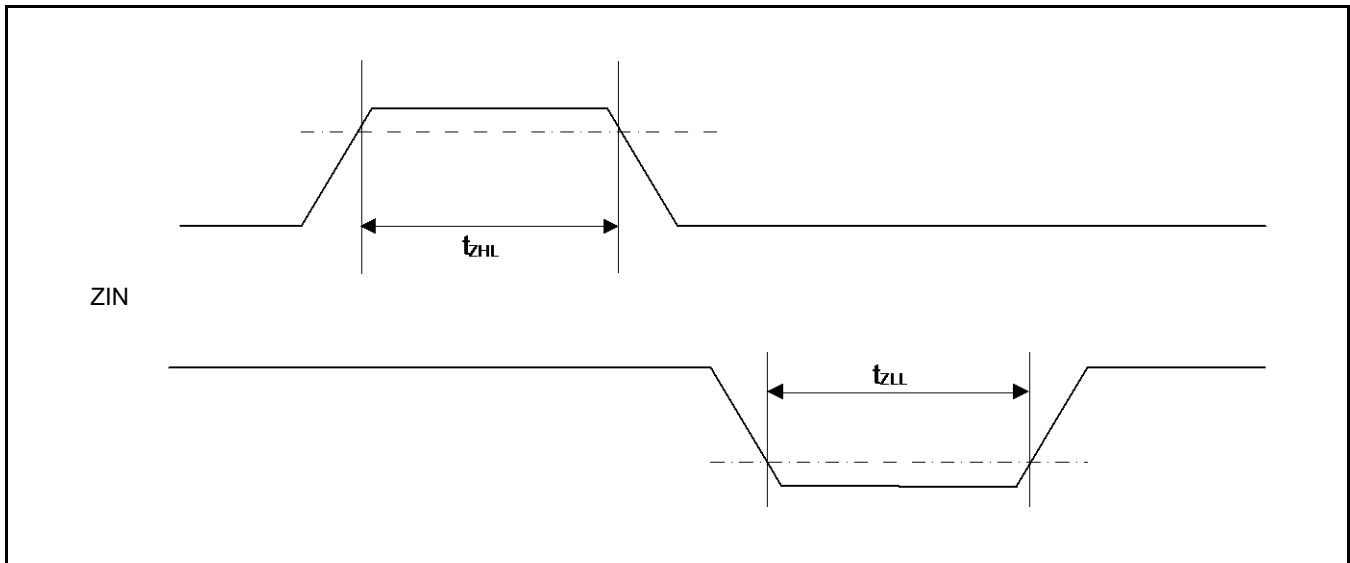
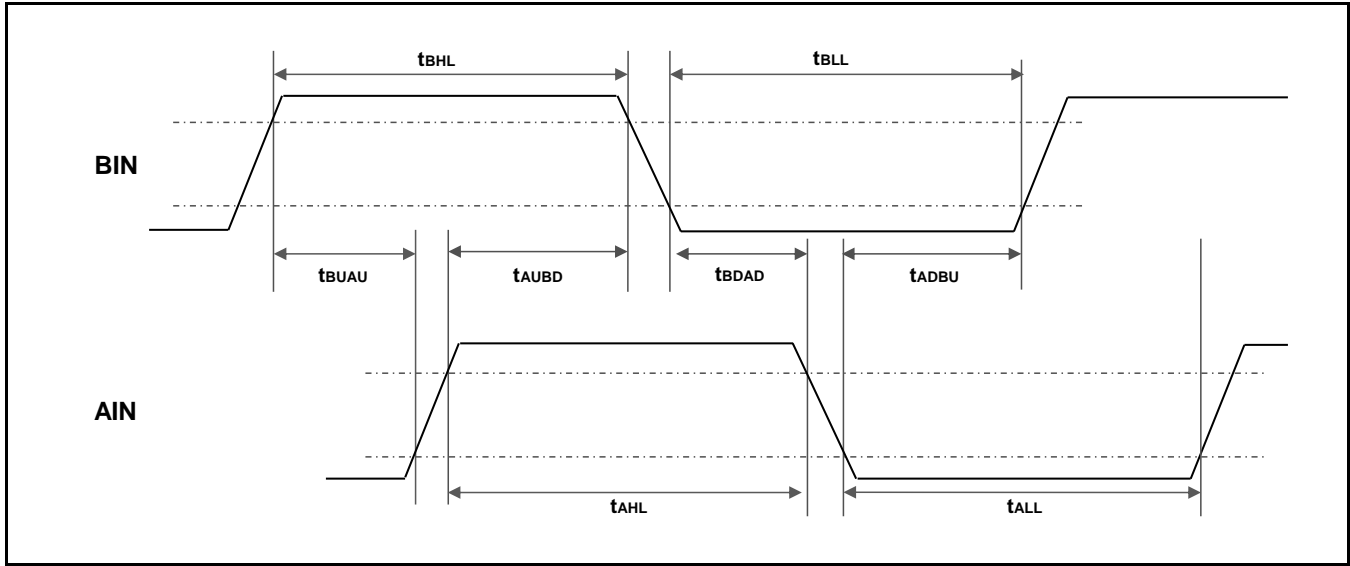
12.4.14 Quadrature Position/Revolution Counter Timing

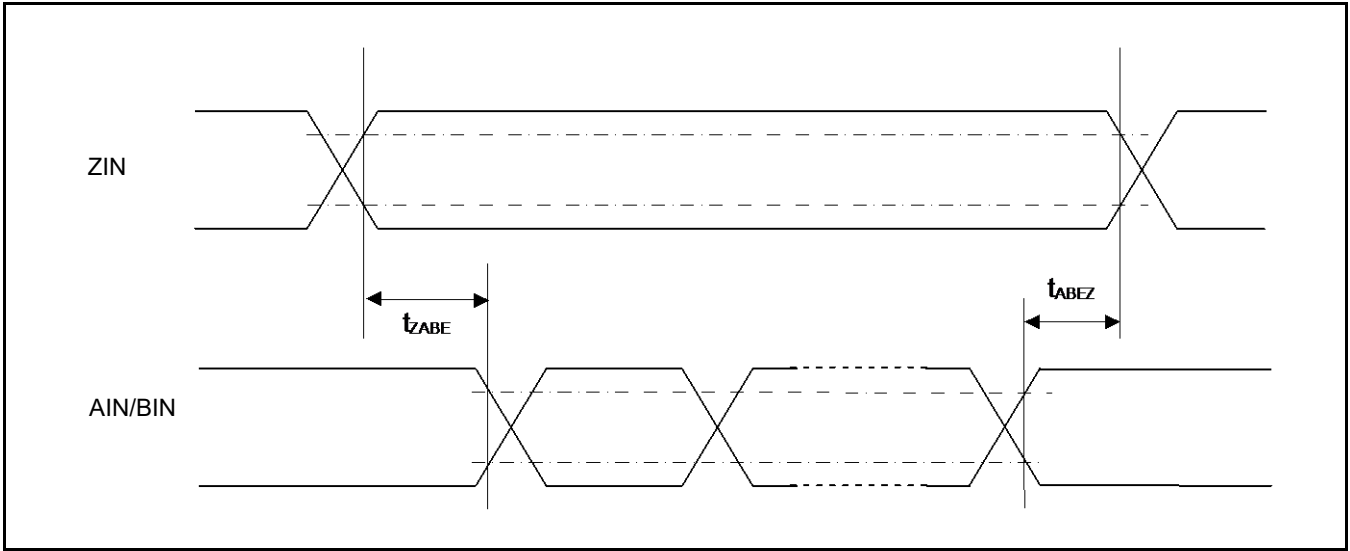
 (V_{CC} = AV_{CC} = 2.7 V to 5.5 V, V_{SS} = AV_{SS} = 0 V, T_A = -40 °C to +105 °C)

| Parameter | Symbol | Conditions | Value | | Unit |
|--|-------------------|----------------------|----------------------|-----|------|
| | | | Min | Max | |
| AIN pin H width | t _{AHL} | - | 2t _{CYCP} * | - | ns |
| AIN pin L width | t _{ALL} | - | | | |
| BIN pin H width | t _{BHL} | - | | | |
| BIN pin L width | t _{BLL} | - | | | |
| BIN rise time from AIN pin H level | t _{AUBU} | PC_Mode2 or PC_Mode3 | | | |
| AIN fall time from BIN pin H level | t _{BUAD} | PC_Mode2 or PC_Mode3 | | | |
| BIN fall time from AIN pin L level | t _{ADBD} | PC_Mode2 or PC_Mode3 | | | |
| AIN rise time from BIN pin L level | t _{BDAU} | PC_Mode2 or PC_Mode3 | | | |
| AIN rise time from BIN pin H level | t _{BUAU} | PC_Mode2 or PC_Mode3 | | | |
| BIN fall time from AIN pin H level | t _{AUBD} | PC_Mode2 or PC_Mode3 | | | |
| AIN fall time from BIN pin L level | t _{BDAD} | PC_Mode2 or PC_Mode3 | | | |
| BIN rise time from AIN pin L level | t _{ADBU} | PC_Mode2 or PC_Mode3 | | | |
| ZIN pin H width | t _{ZHL} | QCR: CGSC = 0 | | | |
| ZIN pin L width | t _{ZLL} | QCR: CGSC = 0 | | | |
| AIN/BIN rise and fall time from determined ZIN level | t _{ZABE} | QCR: CGSC = 1 | | | |
| Determined ZIN level from AIN/BIN rise and fall time | t _{ABEZ} | QCR: CGSC = 1 | | | |

*: t_{CYCP} indicates the APB bus clock cycle time except when in Stop mode, in Timer mode. For more information about the APB bus number to which the quadrature position/revolution counter is connected, see "8. Block Diagram" in this data sheet.







12.4.15 I²C Timing
Standard-mode, Fast-mode

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Conditions | Standard-mode | | Fast-mode | | Unit | Remarks |
|--|--------------------|---|------------------------------------|-----------------------------------|-----------------------------------|-----------------------------------|------|---------|
| | | | Min | Max | Min | Max | | |
| SCL clock frequency | f _{SCL} | C _L = 30 pF, R = (V _p /I _{OL}) ^{*1} | 0 | 100 | 0 | 400 | kHz | |
| (Repeated) START condition hold time SDA ↓ → SCL ↓ | t _{HDSTA} | | 4.0 | - | 0.6 | - | μs | |
| SCL clock L width | t _{LOW} | | 4.7 | - | 1.3 | - | μs | |
| SCL clock H width | t _{HIGH} | | 4.0 | - | 0.6 | - | μs | |
| (Repeated) START condition setup time SCL ↑ → SDA ↓ | t _{SUSTA} | | 4.7 | - | 0.6 | - | μs | |
| Data hold time SCL ↓ → SDA ↓ ↑ | t _{HDDAT} | | 0 | 3.45 ^{*2} | 0 | 0.9 ^{*3} | μs | |
| Data setup time SDA ↓ ↑ → SCL ↑ | t _{SUDAT} | | 250 | - | 100 | - | ns | |
| Stop condition setup time SCL ↑ → SDA ↑ | t _{SUSTO} | | 4.0 | - | 0.6 | - | μs | |
| Bus free time between "Stop condition" and "START condition" | t _{BUF} | | 4.7 | - | 1.3 | - | μs | |
| Noise filter | t _{SP} | | 2 MHz ≤ t _{CYCP} < 40 MHz | 2 t _{CYCP} ^{*4} | - | 2 t _{CYCP} ^{*4} | - | ns |
| | | 40 MHz ≤ t _{CYCP} < 60 MHz | 4 t _{CYCP} ^{*4} | - | 4 t _{CYCP} ^{*4} | - | ns | |
| | | 60 MHz ≤ t _{CYCP} < 80 MHz | 6 t _{CYCP} ^{*4} | - | 6 t _{CYCP} ^{*4} | - | ns | |
| | | 80 MHz ≤ t _{CYCP} ≤ 100 MHz | 8 t _{CYCP} ^{*4} | - | 8 t _{CYCP} ^{*4} | - | ns | |

*1: R and C_L represent the pull-up resistance and load capacitance of the SCL and SDA lines, respectively. V_p indicates the power supply voltage of the pull-up resistance and I_{OL} indicates V_{OL} guaranteed current.

*2: The maximum t_{HDDT} must not extend beyond the low period (t_{LOW}) of the device's SCL signal.

*3: Fast-mode I²C bus device can be used on a Standard-mode I²C bus system as long as the device satisfies the requirement of "t_{SUDAT} ≥ 250 ns."

*4: t_{CYCP} is the APB bus clock cycle time. For more information about the APB bus number to which the I²C is connected, see "8.Block Diagram" in this data sheet.

When using Standard-mode, the peripheral bus clock must be set more than 2 MHz.

When using Fast-mode, the peripheral bus clock must be set more than 8 MHz.

*5: The noise filter time can be changed by register settings. Change the number of the noise filter steps according to the APB bus clock frequency.

Fast Mode Plus (Fm+)

(V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Conditions | Fast Mode Plus (Fm+)*6 | | Unit | Remarks |
|--|--------------------|---|-------------------------------------|------------------------|------|---------|
| | | | Min | Max | | |
| SCL clock frequency | f _{SCL} | C _L = 30 pF, R = (V _p /I _{OL})*1 | 0 | 1000 | kHz | |
| (Repeated) START condition hold time SDA ↓ → SCL ↓ | t _{HDSTA} | | 0.26 | - | μs | |
| SCL clock L width | t _{LOW} | | 0.5 | - | μs | |
| SCL clock H width | t _{HIGH} | | 0.26 | - | μs | |
| SCL clock frequency | t _{SUSTA} | | 0.26 | - | μs | |
| (Repeated) START condition hold time SDA ↓ → SCL ↓ | t _{HDDAT} | | 0 | 0.45*2, *3 | μs | |
| Data setup time SDA ↓ ↑ → SCL ↑ | t _{SUDAT} | | 50 | - | ns | |
| Stop condition setup time SCL ↑ → SDA ↑ | t _{SUSTO} | | 0.26 | - | μs | |
| Bus free time between "Stop condition" and "START condition" | t _{BUF} | | 0.5 | - | μs | |
| Noise filter | t _{SP} | | 60 MHz ≤ t _{CYCP} < 80 MHz | 6 t _{CYCP} *4 | - | ns |
| | | 80 MHz ≤ t _{CYCP} ≤ 100 MHz | 8 t _{CYCP} *4 | - | ns | |

*1: R and C_L represent the pull-up resistance and load capacitance of the SCL and SDA lines, respectively. V_p indicates the power supply voltage of the pull-up resistance and I_{OL} indicates V_{OL} guaranteed current.

*2: The maximum t_{HDDT} must not extend beyond the low period (t_{LOW}) of the device's SCL signal.

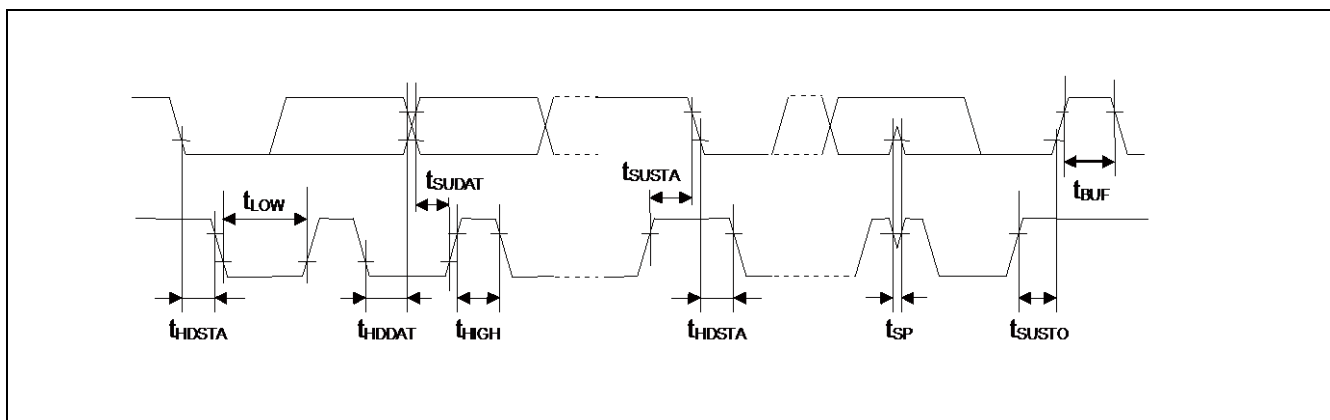
*3: The Fast mode I²C bus device can be used on a Standard-mode I²C bus system as long as the device satisfies the requirement of "t_{SUDAT} ≥ 250 ns."

*4: t_{CYCP} is the APB bus clock cycle time. For more information about the APB bus number to which the I²C is connected, see "8.Block Diagram" in this data sheet.

To use fast mode plus (Fm+), set the peripheral bus clock at 64 MHz or more.

*5: The noise filter time can be changed by register settings. Change the number of the noise filter steps according to the APB bus clock frequency.

*6: When using fast mode plus (Fm+), set the I/O pin to the mode corresponding to I²C Fm+ in the EPFR register. See Chapter12: I/O PORT in FM4 Family Peripheral Manual Main Part (002-04856) for the details.



12.4.16 SD Card Interface Timing

Default-Speed Mode

■ Clock CLK (All values are referenced to V_{IH} and V_{IL} transition points)

($V_{CC} = 2.7\text{ V to }3.6\text{ V}$, $V_{SS} = 0\text{ V}$)

| Parameter | Symbol | Pin Name | Conditions | Value | | Remarks |
|-------------------------------------|-----------|----------|---|-------|-----|---------|
| | | | | Min | Max | |
| Clock frequency Data Transfer Mode | f_{PP} | S_CLK | $C_{CARD} \leq 10\text{ pF}$ (1card) | 0 | 25 | MHz |
| Clock frequency Identification Mode | f_{OD} | S_CLK | | 0/100 | 400 | kHz |
| Clock low time | t_{WL} | S_CLK | | 10 | - | ns |
| Clock high time | t_{WH} | S_CLK | | 10 | - | ns |
| Clock rise time | t_{TLH} | S_CLK | | - | 10 | ns |
| Clock fall time | t_{THL} | S_CLK | | - | 10 | ns |

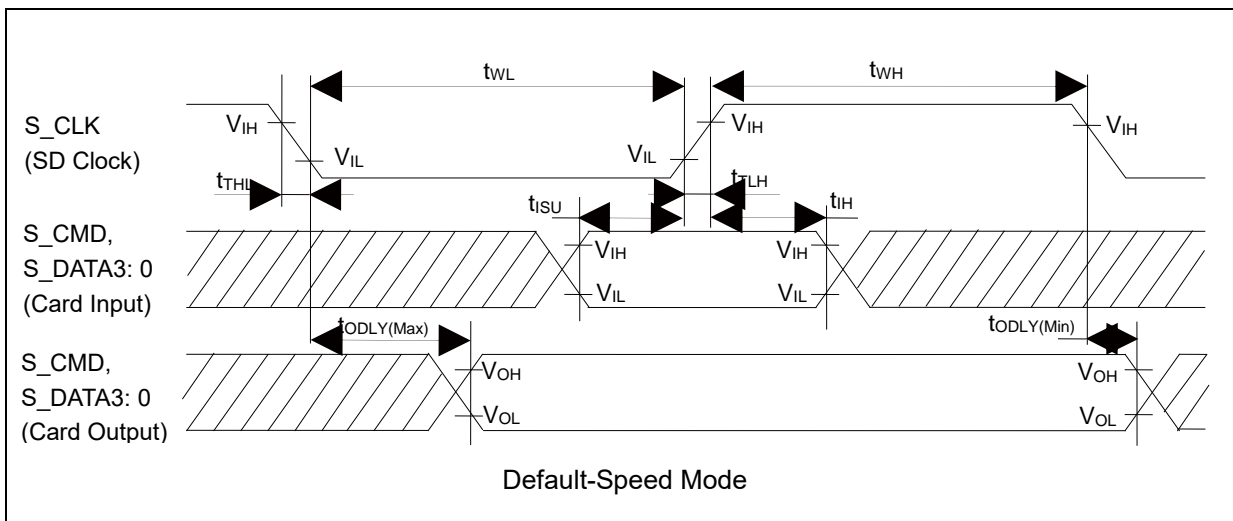
* 0 Hz means to stop the clock. The given minimum frequency range is for cases where a continuous clock is required.

■ Card Inputs CMD, DAT (referenced to Clock CLK)

| Parameter | Symbol | Pin Name | Conditions | Value | | Remarks |
|-------------------|-----------|----------------------|---|-------|-----|---------|
| | | | | Min | Max | |
| Input set-up time | t_{ISU} | S_CMD, S_DATA3: 0 | $C_{CARD} \leq 10\text{ pF}$ (1card) | 5 | - | ns |
| Input hold time | t_{IH} | S_CMD, S_DATA3: 0 | | 5 | - | ns |

■ Card Outputs CMD, DAT (referenced to Clock CLK)

| Parameter | Symbol | Pin Name | Conditions | Value | | Remarks |
|--|------------|----------------------|---|-------|-----|---------|
| | | | | Min | Max | |
| Output Delay time during Data Transfer Mode | t_{ODLY} | S_CMD, S_DATA3: 0 | $C_{CARD} \leq 40\text{ pF}$ (1card) | 0 | 14 | ns |
| Output Delay time during Identification Mode | t_{ODLY} | S_CMD, S_DATA3: 0 | | 0 | 50 | ns |



Notes:

- The Card Input corresponds to the Host Output and the Card Output corresponds to the Host Input because this model is the Host.
- For more information about clock frequency (f_{PP}), see Chapter 15: SD card Interface in FM4 Family Peripheral Manual Main Part (002-04856).

High-Speed Mode

■ Clock CLK (All values are referred to V_{IH} and V_{IL})

($V_{CC} = 2.7\text{ V to }3.6\text{ V}$, $V_{SS} = 0\text{ V}$)

| Parameter | Symbol | Pin Name | Conditions | Value | | Remarks |
|------------------------------------|-----------|----------|--|-------|-----|---------|
| | | | | Min | Max | |
| Clock frequency Data Transfer Mode | f_{PP} | S_CLK | $C_{CARD} \leq 10\text{ pF}$ (1 card) | 0 | 50 | MHz |
| Clock low time | t_{WL} | S_CLK | | 7 | - | ns |
| Clock high time | t_{WH} | S_CLK | | 7 | - | ns |
| Clock rise time | t_{TLH} | S_CLK | | - | 3 | ns |
| Clock fall time | t_{THL} | S_CLK | | - | 3 | ns |

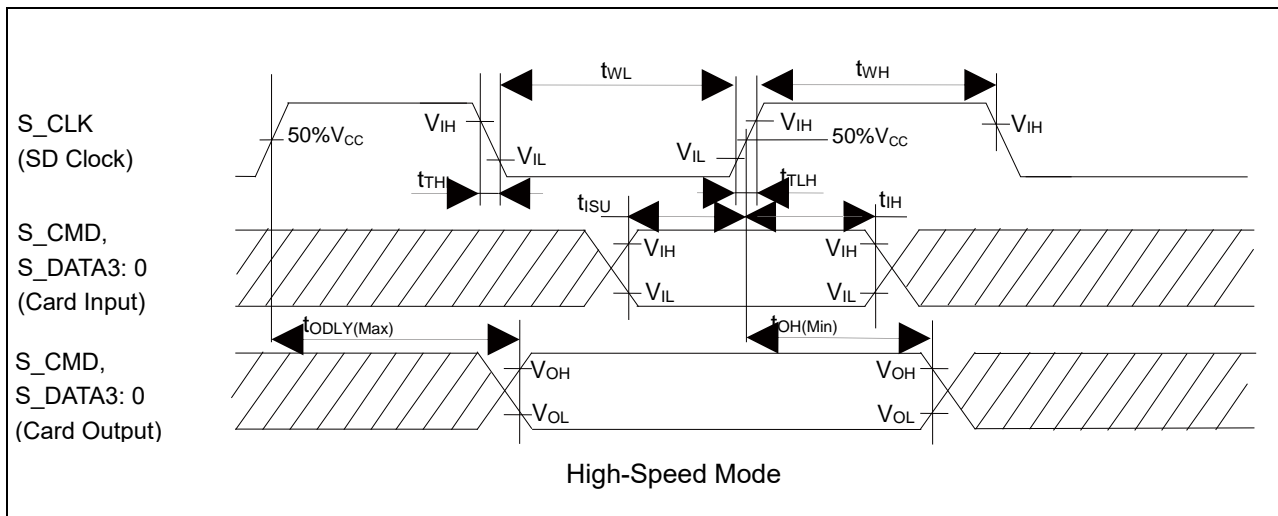
■ Card Inputs CMD, DAT (referenced to Clock CLK)

| Parameter | Symbol | Pin Name | Conditions | Value | | Remarks |
|-------------------|-----------|----------------------|--|-------|-----|---------|
| | | | | Min | Max | |
| Input set-up time | t_{ISU} | S_CMD, S_DATA3: 0 | $C_{CARD} \leq 10\text{ pF}$ (1 card) | 6 | - | ns |
| Input hold time | t_{IH} | S_CMD, S_DATA3: 0 | | 2 | - | ns |

■ Card Outputs CMD, DAT (referenced to Clock CLK)

| Parameter | Symbol | Pin Name | Conditions | Value | | Remarks |
|---|------------|----------------------|-------------------------------------|-------|-----|---------|
| | | | | Min | Max | |
| Output delay time during data transfer mode | t_{ODLY} | S_CMD, S_DATA3: 0 | $C_L \leq 40\text{ pF}$ (1 card) | 0 | 14 | ns |
| Output hold time | t_{OH} | S_CMD, S_DATA3: 0 | $C_L \geq 15\text{ pF}$ (1 card) | 2.5 | - | ns |
| Total system capacitance for each line* | C_L | - | 1 card | - | 40 | pF |

*: In order to satisfy severe timing, host shall drive only one card.



Notes:

- The Card Input corresponds to the Host Output and the Card Output corresponds to the Host Input because this model is the Host.
- For more information about clock frequency (f_{PP}), see Chapter 15: SD card Interface in FM4 Family Peripheral Manual Main Part (002-04856).

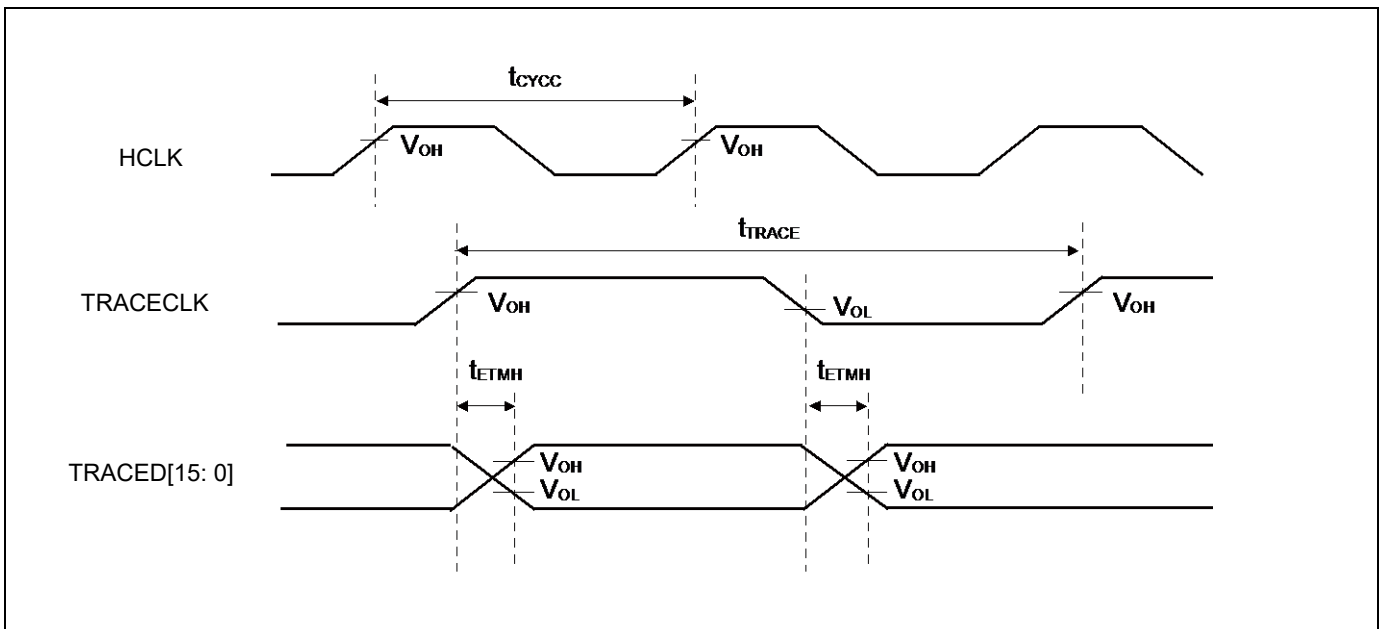
12.4.17 ETM/ HTM Timing

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|----------------------|----------------------|----------------------------|-------------------------|-------|-----|------|---------|
| | | | | Min | Max | | |
| Data hold | t _{ETMH} | TRACECLK, TRACED[15: 0] | V _{CC} ≥ 4.5 V | 2 | 9 | ns | |
| | | | V _{CC} < 4.5 V | 2 | 15 | | |
| TRACECLK frequency | 1/t _{TRACE} | TRACECLK | V _{CC} ≥ 4.5 V | | 50 | MHz | |
| | | | V _{CC} < 4.5 V | | 32 | MHz | |
| TRACECLK clock cycle | t _{TRACE} | | V _{CC} ≥ 4.5 V | 20 | - | ns | |
| | | | V _{CC} < 4.5 V | 31.25 | - | ns | |

Note:

- When the external load capacitance C_L = 30 pF.



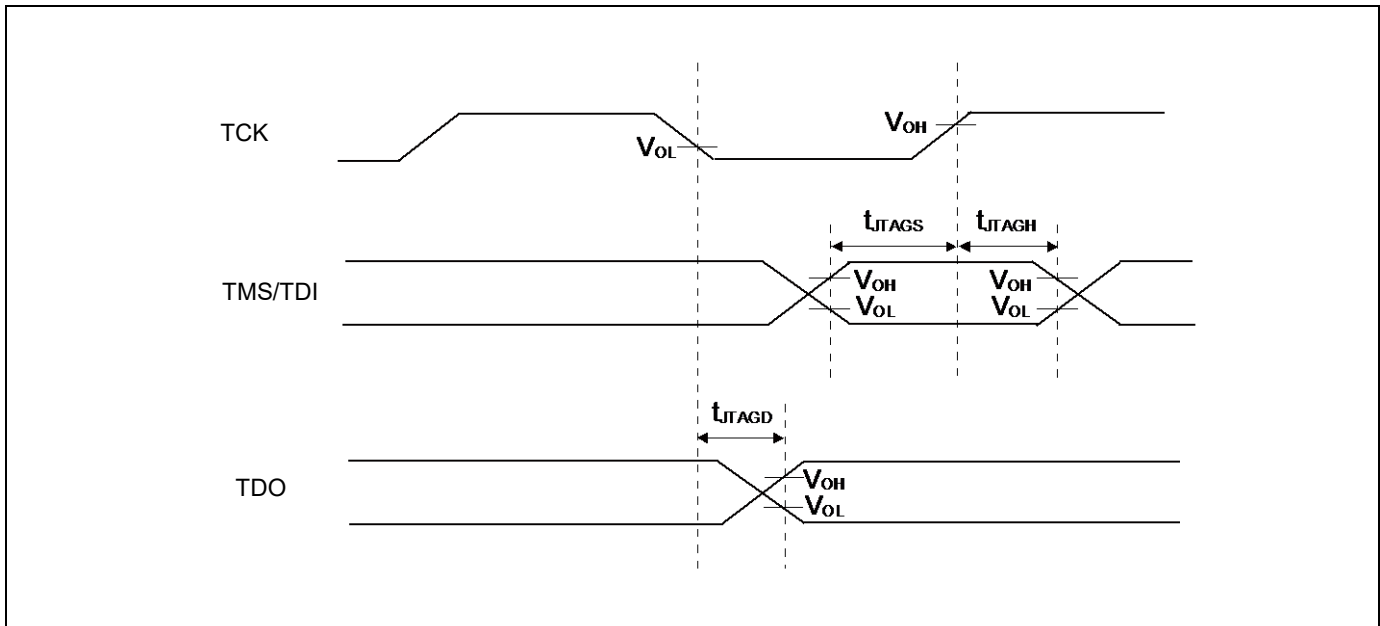
12.4.18 JTAG Timing

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|---------------------|--------------------|------------------|-------------------------|-------|-----|------|---------|
| | | | | Min | Max | | |
| TMS, TDI setup time | t _{JTAGS} | TCK, TMS, TDI | V _{CC} ≥ 4.5 V | 15 | - | ns | |
| | | | V _{CC} < 4.5 V | | | | |
| TMS, TDI hold time | t _{JTAGH} | TCK, TMS, TDI | V _{CC} ≥ 4.5 V | 15 | - | ns | |
| | | | V _{CC} < 4.5 V | | | | |
| TDO delay time | t _{JTAGD} | TCK, TDO | V _{CC} ≥ 4.5 V | - | 25 | ns | |
| | | | V _{CC} < 4.5 V | - | 45 | | |

Note:

- When the external load capacitance C_L = 30 pF.



12.4.19 I²S Timing
Master Mode Timing

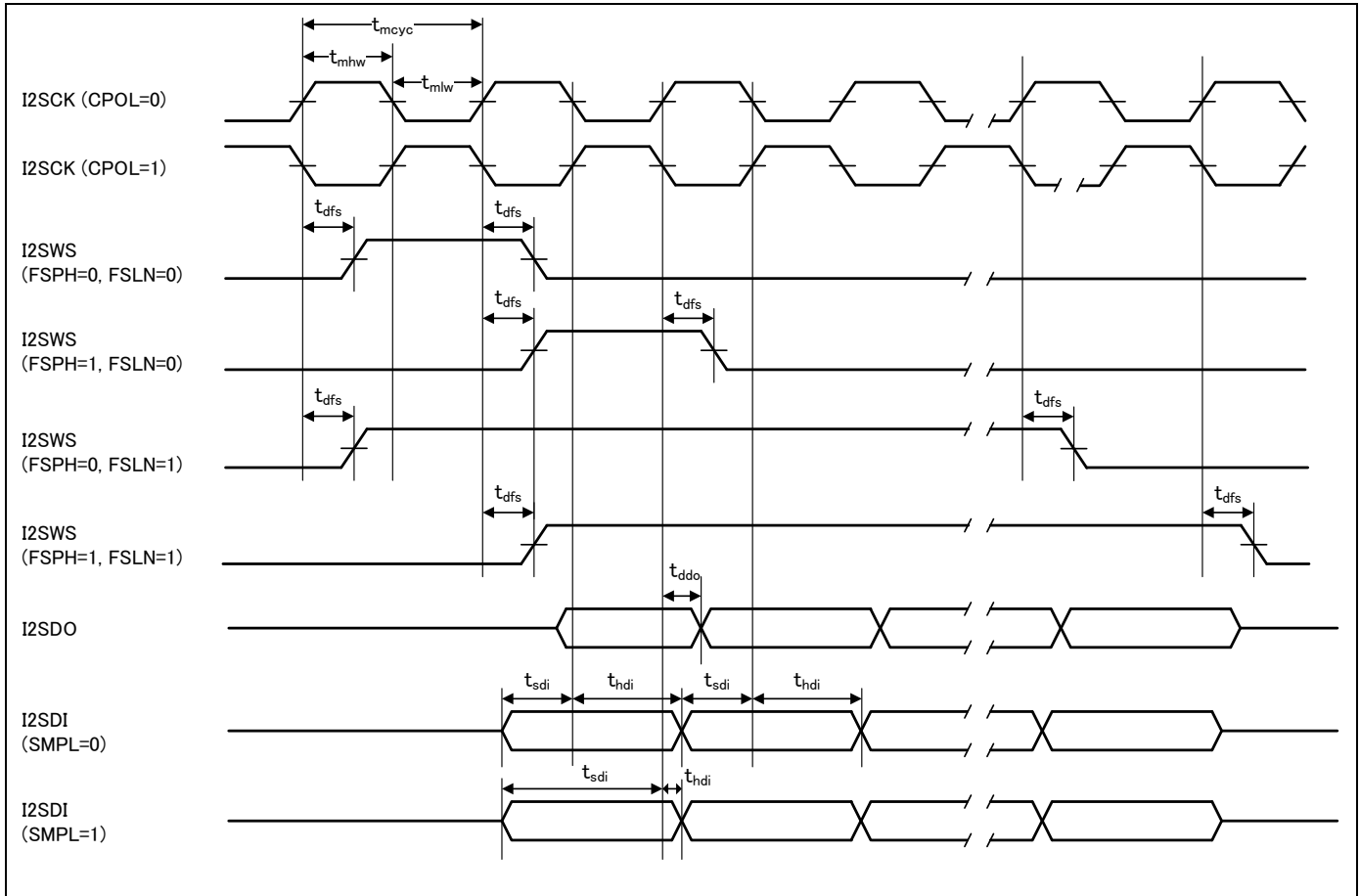
 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|--------------------------|--------------------|--------------|------------|-------|--------|------|---------|
| | | | | Min | Max | | |
| Output frequency | f _{M CYC} | I2SCK | - | - | 12.288 | MHz | |
| Output clock pulse width | t _{M HW} | I2SCK | - | 45 | 55 | % | |
| | t _{M LW} | | | 45 | 55 | % | |
| I2SCK→I2SWS delay time | t _{D FS} | I2SCK, I2SWS | - | 0 | 24.0 | ns | |
| I2SCK→I2SDO delay time* | t _{D DO} | I2SCK, I2SDO | - | 0 | 24.0 | ns | |
| I2SDI→I2SCK setup time | t _{H SDI} | I2SCK, I2SDI | - | 25.0 | - | ns | |
| I2SDI→I2SCK hold time | t _{H DI} | | - | 0 | - | ns | |
| Input signal rise time | t _{F I} | I2SDI | - | - | 5 | ns | |
| Input signal fall time | t _{F I} | | - | - | 5 | ns | |

*: Except for the first bit of transmission frame

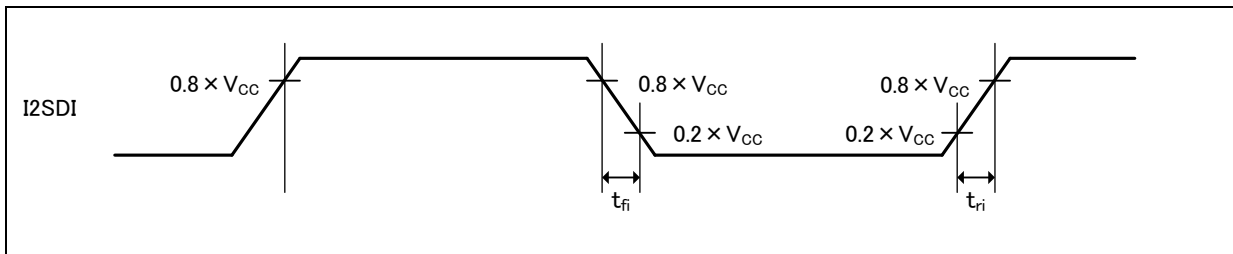
Notes:

- When the external load capacitance C_L = 20 pF
- When I2SWS = 48 kHz, I2MCLK = 256 × I2SWS
 Frame synchronization signal (I2SWS) is settable to 48 kHz, 32 kHz, 16 kHz.
 See Chapter7-2: I²S (Inter-IC Sound bus) Interface in FM4 Family Peripheral Manual Communication Macro Part (002-04862) for the details.



Note:

- See Chapter7-2: I²S (Inter-IC Sound bus) Interface in FM4 Family Peripheral Manual Communication Macro Part (002-04862) for the details of CPOL, FSPH, FSLIN, and SMPL.



Slave Mode Timing

 (V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

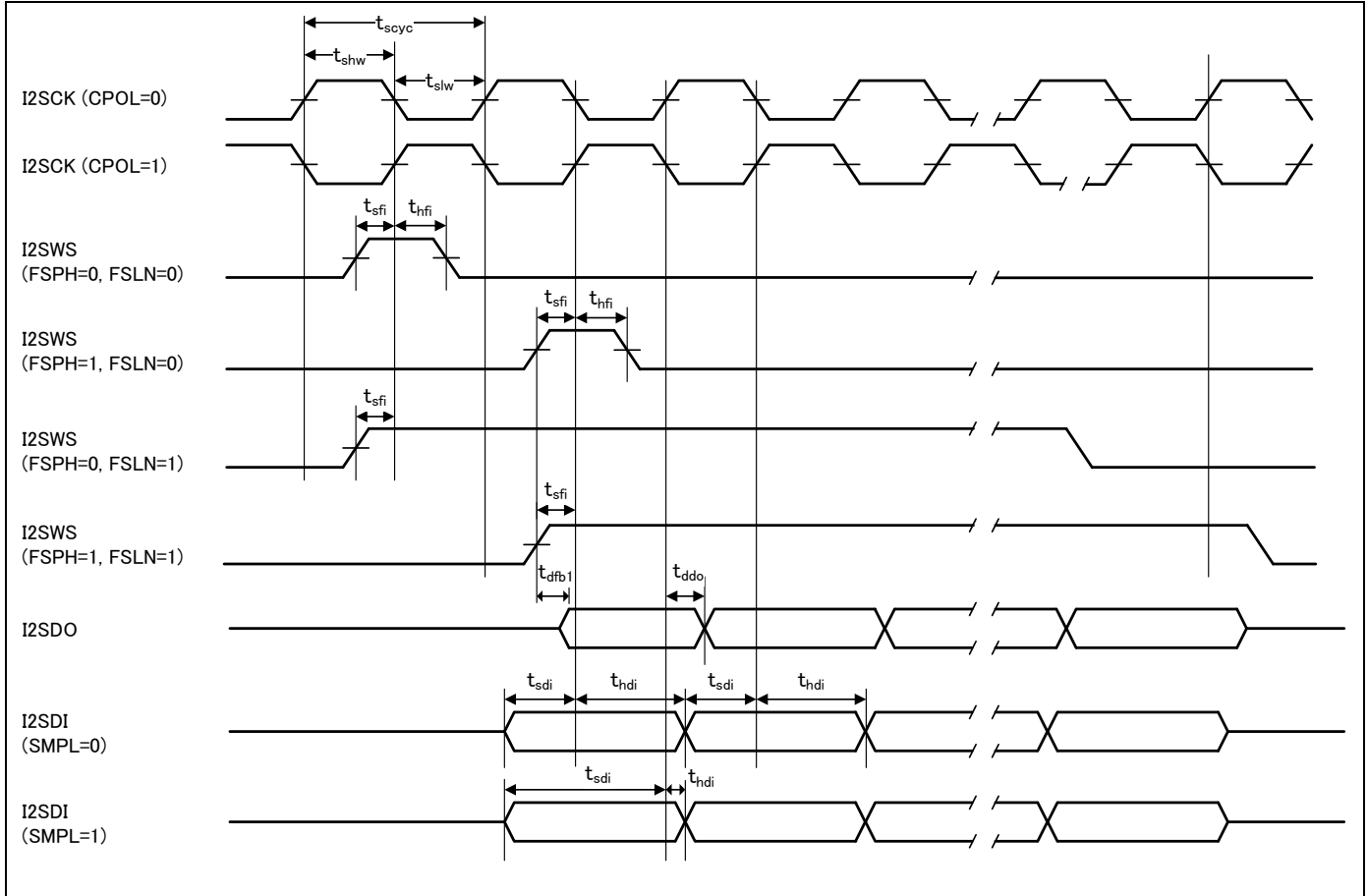
| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|---|-------------------|------------------------|------------|-------|--------|------|---------|
| | | | | Min | Max | | |
| Input frequency | f _{SCYC} | I2SCK | - | - | 12.288 | MHz | |
| Input clock pulse width | t _{SHW} | I2SCK | - | 45 | 55 | % | |
| | t _{SLW} | | | 45 | 55 | % | |
| I2SWS → I2SCK Setup time | t _{SFI} | I2SCK, I2SWS | - | 8 | - | ns | |
| I2SWS → I2SCK Hold time | t _{HFI} | I2SCK, I2SWS | - | 0 | - | ns | |
| I2SCK ↑ → I2SDO Delay time ^{*1} | t _{DDO} | I2SCK, I2SDO | - | 0 | 32 | ns | |
| I2SCK ↑ → I2SDO Delay time ^{*2} | t _{DFB1} | | - | 0 | 32 | ns | |
| I2SDI → I2SCK ↓ Setup time | t _{SDI} | I2SCK, I2SDI | - | 8 | - | ns | |
| I2SDI → I2SCK ↓ Hold time | t _{HDI} | | - | 0 | - | ns | |
| Input signal rise time | t _{FI} | I2SCK, I2SWS, I2SDI | - | - | 5 | ns | |
| Input signal fall time | t _{FI} | | - | - | 5 | ns | |

*1: Except for the first bit of transmission frame

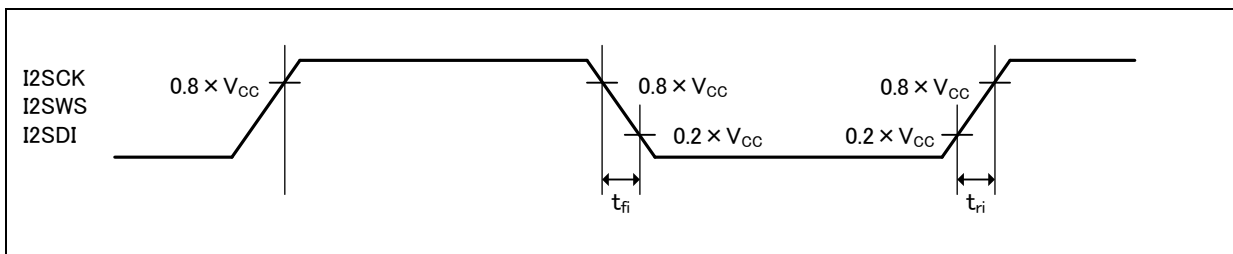
*2: When FSPH bit = 1.

Notes:

- When the external load capacitance C_L = 20 pF
- When I2SWS = 48 kHz, I2MCLK = 256 × I2SWS
 Frame synchronization signal (I2SWS) is settable to 48 kHz, 32 kHz, 16 kHz. See Chapter 7-2: I²S (Inter-IC Sound bus) Interface in FM4 Family Peripheral Manual Communication Macro Part (002-04862) for the details.


Notes:

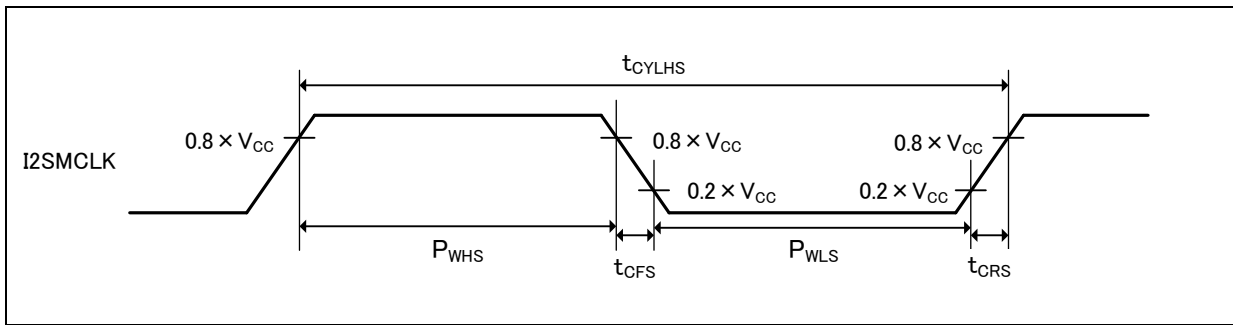
- See Chapter7-2: I²S (Inter-IC Sound bus) Interface in FM4 Family Peripheral Manual Communication Macro Part (002-04862) for the details of FSPH, FSLN, SMPL
- I2SCK input is selectable polarity by CPOL bit of CNTREG register



I2SMCLK Input Characteristics

 ($V_{CC} = 2.7\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$)

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|-------------------------------------|------------------------|----------|--|-------|-----|------|---------------------------|
| | | | | Min | Max | | |
| Input frequency | f_{CHS} | I2SMCK | - | - | 25 | MHz | |
| Input clock cycle | t_{CYLHS} | - | - | 40 | - | ns | |
| Input clock pulse width | - | - | P_{WHS}/t_{CYLHS} P_{WLS}/t_{CYLHS} | 45 | 55 | % | When using external clock |
| Input clock rise time and fall time | t_{CFS} t_{CRS} | - | - | - | 5 | ns | When using external clock |


I2SMCLK Output Characteristics

 ($V_{CC} = 2.7\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$)

| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|------------------|-----------|----------|------------|-------|--------|------|---------|
| | | | | Min | Max | | |
| Output frequency | f_{CHS} | I2SMCK | - | - | 12.288 | MHz | |

12.4.20 High-Speed Quad SPI Timing

 (V_{CC} = 2.7 V to 3.6 V, V_{SS} = 0 V)

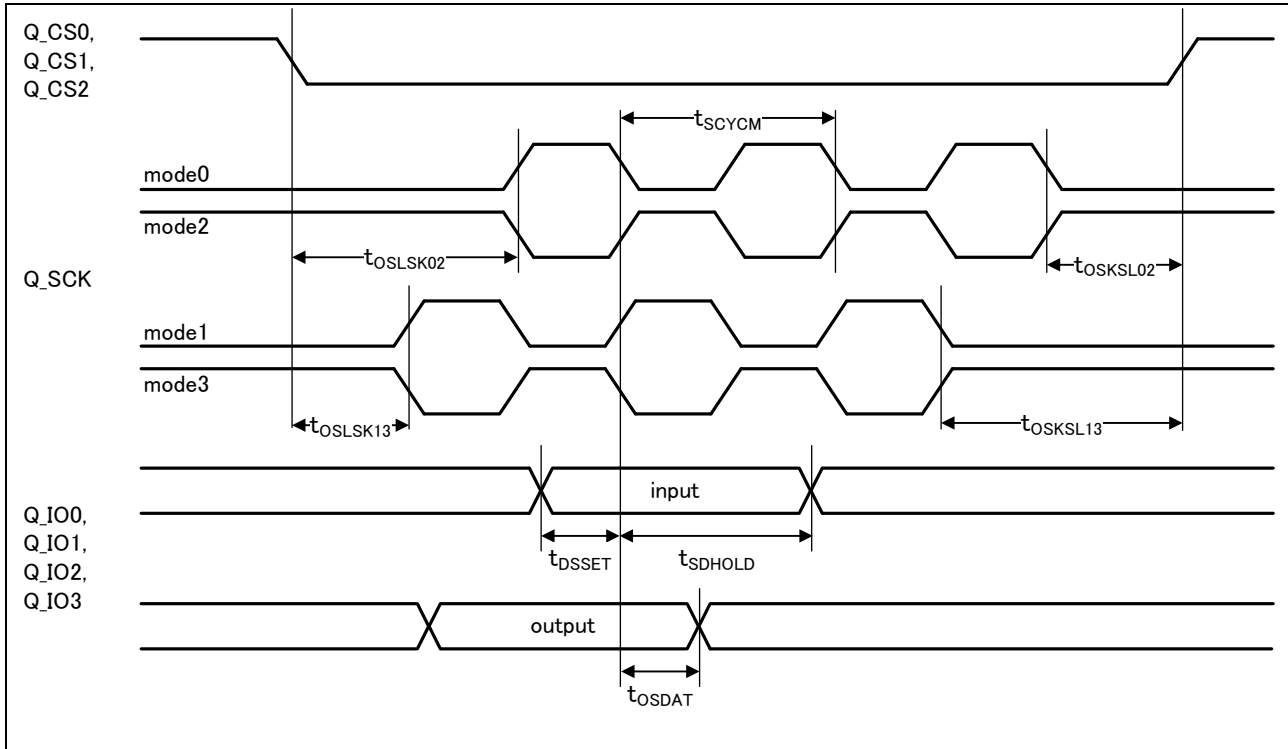
| Parameter | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|---|----------------------|---|--|------------------------------|-----|------|---------|
| | | | | Min | Max | | |
| Serial clock frequency | t _{SCYCM} | Q_SCK_0 | C _L = 15 pF, V _{CC} = 3.0 to 3.6V | - | 66 | MHz | *1 |
| | | | C _L = 30 pF | - | 50 | MHz | *2 |
| Enabled CS→ CLK Starting Time (mode0/mode2) | t _{OSLSK02} | Q_SCK_0, Q_CS0_0, Q_CS1_0, Q_CS2_0 | C _L = 30 pF | 1.5 × t _{SCYCM} - 5 | - | ns | |
| Enabled CS→ CLK Starting Time (mode1/mode3) | t _{OSLSK13} | | | t _{SCYCM} - 5 | - | ns | |
| CLK Last→ Disabled CS Time (mode0/mode2) | t _{OSKSL02} | | | t _{SCYCM} | - | ns | |
| CLK Last→ Disabled CS Time (mode1/mode3) | t _{OSKSL13} | | | 1.5 × t _{SCYCM} | - | ns | |
| SIO Data output time | t _{OSDAT} | Q_SCK_0, Q_IO0_0, Q_IO1_0, Q_IO2_0, Q_IO3_0 | C _L = 15 pF, V _{CC} = 3.0 to 3.6V | 0 | 5 | ns | |
| | | | C _L = 30 pF | 0 | 5 | | |
| SIO Setup | t _{DSSET} | Q_SCK_0, Q_IO0_0, Q_IO1_0, Q_IO2_0, Q_IO3_0 | C _L = 30 pF | 3 | - | ns | *1 |
| | | | | 10 | - | | *2 |
| SIO Hold | t _{SDHOLD} | | C _L = 30 pF | 0.5 × t _{SCYCM} | - | ns | |

*1: When RTM = 1 and mode = 0, 1, 3

*2: When RTM = 1 and mode = 2 or RTM = 0 and mode = 0, 1, 2, 3

Notes:

- See Chapter8-3: High-Speed Quad SPI controller in FM4 Family Peripheral Manual Communication Macro Part (002-04862) for the detail of RTM mode.
- When using High-Speed Quad SPI, please set PDSR register to set the pin drive capability for V_{CC} = 3 V. See Chapter12: I/O Port in FM4 Family Peripheral Manual Main Part (002-04856) for the details.



12.5 12-bit A/D Converter
Electrical Characteristics for the A/D Converter

 (V_{CC} = AV_{CC} = 2.7 V to 5.5 V, V_{SS} = AV_{SS} = AV_{RL} = 0 V)

| Parameter | Symbol | Pin Name | Value | | | Unit | Remarks |
|---|------------------|------------------|-----------------------|------|-----------------------|------|--------------------------------------|
| | | | Min | Typ | Max | | |
| Resolution | - | - | - | - | 12 | bit | |
| Integral nonlinearity | - | - | - 4.5 | - | + 4.5 | LSB | AVRH = 2.7 V to 5.5 V |
| Differential nonlinearity | - | - | - 2.5 | - | + 2.5 | LSB | |
| Zero transition voltage | V _{ZT} | ANxx | - 15 | - | + 15 | mV | |
| Full-scale transition voltage | V _{FST} | ANxx | AVRH - 15 | - | AVRH + 15 | mV | |
| | | | AV _{CC} - 15 | - | AV _{CC} + 15 | mV | |
| Conversion time | - | - | 0.5 ^{*1} | - | - | μs | AV _{CC} ≥ 4.5 V |
| Sampling time *2 | T _s | - | 0.15 | - | 10 | μs | AV _{CC} ≥ 4.5 V |
| | | | 0.3 | - | | | AV _{CC} < 4.5 V |
| Compare clock cycle *3 | T _{ck} | - | 25 | - | 1000 | ns | AV _{CC} ≥ 4.5 V |
| | | | 50 | - | | | AV _{CC} < 4.5 V |
| State transition time to operation permission | T _{stt} | - | - | - | 1.0 | μs | |
| Power supply current (analog + digital) | - | AV _{CC} | - | 0.69 | 0.92 | mA | A/D 1 unit operation |
| | | | - | 1.3 | 22 | μA | When A/D stop |
| Reference power supply current (AVRH) | - | AVRH | - | 1.1 | 1.97 | mA | A/D 1 unit operation AVRH = 5.5 V |
| | | | - | 0.3 | 6.3 | μA | When A/D stop |
| Analog input capacity | C _{AIN} | - | - | - | 12.05 | pF | |
| Analog input resistance | R _{AIN} | - | - | - | 1.2 | kΩ | AV _{CC} ≥ 4.5 V |
| | | | | | 1.8 | | AV _{CC} < 4.5 V |
| Interchannel disparity | - | - | - | - | 4 | LSB | |
| Analog port input leak current | - | ANxx | - | - | 5 | μA | |
| Analog input voltage | - | ANxx | AV _{SS} | - | AVRH | V | |
| | | | AV _{SS} | - | AV _{CC} | V | |
| Reference voltage | - | AVRH | 4.5 | - | AV _{CC} | V | T _{ck} < 50 ns |
| | | | 2.7 | - | AV _{CC} | | T _{ck} ≥ 50 ns |
| | - | AV _{RL} | AV _{SS} | - | AV _{SS} | V | |

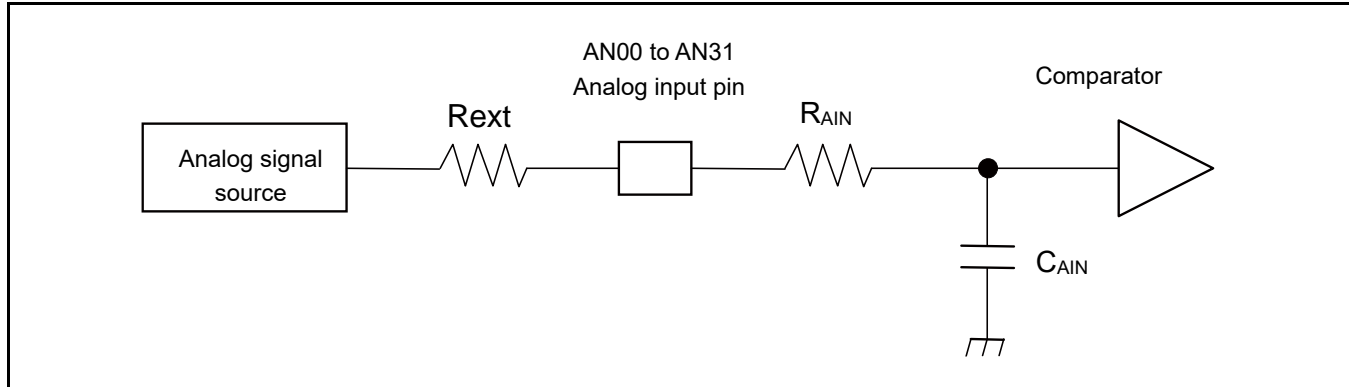
*1: The conversion time is the value of sampling time (T_s) + compare time (T_c).

The condition of the minimum conversion time is when the value of T_s = 150 ns and T_c = 350 ns (AV_{CC} ≥ 4.5V). Ensure that it satisfies the value of sampling time (T_s) and compare clock cycle (T_{ck}). For setting of sampling time and compare clock cycle, see Chapter 1-1: A/D Converter in FM4 Family Peripheral Manual Analog Macro Part (002-04860). The register setting of the A/D converter is reflected by the APB bus clock timing. For more information about the APB bus number to which the A/D converter is connected, see 8. Block Diagram in this data sheet.

The sampling and compare clock are set at base clock (HCLK).

*2: A necessary sampling time changes by external impedance. Ensure that it sets the sampling time to satisfy (Equation 1).

*3: The compare time (T_c) is the value of (Equation 2).



(Equation 1) $T_s \geq (R_{AIN} + R_{ext}) \times C_{AIN} \times 9$

T_s : Sampling time

R_{AIN} : Input resistance of A/D = 1.2 k Ω at 4.5 V $\leq AV_{CC} \leq$ 5.5 V

Input resistance of A/D = 1.8 k Ω at 2.7 V $\leq AV_{CC} <$ 4.5 V

C_{AIN} : Input capacity of A/D = 12.05 pF at 2.7 V $\leq AV_{CC} \leq$ 5.5 V

R_{ext} : Output impedance of external circuit

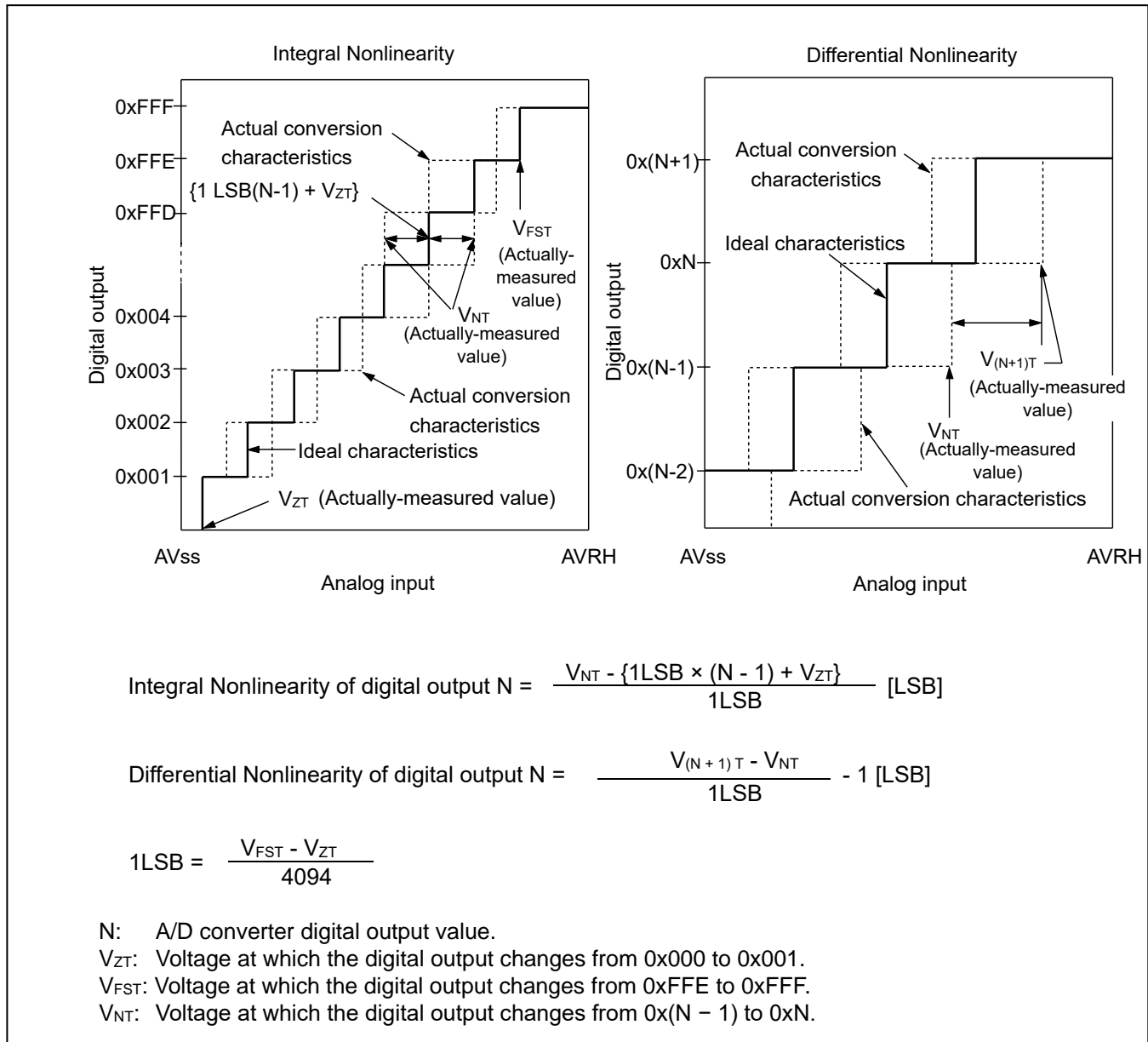
(Equation 2) $T_c = T_{cck} \times 14$

T_c : Compare time

T_{cck} : Compare clock cycle

Definition of 12-bit A/D Converter Terms

- Resolution: Analog variation that is recognized by an A/D converter.
- Integral Nonlinearity: Deviation of the line between the zero-transition point (0b000000000000 ↔ 0b000000000001) and the full-scale transition point (0b111111111110 ↔ 0b111111111111) from the actual conversion characteristics.
- Differential Nonlinearity: Deviation from the ideal value of the input voltage that is required to change the output code by 1 LSB.



12.6 12-bit D/A Converter
Electrical Characteristics for the D/A Converter

 (V_{CC} = AV_{CC} = 2.7 V to 5.5 V, V_{SS} = AV_{SS} = 0 V)

| Parameter | Symbol | Pin Name | Value | | | Unit | Remarks |
|-----------------------------|-------------------|----------|--------|------|-------|---------------|--|
| | | | Min | Typ | Max | | |
| Resolution | - | DAx | - | - | 12 | bit | |
| Conversion time | t _{C20} | | 0.56 | 0.69 | 0.81 | μs | Load 20 pF |
| | t _{C100} | | 2.79 | 3.42 | 4.06 | μs | Load 100 pF |
| Integral nonlinearity * | INL | | - 16 | - | + 16 | LSB | |
| Differential nonlinearity * | DNL | | - 0.98 | - | + 1.5 | LSB | |
| Output voltage offset | V _{OFF} | | - | - | + 10 | mV | When setting 0x000 |
| | | | - 20.0 | - | + 1.4 | mV | When setting 0xFFFF |
| Analog output impedance | R _O | | 3.10 | 3.80 | 4.50 | kΩ | D/A operation |
| | | 2.0 | - | - | MΩ | When D/A stop | |
| Power supply current * | IDDA | AVCC | 260 | 330 | 410 | μs | D/A 1ch operation AV _{CC} = 3.3 V |
| | | | 400 | 510 | 620 | μs | D/A 1ch operation AV _{CC} = 5.0 V |
| | IDSA | | - | - | 14 | μs | When D/A stop |

*: During no load

12.7 USB Characteristics

($V_{CC} = AV_{CC} = 2.7\text{ V to }5.5\text{ V}$, $USBV_{CC0} = USBV_{CC1} = 3.0\text{ V to }3.6\text{ V}$, $V_{SS} = AV_{SS} = 0\text{ V}$)

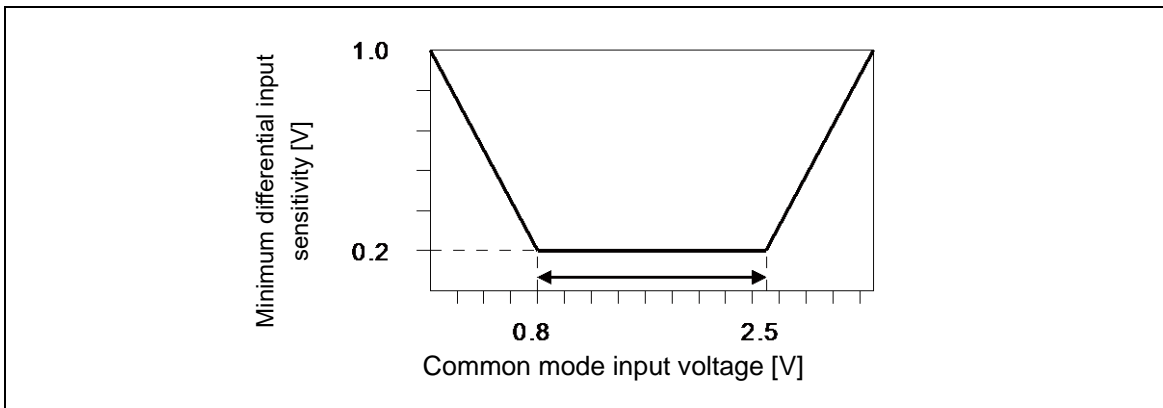
| Parameter | | Symbol | Pin Name | Conditions | Value | | Unit | Remarks |
|------------------------|--------------------------------|------------|---------------------------------|---|----------------|-------------------|------|---------|
| | | | | | Min | Max | | |
| Input characteristics | Input H level voltage | V_{IH} | UDP0/ UDM0, UDP1/ UDM1 | - | 2.0 | $USBV_{CC} + 0.3$ | V | *1 |
| | Input L level voltage | V_{IL} | | - | $V_{SS} - 0.3$ | 0.8 | V | *1 |
| | Differential input sensitivity | V_{DI} | | - | 0.2 | - | V | *2 |
| | Different common mode range | V_{CM} | | - | 0.8 | 2.5 | V | *2 |
| Output characteristics | Output H level voltage | V_{OH} | | External pull-down resistance = 15 k Ω | 2.8 | 3.6 | V | *3 |
| | Output L level voltage | V_{OL} | | External pull-up resistance = 1.5 k Ω | 0.0 | 0.3 | V | *3 |
| | Crossover voltage | V_{CRS} | | - | 1.3 | 2.0 | V | *4 |
| | Rise time | t_{FR} | | Full-Speed | 4 | 20 | ns | *5 |
| | Fall time | t_{FF} | | Full-Speed | 4 | 20 | ns | *5 |
| | Rise/fall time matching | t_{FRFM} | | Full-Speed | 90 | 111.11 | % | *5 |
| | Output impedance | Z_{DRV} | Full-Speed | 28 | 44 | Ω | *6 | |
| | Rise time | t_{LR} | Low-Speed | 75 | 300 | ns | *7 | |
| | Fall time | t_{LF} | Low-Speed | 75 | 300 | ns | *7 | |
| | Rise/fall time matching | t_{LRFM} | Low-Speed | 80 | 125 | % | *7 | |

*1: The switching threshold voltage of the single-end-receiver of USB I/O buffer is set as within $V_{IL}(\text{Max}) = 0.8\text{ V}$, $V_{IH}(\text{Min}) = 2.0\text{ V}$ (TTL input standard).

There is some hysteresis applied to lower noise sensitivity.

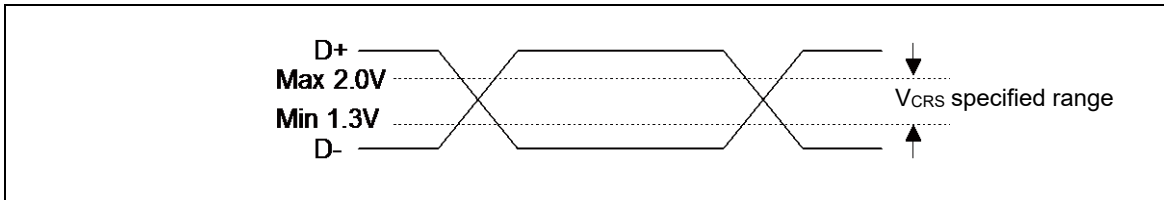
*2: Use differential-receiver to receive USB differential data signal. Differential-receiver has 200 mV of differential input sensitivity when the differential data input is within 0.8 V to 2.5 V to the local ground reference level.

Above voltage range is the common mode input voltage range.

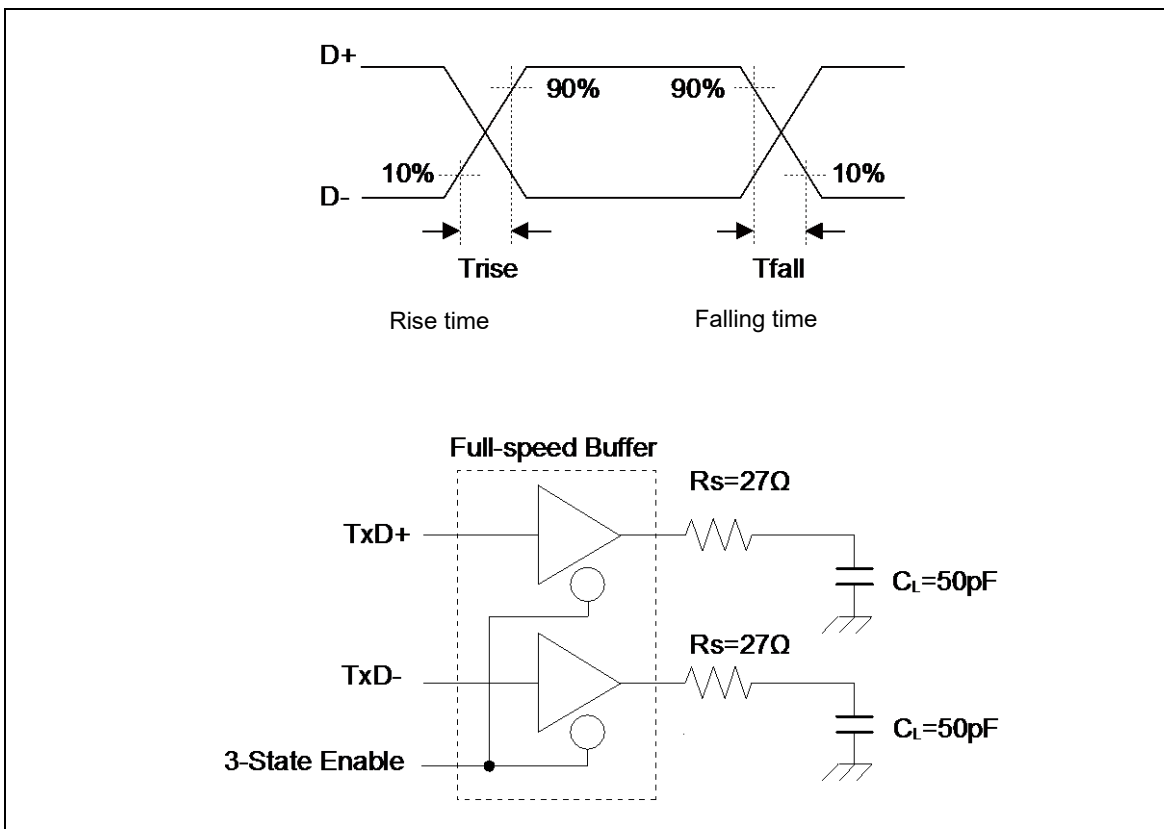


*3: The output drive capability of the driver is below 0.3 V at low state (V_{OL}) (to 3.6 V and 1.5 k Ω load), and 2.8 V or above (to the VSS and 1.5 k Ω load) at high state (V_{OH}).

*4: The cross voltage of the external differential output signal (D +/D -) of USB I/O buffer is within 1.3 V to 2.0 V.

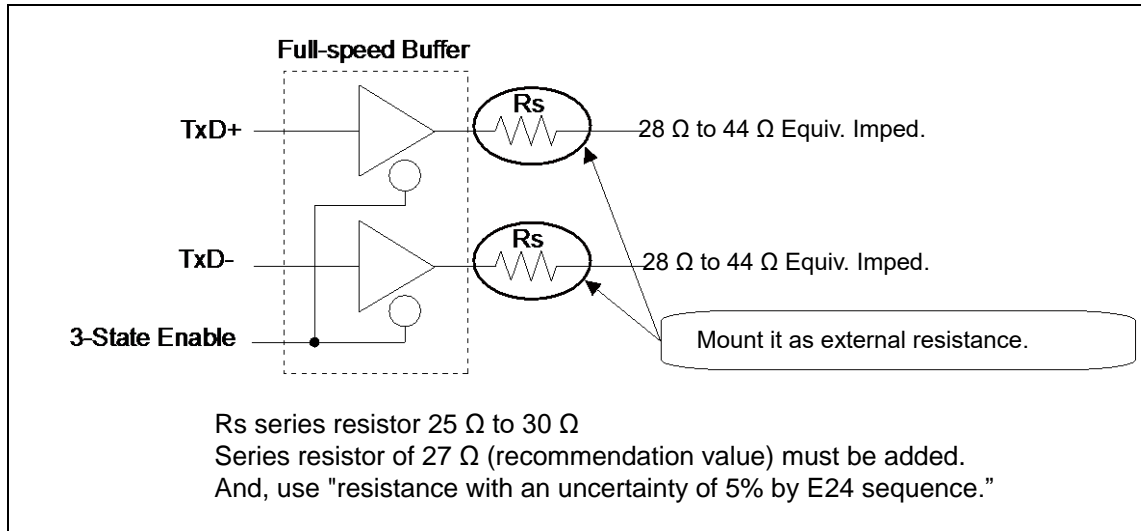


*5: They indicate rise time (T_{rise}) and fall time (T_{fall}) of the full-speed differential data signal. They are defined by the time between 10% and 90% of the output signal voltage. For full-speed buffer, T_r/T_f ratio is regulated as within $\pm 10\%$ to minimize RFI emission.

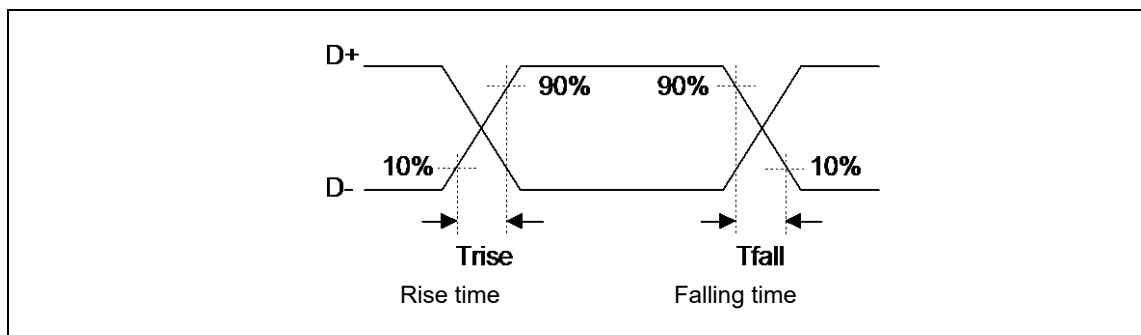


*6: USB Full-speed connection is performed via twisted-pair cable shield with $90 \Omega \pm 15\%$ characteristic impedance (differential mode).

USB standard defines that the output impedance of the USB driver must be in the range from 28Ω to 44Ω . So, a discrete series resistor (R_s) addition is defined in order to satisfy the above definition and keep balance. When using this USB I/O, use it with 25Ω to 30Ω (recommended value 27Ω) series resistor R_s .



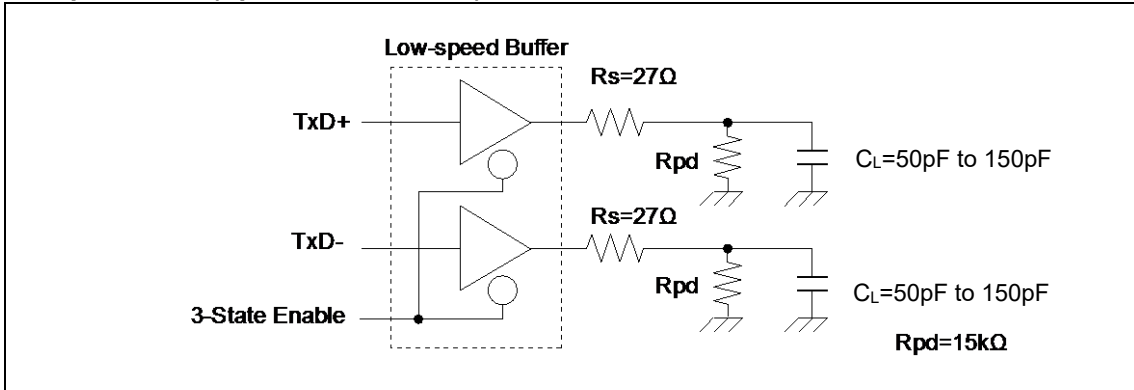
*7: They indicate rise time (T_{rise}) and fall time (T_{fall}) of the low-speed differential data signal. They are defined by the time between 10% and 90% of the output signal voltage.



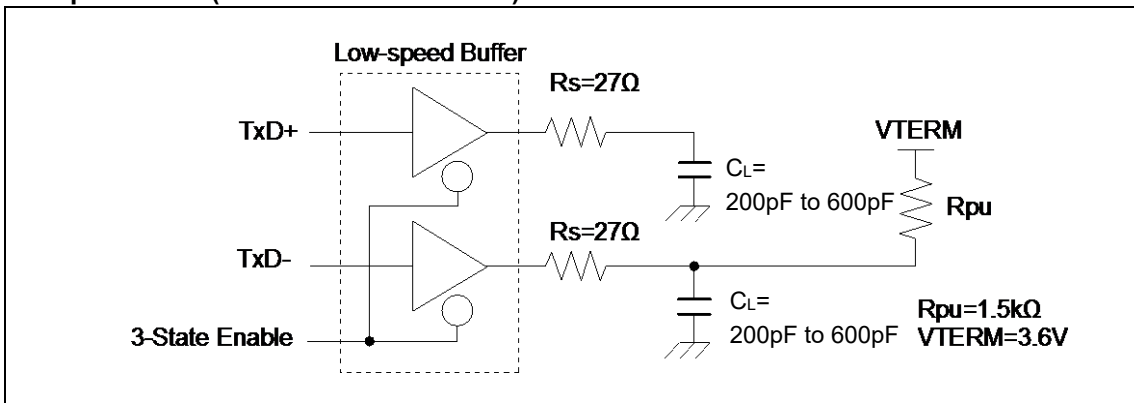
Note:

- See *Low-Speed Load (Compliance Load)* for conditions of external load.

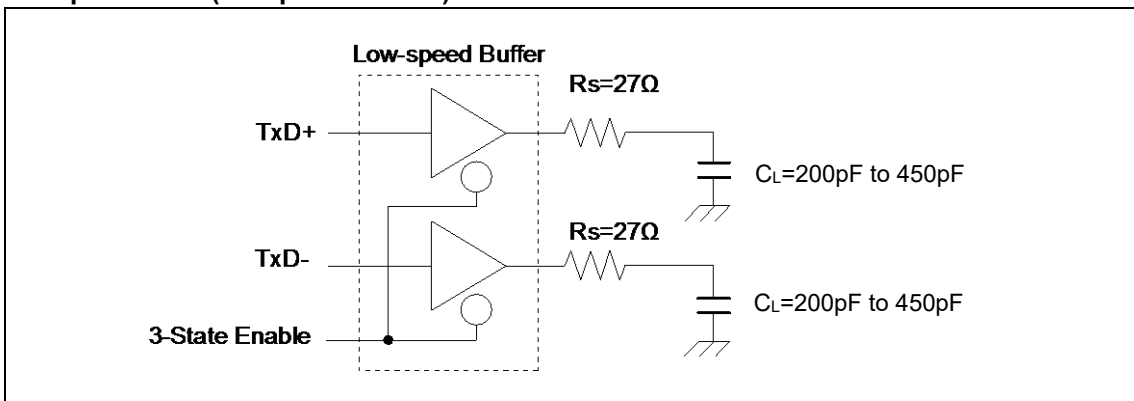
Low-Speed Load (Upstream Port Load) - Reference 1



Low-Speed Load (Downstream Port Load) - Reference 2



Low-Speed Load (Compliance Load)



12.8 Low-Voltage Detection Characteristics

12.8.1 Low-Voltage Detection Reset

| Parameter | Symbol | Conditions | Value | | | Unit | Remarks |
|------------------|--------|------------|-------|------|------|------|--------------------|
| | | | Min | Typ | Max | | |
| Detected voltage | VDL | - | 2.46 | 2.55 | 2.64 | V | When voltage drops |
| Released voltage | VDH | - | 2.51 | 2.60 | 2.69 | V | When voltage rises |

12.8.2 Interrupt of Low-Voltage Detection

| Parameter | Symbol | Conditions | Value | | | Unit | Remarks |
|-----------------------------|-------------------|--------------|-------|------|----------------------------|------|--------------------|
| | | | Min | Typ | Max | | |
| Detected voltage | VDL | SVHI = 00111 | 2.80 | 2.90 | 3.00 | V | When voltage drops |
| Released voltage | VDH | | 2.90 | 3.00 | 3.11 | V | When voltage rises |
| Detected voltage | VDL | SVHI = 00100 | 2.99 | 3.10 | 3.21 | V | When voltage drops |
| Released voltage | VDH | | 3.09 | 3.20 | 3.31 | V | When voltage rises |
| Detected voltage | VDL | SVHI = 01100 | 3.18 | 3.30 | 3.42 | V | When voltage drops |
| Released voltage | VDH | | 3.28 | 3.40 | 3.52 | V | When voltage rises |
| Detected voltage | VDL | SVHI = 01111 | 3.67 | 3.80 | 3.93 | V | When voltage drops |
| Released voltage | VDH | | 3.76 | 3.90 | 4.04 | V | When voltage rises |
| Detected voltage | VDL | SVHI = 01110 | 3.76 | 3.90 | 4.04 | V | When voltage drops |
| Released voltage | VDH | | 3.86 | 4.00 | 4.14 | V | When voltage rises |
| Detected voltage | VDL | SVHI = 01001 | 4.05 | 4.20 | 4.35 | V | When voltage drops |
| Released voltage | VDH | | 4.15 | 4.30 | 4.45 | V | When voltage rises |
| Detected voltage | VDL | SVHI = 01000 | 4.15 | 4.30 | 4.45 | V | When voltage drops |
| Released voltage | VDH | | 4.25 | 4.40 | 4.55 | V | When voltage rises |
| Detected voltage | VDL | SVHI = 11000 | 4.25 | 4.40 | 4.55 | V | When voltage drops |
| Released voltage | VDH | | 4.34 | 4.50 | 4.66 | V | When voltage rises |
| LVD stabilization wait time | T _{LVDW} | - | - | - | 6000 × t _{CYCP} * | μs | |

*: t_{CYCP} indicates the APB2 bus clock cycle time.

12.9 MainFlash Memory Write/Erase Characteristics

(V_{CC} = 2.7 V to 5.5 V)

| Parameter | | Value | | | Unit | Remarks |
|-------------------------------|--------------------------|-------|------|-----|------|---|
| | | Min | Typ | Max | | |
| Sector erase time | Large Sector | - | 0.7 | 3.7 | s | Includes write time prior to internal erase |
| | Small Sector | - | 0.3 | 1.1 | s | |
| Half word (16-bit) write time | Write cycles ≤ 100 times | - | 12 | 100 | μs | Not including system-level overhead time |
| | Write cycles > 100 times | | | 200 | | |
| Chip erase time* | | - | 13.6 | 68 | s | Includes write time prior to internal erase |

*: It indicates the chip erase time of 1 MB MainFlash memory

For devices with 1.5 MB or 2 MB of MainFlash memory, two erase cycles are required.

See 3.2.2 Command Operating Explanations and 3.3.3 Flash Erase Operation in this product's Flash Programming Manual for the detail.

Write Cycles and Data Retention Time

| Erase/Write Cycles (Cycle) | Data Retention Time (Year) |
|----------------------------|----------------------------|
| 1,000 | 20* |
| 10,000 | 10* |
| 100,000 | 5* |

*: This value comes from the technology qualification (using Arrhenius equation to translate high temperature acceleration test result into average temperature value at + 85°C).

12.10 Dual Flash Memory Write/Erase Characteristics

It is the same write/erase characteristics as the MainFlash memory.

See 3.6 Dual flash mode in this product's Flash Programming Manual for the detail of dual flash mode.

12.11 Standby Recovery Time

12.11.1 Recovery cause: Interrupt/WKUP

The time from the interrupt occurring to the time of program operation start is shown.

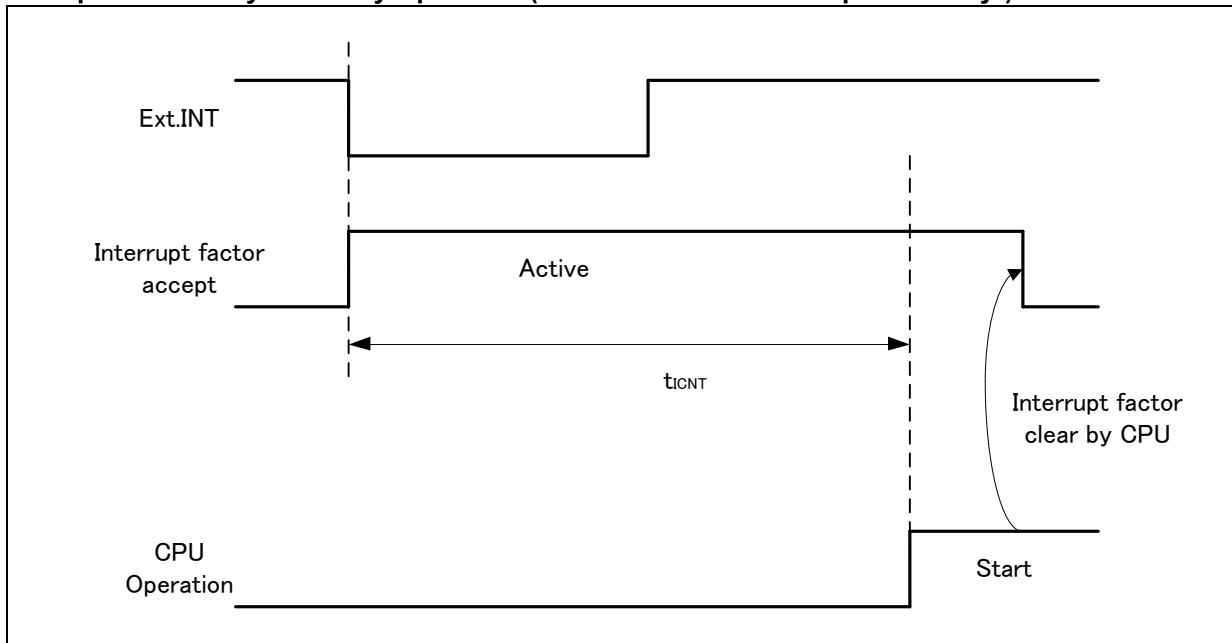
Recovery Count Time

($V_{CC} = 2.7\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$)

| Parameter | Symbol | Value | | Unit | Remarks |
|---|-------------------|--------|------|------|-----------------------|
| | | Typ | Max* | | |
| Sleep mode | t _{ICNT} | HCLK×1 | | μs | |
| High-speed CR Timer mode Main Timer mode PLL Timer mode | | 40 | 80 | μs | |
| Low-speed CR Timer mode | | 450 | 900 | μs | |
| Sub Timer mode | | 896 | 1136 | μs | |
| RTC mode Stop mode (High-speed CR/Main/PLL Run mode return) | | 316 | 581 | μs | |
| RTC mode Stop mode (Low-speed CR/sub Run mode return) | | 270 | 540 | μs | |
| Deep Standby RTC mode with RAM retention | | 365 | 667 | μs | without RAM retention |
| Deep Standby Stop mode with RAM retention | | 365 | 667 | μs | with RAM retention |

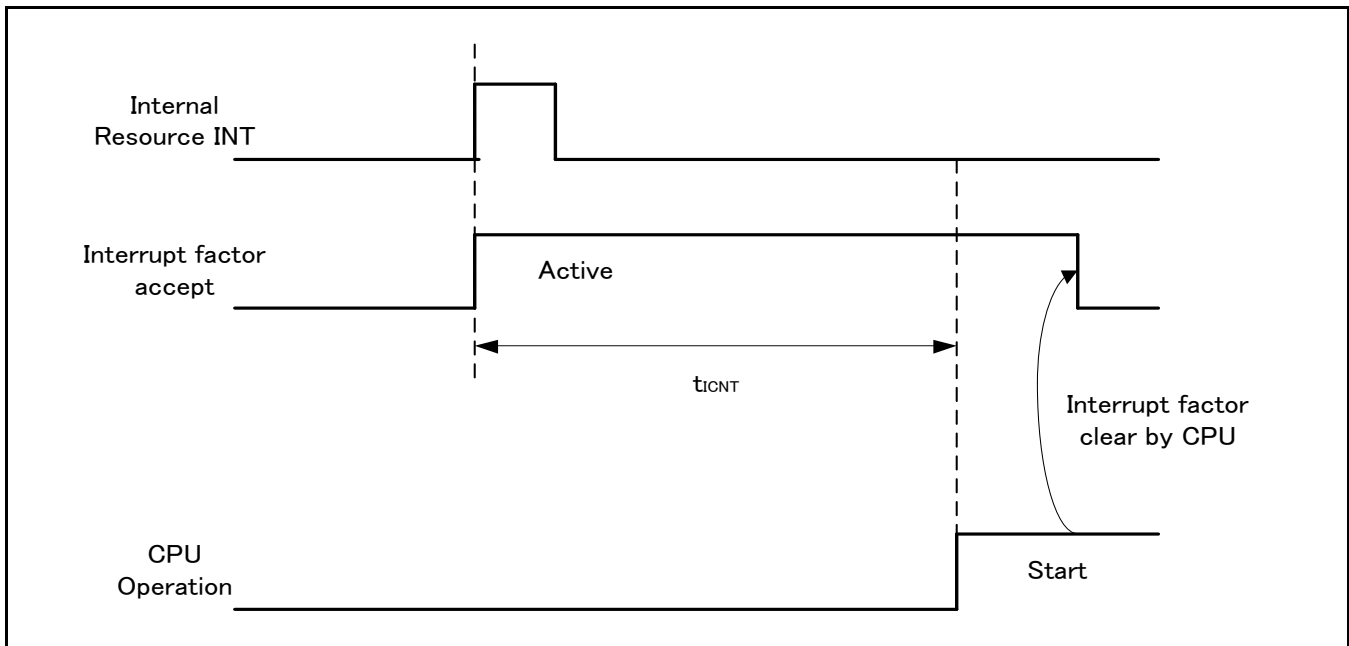
*: The maximum value depends on the built-in CR accuracy.

Example of Standby Recovery Operation (when in External Interrupt Recovery*)



*: External interrupt is set to detecting fall edge.

Example of Standby Recovery Operation (when in Internal Resource Interrupt Recovery*)



*: Depending on the standby mode, interrupt from the internal resource is not included in the recovery cause.

Notes:

- The return factor is different in each low-power consumption mode. See Chapter 6: Low Power Consumption Mode and Operations of Standby Modes in FM4 Family Peripheral Manual Main Part (002-04856).
- The recovery process is unique for each operating mode. See Chapter 6: Low Power Consumption Mode in FM4 Family Peripheral Manual Main Part (002-04856).

12.11.2 Recovery Cause: Reset

The time from reset release to the program operation start is shown.

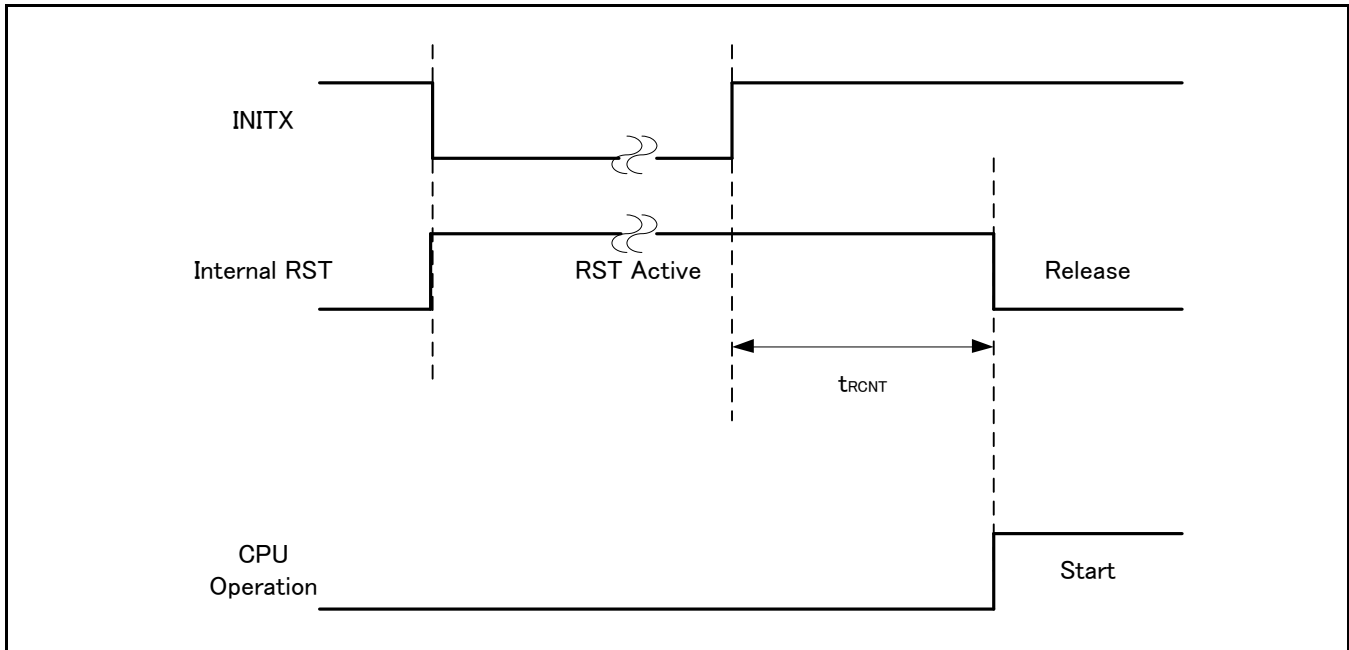
Recovery Count Time

(V_{CC} = 2.7 V to 5.5 V, V_{SS} = 0 V)

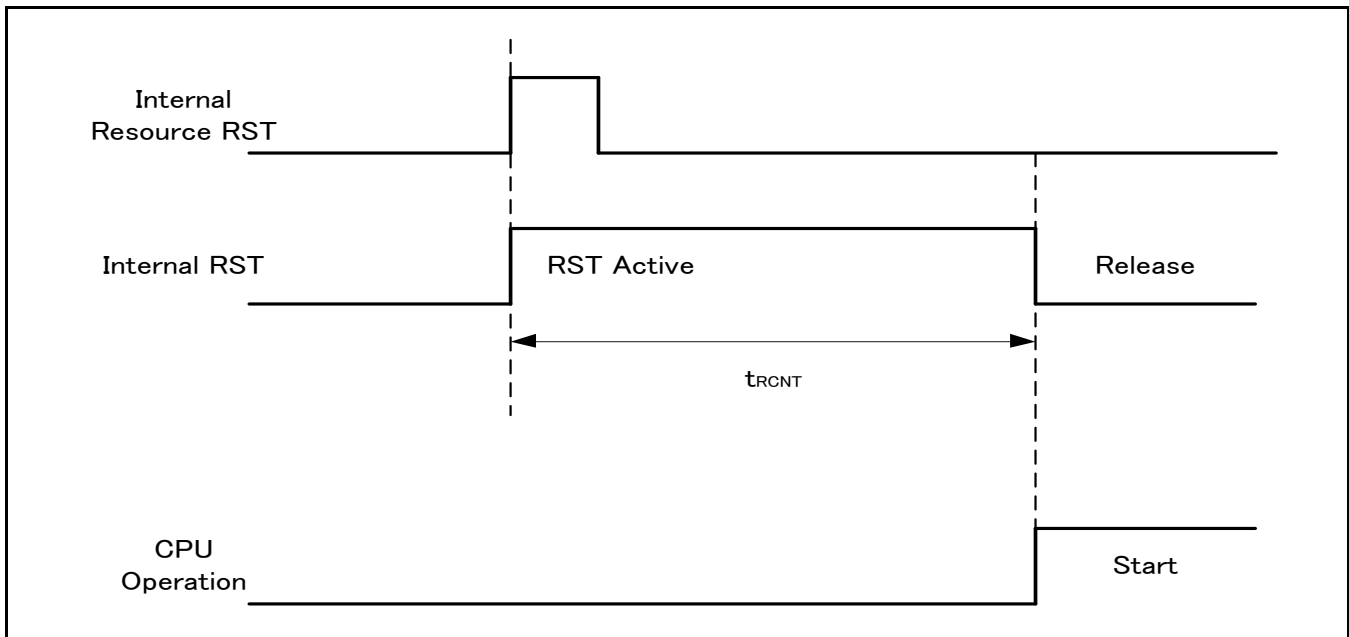
| Parameter | Symbol | Value | | Unit | Remarks |
|---|-------------------|-------|------|------|-----------------------|
| | | Typ | Max* | | |
| Sleep mode | t _{RCNT} | 155 | 266 | μs | |
| High-speed CR Timer mode Main Timer mode PLL Timer mode | | 155 | 266 | μs | |
| Low-speed CR Timer mode | | 315 | 567 | μs | |
| Sub Timer mode | | 315 | 567 | μs | |
| RTC mode Stop mode | | 315 | 567 | μs | |
| Deep Standby RTC mode with RAM retention Deep Standby Stop mode with RAM retention | | 336 | 667 | μs | without RAM retention |
| | | 336 | 667 | μs | with RAM retention |

*: The maximum value depends on the built-in CR accuracy.

Example of Standby Recovery Operation (when in INITX Recovery)



Example of Standby Recovery Operation (when in Internal Resource Reset Recovery*)



*: Depending on the low-power consumption mode, the reset issue from the internal resource is not included in the recovery cause.

Notes:

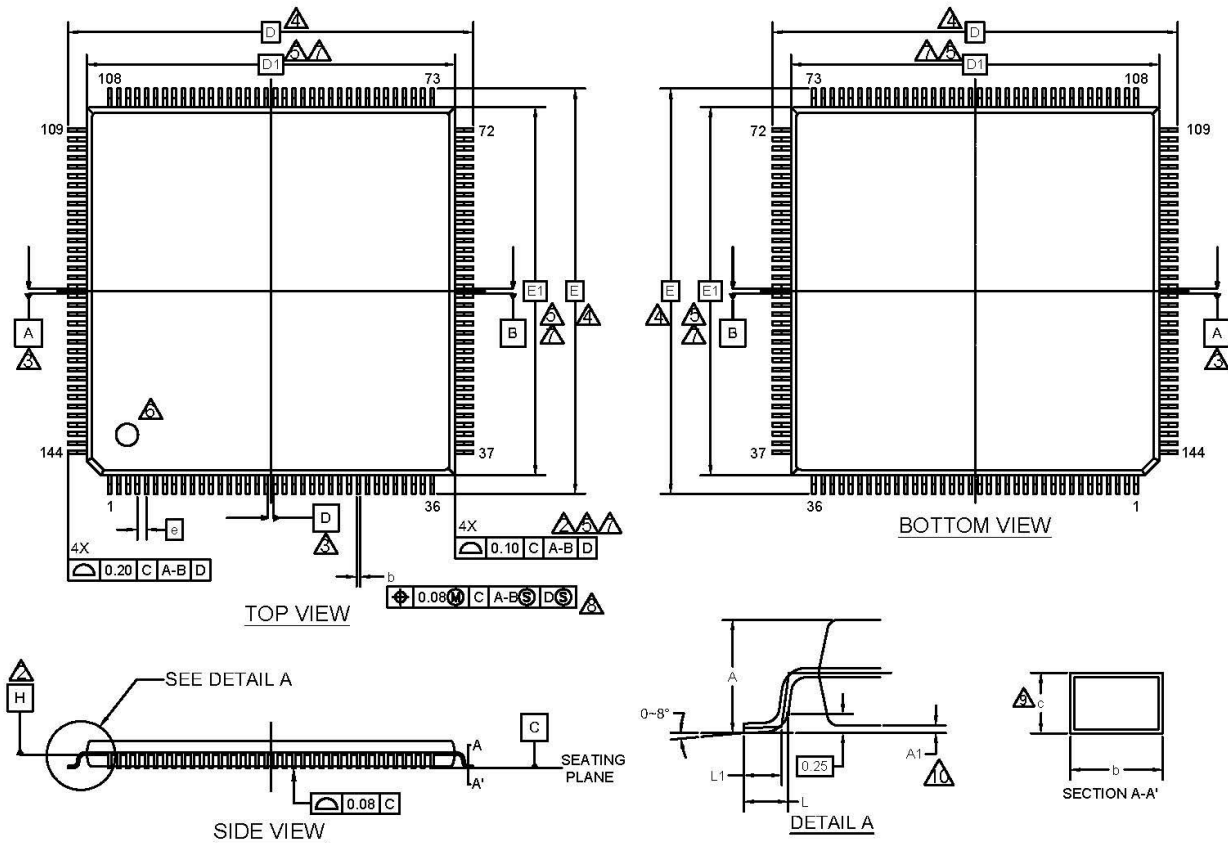
- The return factor is different in each low power consumption mode. See Chapter 6: Low Power Consumption Mode and Operations of Standby Modes in FM4 Family Peripheral Manual Main Part (002-04856).
- The recovery process is unique for each operating mode. See Chapter 6: Low Power Consumption Mode in FM4 Family Peripheral Manual Main Part (002-04856).
- When the power-on reset/low-voltage detection reset, they are not included in the return factor. See 12.4.8 Power-On Reset Timing.
- In recovering from reset, CPU changes to High-speed Run mode. In the case of using the main clock and PLL clock, they need further main clock oscillation stabilization wait time and oscillation stabilization wait time of Main PLL clock.
- Internal resource reset indicates Watchdog reset and CSV reset.

13. Ordering Information

| Part number | Flash | RAM | Crypto | Package |
|-------------------|--------|--------|--------|--|
| S6E2C38H0AGV2000A | 1 MB | 128 KB | N/A | Plastic • LQFP (0.5-mm pitch), 144 pin (LQS144) |
| S6E2C39H0AGV2000A | 1.5 MB | 192 KB | N/A | |
| S6E2C3AH0AGV2000A | 2 MB | 256 KB | N/A | |
| S6E2C38J0AGV2000A | 1 MB | 128 KB | N/A | Plastic • LQFP (0.65-mm pitch), 176 pin (LQP176) |
| S6E2C39J0AGV2000A | 1.5 MB | 192 KB | N/A | |
| S6E2C3AJ0AGV2000A | 2 MB | 256 KB | N/A | |
| S6E2C38J0AGB1000A | 1 MB | 128 KB | N/A | Plastic • LQFP (0.8-mm pitch), 192 pin (LBE192) |
| S6E2C39J0AGB1000A | 1.5 MB | 192 KB | N/A | |
| S6E2C3AJ0AGB1000A | 2 MB | 256 KB | N/A | |
| S6E2C38L0AGL2000A | 1 MB | 128 KB | N/A | Plastic • LQFP (0.4-mm pitch), 216 pin (LQQ216) |
| S6E2C39L0AGL2000A | 1.5 MB | 192 KB | N/A | |
| S6E2C3AL0AGL2000A | 2 MB | 256 KB | N/A | |

14. Package Diagrams

| Package Type | Package Code |
|--------------|--------------|
| LQFP 144 | LQS 144 |



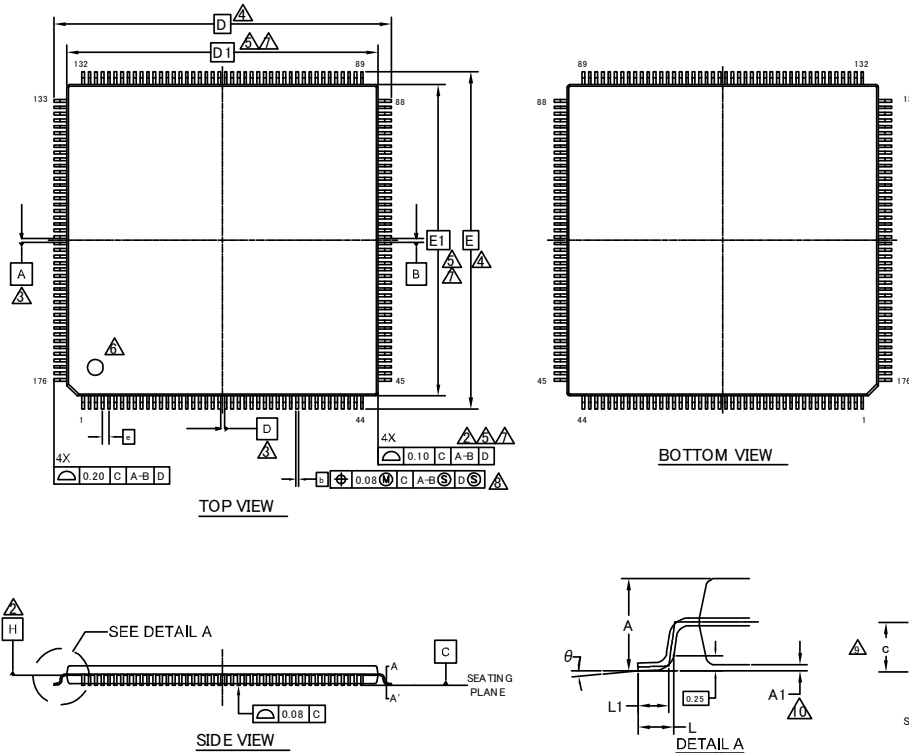
| SYMBOL | DIMENSIONS | | |
|--------|------------|------|------|
| | MIN. | NOM. | MAX. |
| A | — | — | 1.70 |
| A1 | 0.05 | — | 0.15 |
| b | 0.17 | 0.22 | 0.27 |
| c | 0.09 | — | 0.20 |
| D | 22.00 BSC | | |
| D1 | 20.00 BSC | | |
| e | 0.50 BSC | | |
| E | 22.00 BSC | | |
| E1 | 20.00 BSC | | |
| L | 0.45 | 0.60 | 0.75 |
| L1 | 0.30 | 0.50 | 0.70 |

NOTES

- ALL DIMENSIONS ARE IN MILLIMETERS
- DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
- DATUMS A-B AND D TO BE DETERMINED AT DATUM PLANE H.
- TO BE DETERMINED AT SEATING PLANE C.
- DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PRE SIDE. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
- DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
- REGARDLESS OF THE RELATIVE SIZE OF THE UPPER AND LOWER BODY SECTIONS. DIMENSIONS D1 AND E1 ARE DETERMINED AT THE LARGEST FEATURE OF THE BODY EXCLUSIVE OF MOLD FLASH AND GATE BURRS. BUT INCLUDING ANY MISMATCH BETWEEN THE UPPER AND LOWER SECTIONS OF THE MOLDER BODY.
- DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. THE DAMBAR PROTRUSION (S) SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED b MAXIMUM BY MORE THAN 0.08mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT.
- THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm AND 0.25mm FROM THE LEAD TIP.
- A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

002-13015 *A

| Package Type | Package Code |
|--------------|--------------|
| LQFP 176 | LQP 176 |



| SYMBOL | DIMENSIONS | | |
|----------|------------|------|------|
| | MIN. | NOM. | MAX. |
| A | — | — | 1.70 |
| A1 | 0.05 | — | 0.15 |
| b | 0.17 | 0.22 | 0.27 |
| c | 0.09 | — | 0.20 |
| D | 26.00 BSC | | |
| D1 | 24.00 BSC | | |
| e | 0.50 BSC | | |
| E | 26.00 BSC | | |
| E1 | 24.00 BSC | | |
| L | 0.45 | 0.60 | 0.75 |
| L1 | 0.30 | 0.50 | 0.70 |
| θ | 0° | — | 8° |

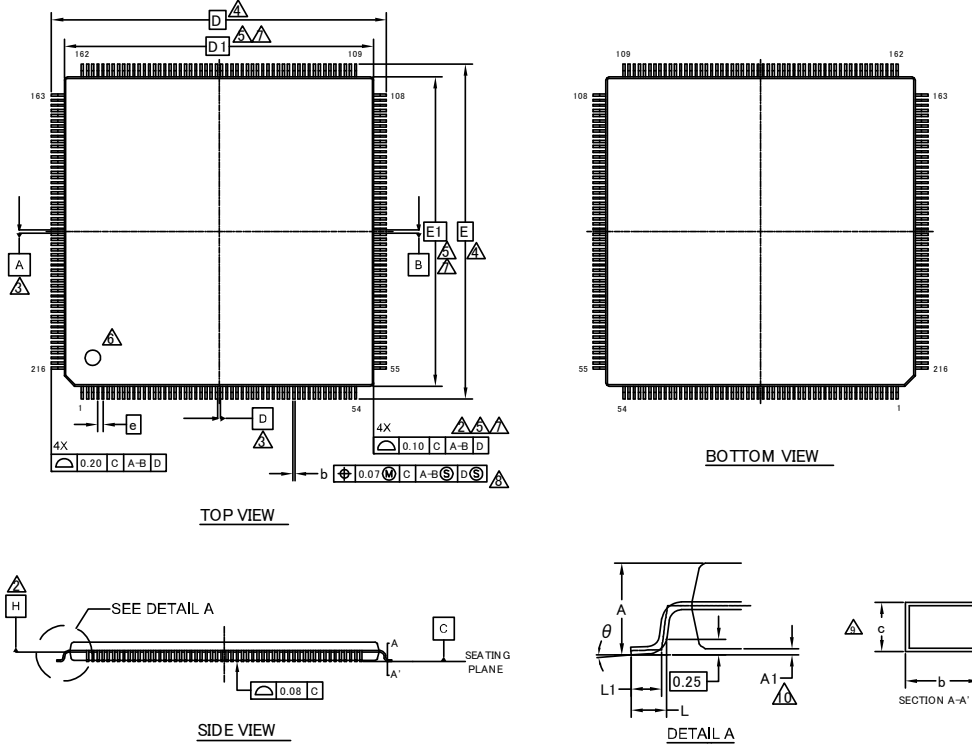
NOTES

- ALL DIMENSIONS ARE IN MILLIMETERS.
- DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
- DATUMS A-B AND D TO BE DETERMINED AT DATUM PLANE H.
- TO BE DETERMINED AT SEATING PLANE C.
- DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PRE SIDE. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
- DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
- REGARDLESS OF THE RELATIVE SIZE OF THE UPPER AND LOWER BODY SECTIONS, DIMENSIONS D1 AND E1 ARE DETERMINED AT THE LARGEST FEATURE OF THE BODY EXCLUSIVE OF MOLD FLASH AND GATE BURRS, BUT INCLUDING ANY MISMATCH BETWEEN THE UPPER AND LOWER SECTIONS OF THE MOLDER BODY.
- DIMENSION b DOES NOT INCLUDE DAMBER PROTRUSION. THE DAMBER PROTRUSION (S) SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED b MAXIMUM BY MORE THAN 0.08mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT.
- THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm AND 0.25mm FROM THE LEAD TIP.
- A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

002-15150 **

 PACKAGE OUTLINE, 176 LEAD LQFP
 24.0X24.0X1.7 MM LQP176 REV**

| | |
|---------------------|---------------------|
| Package Type | Package Code |
| LQFP 216 | LQQ 216 |



| SYMBOL | DIMENSIONS | | |
|----------|------------|------|------|
| | MIN. | NOM. | MAX. |
| A | — | — | 1.70 |
| A1 | 0.05 | — | 0.15 |
| b | 0.13 | 0.18 | 0.23 |
| c | 0.09 | — | 0.20 |
| D | 26.00 BSC. | | |
| D1 | 24.00 BSC. | | |
| e | 0.40 BSC. | | |
| E | 26.00 BSC. | | |
| E1 | 24.00 BSC. | | |
| L | 0.45 | 0.60 | 0.75 |
| L1 | 0.30 | 0.50 | 0.70 |
| θ | 0° | — | 8° |

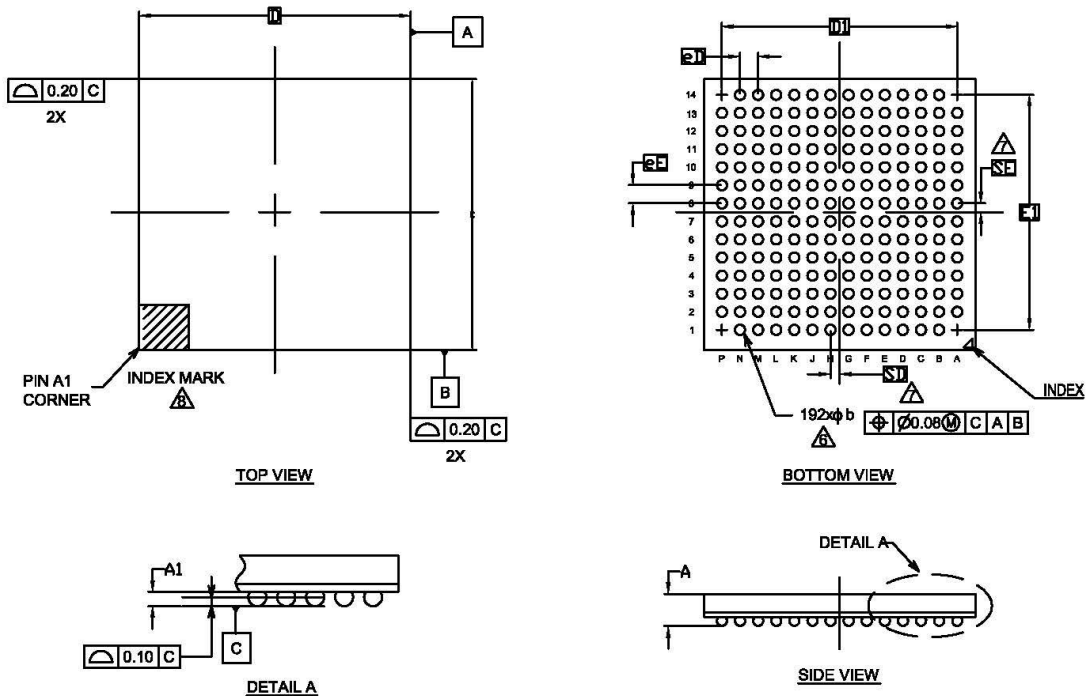
NOTES

- ALL DIMENSIONS ARE IN MILLIMETERS.
- DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
- DATUMS A-B AND D TO BE DETERMINED AT DATUM PLANE H.
- DATUMS A-B AND D TO BE DETERMINED AT SEATING PLANE C.
- DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PRE SIDE. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
- DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
- REGARDLESS OF THE RELATIVE SIZE OF THE UPPER AND LOWER BODY SECTIONS, DIMENSIONS D1 AND E1 ARE DETERMINED AT THE LARGEST FEATURE OF THE BODY EXCLUSIVE OF MOLD FLASH AND GATE BURRS, BUT INCLUDING ANY MISMATCH BETWEEN THE UPPER AND LOWER SECTIONS OF THE MOLDER BODY.
- DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. THE DAMBAR PROTRUSION (S) SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED b MAXIMUM BY MORE THAN 0.08mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT.
- THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm AND 0.25mm FROM THE LEAD TIP.
- A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

002-15153 **

 PACKAGE OUTLINE, 216 LEAD LQFP
 24.0X24.0X1.7 MM LQQ216 REV**

| Package Type | Package Code |
|--------------|--------------|
| PFBGA 192 | LBE 192 |



| SYMBOL | DIMENSIONS | | |
|--------|------------|------|------|
| | MIN. | NOM. | MAX. |
| A | — | — | 1.45 |
| A1 | 0.25 | 0.35 | 0.45 |
| D | 12.00 BSC | | |
| E | 12.00 BSC | | |
| D1 | 10.40 BSC | | |
| E1 | 10.40 BSC | | |
| MD | 14 | | |
| ME | 14 | | |
| n | 192 | | |
| φb | 0.35 | 0.45 | 0.55 |
| eD | 0.80 BSC | | |
| eE | 0.80 BSC | | |
| SD/SE | 0.40 BSC | | |

NOTES

- ALL DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS AND TOLERANCES METHODS PER ASME Y14.5-2009. THIS OUTLINE CONFORMS TO JEP95, SECTION 4.5.
- BALL POSITION DESIGNATION PER JEP95, SECTION 3, SPP-010.
- "e" REPRESENTS THE SOLDER BALL GRID PITCH.
- SYMBOL "MD" IS THE BALL MATRIX SIZE IN THE "D" DIRECTION. SYMBOL "ME" IS THE BALL MATRIX SIZE IN THE "E" DIRECTION. n IS THE NUMBER OF POPULATED SOLDER BALL POSITIONS FOR MATRIX SIZE MD X ME.
- DIMENSION "b" IS MEASURED AT THE MAXIMUM BALL DIAMETER IN A PLANE PARALLEL TO DATUM C.
- "SD" AND "SE" ARE MEASURED WITH RESPECT TO DATUMS A AND B AND DEFINE THE POSITION OF THE CENTER SOLDER BALL IN THE OUTER ROW. WHEN THERE IS AN ODD NUMBER OF SOLDER BALLS IN THE OUTER ROW, "SD" OR "SE" = 0. WHEN THERE IS AN EVEN NUMBER OF SOLDER BALLS IN THE OUTER ROW, "SD" = eD/2 AND "SE" = eE/2.
- A1 CORNER TO BE IDENTIFIED BY CHAMFER, LASER OR INK MARK. METALLIZED MARK INDENTATION OR OTHER MEANS.
- "+" INDICATES THE THEORETICAL CENTER OF DEPOPULATED BALLS.

002-13493 *A

15. Major Changes

Spansion Publication Number: S6E2C3_DS709-00012

| Page | Section | Change Results |
|----------------------|--|---|
| Revision 0.1 | | |
| - | - | Initial release |
| Revision 1.0 | | |
| 11 13 87 88 | 2. Features 3. Product Lineup 10. Block Diagram 12. Memory Map | Deleted HDM-CEC/Remote Control Receiver. |
| 16-18 | 5. Pin Assignments | Deleted the pins of HDM-CEC/Remote Control Receiver.(CEC0,CEC1) Revised the pin name of I2S. (MI2S*_0→MI2S*0_0) Deleted the pin of IGTRG0_0. |
| 20-71 | 6. Pin Descriptions | Deleted the pins of HDM-CEC/Remote Control Receiver.(CEC0,CEC1) Revised the pin name of I2S. (MI2S*_0→MI2S*0_0) Revised the pin number of PF7 in LQFP216.(91→90) revised the pin number of X1. (73, 58, 50, P5→107, 87, 71, P13) Revised the pin number of X0A. (107, 87, 71, P13→73, 58, 50, P5) |
| 72-79 | 7. I/O Circuit Type | Revised IOH/IOL of Type S.(IOH=-12mA→-10mA, IOL=12mA→10mA) Added the case of using I2C in Type E, F, G, L, N, S. |
| 94-101 | 13. Pin Status In Each CPU State | Deleted X and Y in Pin Status Type. |
| 102-103 | 14.1. Absolute Maximum Ratings | Added 10mA type. |
| 104-107 | 14.2. Recommended Operating Conditions | Added AVRL in Analog reference voltage. Revised the leakage current in Maximum leakage current at operating |
| 108-117 | 14.3.1. Current Rating | Revised the maximum current of each category. |
| 118-119 | 14.3.2. Pin Characteristics | Added the characteristic of external bus in H level input voltage (hysteresis input). Added the characteristic of 10 mA type. |
| 122 | 14.4.5. Operating Conditions of USB PLL · I2S PLL (in the case of using main clock for input clock of PLL) | Revised the maximum of I2S PLL macro oscillation clock frequency. (307.2 MHz→384 MHz) |
| 186 | 14.5.12-bit A/D Converter | Revised the minimum of Sampling time. Revised the characteristic of State transition time to operation permission Added AVRL in Analog reference voltage. |
| 194 | 14.8.2. Interrupt of Low-Voltage Detection | Revised the SVHI values in Conditions |

NOTE: Please see “Document History” about later revised information.

Document History

Document Title: S6E2C3 Series 32-bit ARM® Cortex®-M4F, FM4 Microcontroller
 Document Number: 002-04988

| Revision | ECN | Orig. of Change | Submission Date | Description of Change |
|----------|---------|-----------------|-----------------|---|
| ** | - | AKIH | 04/22/2015 | New Spec. |
| *A | 5126421 | HITK | 02/05/2016 | Company name and layout design change. Added the note of TAP pin. Updated Package Code and Dimensions (LQFP-144, LQFP-176, LQFP-216). |
| *B | 5634625 | YSKA | 02/20/2017 | Deleted CAN in communications interfaces. (Page 1) Deleted CAN(RX0_2, TX0_2) in LQQ216 pin assignments (Page 12) Deleted RX2_0 in P7D in "4. Pin Descriptions" (Page 20) Updated 12.4.8 Power-On Reset Timing. Changed parameter from "Power Supply rise time(t_{VCCR})[ms]" to "Power ramp rate(dV/dt)[mV/us]" and add some comments. (Page 113) Modified CSIO timing typo (12.4.12 CSIO(SPI) Timing) Deleted "SPI=1, MS=0" in the titles and added MS=0,1 in the schematic (Page 134-141, 150-157) Modified RTC description(Features, Real-Time Clock(RTC)) Deleted "second , or day of the week" in the Interrupt function.(Page 3) Modifications related to the VBAT in the following chapter. "7. Handling Devices" Notes on Power-on (Page 76) "11. Pin Status in Each CPU State" List of VBAT Domain Pin Status (Page 90) "12.3.1 Current Rating" Table12-9. Typical and Maximum Current Consumption in Deep Standby STOP Mode, Deep Standby RTC Mode and VBAT (Page 105) Deleted MPNs below from "13. Ordering Information" (Page 190) S6E2C38H0AGV20000, S6E2C38J0AGB10000, S6E2C38J0AGV20000, S6E2C38L0AGL20000, S6E2C39H0AGV20000, S6E2C39J0AGB10000, S6E2C39J0AGV20000, S6E2C39L0AGL20000, S6E2C3AH0AGV20000, S6E2C3AJ0AGB10000, S6E2C3AJ0AGV20000, S6E2C3AL0AGL20000 Added MPNs below to "13. Ordering Information" (Page 190) S6E2C38H0AGV2000A, S6E2C38J0AGB1000A, S6E2C38J0AGV2000A, S6E2C38L0AGL2000A, S6E2C39H0AGV2000A, S6E2C39J0AGB1000A, S6E2C39J0AGV2000A, S6E2C39L0AGL2000A, S6E2C3AH0AGV2000A, S6E2C3AJ0AGB1000A, S6E2C3AJ0AGV2000A, S6E2C3AL0AGL2000A Deleted Baud rate spec for High-Speed Synchronous Serial in "12.4.12 CSIO(SPI) Timing"(Page 142-148) Modified the expression of the "Built-in CR" and add Note in the "1. Product Lineup"(Page 8) Modified typo(SCLKx_0 -> SCKx_0)(Page 126, 128, 130, 132) Change the name from "USB Function" to "USB Device" (Page 1, 8, 58) Added Maximum Access size in "Features"(Page 1) Updated IO circuit (type A) (Page 62) |

| | | | | |
|----|---------|------|------------|--|
| *C | 6095085 | HUAL | 03/12/2018 | Updated Package Diagrams: Spec 002-13015 – Changed revision from ** to *A. Spec 002-13493 – Changed revision from ** to *A. Updated to new template. Completing Sunset Review. |
|----|---------|------|------------|--|

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